

Mixed Signal MCU

MD6601

Data Sheet

Not Recommended for New Designs

MD6601 Data Sheet	Rev. 1.0
Date of issue	2014.03.06
Publication	SANKEN ELECTRIC CO.,LTD.
Editing	SANKEN ELECTRIC CO.,LTD.
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Not Recommended for New Designs

MD6601 (Mixed Signal MCU)

1. Product Overview

1.1 Features

1.1.1 Analog Sub System

- **High Speed 10bit SAR ADC**
 - 2 Units (Independent)
 - 10 Inputs/unit
 - Conversion Speed: 4MSPS (4MSPS includes Sampling Time)
 - Simultaneous Sampling
 - Sequence Conversion
 - Configurable Conversion Triggers
 - Configurable Result Offset
- **High Precision 12bit SAR ADC**
 - 1 Unit
 - 10 inputs
 - Conversion Speed: 1MSPS
 - Sequence Conversion
 - Configurable Conversion Triggers
 - Configurable Result Offset
- **High Precision 12bit DAC**
 - 1 Units
 - Update Rate: 1MSPS
 - Configurable Update Triggers
- **High Speed Analog Comparator**
 - 4 Units
 - Response Time: 20ns
 - Rail-to-Rail Input
 - Digital Hazard Filter
 - Configurable Event Generation
- **Operational Amplifier (OPAMP)**
 - 2 Units
 - Rail-to-Rail Input / Output
 - Standalone or Unity, Selectable
- **Voltage Reference**
 - Generate 1.2V
- **Temperature Sensor**
 - Measures Junction Temperature
 - Read from Internal ADC
- **Analog Inter-Connection Network**
 - Configurable Inter-Connections among In/Out Signals of Analog Modules and External Pins

1.1.2 Digital Sub System

- **Pipelined 8bit CPU**
 - 8051 Compatible Instructions
 - Pipeline with 3-5 stages
 - 50MHz, 1cycle/8bit-instruction
 - 256bytes Internal RAM
- **1-wire On-Chip-Debug Interface**
 - R/W to all Internal Resources
 - Go / Step / Stop
 - PC Break / Data Access Break
 - Reset
 - FLASH Program / Erase
- **FLASH Memory**
 - 16KB
 - Feeds 8bit Instruction in 1cyc
 - Protection Supported
- **Internal RAM**
 - 1KB
- **Tiny DSP**
 - 2 Units (Independent)
 - 16bit Fixed Point
 - Sequence Programmable
 - 32step Instruction Memory
 - 16 Data Registers + Accumulator
 - Instructions: Multiply, Division, MAC, Barrel-Shift, Move, Jump
 - Hardware Divider Supported
 - Event Synchronized Sequence
 - Configurable Event Generation
 - Example: 2P3Z IIR Filter → 10 cyc
- **High Resolution PWM**
 - 8-outputs (4-pairs for Hi/Lo Sides)
 - 4 x 16bit Counters for each pair
 - Counters can be Synchronized
 - PWM Resolution: 1ns
 - Configurable PWM Duty (0%-100%) and Carrier Frequency in every PWM cycle
 - Configurable Non-Overlap Time
 - Counter Modes: Up and Up/Down
 - Phase Shift Mode Supported
 - Re-Trigger Operations by Internal /external Events
- **Direct SFR Access Controller**
 - Direct Data Transfer between Peripheral Registers (SFR: Special Function Register)
 - Selectable Transfer Trigger Event

- **Interrupt Timers**
 - 2 Units
 - 16bit Counter
 - Compare Match generates Event
 - synchronization with PWM
- **SPI**
 - 1 Unit, Master/Slave
 - 3-wires (Clock, MOSI, MISO)
 - Dedicated Baud Rate Generator
- **I2C (SMBUS)**
 - 1 Unit, Master/Slave
 - Dedicated Baud Rate Generator
 - SMBUS Compatible I/O Buffer
- **UART**
 - 1 Unit
 - Dedicated Baud Rate Generator
- **GPIO**
 - Digital & Analog Multiplexed
 - Pull-Up MOS
 - Configurable as Interrupt Sources
- **Interrupt Controller**
- **Watch Dog Timer (WDT)**
- **Low Voltage Detector (LVD)**
- **Reset Control**
 - External Reset
 - Internal Power On Reset (POR)
- **Clock Control**
 - External XTAL Oscillator
 - Internal Ring Oscillator (IRC)
 - PLL
- **External Power Supply Voltage**
 - 3.3V for each DVCC and AVCC
 - Internal Core Voltage Regulator
- **Package**
 - QFN-40 (6x6mm, P0.5)
 - LQFP-44 (10x10mm, P0.8)

Not Recommended for New Designs

1.2 Description

The LSI is a MCU (Micro Controller Unit) with Rich and Powerful Analog Elements such as High Speed 10bit ADC, High Precision 12bit ADC/DAC, High Speed Comparators, and Operational Amplifiers. These analog blocks can be connected via inter-connection-network to configure the LSI as a user-defined mixed signal device. Moreover, this LSI integrates not only CPU but also Dedicated Tiny DSP separated from CPU, High-Resolution PWM, and Automatic Data Transfer Scheme in one chip, which realize Self-Running Feedback Control System without CPU. In such system, CPU can engage in other tasks such as intelligent controls, communications, system watches, error detections and non-linear controls, etc. and then, the LSI will provide you high performance control system

1.3 Application

- Digital DC-DC Power Supply
- Digital AC-DC Power Supply
- Digital Assist Power Supply
- LED Lighting Control
- LED Signage
- Wireless Charger
- MPPT Solar Controller
- Inverter for Solar Battery
- Inverter for Motor Control
- E-Bike, E-Assist Bicycle
- EV Charger
- ...

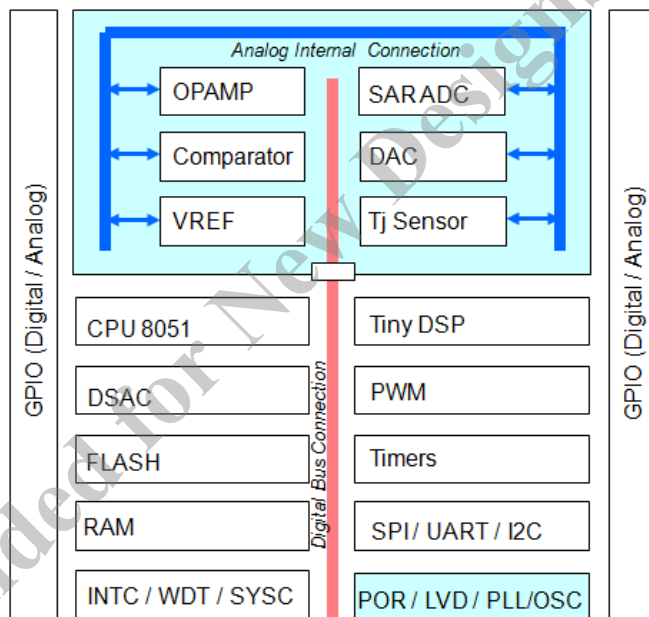


Figure 1-1 MSM Internal Functions

1.4 Ordering Information

Part #	FLASH/RAM	Vcc	Package	Note
MD6601FNV	16KB/1KB	3.3V	QFN-40	Tray
MD6601FNVL	16KB/1KB	3.3V	QFN-40	Tape & Reel
MD6601FLV	16KB/1KB	3.3V	LQFP-44	

2. Block Diagram

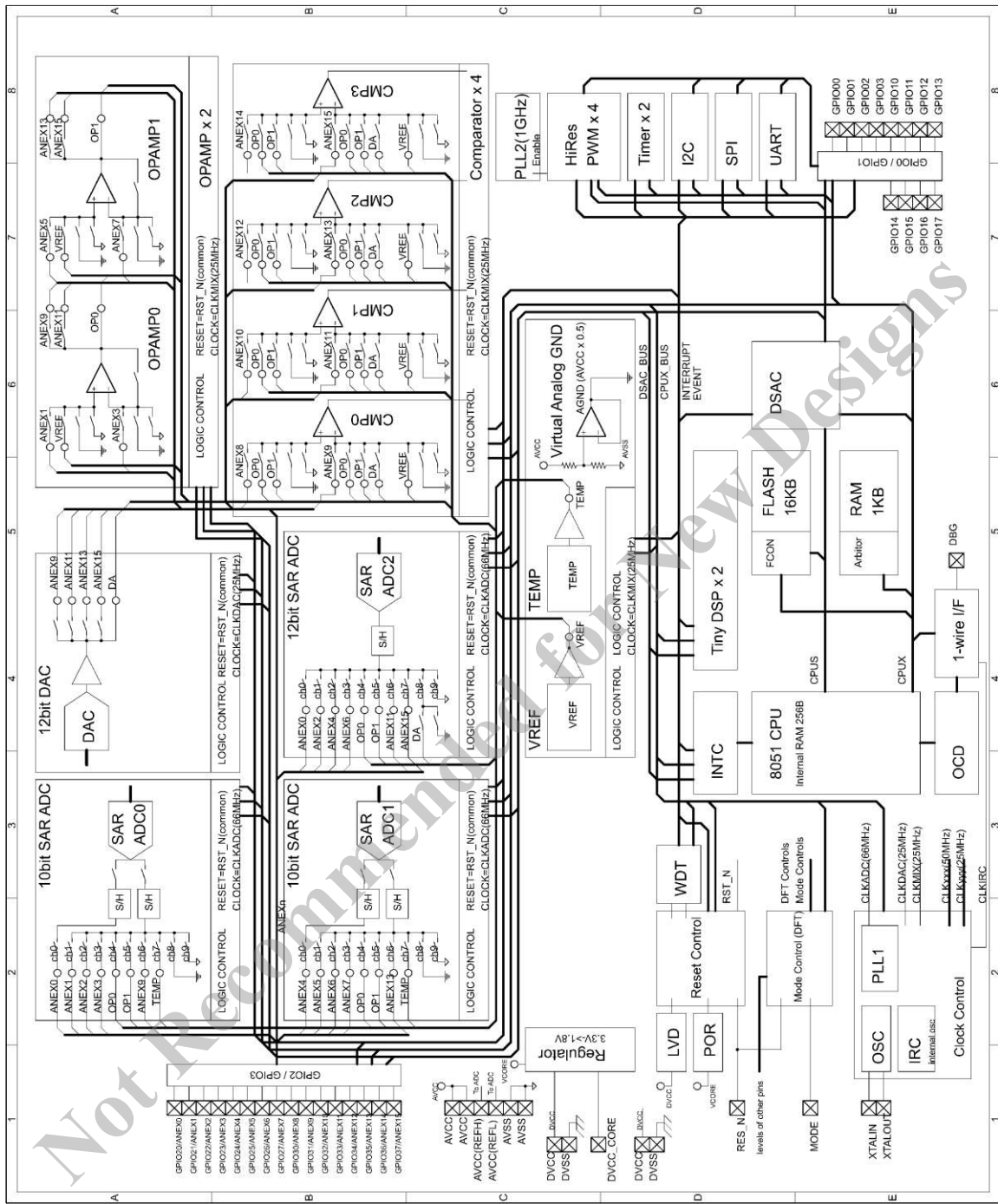


Figure 2-1 LSI Block Diagram

3. Pin Description

3.1 Pin Arrangement

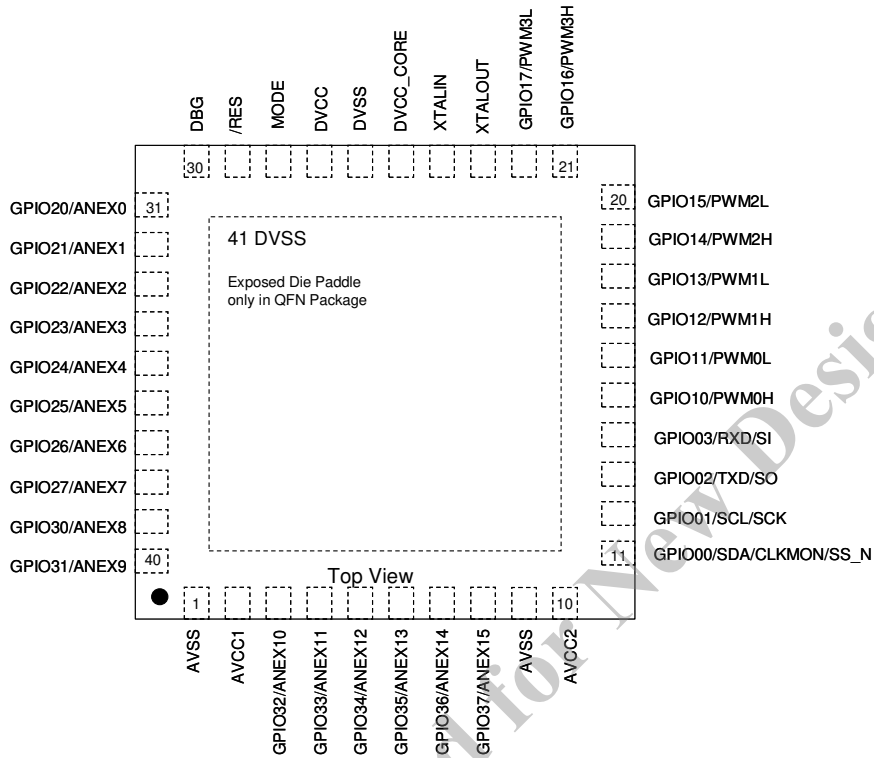


Figure 3-1 Pin Arrangement for QFN-40 (QFN-41)

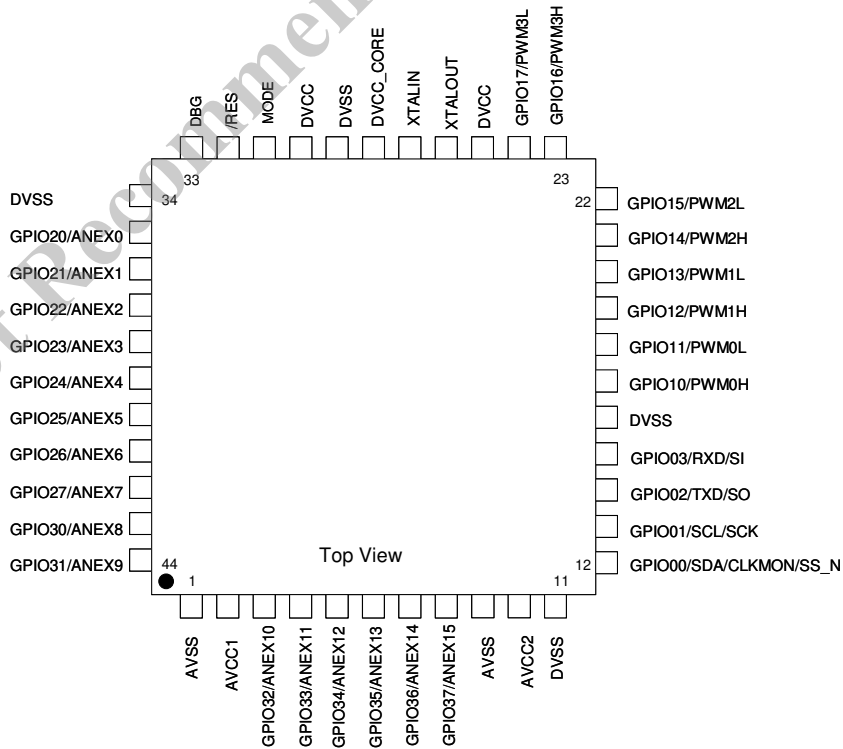


Figure 3-2 Pin Arrangement for LQFP-44

3.2 Signal Description

Class	QFN Pin No.	LQFP Pin No.	Pin Name	I/O	PUP	Description	INT	5V In	Schmitt	Logic Level	3.3V Iout
Digital Power Supply	27	25,30	DVCC	-	-	Digital 3.3V					
	26,41	11,162 9,34	DVSS	-	-	Digital 0V					
	25	28	DVCC_CORE	-	-	Digital Power for Internal Logic (Connect Capacitor.)					
Analog Power Supply	2	2	AVCC1	-	-	Analog 3.3V					
	10	10	AVCC2	-	-	Analog 3.3V					
	1,9	1,9	AVSS	-	-	Analog 0V					
System	28	31	MODE	IN	-	Chip Mode (Fixed to 0)			Yes	LVTTTL	
OSC	29	32	/RES	IN	U	Reset Input			Yes	LVTTTL	
	24	27	XTALIN	IN	-	XTAL Input					
	23	26	XTALOUT	O	-	XTAL Output					
Debug	30	33	DBG	I/O	U	1-wire Debug Port (open drain)		Yes		LVTTTL	4mA
Serial	11	12	GPIO00/SDA/ CLKMON/SS_N	I/O	U	GPIO or SDA (od) or CLKMON or SS_N(SPI)	Yes	Yes		LVTTTL	4mA
	12	13	GPIO01/SCL/SCK	I/O	U	GPIO or SCL (od) or SCK(SPI)	Yes	Yes		LVTTTL	4mA
	13	14	GPIO02/TXD/SO	I/O	U	GPIO or TXD or SO(SPI)	Yes	Yes		LVTTTL	4mA
	14	15	GPIO03/RXD/SI	I/O	U	GPIO or RXD or SI(SPI)	Yes	Yes		LVTTTL	4mA
PWM	15	17	GPIO10/PWM0H	I/O	U	GPIO or PWM0H	Yes	Yes		LVTTTL	16mA
	16	18	GPIO11/PWM0L	I/O	U	GPIO or PWM0L	Yes	Yes		LVTTTL	16mA
	17	19	GPIO12/PWM1H	I/O	U	GPIO or PWM1H	Yes	Yes		LVTTTL	16mA
	18	20	GPIO13/PWM1L	I/O	U	GPIO or PWM1L	Yes	Yes		LVTTTL	16mA
	19	21	GPIO14/PWM2H	I/O	U	GPIO or PWM2H	Yes	Yes		LVTTTL	16mA
	20	22	GPIO15/PWM2L	I/O	U	GPIO or PWM2L	Yes	Yes		LVTTTL	16mA
	21	23	GPIO16/PWM3H	I/O	U	GPIO or PWM3H	Yes	Yes		LVTTTL	16mA
	22	24	GPIO17/PWM3L	I/O	U	GPIO or PWM3L	Yes	Yes		LVTTTL	16mA
Analog	31	35	GPIO20/ANEX0	I/O	U	GPIO or Analog External 0	Yes			LVTTTL	4mA
	32	36	GPIO21/ANEX1	I/O	U	GPIO or Analog External 1	Yes			LVTTTL	4mA
	33	37	GPIO22/ ANEX2	I/O	U	GPIO or Analog External 2	Yes			LVTTTL	4mA
	34	38	GPIO23/ ANEX3	I/O	U	GPIO or Analog External 3	Yes			LVTTTL	4mA
	35	39	GPIO24/ ANEX4	I/O	U	GPIO or Analog External 4	Yes			LVTTTL	4mA
	36	40	GPIO25/ ANEX5	I/O	U	GPIO or Analog External 5	Yes			LVTTTL	4mA
	37	41	GPIO26/ ANEX6	I/O	U	GPIO or Analog External 6	Yes			LVTTTL	4mA
	38	42	GPIO27/ ANEX7	I/O	U	GPIO or Analog External 7	Yes			LVTTTL	4mA
	39	43	GPIO30/ANEX8	I/O	U	GPIO or Analog External 8	Yes			LVTTTL	4mA
	40	44	GPIO31/ANEX9	I/O	U	GPIO or Analog External 9	Yes			LVTTTL	4mA
	3	3	GPIO32/ ANEX10	I/O	U	GPIO or Analog External 10	Yes			LVTTTL	4mA
	4	4	GPIO33/ ANEX11	I/O	U	GPIO or Analog External 11	Yes			LVTTTL	4mA
	5	5	GPIO34/ ANEX12	I/O	U	GPIO or Analog External 12	Yes			LVTTTL	4mA
	6	6	GPIO35/ ANEX13	I/O	U	GPIO or Analog External 13	Yes			LVTTTL	4mA
	7	7	GPIO36/ ANEX14	I/O	U	GPIO or Analog External 14	Yes			LVTTTL	4mA
8	8	GPIO37/ ANEX15	I/O	U	GPIO or Analog External 15	Yes			LVTTTL	4mA	

4. Reset System and Low Voltage Detector (LVD)

4.1 Overview

Block diagram of Reset System and Low Voltage Detector (LVD) are shown in Figure 4-1. The LSI has Internal Voltage Regulator which generates internal core voltage supply V_{CORE} (1.8V) from external power supply DV_{CC} (3.3V).

Internal POR (Power on Reset) watches the V_{CORE} and it asserts reset signal when V_{CORE} is low. The POR output is stretched by digital delay, and it is ored with external reset signal /RES to make the whole chip in reset state.

Several modules can generate reset signal and there are priorities among them as shown in Figure 4-1.

Note that the 1-wire OCD (On-Chip-Debugger) generates two kinds of reset, one is whole chip reset, and the other is CPU reset.

Low Voltage Detector watches external power supply DV_{CC} and it sets detect LVD flag once DV_{CC} becomes lower than the threshold. If any, LVD flag can generate interrupt. The POR checks internal core voltage (V_{CORE}) which is generated from DV_{CC} by internal voltage regulator. So, LVD will detect low voltage state earlier than POR.

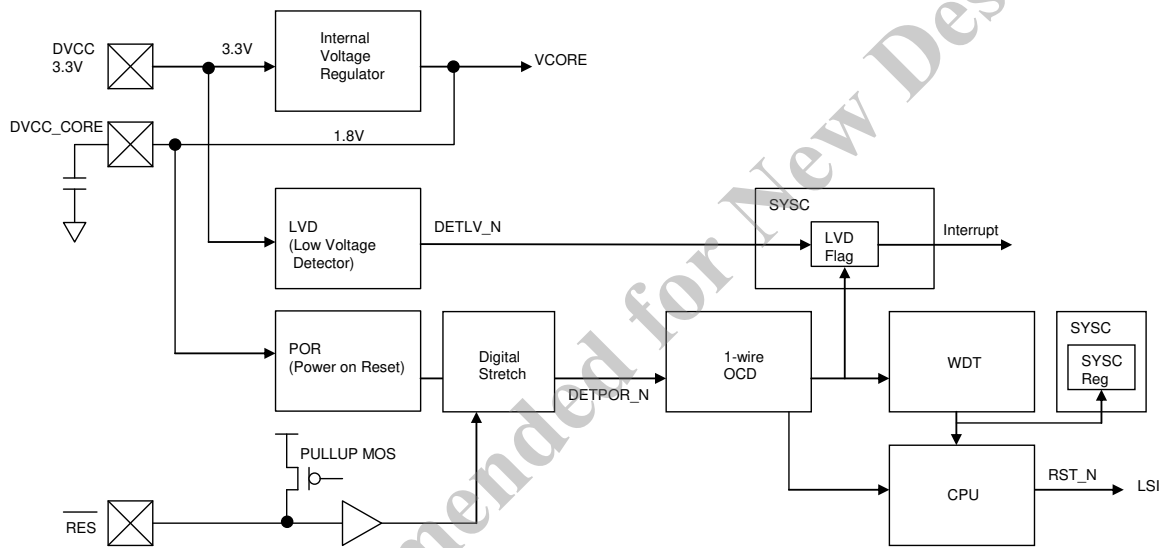


Figure 4-1 Reset System and Low Voltage Detector (LVD)

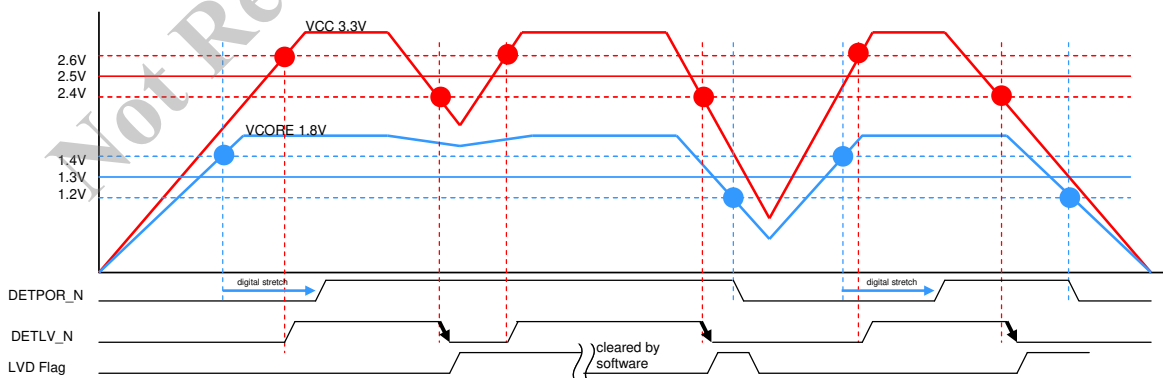


Figure 4-2 Power On Reset and Low Voltage Detection

Table 4-1 Reset Sources and Each Effect

Reset Source	OCD is...	WDT is...	LVD flag is...	SYSC is...	Others are...
/RES	Initialized	Initialized	Initialized	Initialized	Initialized
POR	Initialized	Initialized	Initialized	Initialized	Initialized
WDT	Not-Initialized	Not-Initialized	Not-Initialized	Initialized	Initialized
OCD (whole chip)	Not-Initialized	Initialized	Initialized	Initialized	Initialized
OCD (CPU reset)	Not-Initialized	Not-Initialized	Not-Initialized	Not-Initialized	Initialized

4.2 Register Description

Table 4-2 List of Register

Symbol	Name	Address	initial value
LVDCTRL	LVD Control	0xFF90	0x00

4.2.1 Detect low power-supply voltage

Register		LVDCTRL		LVD Control		Address	0xFF90
Bit	Bit Name	R/W	Initial	Description		Note	
7	LVDE	R/W	0	LVD Enable 0: LVD Disable 1: LVD Enable			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	LVDIE	R/W	0	LVD Interrupt Enable 0: LVD Interrupt Disable 1: LVD Interrupt Enable			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	reserved	R	0	Read value is 0. Write only 0.			
0	LVDIF	R/C	0	LVD Interrupt Flag (before mask; independent LVDIE) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit			

While LVD flag is set, LVD can not detect low voltage state.

Once LVD flag is cleared, LVD can detect low voltage state after having five clock wait.

5. Clock System

5.1 Overview

The clock system of the LSI is shown in Figure 5-1.

After power on reset, base clock comes from IRC (Internal Ring Oscillator: 10MHz). The CPU Program can change the base clock to external XTAL.

There are 4 types of clock speed in the LSI. CLKFAST(50MHz max) is used for CPU and related resources. CLKSLOW (25MHz max) is used for peripherals. CLKADC (133MHz max) is used for ADC which requires fine pitch clock edges. CLKPWM1000 is used for High Resolution PWM.

The 1-wire UART portion of OCD (On Chip Debugger) uses clock of IRC to make constant baud rate.

Basically in default mode, clock for each module is stopped except for CLKCPU. Each clock can be enabled by setting its gating signal (EN_CLKxxx) by CPU program.

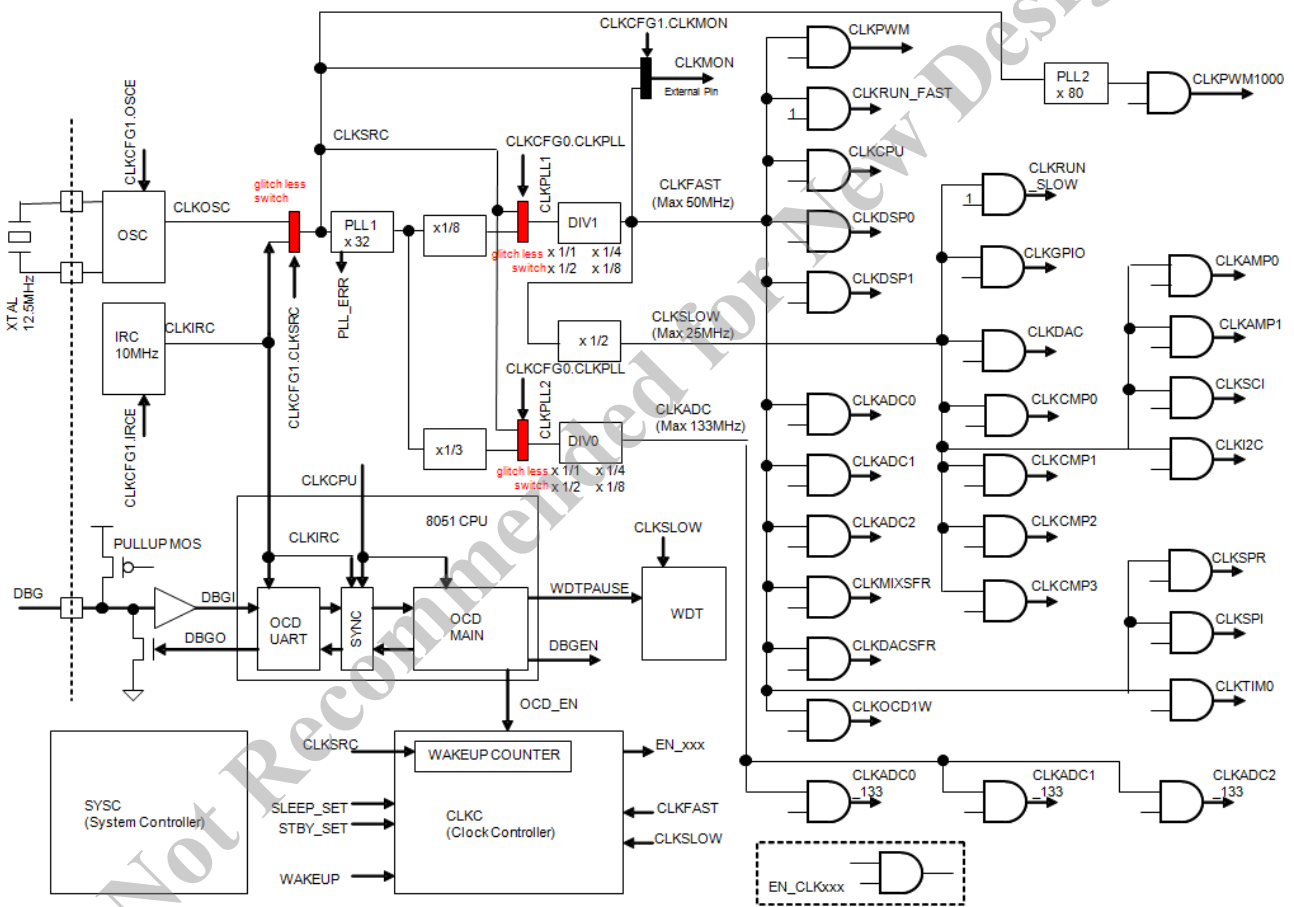


Figure 5-1 Clock System

5.2 Register Description

Table 5-1 List of Registers

Symbol	Name	Address	Initial value
CLKCFG0	Clock Configuration	0xFF80	0x00
CLKCFG1	Clock Configuration	0xFF81	0x01
MCLKE0	Module Clock Enable 0	0xFF84	0x00
MCLKE1	Module Clock Enable 1	0xFF85	0x00
MCLKE2	Module Clock Enable 2	0xFF86	0x00
MCLKE3	Module Clock Enable 3	0xFF87	0x00
LPCTRL	Low Power Control	0xFFA0	0x00

5.2.1 Clock controller

Register		CLKCFG0	Clock Configuration		Address	0xFF80
Bit	Bit Name	R/W	Initial	Description	Note	
7	PLLERR	R	0	PLL1 Error 0: PLL1 is in normal state 1: PLL1 says something error.		
6	PLEN	R/W	0	PLL1 Enable 0: PLL1 Disable 1: PLL1 Enable		
5	CLKPLL	R/W	0	PLL Clock Select 0: CLKPLL1 and CLKPLL2 are connected to CLKSRC 1: CLKPLL1 and CLKPLL2 are connected to PLL1 output through fix dividers : 1/8 and 1/3. Note: Even if CLKPLL is 0, the PLL1 runs in user mode.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	DIV11	R/W	0	Main Divider Configuration 00: x1/8 01: x1/4 10: x1/2 11: x1/1		
2	DIV10	R/W	0			
1	DIV01	R/W	0	CLKADC Divider Configuration 00: x1/8 01: x1/4 10: x1/2 11: x1/1		
0	DIV00	R/W	0			

Note:

When PLL disabled, "1" cannot be set in CLKPLL.

DIVXX and CLKPLL can read the present preset value by setting CLKC.

Register		CLKCFG1		Clock Configuration		Address	0xFF81
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	CLKMON	R/W	0	Clock Monitor Select 0: CLKSRC is connected to CLKMON 1: CLKFAST is connected to CLKMON			
2	CLKSRC	R/W	0	Clock Source Select 0: IRC is connected to PLL 1: OSC is connected to PLL			
1	OSCE	R/W	0	External XTAL Oscillator Enable 0: OSC Disable 1: OSC Enable			
0	IRCE	R/W	1	Internal Ring Oscillator Clock Enable 0: IRC Disable 1: IRC Enable			

Note:

If you try to clear both OSCE and IRCE or select disabled clock source, this register can not change.

In STBY mode, OSC and IRC will stop regardless of the value of the OSCE and IRCE.

In addition, if you want to switch from IRC to OSC or from OSC to IRC, must be set to 2'b11 the CLKCFG[1:0].

Register		MCLKE0		Module Clock Enable 0		Address	0xFF84
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	ME_TIM0	R/W	0	Module Clock Enable 0: Clock Stops 1: Clock Runs			
3	ME_SPI	R/W	0				
2	ME_I2C	R/W	0				
1	ME_UART	R/W	0				
0	ME_GPIO	R/W	0				

Register		MCLKE1		Module Clock Enable 1		Address	0xFF85
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	ME_DSP1	R/W	0	Module Clock Enable 0: Clock Stops 1: Clock Runs			
4	ME_DSP0	R/W	0				
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	ME_PWMPLL	R/W	0	Module Clock Enable 0: Clock Stops 1: Clock Runs			
0	ME_PWM	R/W	0				

Register	MCLKE2		Module Clock Enable 2	Address	0xFF86
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	ME_ADC2	R/W	0	CLKADC2 Enable 0: Clock Stops 1: Clock Runs	
5	ME_ADC1	R/W	0	CLKADC1 & CLKADC1_133 Enable 0: Clock Stops 1: Clock Runs	
4	ME_ADC0	R/W	0	CLKADC0 & CLKADC0_133 Enable 0: Clock Stops 1: Clock Runs	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0	
0	ME_DAC	R/W	0	Module Clock Enable 0: Clock Stops 1: Clock Runs	

Register	MCLKE3		Module Clock Enable 3	Address	0xFF87
Bit	Bit Name	R/W	Initial	Description	Note
7	ME_SPR	R/W	0	Module Clock Enable 0: Clock Stops 1: Clock Runs	
6	reserved	R	0	Read value is 0. Write only 0.	
5	ME_AMP1	R/W	0	Module Clock Enable 0: Clock Stops 1: Clock Runs	
4	ME_AMP0	R/W	0		
3	ME_CMP3	R/W	0		
2	ME_CMP2	R/W	0		
1	ME_CMP1	R/W	0		
0	ME_CMP0	R/W	0		

Note:

There are clocks which are not directly controlled by registers. Table5-2 shows conditions that clocks enable or disable.

Table 5-2: clock's enabler condition and disabler condition

Clock name	Enable Condition	Disable Conditon
CLKCPU	By reset Return from SLEEP or STBY mode	Being SLEEP or STBY mode
CLKMIXSFR	Any of CLKCMPn or CLKADCn enable	All of CLKCMPn and CLKADCn disable
CLKDACSFR	CLKDAC enable	CLKDAC disable
CLKOCD1W	DBG pin has been once driven "Low".	DBG pin has been never driven "Low".

5.2.2 Low Power Controller

Register		LPCTRL	Low Power Control		Address	0xFFFA0
Bit	Bit Name	R/W	Initial	Description	Note	
7	WUPTM	R/W	0	00:26ms(Details time→TBD)		
6				01:13ms 10:6.6ms 11:3.3ms		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	reserved	R	0	Read value is 0. Write only 0.		
2	DISWC	R/W	0	Disable Wake Up Counter 0: Use Wake Up Counter 1: Disable Wake Up Counter which makes immediate wake up. (This bit should be used only for test.)		
1	LPSEL	R/W	0	Low Power Mode Select 0: SLEEP (Only CPU Stops) 1: STBY (Entire Chip Stops)		
0	GOTOLPM	R/W	0	Go to Low Power Mode 0: Normal Mode 1: Low Power Mode		

5.3 Clock Initialization Sequence

- (1) After power on reset, IRC is enabled and its output IRCOUT is connected through CLKIRC, CLKSRC and CLKPLL. Note that after power on reset, PLL is not used.
- (2) If user wants to use IRC continuously, enable the PLL1. After waiting for PLL1 stable time (by software loop), change master clock from CLKSRC to CLKPLL.
- (3) Or, if user wants to use OSC (external XTAL) instead of IRC, connect CLKOSC to CLKSRC, and enable the PLL1. After waiting for PLL1 stable time (by software loop), change master clock from CLKSRC to CLKPLL.

5.4 Low Power Mode

- (1) There are two modes in Low Power state. One is SLEEP, the other is STBY.
- (2) In SLEEP mode, only CPU clock stops. In STBY mode, entire chip clock stops. Even if EN_CLKxxx is set, corresponding to EN_CLKCLK = ~(SLEEP | STBY) or EN_CLKxxx = ME_xxx & ~STBY
- (3) By setting GOTOLPM bit, the LSI enters in Low Power Mode. Physically, GOTOLPM bit is 1 during Low Power Mode until waking up. Read the value of GPTOLPM corresponding to SLEEP | STBY.
- (4) Any interrupts from external pins or internal modules can make CPU awake from SLEEP mode.
- (5) Only interrupts from external pins can make CPU awake from STBY mode. At that time, to wait for stable clock oscillation and stable PLL output, internal Wake-Up-Counter is used. Interrupts from external pins immediately start OSC, IRC and PLL, and the Wake-Up-Counter starts its count-up. Once the counter overflows, system signal STBY is negated. Wake up period will be less than 10ms.

5.4.1 SLEEP Mode

In sleep mode, only CPU clock stops. Sequences shifting to and returning from sleep mode are shown in Figure 5-2. The system instantly returns from sleep mode by occurring event (multiple choice allowed) of interrupt setting in advance. At that time, CLKC automatically clears GOTOLPM bit of LPCTRL register.

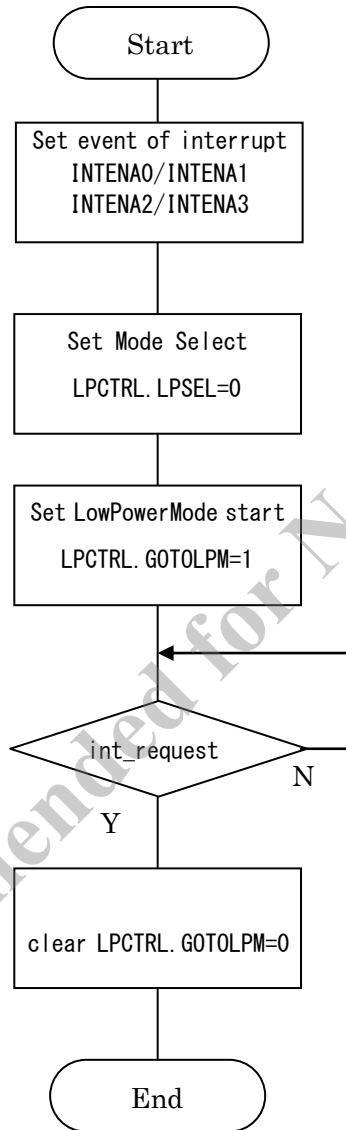


Figure 5-2 Sleep Mode Sequence

5.4.2 STBY Mode

In STBY mode, entire chip clock(OSC/IRC/PLL1/PLL2) stops, and clocks are not supplied function blocks. Sequences shifting to and returning from STBY mode are shown in Figure 5-3. Event (multiple choice allowed) of interrupt by GPIO specified in advance is used for trigger of returning from STBY mode. After interrupt, STBY mode is remained in term set by LPCTRL.WUPTM to wait for clocks stable time. Then, clock is resumed to supply function blocks and, CLKC automatically clear LPCTRL.GOTOLPM.

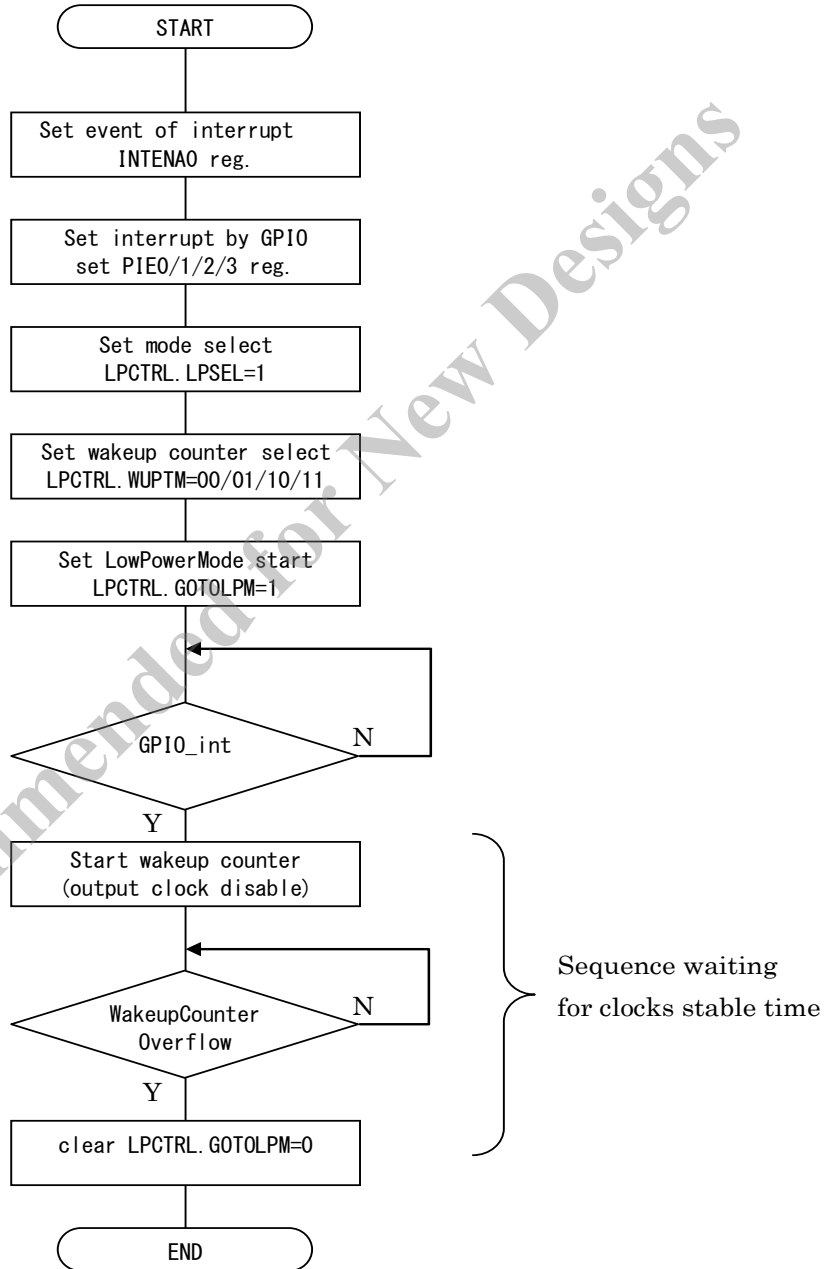


Figure 5-3 STBY Mode Sequence

5.5 An example way to configure Clock Settings after Power On

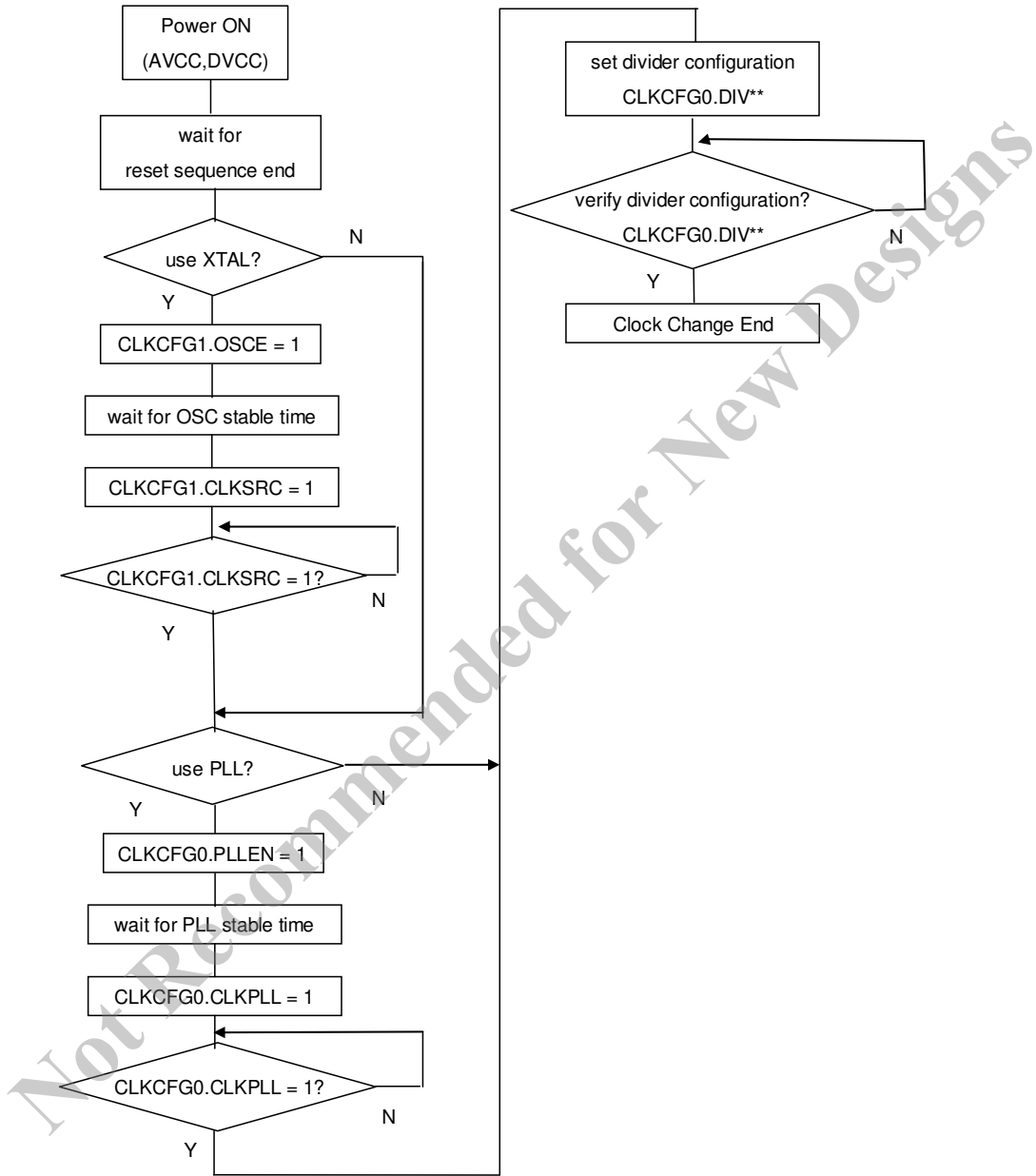


Figure 5-4 A example way to configure Clock Settings after Power On

5.6 Limitation of Clock System

5.6.1 Limitation of Low Power Mode

Once 1-wire OCD has accessed the system, the system can not enter Low power Mode.

Not Recommended for New Designs

6. 8051 CPU Subsystem

6.1 Introduction

The UL8051 is a CPU core with Intel MCS-51 (8051 family) compatible ISA (Instruction Set Architecture).

Note that the UL8051 is actually compatible with 8052 type core, we call it UL8051.

The UL8051 has some enhanced features compared to original 8052. The UL8051 can execute one byte instruction in only 1 cycle by its pipelined micro architecture and 4-byte pre-fetch operation.

The UL8051 also has the flexible on-chip debugger with simple 1-wire interface which can prevent from increasing pin counts.

6.2 Overview

Table 6-1 shows brief specification of UL8051.

Table 6-1 Feature of UL8051

No.	Item	Description	Note
1	Instruction Set	MCS-51 (8052) Compatible	
2	Execution Cycle	1cycle/1byte-fetch (1T Core).	
3	Pipeline	Yes	
4	Instruction Bus	8bit Width (XPROG Bus)	
5	Data Bus	8bit Width (XDATA Bus)	
6	SFR Bus	8bit Width with Bit Write Strobe	
7	Interrupt	Maximum 32 Interrupt sources	
8	On Chip Debugger	Full debugging features with simple 1-wire interface	

6.3 System Configuration around CPU

An example of system configuration around CPU is shown in Figure 6-1.

- (1) XPROG-BUS: A dedicated bus to fetch instructions from internal ROM, which has 8bit width. Total address space size is 64KB on XPROG-BUS. The data flow on XPROG-BUS is only “READ” direction. To read internal ROM as data, you should use MOV_C instruction.
- (2) XDATA-BUS: A dedicated bus to read/write on-chip RAM and other peripheral registers, which has 8bit width. Total address space size is 64KB on XDATA-BUS. To access on-chip RAM and peripherals, you should use MOV_X instruction.
- (3) SFR-BUS: A dedicated bus to read/write SFR (Special Function Register), which has 8bit width. Total address space size is 128bytes on SFR-BUS. To access SFR on SFR-BUS, you should use instructions with Direct Addressing.
- (4) IRAM-BUS: A dedicated bus to connect internal RAM.

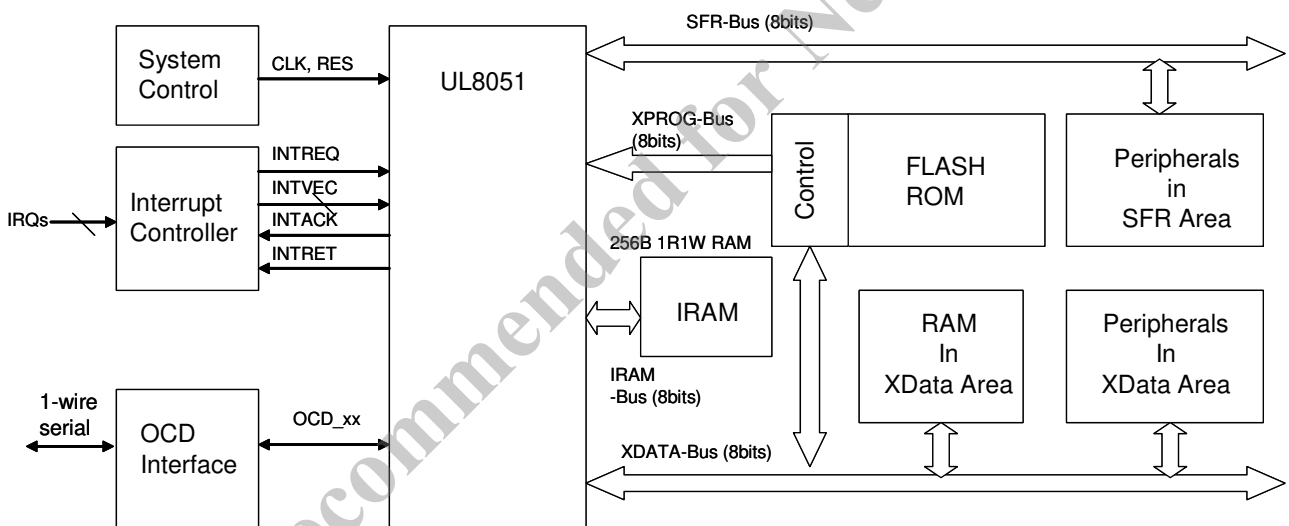


Figure 6-1 Example of System Configuration

6.4 Memory Map

System Address Maps is shown in Figure 6-2.

- (1) Internal Data Memory of 8052 architecture is divided into 3 blocks.
- (2) Internal Data Memory (1): Address space is 0x00-0x7F (128bytes). It includes CPU registers (4bank, 32bytes), Bit Address Area (16bytes) and General IRAM_1 (80bytes).
- (3) Internal Data Memory (2): Address space is 0x80-0xFF (128bytes). To access here, you should use Indirect Address Mode. It includes General IRAM_2 (128bytes).
- (4) Internal Data Memory (3): Address space is 0x80-0xFF (128bytes). To access here, you should use Direct Address Mode. It includes Special Function Registers (SFR). Most resources in SFR are connected on SFR-Bus. In the SFR area, each byte on address 0xX0 (X=8-F) can be accessed by instructions with bit addressing.
- (5) Program Memory Space: Dedicated instruction memory space. Address space is 0x0000-0xFFFF. Typically, FLASH ROM is assigned from bottom address. The devices in this space are connected on XPROG-Bus. Use MOVC instruction to read the space as data.
- (6) Data Memory Space: Dedicated data memory space. Address space is 0x0000-0xFFFF. The devices in this space are connected on XDATA-Bus. Use MOVX instruction to access in the space.
- (7) Peripheral Registers: Note that peripheral registers in the LSI are assigned in both SFR area and Data Memory Space.

Not Recommended for New Designs

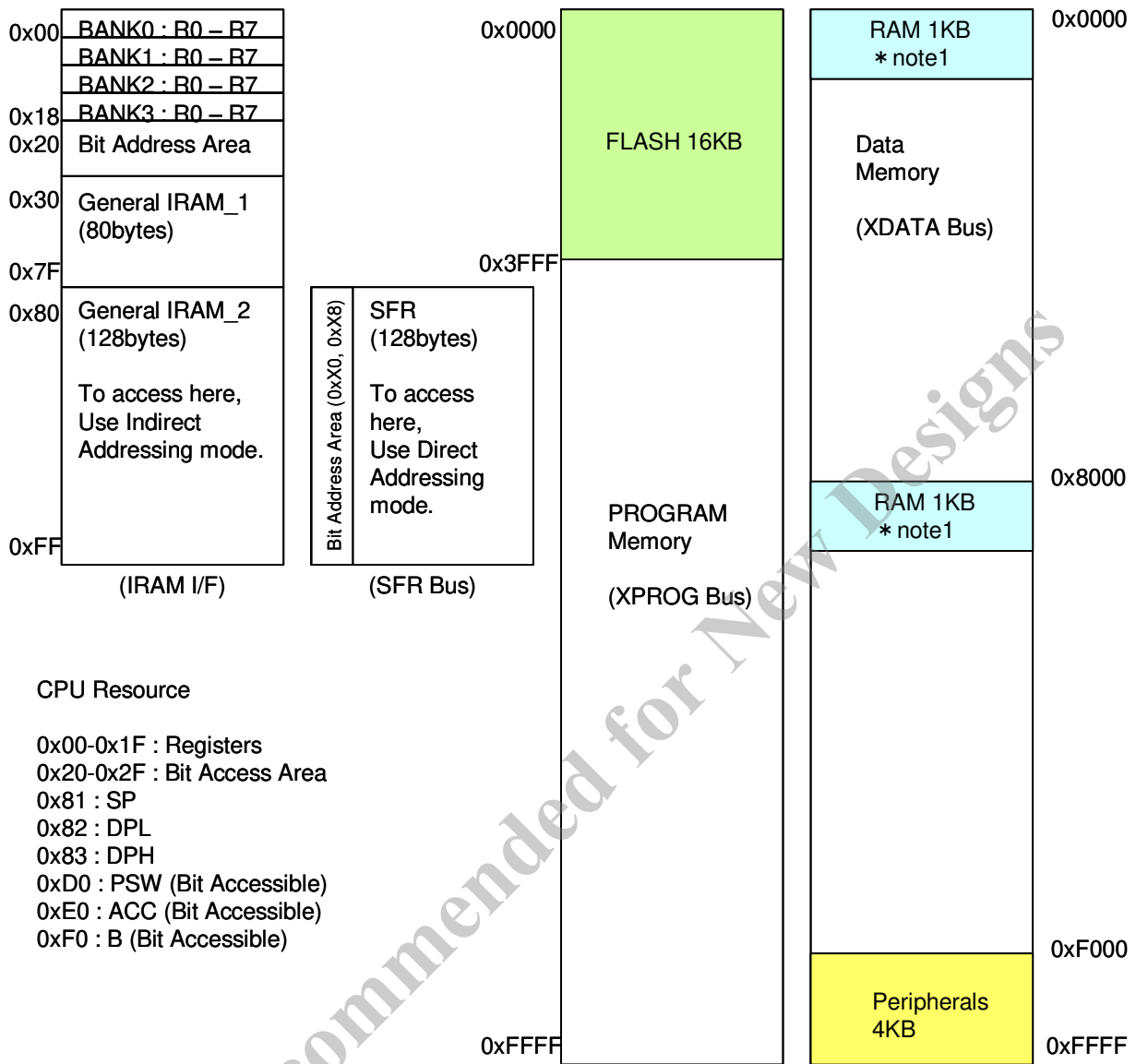


Figure 6-2 System Address Map

*note1 RAM areas from 0x0000 and 0x8000 are shadow memory and identical to each other.

6.5 Register Description

6.5.1 Remap Control (REMAP)

Register	REMAP		Remap Control	Address	0xFFC0
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0.	
0	REMAP	R/W	0	Remap Control 0: Normal 1: Remapped	

If REMAP is set to 1, the data of the internal RAM are copied on FLASH memory area from 0x0000 to 0x03FF(1kB).

Not Recommended for New Designs

6.6 Instruction Code Map

Table 6-2 Instruction Code Map

Upper		Lower										Upper	Lower		
0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
NOP	AJMP addr11	LJMP addr16	RR A	INC A	INC direct	INC @Ri	INC @Ri	INC Rn	INC Rn	INC Rn	INC Rn	INC Rn	INC Rn	INC Rn	INC Rn
JBC bit, rel	ACALL addr11	LCALL addr16	RRC A	DEC A	DEC direct	DEC @Ri	DEC @Ri	DEC Rn	DEC Rn	DEC Rn	DEC Rn	DEC Rn	DEC Rn	DEC Rn	DEC Rn
JB bit, rel	AJMP addr11	RET	RL A	ADD A, #data	ADD A, direct	ADD A, @Ri	ADD A, @Ri	ADD A, Rn	ADD A, Rn	ADD A, Rn	ADD A, Rn	ADD A, Rn	ADD A, Rn	ADD A, Rn	ADD A, Rn
JNB bit rel	ACALL addr11	RETI	RLC A	ADDC A, #data	ADDC A, direct	ADDC A, @Ri	ADDC A, @Ri	ADDC A, Rn	ADDC A, Rn	ADDC A, Rn	ADDC A, Rn	ADDC A, Rn	ADDC A, Rn	ADDC A, Rn	ADDC A, Rn
JC rel	AJMP addr11	ORL direct, A	ORL direct, #	ORL A, #data	ORL A, direct	ORL A, @Ri	ORL A, @Ri	ORL A, Rn	ORL A, Rn	ORL A, Rn	ORL A, Rn	ORL A, Rn	ORL A, Rn	ORL A, Rn	ORL A, Rn
JNC rel	ACALL addr11	ANL direct, A	ANL direct, #	ANL A, #data	ANL A, direct	ANL A, @Ri	ANL A, @Ri	ANL A, Rn	ANL A, Rn	ANL A, Rn	ANL A, Rn	ANL A, Rn	ANL A, Rn	ANL A, Rn	ANL A, Rn
JZ rel	AJMP addr11	XRL direct, A	XRL direct, #	XRL A, #data	XRL A, direct	XRL A, @Ri	XRL A, @Ri	XRL A, Rn	XRL A, Rn	XRL A, Rn	XRL A, Rn	XRL A, Rn	XRL A, Rn	XRL A, Rn	XRL A, Rn
JNZ rel	ACALL addr11	ORL C, bit	JMP @A+DP	MOV A, #data	MOV d, #data	MOV @Ri, #data	MOV @Ri, #data	MOV Rn, #data	MOV Rn, #data	MOV Rn, #data	MOV Rn, #data	MOV Rn, #data	MOV Rn, #data	MOV Rn, #data	MOV Rn, #data
SJMP rel	AJMP addr11	ANL C, bit	MOVC A, @A+P	DIV AB	MOV d, d, s	MOV direct, @Ri	MOV direct, @Ri	MOV direct, Rn	MOV direct, Rn	MOV direct, Rn	MOV direct, Rn	MOV direct, Rn	MOV direct, Rn	MOV direct, Rn	MOV direct, Rn
MOV DPTR, #	ACALL addr11	MOV bit, C	MOVC A, @A+D	SUB A, #data	SUB A, direct	SUB A, @Ri	SUB A, @Ri	SUB A, Rn	SUB A, Rn	SUB A, Rn	SUB A, Rn	SUB A, Rn	SUB A, Rn	SUB A, Rn	SUB A, Rn
ORL C, /bit	AJMP addr11	MOV C, bit	INC DPTR	MUL AB	(SBRK 0x0103)	MOV @Ri, direct	MOV @Ri, direct	MOV Rn, direct	MOV Rn, direct	MOV Rn, direct	MOV Rn, direct	MOV Rn, direct	MOV Rn, direct	MOV Rn, direct	MOV Rn, direct
ANL C, /bit	ACALL addr11	CPL bit	CPL C	CJNE A, #, rel	CJNE A, d, rel	CJNE @Ri, #data, rel	CJNE @Ri, #data, rel	CJNE Rn, #data, rel	CJNE Rn, #data, rel	CJNE Rn, #data, rel	CJNE Rn, #data, rel	CJNE Rn, #data, rel	CJNE Rn, #data, rel	CJNE Rn, #data, rel	CJNE Rn, #data, rel
PUSH direct	AJMP addr11	CLR bit	CLR C	SWAP A	XCH A, direct	XCH A, @Ri	XCH A, @Ri	XCH A, Rn	XCH A, Rn	XCH A, Rn	XCH A, Rn	XCH A, Rn	XCH A, Rn	XCH A, Rn	XCH A, Rn
POP direct	ACALL addr11	SETB bit	SETB C	DA A	DJNZ d, rel	XCHD A, @Ri	XCHD A, @Ri	DJNZ Rn, rel	DJNZ Rn, rel	DJNZ Rn, rel	DJNZ Rn, rel	DJNZ Rn, rel	DJNZ Rn, rel	DJNZ Rn, rel	DJNZ Rn, rel
MOVX A, @DP	AJMP addr11	MOVX A, @Ri	CLR A	CLR A	MOV direct, A	MOV @Ri, A	MOV @Ri, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A
MOVX @DP, A	ACALL addr11	MOVX @Ri, A	CPL A	CPL A	MOV direct, A	MOV @Ri, A	MOV @Ri, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A	MOV Rn, A

6.6.1 Notes on Instruction Spec

(1) Operation of Undefined Instruction (0xa5)

This code (0xa5) acts as "Software Break : SBRK 0x0103". The Functionality is almost similar to LCALL 0x0103 (call fixed address), but the return address (PC written to stack) is the address of itself (where 0xa5 code is placed).

(2) Operation of division by zero in DIV AB

If B=0, result of A(Quotient) is 255 and B(Remainder) is initial value of A, and OV is set.

(3) Stack Pointer

The initial value of Stack Pointer (SP) is 0x07, so please ensure NOT TO OVERLAP stack area with CPU resource area to be used in your program, such as R0-R7 (bank0-bank3), Bit Addressable Area, and other internal RAM area to be used.

Not Recommended for New Designs

6.6.2 CPU Instruction Execution Cycle

Conditional Jump: (Taken)/(Not Taken)					Conditional Jump: (Taken)/(Not Taken)				
OPCODE	Mne monic	Operand	UL8051 Cycle	Original Cycle	OPCODE	Mne monic	Operand	UL8051 Cycle	Original Cycle
aaa10001	aaaaaaa	ACALL addr11	4	24	1000011m	ddddddd	MOV direct, @Rm	2	24
00100100	iiiiiii	ADD A, #imm	2	12	10001nnn	ddddddd	MOV direct, Rn	2	24
00100101	ddddddd	ADD A, direct	3	12	10010000	iiiiiii	MOV DPTR, #imm16	3	24
0010011m		ADD A, @Rm	2	12	10010010	bbbbbbb	MOV bit, C	3	24
00101nnn		ADD A, Rn	1	12	10100010	bbbbbbb	MOV C, bit	3	12
00110100	iiiiiii	ADDC A, #imm	2	12	1010011m	ddddddd	MOV @Rm, direct	3	24
00110101	ddddddd	ADDC A, direct	3	12	10101nnn	ddddddd	MOV Rn, direct	3	24
0011011m		ADDC A, @Rm	2	12	11100101	ddddddd	MOV A, direct	3	12
00111nnn		ADDC A, Rn	1	12	1110011m		MOV A, @Rm	2	12
aaa00001	aaaaaaa	AJMP addr11	3	24	11101nnn		MOV A, Rn	1	12
01010010	ddddddd	ANL direct, A	3	12	11101010	ddddddd	MOV direct, A	2	12
01010011	iiiiiii	ANL direct, #imm	3	24	111011m		MOV @Rm, A	1	12
01010100	iiiiiii	ANL A, #imm	2	12	11111nnn		MOV Rn, A	1	12
01010101	ddddddd	ANL A, direct	3	12	10000011		MOVC A, @A+PC	4	24
0101011m		ANL A, @Rm	2	12	10010011		MOVC A, @A+DPTR	4	24
01011nnn		ANL A, Rn	1	12	11100000		MOVX A, @DPTR	3	24
10000010	bbbbbbb	ANL C, bit	3	24	1110001m		MOVX A, @Rm	3	24
10110000	bbbbbbb	ANL C, /bit	3	24	11110000		MOVX @DPTR, A	1	24
10110100	iiiiiii	CJNE A, #imm, rel	4/4	24/24	1111001m		MOVX @Rm, A	1	24
10110101	ddddddd	CJNE A, direct, rel	5/5	24/24	10100100		MUL AB	1	48
1011011m	iiiiiii	CJNE @Rm, #imm, rel	4/4	24/24	00000000		NOOP	1	12
10111nnn	iiiiiii	CJNE Rn, #imm, rel	4/4	24/24	01000010	ddddddd	ORL direct, A	3	12
11000010	bbbbbbb	CLR bit	3	12	01000011	iiiiiii	ORL direct, #imm	3	24
11000011		CLR C	1	12	01000100	iiiiiii	ORL A, #imm	2	12
11100100		CLR A	1	12	01000101	ddddddd	ORL A, direct	3	12
10110010	bbbbbbb	CPL bit	3	12	1000011m		ORL A, @Rm	2	12
10110011		CPL C	1	12	01001nnn		ORL A, Rn	1	12
11101000		CPL A	1	12	01110010	bbbbbbb	ORL C, bit	3	24
11010100		DA A	1	12	10100000	bbbbbbb	ORL C, /bit	3	24
00010100		DEC A	1	12	11010000	ddddddd	POP direct	2	24
00010101	ddddddd	DEC direct	3	12	11000000	ddddddd	PUSH direct	3	24
0001011m		DEC @Rm	2	12	00100010		RET	5	24
00011nnn		DEC Rn	1	12	00110010		RETI	5	24
10000100		DIV AB	10	48	00100011		RL A	1	12
11010101	ddddddd	DJNZ direct, rel	5/5	24/24	00110011		RLC A	1	12
11011nnn	rrrrrrr	DJNZ Rn, rel	3/3	24/24	00000011		RR A	1	12
00000100		INC A	1	12	00010011		RRC A	1	12
00000101	ddddddd	INC direct	3	12	10100101		SBRK 0x0103	4	Undef.
0000011m		INC @Rm	2	12	11010010	bbbbbbb	SETB bit	3	12
00001nnn		INC Rn	1	12	11010011		SETB C	1	12
10100011		INC DPTR	1	24	10000000	rrrrrrr	SJMP rel	3	24
00100000	bbbbbbb	JB bit, rel	5/5	24/24	10010100	iiiiiii	SUBB A, #imm	2	12
00010000	bbbbbbb	JBC bit, rel	5/5	24/24	10010101	ddddddd	SUBB A, direct	3	12
01000000	rrrrrrr	JC rel	3/2	24/24	1001011m		SUBB A, @Rm	2	12
01110011		JMP @A+DPTR	3	24	10011nnn		SUBB A, Rn	1	12
00110000	bbbbbbb	JNB bit, rel	5/5	24/24	11000100		SWAP A	1	12
01010000	rrrrrrr	JNC rel	3/2	24/24	11000101	ddddddd	XCH A, direct	3	12
01110000	rrrrrrr	JNZ rel	3/2	24/24	1100011m		XCH A, @Rm	2	12
01100000	rrrrrrr	JZ rel	3/2	24/24	11001nnn		XCH A, Rn	1	12
00010010	aaaaaaa	LCALL addr16	4	24	1101011m		XCHD A, @Rm	2	12
00000010	aaaaaaa	LJMP addr16	4	24	01100010	ddddddd	XRL direct, A	3	12
01110100	iiiiiii	MOV A, #imm	2	12	01100011	ddddddd	XRL direct, #imm	3	24
01110101	ddddddd	MOV direct, #imm	3	24	01100100	iiiiiii	XRL A, #imm	2	12
0111011m	iiiiiii	MOV @Rm, #imm	2	12	01100101	ddddddd	XRL A, direct	3	12
01111nnn	iiiiiii	MOV Rn, #imm	2	12	0110011m		XRL A, @Rm	2	12
10000101	ddd(src)	MOV dir(dst), dir(src)	3	24	01101nnn		XRL A, Rn	1	12

Note1: The FLASH access speed is 25MHz (2-cycle access) whereas CPU speed is 50MHz. To absorb this difference, the LSI has following implementations: (1) CPU Program Bus width = 8bits, (2) Internal FLASH Memory Bus Width = 32bits, (3) Small cache logic between CPU and FLASH. Therefore, it can keep Instruction Feeding Speed from FLASH up to 1byte/1cycle (@50MHz) if contiguous instructions are being executed. But, once branch has happened, the FLASH access should be restarted using 2-cycle access. So please note that there might be additional 2cycles in the case of branch/jump is taken.

Note2: It takes 2cycles to access RAM and Peripheral Registers connected to XDATA-BUS. Therefore, MOVX instruction takes additional 1cycle.

7. Register Mapping

7.1 Peripherals on XDATA-Bus

Table 7-1 Peripherals on XDATA-Bus

No.	Module	Address	
		Start	End
1	ADC0	F000	F07F
2	ADC1	F080	F0FF
3	ADC2	F100	F17F
4		F180	F1FF
5	DAC	F200	F27F
6		F280	F2FF
7		F300	F37F
8	CMP0	F380	F3FF
9	CMP1	F400	F47F
10	CMP2	F480	F4FF
11	CMP3	F500	F57F
12		F580	F5FF
13	OPAMP0	F600	F67F
14	OPAMP1	F680	F6FF
15		F700	F77F
16	DSP0	F780	F7FF
17	DSP1	F800	F87F
18	DSAC	F880	F8FF
19	PWM	F900	F9FF
20	TIMER	FA00	FA7F
21		FA80	FAFF
22		FB00	FB7F
23	SPI	FB80	FBFF
24	I2C	FC00	FC7F
25	UART	FC80	FCFF
26		FD00	FD7F
27	POC	FD80	FDFF
28	GPIO	FE00	FE7F
29	WDT	FE80	FEFF
30	FLC	FF00	FF7F
31	SYSC	FF80	FFFF

Details of register address should refer to each section.

7.2 Peripherals on SFR-Bus

In addition to CPU system registers, the peripheral registers which should be accessed frequently are mapped to SFR area. CPU can read/write a SFR in 1-cycle. PSW, ACC and B register are bit-addressable registers. The unmapped address (gray color) must not be accessed.

Table 7-2 Peripherals on SFR-Bus

80		SP	DPL	DPH					87
88								SPR4	8F
90	PDR0	SPR0			SPR5		MIXDA L/H	Reserved	97
98	PDR1	ADL/H00	ADL/H01	ADL/H02	INTMST		SPR6	SPR7	9F
A0		ADL/H10	ADL/H11	ADL/H12	INTENA0	INTENA1	INTENA2	INTENA3	A7
A8		ADL/H20	ADL/H21	ADL/H22	INTLVL0	INTLVL1	INTLVL2	INTLVL3	AF
B0	PDR2	ADL/H30	ADL/H31	ADL/H32	INTCFG0	INTCFG1	INTCFG2	INTCFG3	B7
B8		ADL/H40	ADL/H41	ADL/H42	INTFLG0	INTFLG1	INTFLG2	INTFLG3	BF
C0	PDR3	ADL/H50	ADL/H51	ADL/H52	DSP0 R0_L/H	DSP0 R1_L/H	DSP0 R2_L/H	DSP0 R3_L/H	C7
C8	PIF0	ADL/H60	ADL/H61	ADL/H62	DSP0 R4_L/H	DSP0 R5_L/H	DSP0 R6_L/H	DSP0 R7_L/H	CF
D0	PSW	ADL/H70	ADL/H71	ADL/H72	DSP1 R0_L/H	DSP1 R1_L/H	DSP1 R2_L/H	DSP1 R3_L/H	D7
D8	PIF1	ADL/H80	ADL/H81	ADL/H82	DSP1 R4_L/H	DSP1 R5_L/H	DSP1 R6_L/H	DSP1 R7_L/H	DF
E0	ACC	ADL/H90	ADL/H91	ADL/H92	BUF_A0 _L/H	BUF_B0 _L/H	BUF_C0 _L/H	BUF_D0 _L/H	E7
E8	PIF2				BUF_A1 _L/H	BUF_B1 _L/H	BUF_C1 _L/H	BUF_D1 _L/H	EF
F0	B	ADT	ADI	CMI	BUF_A2 _L/H	BUF_B2 _L/H	BUF_C2 _L/H	BUF_D2 _L/H	F7
F8	PIF3	SPR1	SPR2	SPR3	BUF_A3 _L/H	BUF_B3 _L/H	BUF_C3 _L/H	BUF_D3 _L/H	FF

7.3 Scratch Pad Register

Scratch Pad Registers are used for temporary storage of preliminary data. There are eight Scratch Pad Registers, SPR0 ~ SPR7, which are mapped SFR area.

Also DSAC can access these Scratch Pad Registers. Information of these registers is shown in Table 7-3.

Table 7-3 Scratch Pad Register

Register	SPR0	Scratch Pad Register 0	Address	0x91	
Register	SPR1	Scratch Pad Register 1	Address	0xF9	
Register	SPR2	Scratch Pad Register 2	Address	0xFA	
Register	SPR3	Scratch Pad Register 3	Address	0xFB	
Register	SPR4	Scratch Pad Register 4	Address	0x8F	
Register	SPR5	Scratch Pad Register 5	Address	0x94	
Register	SPR6	Scratch Pad Register 6	Address	0x9E	
Register	SPR7	Scratch Pad Register 7	Address	0x9F	
Bit	Bit Name	R/W	Initial	Description	Note
7	SPR_7	R/W	0	The Register is used for temporary storage of preliminary data.	
6	SPR_6	R/W	0		
5	SPR_5	R/W	0		
4	SPR_4	R/W	0		
3	SPR_3	R/W	0		
2	SPR_2	R/W	0		
1	SPR_1	R/W	0		
0	SPR_0	R/W	0		

8. GPIO

This LSI has the General Purpose I/O(GPIO) function with all function pins. Each pin function can be selected independently. If the function is GPIO, the signal direction can be selected independently, too. Each pin has Pull Up MOS (PUP) and can be independently ON/OFF by software.

8.1 GPIO Structure

Pins	Topology + Spec	Signals	Signal Level (power)
/RES		in	DVCC(3.3V)
MODE		in	DVCC (3.3V)
Reset/Mode signals are required to stay at 3.3V, because internal regulator may not be in ready during reset.			
Pins	Topology + Spec	Signals	Signal Level (power)
DBG GPIO00 GPIO01 GPIO02 GPIO03		od pp i	DVCC_CORE(1.8V) DVCC_CORE(1.8V) DVCC_CORE(1.8V)
GPIO10 GPIO11 GPIO12 GPIO13 GPIO14 GPIO15 GPIO16 GPIO17		od pp i	DVCC_CORE(1.8V) DVCC_CORE(1.8V) DVCC_CORE(1.8V)

Pins	Topology + Spec	Signals	Signal Level (power)
GPIO20 GPIO21 GPIO22 GPIO23 GPIO24 GPIO25 GPIO26 GPIO27 GPIO30 GPIO31 GPIO32 GPIO33 GPIO34 GPIO35 GPIO36 GPIO37		od pp i e aio	DVCC_CORE(1.8V) DVCC_CORE(1.8V) DVCC_CORE(1.8V) DVCC_CORE(1.8V) AVCC (3.3V)
XTALIN XTALOUT		i ei	DVCC_CORE(1.8V) DVCC_CORE(1.8V)

Figure 8-1 GPIO/PIN Structures

8.2 Register Description

Each bit may not have corresponding physical pin. In the case the bit is reserved and its read value is always 0 and write value should be always 0.

Table 8-1 GPIO Registers

Symbol	Name	Address	initial value
PFS0	Pin Function Select for GPIO0	0xFE00	0x00
PFS1	Pin Function Select for GPIO1	0xFE01	0x00
PFS2	Pin Function Select for GPIO2	0xFE02	0x00
PFS3	Pin Function Select for GPIO3	0xFE03	0x00
PDD0	Pin Data Direction for GPIO0	0xFE04	0x00
PDD1	Pin Data Direction for GPIO1	0xFE05	0x00
PDD2	Pin Data Direction for GPIO2	0xFE06	0x00
PDD3	Pin Data Direction for GPIO3	0xFE07	0x00
PDR0	Pin Data for GPIO0	0x90	0x00
PDR1	Pin Data for GPIO1	0x98	0x00
PDR2	Pin Data for GPIO2	0xB0	0x00
PDR3	Pin Data for GPIO3	0xC0	0x00
PPU0	Pin Pull Up Control for GPIO0	0xFE08	0xFF
PPU1	Pin Pull Up Control for GPIO1	0xFE09	0xFF
PPU2	Pin Pull Up Control for GPIO2	0xFE0A	0xFF
PPU3	Pin Pull Up Control for GPIO3	0xFE0B	0xFF
PIE0	Pin Interrupt Enable for GPIO0	0xFE10	0x00
PIE1	Pin Interrupt Enable for GPIO1	0xFE11	0x00
PIE2	Pin Interrupt Enable for GPIO2	0xFE12	0x00
PIE3	Pin Interrupt Enable for GPIO3	0xFE13	0x00
PIF0	Pin Interrupt Flag for GPIO0	0xC8	0x00
PIF1	Pin Interrupt Flag for GPIO1	0xD8	0x00
PIF2	Pin Interrupt Flag for GPIO2	0xE8	0x00
PIF3	Pin Interrupt Flag for GPIO3	0xF8	0x00
PIS0	Pin Interrupt Sense for GPIO0	0xFE14	0x00
PIS1	Pin Interrupt Sense for GPIO1	0xFE15	0x00
PIS2	Pin Interrupt Sense for GPIO2	0xFE16	0x00
PIS3	Pin Interrupt Sense for GPIO3	0xFE17	0x00
PIL0	Pin Interrupt Level for GPIO0	0xFE18	0x00
PIL1	Pin Interrupt Level for GPIO1	0xFE19	0x00
PIL2	Pin Interrupt Level for GPIO2	0xFE1A	0x00
PIL3	Pin Interrupt Level for GPIO3	0xFE1B	0x00
PIB0	Pin Interrupt Both Edge for GPIO0	0xFE1C	0x00
PIB1	Pin Interrupt Both Edge for GPIO1	0xFE1D	0x00
PIB2	Pin Interrupt Both Edge for GPIO2	0xFE1E	0x00
PIB3	Pin Interrupt Both Edge for GPIO3	0xFE1F	0x00
PEADC0	ADC Event Select from GPIO0	0xFE20	0x00
PEADC1	ADC Event Select from GPIO1	0xFE21	0x00
PEADC2	ADC Event Select from GPIO2	0xFE22	0x00
PEADC3	ADC Event Select from GPIO3	0xFE23	0x00
PEPWM0	PWM Event Select from GPIO0	0xFE24	0x00
PEPWM1	PWM Event Select from GPIO1	0xFE25	0x00
PEPWM2	PWM Event Select from GPIO2	0xFE26	0x00
PEPWM3	PWM Event Select from GPIO3	0xFE27	0x00
PEMETHOD	PWM Event Gathering Method	0xFE28	0x00

8.2.1 Pin Function Select for GPIO0 (PFS0)

Register		PFS0		Pin Function Select for GPIO0		Address	0xFE00
Bit	Bit Name	R/W	Initial	Description		Note	
7	PF31	R/W	0	Function Select for GPIO03 00: GPIO03, RXD, SI(SPI) 01: (Reserved, Do not select.) 10: (Reserved, Do not select.) 11: (Reserved, Do not select.)			
6	PF30	R/W	0				
5	PF21	R/W	0	Function Select for GPIO02 00: GPIO02 01: TXD 10: SO(SPI) 11: (Reserved, Do not select.)			
4	PF20	R/W	0				
3	PF11	R/W	0	Function Select for GPIO01 00: GPIO01 01: SCL (open drain) 10: SCK(SPI) 11: (Reserved, Do not select.)			
2	PF10	R/W	0				
1	PF01	R/W	0	Function Select for GPIO00 00: GPIO00, SS_N(SPI) 01: SDA (open drain) 10: CLKMON 11: (Reserved, Do not select.)			
0	PF00	R/W	0				

Signal direction of the pin depends on selected functionality.

8.2.2 Pin Function Select for GPIO_n (PFS_n) (n=1-3)

Register		PFS1		Pin Function Select for GPIO1		Address	0xFE01
Register		PFS2		Pin Function Select for GPIO2		Address	0xFE02
Register		PFS3		Pin Function Select for GPIO3		Address	0xFE03
Bit	Bit Name	R/W	Initial	Description		Note	
7	PF7	R/W	0	Function Select for GPIO1~3 0: GPIO 1: Other Function If Other function is selected, signal direction of the pin depends on selected functionality.			
6	PF6	R/W	0				
5	PF5	R/W	0				
4	PF4	R/W	0				
3	PF3	R/W	0				
2	PF2	R/W	0				
1	PF1	R/W	0				
0	PF0	R/W	0				

8.2.3 Pin Data Direction for GPIO_n (PDD_n) (n=0-3)

Register	PDD0	Pin Data Direction for GPIO0		Address	0xFE04
Register	PDD1	Pin Data Direction for GPIO1		Address	0xFE05
Register	PDD2	Pin Data Direction for GPIO2		Address	0xFE06
Register	PDD3	Pin Data Direction for GPIO3		Address	0xFE07
Bit	Bit Name	R/W	Initial	Description	Note
7	DD7	R/W	0	Pin Data Direction Select 0: Input 1: Output Each bit makes sense when the pin is selected as GPIO.	
6	DD6	R/W	0		
5	DD5	R/W	0		
4	DD4	R/W	0		
3	DD3	R/W	0		
2	DD2	R/W	0		
1	DD1	R/W	0		
0	DD0	R/W	0		

8.2.4 Pin Data for GPIO_n (PDR_n) (n=0-3)

Register	PDR0	Pin Data for GPIO0		Address	0x90
Register	PDR1	Pin Data for GPIO1		Address	0x98
Register	PDR2	Pin Data for GPIO2		Address	0xB0
Register	PDR3	Pin Data for GPIO3		Address	0xC0
Bit	Bit Name	R/W	Initial	Description	Note
7	PD7	R/W	0	Pin Data Read 0: The pin state is in low level Read 1: The pin state is in high level. Write 0: If the pin is GPIO output, the pin level will be low. Write 1: If the pin is GPIO output, the pin level will be high. If the pin is GPIO input or another digital function, read value shows external pin level, and write value has no effect. If the pin is GPIO output, write value will be output level of the pin and read value shows external pin level (not written value if external signal contention happens, for instance). If the pin is in analog function, read value is always zero, and write value has no effect. Note that write value is stored to internal register, so when pin function or pin direction are changed, output pin level might be affected by the register value.	
6	PD6	R/W	0		
5	PD5	R/W	0		
4	PD4	R/W	0		
3	PD3	R/W	0		
2	PD2	R/W	0		
1	PD1	R/W	0		
0	PD0	R/W	0		

8.2.5 Pin Pull Up Control for GPIO_n (PPU_n) (n=0-3)

Register	PPU0		Pin Pull Up Control for GPIO0	Address	0xFE08
Register	PPU1		Pin Pull Up Control for GPIO1	Address	0xFE09
Register	PPU2		Pin Pull Up Control for GPIO2	Address	0xFE0A
Register	PPU3		Pin Pull Up Control for GPIO3	Address	0xFE0B
Bit	Bit Name	R/W	Initial	Description	Note
7	PPU7	R/W	1	Pin Pull Up Enable 0: Pull Up MOS is OFF 1: Pull Up MOS is ON If the pin function is analog, this bit will be ignored.	
6	PPU6	R/W	1		
5	PPU5	R/W	1		
4	PPU4	R/W	1		
3	PPU3	R/W	1		
2	PPU2	R/W	1		
1	PPU1	R/W	1		
0	PPU0	R/W	1		

8.2.6 Pin Interrupt Enable for GPIO_n (PIE_n) (n=0-3)

Register	PIE0		Pin Interrupt Enable for GPIO0	Address	0xFE10
Register	PIE1		Pin Interrupt Enable for GPIO1	Address	0xFE11
Register	PIE2		Pin Interrupt Enable for GPIO2	Address	0xFE12
Register	PIE3		Pin Interrupt Enable for GPIO3	Address	0xFE13
Bit	Bit Name	R/W	Initial	Description	Note
7	PIE7	R/W	0	Pin Interrupt Enable 0: Disable 1: Enable If the pin function is analog, this bit will be ignored. If the pin function is digital, this bit is effective regardless of pin function or pin direction. This means PWM toggle can make interrupts.	
6	PIE6	R/W	0		
5	PIE5	R/W	0		
4	PIE4	R/W	0		
3	PIE3	R/W	0		
2	PIE2	R/W	0		
1	PIE1	R/W	0		
0	PIE0	R/W	0		

8.2.7 Pin Interrupt Flag for GPIO_n (PIF_n) (n=0-3)

Register	PIF0		Pin Interrupt Flag for GPIO0	Address	0xC8
Register	PIF1		Pin Interrupt Flag for GPIO1	Address	0xD8
Register	PIF2		Pin Interrupt Flag for GPIO2	Address	0xE8
Register	PIF3		Pin Interrupt Flag for GPIO3	Address	0xF8
Bit	Bit Name	R/W	Initial	Description	Note
7	PIF7	R/C	0	Pin Interrupt Flag (before mask; independent PIE _x) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit	
6	PIF6	R/C	0		
5	PIF5	R/C	0		
4	PIF4	R/C	0		
3	PIF3	R/C	0		
2	PIF2	R/C	0		
1	PIF1	R/C	0		
0	PIF0	R/C	0		

8.2.8 Pin Interrupt Sense for GPIO_n (PIS_n) (n=0-3)

Register	PIS0		Pin Interrupt Sense for GPIO0	Address	0xFE14
Register	PIS1		Pin Interrupt Sense for GPIO1	Address	0xFE15
Register	PIS2		Pin Interrupt Sense for GPIO2	Address	0xFE16
Register	PIS3		Pin Interrupt Sense for GPIO3	Address	0xFE17
Bit	Bit Name	R/W	Initial	Description	Note
7	PIS7	R/W	0	Pin Interrupt Sense Select 0: Level 1: Edge Implementation of edge sense is analog delay type (with some proper noise filter) to realize wake-up function.	
6	PIS6	R/W	0		
5	PIS5	R/W	0		
4	PIS4	R/W	0		
3	PIS3	R/W	0		
2	PIS2	R/W	0		
1	PIS1	R/W	0		
0	PIS0	R/W	0		

8.2.9 Pin Interrupt Level for GPIO_n (PIL_n) (n=0-3)

Register	PIL0	Pin Interrupt Level for GPIO0		Address	0xFE18
Register	PIL1	Pin Interrupt Level for GPIO1		Address	0xFE19
Register	PIL2	Pin Interrupt Level for GPIO2		Address	0xFE1A
Register	PIL3	Pin Interrupt Level for GPIO3		Address	0xFE1B
Bit	Bit Name	R/W	Initial	Description	Note
7	PIL7	R/W	0	Pin Interrupt Level Select 0: Level-Low, Edge-Falling 1: Level-High, Edge-Rising If edge sense is selected, PIB _x has the higher priority in the configuration.	
6	PIL6	R/W	0		
5	PIL5	R/W	0		
4	PIL4	R/W	0		
3	PIL3	R/W	0		
2	PIL2	R/W	0		
1	PIL1	R/W	0		
0	PIL0	R/W	0		

8.2.10 Pin Interrupt Both Edge for GPIO_n (PIB_n) (n=0-3)

Register	PIB0	Pin Interrupt Both Edge for GPIO0		Address	0xFE1C
Register	PIB1	Pin Interrupt Both Edge for GPIO1		Address	0xFE1D
Register	PIB2	Pin Interrupt Both Edge for GPIO2		Address	0xFE1E
Register	PIB3	Pin Interrupt Both Edge for GPIO3		Address	0xFE1F
Bit	Bit Name	R/W	Initial	Description	Note
7	PIB7	R/W	0	Pin Interrupt Both Edge Select 0: Falling edge or Rising edge according to PIL _x setting. 1: Both Edge regardless of PIL _x setting. Each bit is effective only when edge sense is selected.	
6	PIB6	R/W	0		
5	PIB5	R/W	0		
4	PIB4	R/W	0		
3	PIB3	R/W	0		
2	PIB2	R/W	0		
1	PIB1	R/W	0		
0	PIB0	R/W	0		

8.2.11 ADC Event Select from GPIO_n (PEADC_n) (n=0-3)

Register	PEADC0	ADC Event Select from GPIO0	Address	0xFE20	
Register	PEADC1	ADC Event Select from GPIO1	Address	0xFE21	
Register	PEADC2	ADC Event Select from GPIO2	Address	0xFE22	
Register	PEADC3	ADC Event Select from GPIO3	Address	0xFE23	
Bit	Bit Name	R/W	Initial	Description	Note
7	EVTADC7	R/W	0	ADC Event Select 0: An input signal is not used as an event for ADC. 1: An input signal is used as an event for ADC. Selected GPIO signals, EVTADC[7:0] are set "1", will be ORed, or ANDed according to PEMETHOD Register, and this will be sent to all ADC as the start trigger.	
6	EVTADC6	R/W	0		
5	EVTADC5	R/W	0		
4	EVTADC4	R/W	0		
3	EVTADC3	R/W	0		
2	EVTADC3	R/W	0		
1	EVTADC1	R/W	0		
0	EVTADC0	R/W	0		

8.2.12 PWM Event Select from GPIO_n (PEPWM_n) (n=0-3)

Register	PEPWM0	PWM Event Select from GPIO0	Address	0xFE24	
Register	PEPWM1	PWM Event Select from GPIO1	Address	0xFE25	
Register	PEPWM2	PWM Event Select from GPIO2	Address	0xFE26	
Register	PEPWM3	PWM Event Select from GPIO3	Address	0xFE27	
Bit	Bit Name	R/W	Initial	Description	Note
7	EVTPWM7	R/W	0	PWM Event Select 0: An input signal is not used as an event for PWM. 1: An input signal is used as an event for PWM. Selected GPIO signals, EVTPWM[7:0] are set "1", will be ORed, or ANDed according to PEMETHOD Register, and this will be sent to all PWM blocks for the Re-trigger Operation.	
6	EVTPWM6	R/W	0		
5	EVTPWM5	R/W	0		
4	EVTPWM4	R/W	0		
3	EVTPWM3	R/W	0		
2	EVTPWM2	R/W	0		
1	EVTPWM1	R/W	0		
0	EVTPWM0	R/W	0		

8.2.13 PWM Event Gathering Method (PEMETHOD)

Register		PEMETHOD		PWM Event Gathering Method		Address	0xFE28
Bit	Bit Name	R/W	Initial	Description		Note	
7	MPEPWM3	R/W	0	PWM Event Gathering Method 0: By ORed 1: By ANDED Each bit is corresponding to Register PEPWM0-3.			
6	MPEPWM2	R/W	0				
5	MPEPWM1	R/W	0				
4	MPEPWM0	R/W	0				
3	MPEADC3	R/W	0	ADC Event Gathering Method 0: By ORed 1: By ANDED Each bit is corresponding to Register PEADC0-3,			
2	MPEADC2	R/W	0				
1	MPEADC1	R/W	0				
0	MPEADC0	R/W	0				

Not Recommended for New Designs

9. Event Connections in the LSI

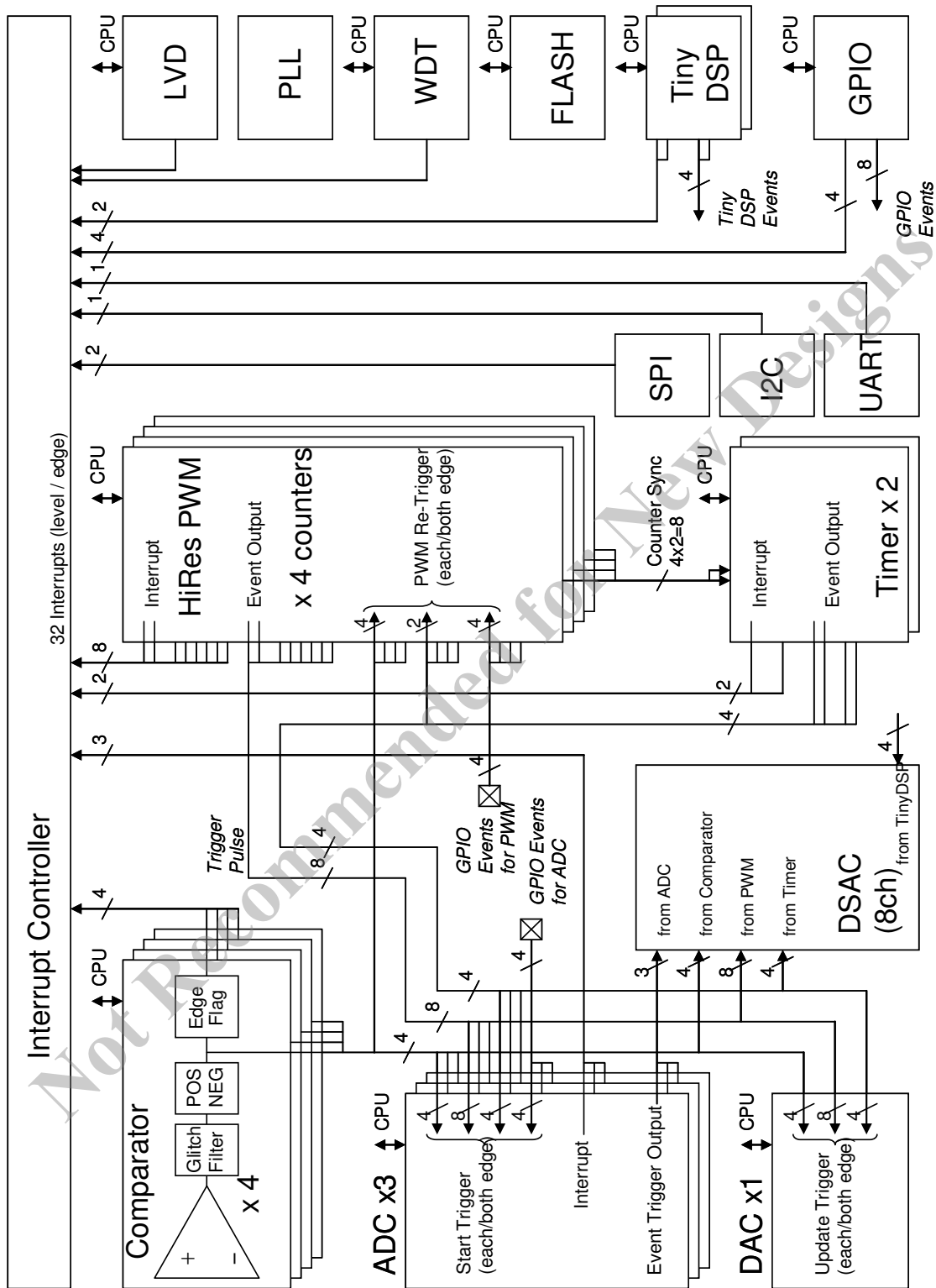


Figure 9-1 Internal Event Connection in MCU

10. Interrupt Controller

10.1 Overview

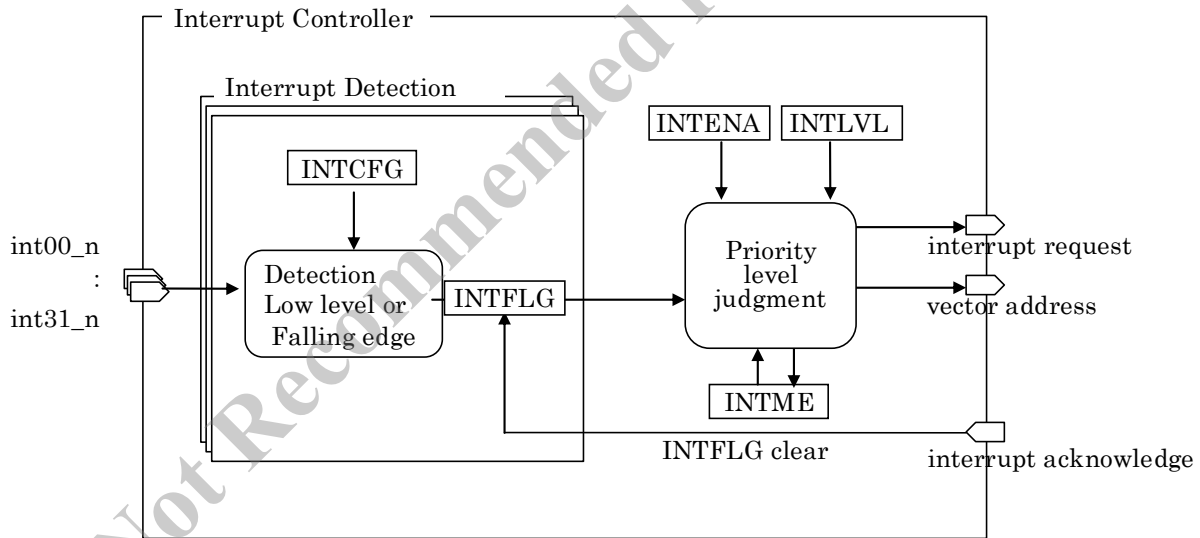
The interrupt controller (INTC) responds to interrupt signals from peripheral modules to convey interrupt requests to the CPU.

Table 10-1 lists the specifications of the interrupt controller, and Figure 10-1 shows a block diagram of the interrupt controller.

Table 10-1 Feature of INTC

Item	Description
Number of Sources	32 (int00 - int31)
Interrupt detection	Low level / falling edge Edge detection or level detection is determined for each source of connected peripheral modules.
Interrupt Enable	Interrupt enable of each channel can be set.
Interrupt priority	Two level priorities (“High” or “Low”) will be selectable.
Vector address	Each Vector address is allocated to corresponding interrupt source.

Interrupt by GPIO should refer to section 8.



[Note]
 INTME : Interrupt Master Enable signal
 INTENA : Interrupt Enable register
 INTLVL : Interrupt Level register
 INTCFG : Interrupt Config. register
 INTFLG : Interrupt Flag register

Figure 10-1 block diagram of the interrupt controller

10.2 Interrupt Vectors

There are 32 interrupt sources. Table 10-2 provides a summary of all interrupt sources which have vector No and vector address.

For SDCC (Small Device C Compiler), interrupt handlers (interrupt service routine: ISR) should be defined as follows.

```
void some_isr(void) __interrupt (5) __using (3)
{
}

```

The keyword `__interrupt (5)` means this ISR is corresponding to interrupt vector No.5. The keyword `__using (3)` means this ISR uses register bank No.3.

In SDCC, if you follow above manner, the vector table is automatically generated.

Table 10-2 Interrupt Vectors

Vector No.	Vector Address	Interrupt Source	Default Priority	Note
0	0x0003	GPIO0	HIGHER	
1	0x000b	GPIO1		
2	0x0013	GPIO2		
3	0x001b	GPIO3		
4	0x0023	LVD Interrupt		
5	0x002b	WDT Interrupt		
6	0x0033	Comparator 0 Interrupt		
7	0x003b	Comparator 1 Interrupt		
8	0x0043	Comparator 2 Interrupt		
9	0x004b	Comparator 3 Interrupt		
10	0x0053	ADC0 Interrupt		
11	0x005b	ADC1 Interrupt		
12	0x0063	ADC2 Interrupt		
13	0x006b	PWM0A Interrupt		
14	0x0073	PWM0B Interrupt		
15	0x007b	PWM1A Interrupt		
16	0x0083	PWM1B Interrupt		
17	0x008b	PWM2A Interrupt		
18	0x0093	PWM2B Interrupt		
19	0x009b	PWM3A Interrupt		
20	0x00a3	PWM3B Interrupt		
21	0x00ab	Timer0 Interrupt		
22	0a00b3	Timer1 Interrupt		
23	0x00bb	TinyDSP0 Interrupt		
24	0x00c3	TinyDSP1 Interrupt		
25	0x00cb	SPI Rx Interrupt		
26	0x00d3	SPI Tx Interrupt		
27	0x00db	I2C Tx/Rx Interrupt		
28	0x00e3	Reserved		
29	0x00eb	UART Tx/Rx Interrupt		
30	0x00f3	Reserved		
31	0x00fb	FLASH Interrupt	LOWER	

10.3 Register Description

All of the registers in INTC are shown in the Table 10-3

Table 10-3 List of Registers

SYMBOL	Name	address	Initial value
INTMST	Interrupt Master Control	0x9C	0x00
INTENA0	Interrupt Enable 0	0xA4	0x00
INTENA1	Interrupt Enable 1	0xA5	0x00
INTENA2	Interrupt Enable 2	0xA6	0x00
INTENA3	Interrupt Enable 3	0xA7	0x00
INTLVL0	Interrupt Level 0	0xAC	0x00
INTLVL1	Interrupt Level 1	0xAD	0x00
INTLVL2	Interrupt Level 2	0xAE	0x00
INTLVL3	Interrupt Level 3	0xAF	0x00
INTCFG0	Interrupt Config 0	0xB4	0x00
INTCFG1	Interrupt Config 1	0xB5	0x00
INTCFG2	Interrupt Config 2	0xB6	0x00
INTCFG3	Interrupt Config 3	0xB7	0x00
INTFLG0	Interrupt Flag 0	0xBC	0x00
INTFLG1	Interrupt Flag 1	0xBD	0x00
INTFLG2	Interrupt Flag 2	0xBE	0x00
INTFLG3	Interrupt Flag 3	0xBF	0x00

*The registers are on the region of SFR. The data of them are not to be transferred by DSAC.

10.3.1 INTMST

Register		INTMST		Interrupt Master Control		Address	0x9C
Bit	Bit Name	R/W	Initial	Description		Note	
7	HIP	R	0	High Priority Interrupt Flag 0 : High priority interrupt handler is not running. 1 : High priority interrupt handler is running.			
6	LIP	R	0	Low Priority Interrupt Flag 0 : Low priority interrupt handler is not running. 1 : Low priority interrupt handler is running or suspending.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	reserved	R	0	Read value is 0. Write only 0.			
0	INTME	R/W	0	Interrupt Master Enable 0: Disable all Interrupts 1: Permit enabled Interrupts			

10.3.2 INTENA

Register	INTENA0	Interrupt Enable 0			Address	0xA4
Register	INTENA1	Interrupt Enable 1			Address	0xA5
Register	INTENA2	Interrupt Enable 2			Address	0xA6
Register	INTENA3	Interrupt Enable 3			Address	0xA7
Bit	Bit Name	R/W	Initial	Description	Note	
7	INTE7	R/W	0	Each Interrupt Enable 0: Disable Corresponding Interrupt 1: Enable Corresponding Interrupt INTE _y bit in INTENA _x register corresponds to Interrupt whose vector No. is (y + x * 8)		
6	INTE6	R/W	0			
5	INTE5	R/W	0			
4	INTE4	R/W	0			
3	INTE3	R/W	0			
2	INTE2	R/W	0			
1	INTE1	R/W	0			
0	INTE0	R/W	0			

10.3.3 INTLVL

Register	INTLVL0	Interrupt Level 0			Address	0xAC
Register	INTLVL1	Interrupt Level 1			Address	0xAD
Register	INTLVL2	Interrupt Level 2			Address	0xAE
Register	INTLVL3	Interrupt Level 3			Address	0xAF
Bit	Bit Name	R/W	Initial	Description	Note	
7	INTL7	R/W	0	Each Interrupt Priority Level 0: The Interrupt is Low Priority Level 1: The Interrupt is High Priority Level INTL _y bit in INTLVL _x register corresponds to Interrupt whose vector No. is (y + x * 8)		
6	INTL6	R/W	0			
5	INTL5	R/W	0			
4	INTL4	R/W	0			
3	INTL3	R/W	0			
2	INTL2	R/W	0			
1	INTL1	R/W	0			
0	INTL0	R/W	0			

10.3.4 INTCFG

Register	INTCFG0	Interrupt Config 0	Address	0xB4	
Register	INTCFG1	Interrupt Config 1	Address	0xB5	
Register	INTCFG2	Interrupt Config 2	Address	0xB6	
Register	INTCFG3	Interrupt Config 3	Address	0xB7	
Bit	Bit Name	R/W	Initial	Description	Note
7	INTS7	R/W	0	Each Interrupt Sensitivity 0: Low level sensitivity 1: Falling Edge sensitivity INTSy bit in INTCFGx register corresponds to Interrupt whose vector No. is (y + x * 8)	
6	INTS6	R/W	0		
5	INTS5	R/W	0		
4	INTS4	R/W	0		
3	INTS3	R/W	0		
2	INTS2	R/W	0		
1	INTS1	R/W	0		
0	INTS0	R/W	0		

10.3.5 INTFLG

Register	INTFLG0	Interrupt Flag 0	Address	0xBC	
Register	INTFLG1	Interrupt Flag 1	Address	0xBD	
Register	INTFLG2	Interrupt Flag 2	Address	0xBE	
Register	INTFLG3	Interrupt Flag 3	Address	0xBF	
Bit	Bit Name	R/W	Initial	Description	Note
7	INTF7	R/W	0	Each Interrupt Flag 0: No interrupt 1: Interrupt receipt INTFy bit in INTFLGx register corresponds to Interrupt whose vector No. is (y + x * 8) Cleared by write "1"	
6	INTF6	R/W	0		
5	INTF5	R/W	0		
4	INTF4	R/W	0		
3	INTF3	R/W	0		
2	INTF2	R/W	0		
1	INTF1	R/W	0		
0	INTF0	R/W	0		

In edge sensitivity mode(INTCFGx.INTSy=1), INTFy is cleared automatically when the corresponding interrupt is accepted.

10.4 Operation

10.4.1 Initial setting

In order to issue the interrupt request which is base on each interrupt source, it is necessary to do the initial setting as shown in Figure 10-2.

- Setting INTLVLx.INTLy bit is for determination of each interrupt priority level.
- Each interrupt can take two priority levels, “High” or “Low”, and these priority levels are selectable for setting INTLVLx.INTLy bit. Detail description is mentioned in 10.4.3.
- Setting INTCFGx.INTSy bit is for determination of each interrupt Sensitivity.
- Each interrupt can take two sensitivity, “Low level” or “Falling edge”, and these sensitivities are selectable for setting INTCFGx.INTSy bit.
- INTENAx.INTEy bit can enable the corresponding interrupt source.
- INTMST.INTME bit can permit the enabled interrupt to issue the request for CPU

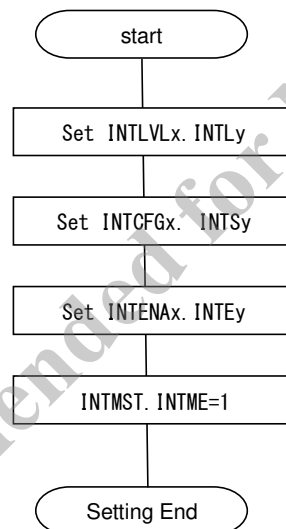


Figure 10-2 Flowchart of INTC initial setting

10.4.2 Interrupt flag

Interrupt flag (INTFLG register) indicates, the detected interrupt source depend on setting INTENAx.INTEy.

There are two kinds of sensitivity to detect interrupt. One is Low level sensitivity, another is Failling edge sensitivity. These sensitivities are selectable for setting INTCFGx.INTSy bit.

In case of the failing edge sensitivity, INTFLGx.INTFy bit will be held up to cleare by writing “1”

In case of the low level sensitivity, INTFLGx.INTFy bit is indicating the corresponding interrupt source, and it will not be held if interrupt source change the level

10.4.3 Interrupt level

Each interrupt can take two priority levels, “High” or “Low”. Only high level interrupt will be accepted when CPU is handling low level interrupt. While CPU is handling high level interrupt, no interrupt can be accepted. When same level interrupts are occurred simultaneously, lower vector number interrupt will be accepted. Interrupts which are not accepted by CPU should be holding until the service routine finish.

In each interrupt handler, software should clear corresponding peripheral flags. The above is shown in Figure 10-3.

Note: It is impossible to generate new interrupt signals at such time as below.

- When executing RETI instruction.
- The time before receiving acknowledgement of CPU after issuing the interrupt request, and doing it.

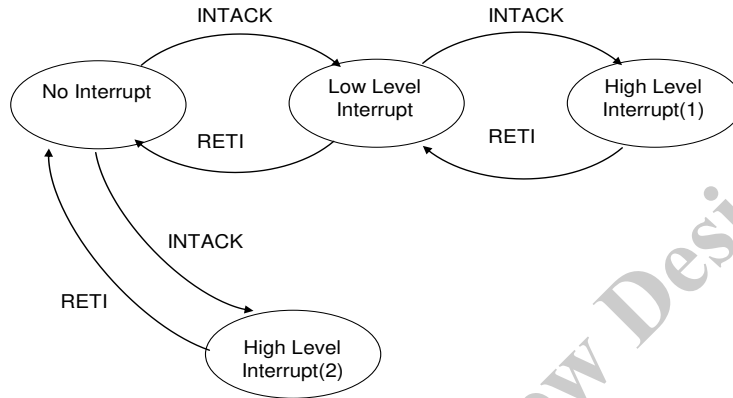


Figure 10-3 diagram of INTC state transition

By executing RETI instruction at end of interrupt routine, it is cleared that INTMST.HIP/LIP bits corresponding to priority of this routine.

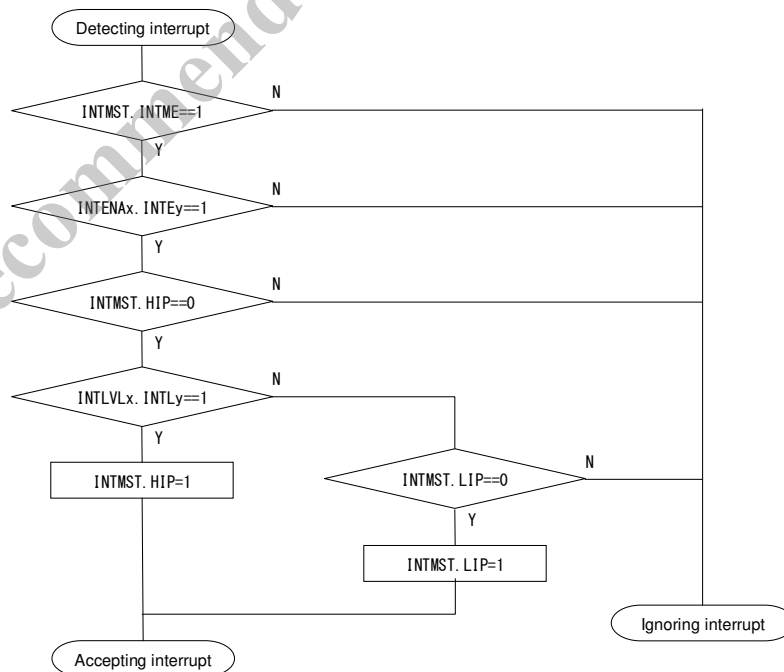


Figure 10-4 Flowchart of INTC accepting interrupt

Decisions of Figure 10-4 are processed by hardware.

10.4.4 Interrupt of external pins

All GPIO can be used external interrupt pin in accord with GPIO register settings. Signals of interrupt by GPIO are ORed. The signals ORed is input on INTC after it is converted. Logic diagram of interrupt by GPIO is shown in Figure 10-5. Wave form diagram of generating interrupt by GPIO is shown in **Figure 10-6**. Vector addresses of each GPIO refer to Table 10-2. Details information of external interrupt by GPIO is described in section.8.

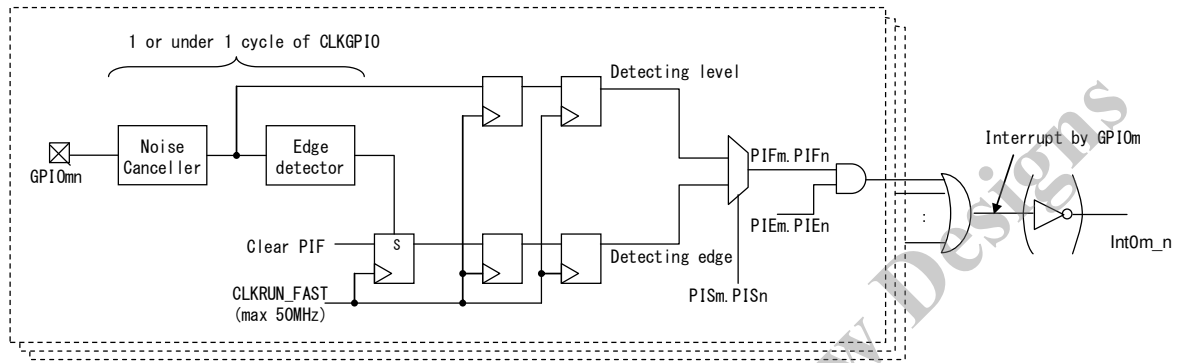


Figure 10-5 Logic diagram of interrupt by GPIO

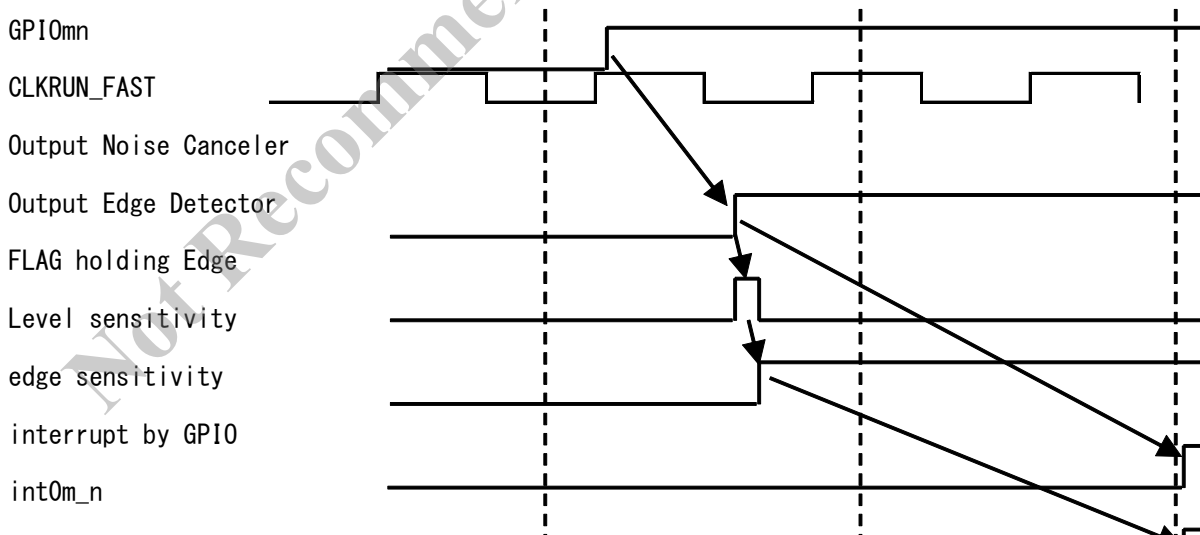


Figure 10-6 Wave form diagram of interrupt by GPIO

11. DSAC (Direct SFR Access Controller)

11.1 Overview

DSAC can transfer data directly between two SFRs without using the CPU. This function can be applied only to the SFRs for peripheral and eliminate the data-transfer time drastically.

Note: DSAC can't access the SFRs related to CPU and INTC. If DSAC tries to read these SFRs, the data will be unknown, and if DSAC tries to write these SFRs, it will be of no effect on operation. DSAC Block diagram is shown in Figure 11-1 and features are shown in Table 11-1

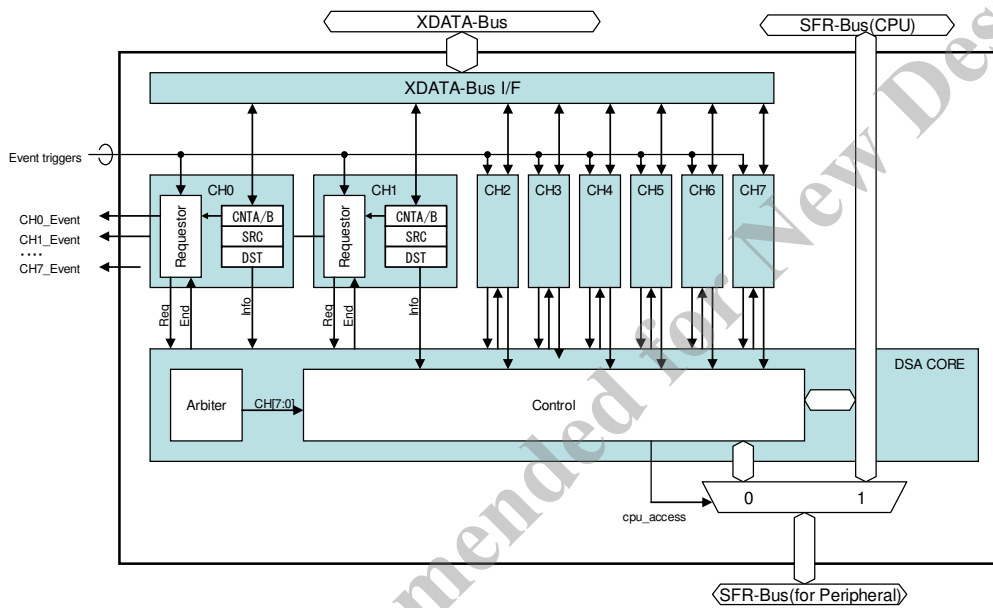


Figure 11-1 DSAC Block Diagram

Table 11-1 Feature of DSAC

Item	Description
Number of channels	8 channels
Request source	Maximum 32. select by a register
transfer size	1/2/4byte. select by a register
Address mode	fixed/increment Souce/Destination mode can be set independently.
Channel priority	CH0 > CH1 > ... > CH6 > CH7
SFR Bus access priority	CPU > DSAC
Transfer mode	Cycle steal

11.2 Event

DSAC is activated by Trigger events which are shown in Table 11-2. The Trigger events activating DSAC are selected with the DSACNTAn registers.

Table 11-2 DSAC Events

Event No.	Event Source	Trigger Event	Note
0	Comparator 0	Toggled specified Polarity	
1	Comparator 1	Toggled specified Polarity	
2	Comparator 2	Toggled specified Polarity	
3	Comparator 3	Toggled specified Polarity	
4	ADC Unit0	The register is updated by conversion	
5	ADC Unit1	The register is updated by conversion	
6	ADC Unit2	The register is updated by conversion	
7	PWM0 Event0	Corresponding Event happens	
8	PWM0 Event1	Corresponding Event happens	
9	PWM1 Event0	Corresponding Event happens	
10	PWM1 Event1	Corresponding Event happens	
11	PWM2 Event0	Corresponding Event happens	
12	PWM2 Event1	Corresponding Event happens	
13	PWM3 Event0	Corresponding Event happens	
14	PWM3 Event1	Corresponding Event happens	
15	Timer0 CM0	Corresponding Event happens	
16	Timer0 CM1	Corresponding Event happens	
17	Timer1 CM0	Corresponding Event happens	
18	Timer1 CM1	Corresponding Event happens	
19	TinyDSP0 Event 0	Corresponding Event happens	
20	TinyDSP0 Event 1	Corresponding Event happens	
21	TinyDSP1 Event 0	Corresponding Event happens	
22	TinyDSP1 Event 1	Corresponding Event happens	
23	reserved		
24	reserved		
25	reserved		
26	reserved		
27	reserved		
28	reserved		
29	reserved		
30	reserved		
31	reserved		

11.3 Register Description

Table 11-3 XDATA-Bus registers

Symbol	Name	Address	Initial value
DSACNTA0	DSA Control A Channel 0	0xF880	0x00
DSACNTB0	DSA Control B Channel 0	0xF881	0x00
DSASRC0	DSA Source Address Channel 0	0xF882	0x80
DSADST0	DSA Destination Address Channel 0	0xF883	0x80
DSACNTA1	DSA Control A Channel 1	0xF884	0x00
DSACNTB1	DSA Control B Channel 1	0xF885	0x00
DSASRC1	DSA Source Address Channel 1	0xF886	0x80
DSADST1	DSA Destination Address Channel 1	0xF887	0x80
DSACNTA2	DSA Control A Channel 2	0xF888	0x00
DSACNTB2	DSA Control B Channel 2	0xF889	0x00
DSASRC2	DSA Source Address Channel 2	0xF88A	0x80
DSADST2	DSA Destination Address Channel 2	0xF88B	0x80
DSACNTA3	DSA Control A Channel 3	0xF88C	0x00
DSACNTB3	DSA Control B Channel 3	0xF88D	0x00
DSASRC3	DSA Source Address Channel 3	0xF88E	0x80
DSADST3	DSA Destination Address Channel 3	0xF88F	0x80
DSACNTA4	DSA Control A Channel 4	0xF890	0x00
DSACNTB4	DSA Control B Channel 4	0xF891	0x00
DSASRC4	DSA Source Address Channel 4	0xF892	0x80
DSADST4	DSA Destination Address Channel 4	0xF893	0x80
DSACNTA5	DSA Control A Channel 5	0xF894	0x00
DSACNTB5	DSA Control B Channel 5	0xF895	0x00
DSASRC5	DSA Source Address Channel 5	0xF896	0x80
DSADST5	DSA Destination Address Channel 5	0xF897	0x80
DSACNTA6	DSA Control A Channel 6	0xF898	0x00
DSACNTB6	DSA Control B Channel 6	0xF899	0x00
DSASRC6	DSA Source Address Channel 6	0xF89A	0x80
DSADST6	DSA Destination Address Channel 6	0xF89B	0x80
DSACNTA7	DSA Control A Channel 7	0xF89C	0x00
DSACNTB7	DSA Control B Channel 7	0xF89D	0x00
DSASRC7	DSA Source Address Channel 7	0xF89D	0x80
DSADST7	DSA Destination Address Channel 7	0xF89F	0x80

11.3.1 DSACNTAn (DSAC Control A Register)

Register	DSACNTA0	DSA Control A Channel 0	Address	0xF880	
Register	DSACNTA1	DSA Control A Channel 1	Address	0xF884	
Register	DSACNTA2	DSA Control A Channel 2	Address	0xF888	
Register	DSACNTA3	DSA Control A Channel 3	Address	0xF88C	
Register	DSACNTA4	DSA Control A Channel 4	Address	0xF890	
Register	DSACNTA5	DSA Control A Channel 5	Address	0xF894	
Register	DSACNTA6	DSA Control A Channel 6	Address	0xF898	
Register	DSACNTA7	DSA Control A Channel 7	Address	0xF89C	
Bit	Bit Name	R/W	Initial	Description	Note
7	DSACHE	R/W	0	DSA Channel Enable 0: Disable 1: Enable	
6	DSATB1	R/W	0	DSA Transfer Bytes 00: 1-byte 01: 2-bytes 10: 4-bytes 11: reserved	
5	DSATB0	R/W	0		
4	DSAEV4	R/W	0	DSA Channel Trigger 00000: Link to Event No.0 00001: Link to Event No.1 ... 11111: Link to Event No.31 No DSAC Event is assigned from Event No.23 to Event No.31 in this LSI. So don't set these Event No..	
3	DSAEV3	R/W	0		
2	DSAEV2	R/W	0		
1	DSAEV1	R/W	0		
0	DSAEV0	R/W	0		

11.3.2 DSACNTBn (DSAC Control B Register)

Register	DSACNTB0	DSA Control B Channel 0	Address	0xF881	
Register	DSACNTB1	DSA Control B Channel 1	Address	0xF885	
Register	DSACNTB2	DSA Control B Channel 2	Address	0xF889	
Register	DSACNTB3	DSA Control B Channel 3	Address	0xF88D	
Register	DSACNTB4	DSA Control B Channel 4	Address	0xF891	
Register	DSACNTB5	DSA Control B Channel 5	Address	0xF895	
Register	DSACNTB6	DSA Control B Channel 6	Address	0xF899	
Register	DSACNTB7	DSA Control B Channel 7	Address	0xF89D	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0	
6	reserved	R	0	Read value is 0. Write only 0	
5	reserved	R	0	Read value is 0. Write only 0	
4	reserved	R	0	Read value is 0. Write only 0	
3	reserved	R	0	Read value is 0. Write only 0	
2	reserved	R	0	Read value is 0. Write only 0	
1	DSADSTC	R/W	0	Destination Address Control 0: Address stays at same value. 1: Increment according to DSATB[1:0] setting	
0	DSASRCC	R/W	0	Source Address Control 0: Address stays at same value. 1: Increment according to DSATB[1:0] setting	

11.3.3 DSASRCn (DSAC Source address Register)

Register	DSASRC0	DSA Source Address Channel 0	Address	0xF882	
Register	DSASRC1	DSA Source Address Channel 1	Address	0xF886	
Register	DSASRC2	DSA Source Address Channel 2	Address	0xF88A	
Register	DSASRC3	DSA Source Address Channel 3	Address	0xF88E	
Register	DSASRC4	DSA Source Address Channel 4	Address	0xF892	
Register	DSASRC5	DSA Source Address Channel 5	Address	0xF896	
Register	DSASRC6	DSA Source Address Channel 6	Address	0xF89A	
Register	DSASRC7	DSA Source Address Channel 7	Address	0xF89D	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	1	Read value is 1. Write only 1	
6	DSASA6	R/W	0	SFR Source Address (Corresponding to 0x80 – 0xFF)	
5	DSASA5	R/W	0		
4	DSASA4	R/W	0		
3	DSASA3	R/W	0		
2	DSASA2	R/W	0		
1	DSASA1	R/W	0		
0	DSASA0	R/W	0		

11.3.4 DSADSTn (DSAC Destination address Register)

Register	DSADST0	DSA Destination Address Channel 0	Address	0xF883	
Register	DSADST1	DSA Destination Address Channel 1	Address	0xF887	
Register	DSADST2	DSA Destination Address Channel 2	Address	0xF88B	
Register	DSADST3	DSA Destination Address Channel 3	Address	0xF88F	
Register	DSADST4	DSA Destination Address Channel 4	Address	0xF893	
Register	DSADST5	DSA Destination Address Channel 5	Address	0xF897	
Register	DSADST6	DSA Destination Address Channel 6	Address	0xF89B	
Register	DSADST7	DSA Destination Address Channel 7	Address	0xF89F	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	1	Read value is 1. Write only 1.	
6	DSADA6	R/W	0	SFR Destination Address (Corresponding to 0x80 – 0xFF)	
5	DSADA5	R/W	0		
4	DSADA4	R/W	0		
3	DSADA3	R/W	0		
2	DSADA2	R/W	0		
1	DSADA1	R/W	0		
0	DSADA0	R/W	0		

11.4 Operation

The DSAC is activated by Trigger events which are shown in Table 11-2. The Trigger events to activate the DSAC are selected with the DSACNTAn registers. The DSAC has 8-channels, and each channel is linked to one of the Trigger events. When one of the channels detects the Trigger event, transfer operation will start base on corresponding bits among DSAEV0 to DSAEV4 in the DSACNTAn register.

Regarding the priority of DSAC, lower No. channel is higher than higher No. channel. If plural channels are initiated at same time, lower No. channel should be activated and higher No. channel will wait for until lower No. channel complete the transfer operation.

Each channel operation is configured by registers, such as source SFR address in DSASRCn, destination SFR address in DSADSTn, transfer bytes (from 1, 2, or 4) in DSACNTAn.

In multi-bytes transfer, both source address and destination address will be increased and put into the temporary registers, but DSASRCn and DSADST register's values will not be changed.

Detailed information shows on Figure 11-2.

During one channel is trasfering the data, even next Trigger event which linked to same channel is occurred, the next Trigger event will be ignored.

Please note that CPU has the higher priority than DSAC when SFR access from CPU and DSAC collides. In this collision case, DSAC should wait for finish of CPU's SFR access, but there is no wait cycle in the CPU's SFR access cycle.

4(1,2) Bytes transfer

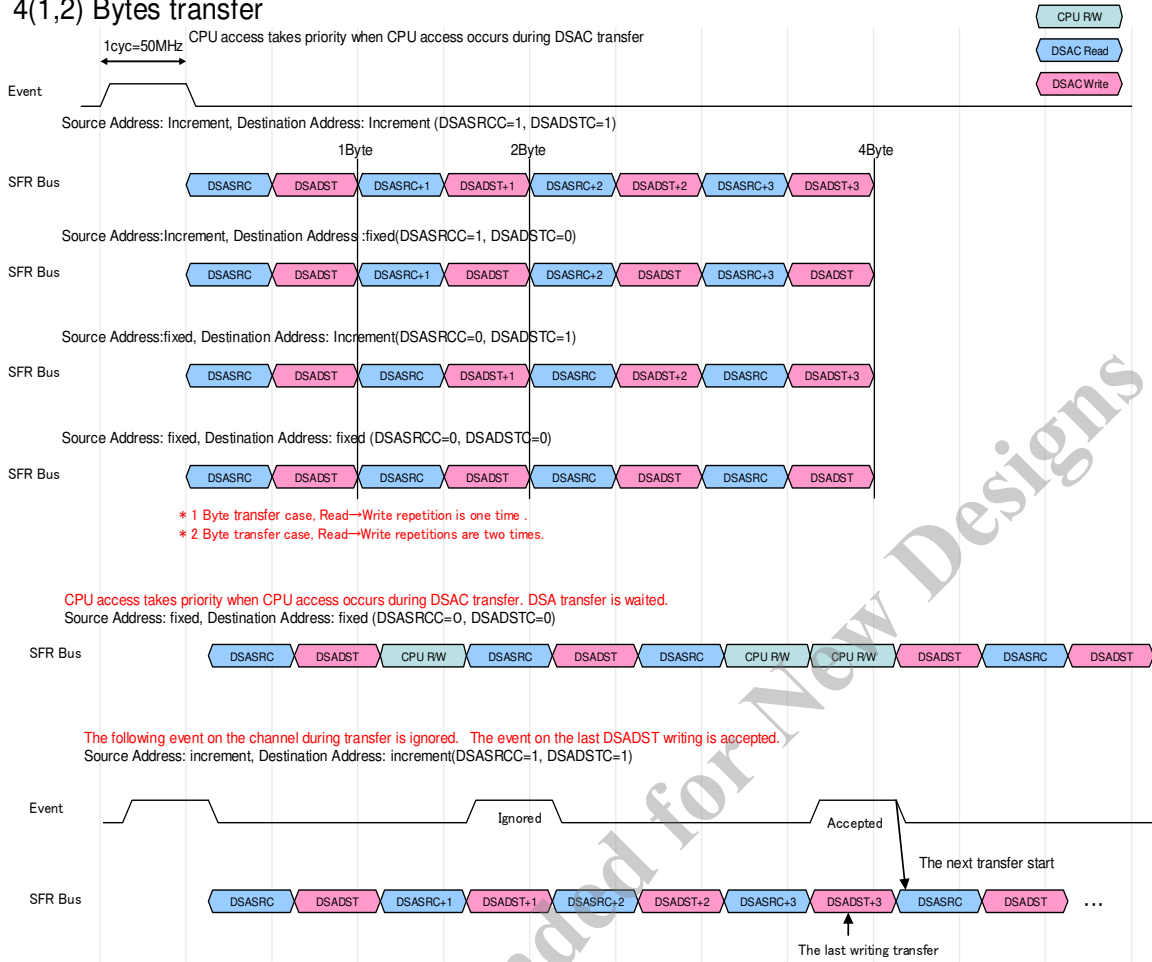


Figure 11-2 4(1,2) Bytes transfer

11.5 Initialization sequence

Figure 11-3 shows the initialization sequence.

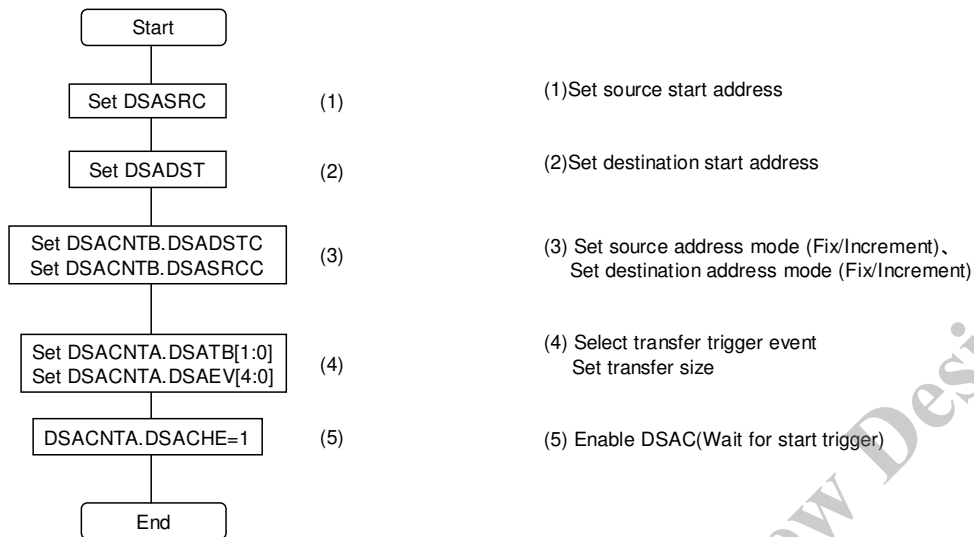


Figure 11-3 Initialization sequence

11.6 Limitation of DSAC

11.6.1 Disabling DSAC

CHn is disabled by writing DSACNTAn.DSACHE bit to 0. CHn is disabled after corresponding channel transmit is completed. If CHn has an unexecuted transfer request, the request is accepted and the transfer is occurred. When the transfer is finished, CHn is disabled. The request is ignored which reaches after writing DSACNTAn.DSACHE bit to 0.

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12. FLASH Memory Control

12.1 Overview

The LSI has FLASH memory to store program and data. The FLASH can be erased or written via 1-wire debugger interface.

Also some protection levels are supported not to be stolen application program and data.

Table 12-1 Feature of FLC

item	Description
Flash memory	Times for programming, erasure durability: 20000 times
Main block (Program)	Size : 16KB(4Kword x 32bit) Page size: 16pages Row size: 8rows/page Word size: 32words/row = 128bytes
Information block	Size : 1KB(256word x 32bit) Page size: 1pages Row size: 8rows/page Word size: 32words/row = 128bytes
Program fetch	Fetch data width : 32bit Instruction Buffer: 32bit x 2line. Data Buffer: 32bit x 1 line Access mode : Fast clock mode(2cyc) / Slow clock mode(1cyc) Prefetch : occur when reading 4n+2 or 4n+3 address (Fast clock mode) occur when reading 4n+3 address (Slow clock mode) Only Instruction buffer has prefetch function.
Flash programming	Mode : 8 modes Programming : info/main row programming mode Erase : main page/mass erase mode Read : info/main read mode Protecting Release : Changing protect level
Flash security management	Security Level: Level1/Level2 Security code length: 32bit The security level can change using "protect release mode". Avoid flash read after fetching program from RAM in Level2 Avoid flash read from OCD in Level2. The security codes store the info block of flash memory.

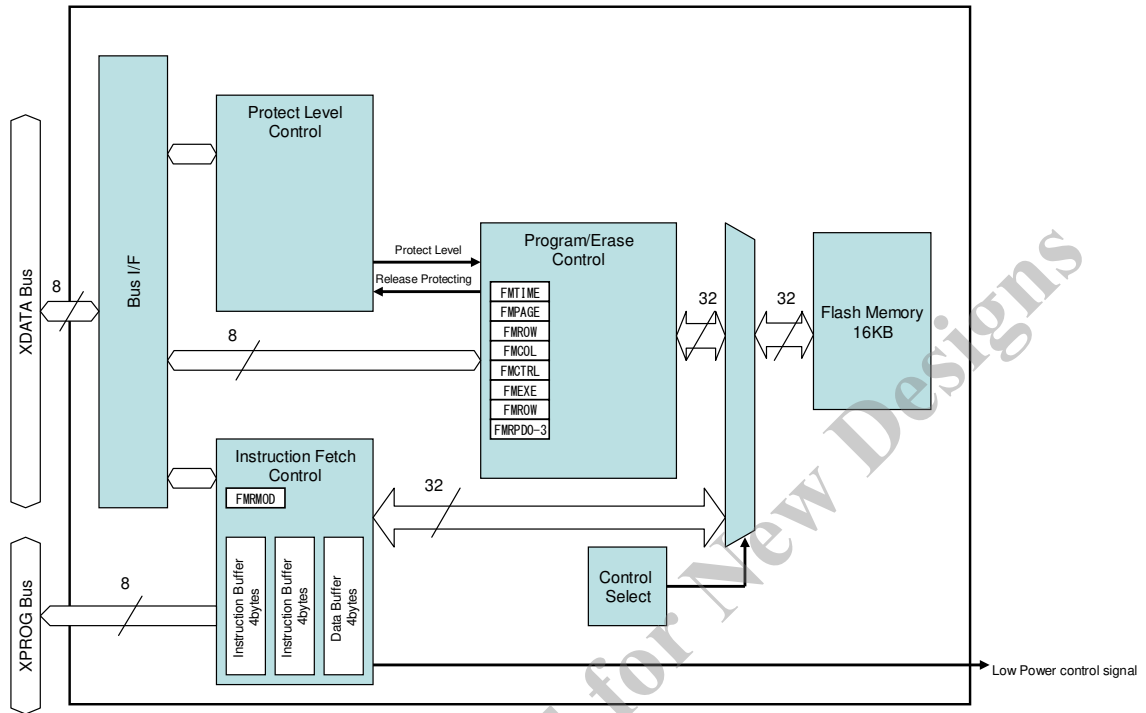


Figure 12-1 Block Diagram of FLC

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12.2 Flash memory mat structure

The flash memory of the LSI is structured by 16K byte Main block and 1K byte information block. Main block is divided by 16 in the page of the 1K byte unit.

Information block is used for writing the protect code. The structure is shown on Figure 12-2.

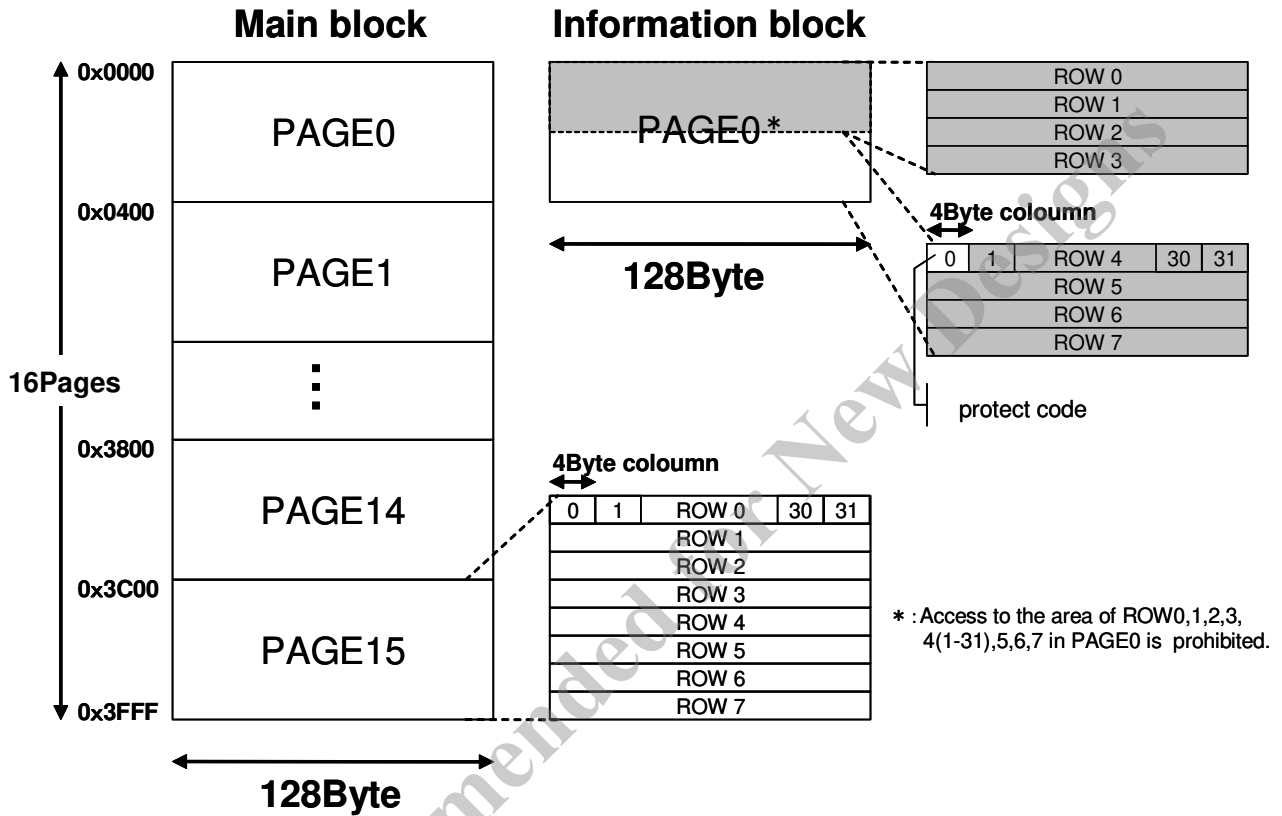


Figure 12-2 Flash memory mat structure

12.3 Register Description

Table 12-2 shows the registers in FLC.

Table 12-2 List of Registers

SYMBOL	Name	address	Initial value
FMTIME	Flash Memory Control Time register	0xFF00	0x0F
FMPAGE	Flash Memory Page address register	0xFF01	0x00
FMROW	Flash Memory Row address register	0xFF02	0x00
FMCOL	Flash Memory Column address register	0xFF03	0x00
FMCTRL	Flash Memory Control register	0xFF04	0x00
FMEXE	Flash Memory Program execute register	0xFF05	0x00
FMRPD0	Flash Memory Row Program Data0 register	0xFF10	0x00
FMRPD1	Flash Memory Row Program Data0 register	0xFF11	0x00
FMRPD2	Flash Memory Row Program Data0 register	0xFF12	0x00
FMRPD3	Flash Memory Row Program Data0 register	0xFF13	0x00
FMRMOD	Flash Memory Read mode register	0xFF20	0x01

12.3.1 FMTIME

Register	FMTIME		FLASH Memory Control Time Base		Address	0xFF00
Bit	Bit Name	R/W	Initial	Description	Note	
7	TIME7	R/W	0	FLASH Memory Control Time Base To make “1us” time tick, set value as shown below. $FMTIME = ((\text{Frequency of CLKCPU}) * 1 / 10^6) - 1$ FMTIME register can be written only when FMEXE=0.		
6	TIME6	R/W	0			
5	TIME5	R/W	0			
4	TIME4	R/W	0			
3	TIME3	R/W	1			
2	TIME2	R/W	1			
1	TIME1	R/W	1			
0	TIME0	R/W	1			

12.3.2 FMPAGE

Register		FMPAGE		FLASH Memory PAGE Address		Address	0xFF01
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	PAGE3	R/W	0	FLASH Memory PAGE Address Specify PAGE Address in the Module. This PAGE address specifies target page position to be programmed or erased. FMPAGE register can be written only when FMEXE=0.			
2	PAGE2	R/W	0				
1	PAGE1	R/W	0				
0	PAGE0	R/W	0				

12.3.3 FMROW

Register		FMROW		FLASH Memory ROW Address		Address	0xFF02
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	ROW2	R/W	0	FLASH Memory ROW Address Specify ROW Address in a Page. This ROW address specifies target ROW position to be programmed. FMROW register can be written only when FMEXE=0.			
1	ROW1	R/W	0				
0	ROW0	R/W	0				

In protect level 1, ROW2 bit should be set to 1'b1. If ROW2 bit is 1'b0 in protect level 1, the flash operation sequence is running but the flash operation do not affect the flash memory not to access to the top half of the information block when accessing information block.

12.3.4 FMCOL

Register		FMCOL		FLASH Memory Column Address		Address	0xFF03
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	COL4	R/W	0	FLASH Memory Column Address Specify Column Address of each Word in a Row. This Column address specifies target position to be programmed in a row. FMCOL is automatically incremented when sequential reading(FMEXE=1 and reading FMRPD3 in read mode), or when the current writing sequence is finished. FMCOL register can be written only when FMEXE=0.			
3	COL3	R/W	0				
2	COL2	R/W	0				
1	COL1	R/W	0				
0	COL0	R/W	0				

12.3.5 FMCTRL

Register		FMCTRL		FLASH Memory Control		Address	0xFF04
Bit	Bit Name	R/W	Initial	Description		Note	
7	FMIF	R/C	0	FLASH Memory Interrupt Flag Read 0: Operation not finished. Read 1: Operation finished. Write 0: No effect Write 1: Clear this flag.			
6	FMIE	R/W	0	FLASH Memory Interrupt Enable 0: Disable 1: Enable (Actual Interrupt Signal = FMIF & FMIE)			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	FMCMD3	R/W	0	FLASH operation mode 0000: Normal operation mode CPU opecode fetch via CPUX-bus 0100: Main block Read mode 0101: Main block Row programming mode 0110: Main block Page erase mode 0111: Main block Mass erase mode 1000: Information block Read mode 1001:Information block Row programming mode 1111: Protecting release mode others: prohibited			
2	FMCMD2	R/W	0				
1	FMCMD1	R/W	0				
0	FMCMD0	R/W	0				

FMCTRL.FMCMD[3:0] register can be written only when FMEXE=0.

According to the difference of the current protect level, there is unacceptable write value of FCMD[3:0]. Table 12-3 shows the acceptable mode according to the current security mode.

Table 12-3 Protect level vs FMCMD[3:0]

Mode	Value	Level1	Level2
Normal operation mode	b'0000	X	X
Main block Read mode	b'0100	X	-
Main block Row programming mode	b'0101	X	-
Main block Page erase mode	b'0110	X	-
Main block Mass erase mode	b'0111	X	-
Information block Read mode	b'1000	X	-
Information block Row programming mode	b'1001	X	-
Protecting release mode	b'1111	X	X
Others	others	-	-

12.3.6 FMEXE

Register		FMEXE	FLASH Memory program execute		Address	0xFF05
Bit	Bit Name	R/W	Initial	Description	Note	
7	reserved	R	0	Read value is 0. Write only 0.		
6	reserved	R	0	Read value is 0. Write only 0.		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	reserved	R	0	Read value is 0. Write only 0.		
2	reserved	R	0	Read value is 0. Write only 0.		
1	reserved	R	0	Read value is 0. Write only 0.		
0	FMEXE	R/W	0	FLASH operation execute Read 0: FLASH operation is not executed. Read 1: FLASH operation is executed now (BUSY). Write 0: Abort FLASH operation. Write 1: Start FLASH operation.		

FMEXE bit cannot be written when FMCMD[3:0]=4'b0000.

12.3.7 FMRPD0-3

Register	FMRPD0	FLASH Row Program Data 0		Address	0xFF10
Register	FMRPD1	FLASH Row Program Data 1		Address	0xFF11
Register	FMRPD2	FLASH Row Program Data 2		Address	0xFF12
Register	FMRPD3	FLASH Row Program Data 3		Address	0xFF13
Bit	Bit Name	R/W	Initial	Description	Note
7	RPD7	R/W	0	FLASH Memory Row Program Data These registers store word data to be programmed in specified word lane in a row. FMRPD0 corresponds to FLASH read address 4n. Also, FMRPD1→4n+1, FMRPD2→4n+2, FMRPD3→4n+3.	
6	RPD6	R/W	0		
5	RPD5	R/W	0		
4	RPD4	R/W	0		
3	RPD3	R/W	0		
2	RPD2	R/W	0		
1	RPD1	R/W	0		
0	RPD0	R/W	0		

12.3.8 FMRRMOD

Register	FMRRMOD	FLASH Memory Read Mode register		Address	0xFF20
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0.	
0	FAST	R/W	1	FAST clock read mode 0: Slow clock read mode(1cyc) 1: Fast clock read mode(2cyc) The written value can be read after the flash access will be active to idle. The clock frequency must be changed after confirming that the read data equals to written data.	

12.4 Operation

12.4.1 Instruction fetch

The Instruction Fetch Controller (IFC) controls instruction fetch from Flash to CPU. IFC has a 4bytes x 2 lines instruction buffer (IBUF). IFC reads 4bytes instruction code from Flash, then returns 1byte instruction code to CPU and writes fetched 4bytes instruction code to the instruction buffer. If the instruction buffer has the code that CPU requests to fetch, IFC returns the instruction code in the instruction buffer without wait states. This mechanism reduces number of flash access and avoids to decrease CPU performance.

IFC also has constant data buffer (DBUF). DBUF consist of 4bytes x 1line buffer. When CPU reads constant value from Flash using MOVC instruction, IFC reads 4bytes constant value from FLASH, then returns 1byte value to CPU and writes fetched 4bytes constant value to the data buffer.

IFC has two flash access modes: Fast clock mode and Slow clock mode. The flash access mode can be selected by FMRMOD register. In Fast clock mode, IFC accesses to flash memory by two cycles. In Slow clock mode, IFC access to flash memory by one cycle. When the frequency of CLKFAST is less than 25MHz, Slow clock mode can be used. When the frequency of CLKFAST is more than 25MHz, Fast clock mode must be used.

IBUF has instruction prefetch mechanism to avoid reducing CPU performance. In Fast clock mode, the prefetch starts when CPU fetches instruction code from address $4n+2$ or $4n+3$ ($n \geq 0$). In Slow clock mode, the prefetch starts when CPU fetches it from address $4n+3$ ($n \geq 0$). If the prefetch is successful, CPU can fetch instructions without prefetch missing penalty. If the prefetch is failed due to JMP instruction, etc, IFC fetches instruction code again from correct address with prefetch missing penalty. CPU waits for finishing instruction re-fetch.

In protect level2,

- (1) The flash cannot be read after CPU fetches the instruction from outside of flash area.
- (2) The flash cannot be read after CPU accesses the data located 0x8000-0xFFFF using MOVC instruction.
- (3) The flash cannot be read for OCD.

12.4.2 Flash programming

12.4.2.1. Mass Erase

The Mass Erase operation erases whole block of the data area. Main block erase mode (FMCTRL.FMCMD[3:0]=b'0111). After setting FMCTRL register, the Mass erase operation starts when setting FMEXE.FMEXE=1. During mass erasing, the FMEXE bit stays 1 to inform busy status, and will be cleared zero when the mass erase is finished. When finished, FMIF flag is set. If FMIE bit is set, interrupt request from FLASH memory is issued. FMIF should be cleared in the interrupt service routine.

The Main block erase mode operation can be executed in protecting level1.

Figure 12-3 shows mass erase operation sequence.

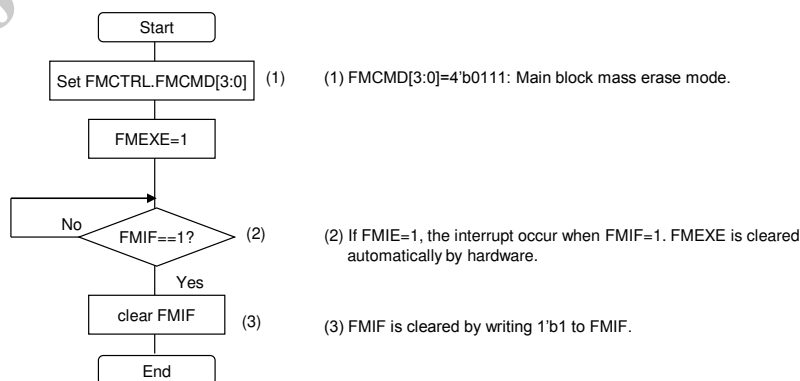


Figure 12-3 Mass erase operation sequence

12.4.2.2. Page Erase

The Page Erase operation erases a page of the main block. The erasing page can be selected by FMPAGE register. Main block page erase mode (FMCTRL.FMCMD[3:0]=b'0110). After setting FMCTRL register, the Page Erase operation starts when setting FMEXE.FMEXE=1. During page erasing, the FMEXE bit stays 1 to inform busy status, and will be cleared zero when the page erase is finished. When finished, FMIF flag is set. If FMIE bit is set, interrupt request from FLASH memory is issued. FMIF should be cleared in the interrupt service routine.

The Main block page erase mode operation can be executed in protecting level1.

Figure 12-4 shows page erase operation sequence.

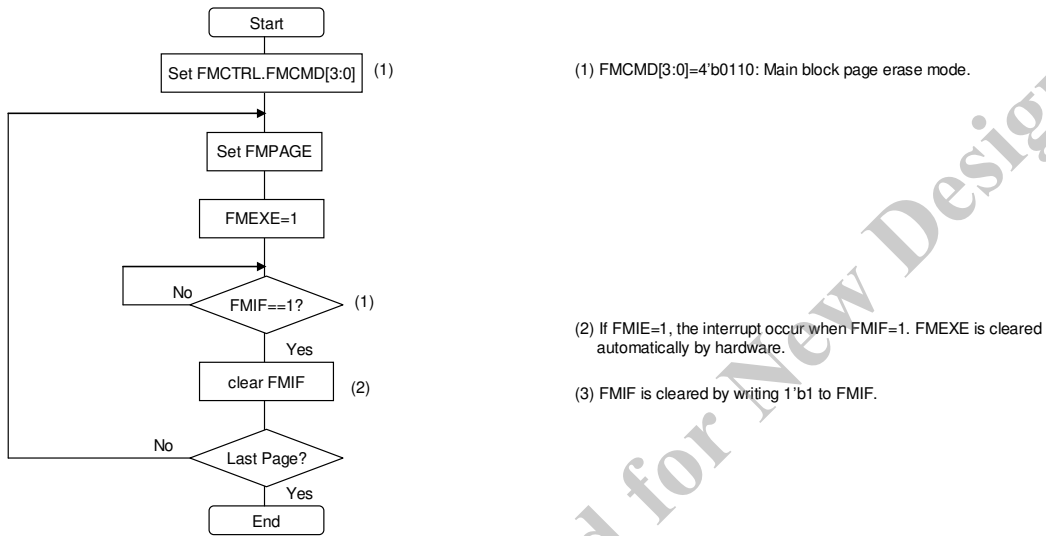


Figure 12-4 Page erase operation sequence

Not Recommended for New Designs

12.4.2.3. Row Programming

The Row Programming operation writes program data to the specified address of Info/Main block area. The Row programming operation has two modes: Info block Row programming mode(FMCTRL.FMCMD[3:0]=b'1001) and Main block Row programming mode(FMCTRL.FMCMD[3:0]=b'0110). At first FMCTRL register should be set to Row programming operation mode. After that, to program FLASH, user should specify Page Address(FMPAGE register), Row Address(FMROW register) and Initial Column Address(FMROW register) in advance. Then the Row programming operation becomes ready to start when setting FMEXE.FMEXE=1. The specified column address programming starts when FMPRD3 is written. The programmed data is the value of FMPRD0 to FMPRD3 when FMPRD3 is just written. During the word is programming, FMEXE bit stays 1 to inform busy status, and will be cleared zero when the word programming is finished or the current column address programming when FMEXE bit is set to b'0 is finished. When it is finished, FMIF flag is set. If FMIE bit is set, interrupt request from FLASH memory is issued. FMIF should be cleared in the interrupt service routine. FMCOL register is incremented by hardware. If user wants to program next column, prepare the next word data in FMPRD0 to FMPRD3 again.

The Info/Main block Row programming mode operation can be executed in protecting level1.

Figure 12-5 shows Page/Mass erase operation sequence.

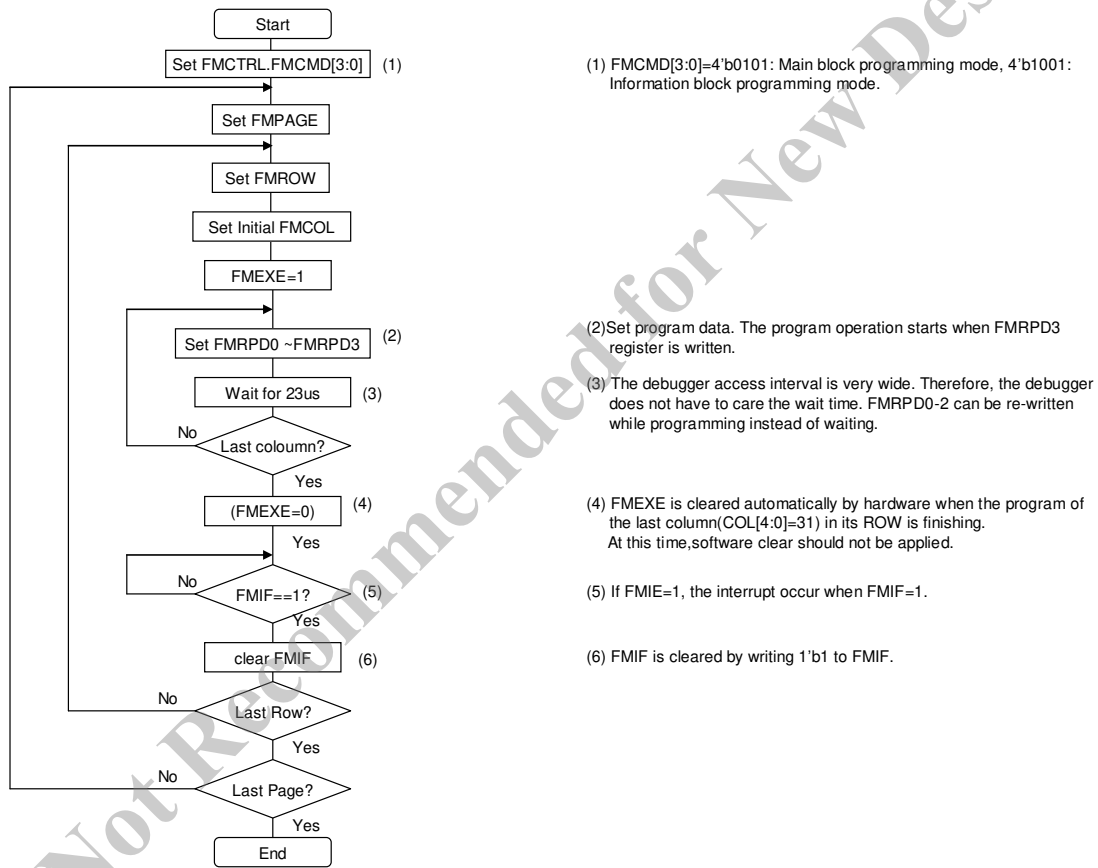


Figure 12-5 Row program operation sequence

12.4.2.4. Row Data Read

The Row Data read operation reads program data from the specified address of Info/Main block area. The Row Data read operation has two modes: Info block Row read mode(FMCTRL.FMCMD[3:0]=b'1000) and Main block Row read mode(FMCTRL.FMCMD[3:0]=b'0100). At first FMCTRL register should be set to Info or Main Row read operation mode. After that, to read FLASH, user should specify Page Address (FMPAGE register), Row Address(FMROW register) and Initial Column Address(FMCOL register) in advance. The specified column address reading starts when setting FMEXE.FMEXE=1 or when FMPRD3 is read. The read data is held FMPRD0 to FMPRD3. During the word is reading, FMEXE bit stays 1 to inform busy status, and will be cleared zero when the word reading is finished or the current column address reading when FMEXE bit is set to b'0 is finished. When it is finished, FMIF flag is set. If FMIE bit is set, interrupt request from FLASH memory is issued. FMIF should be cleared in the interrupt service routine. FMCOL register is incremented by hardware. If user wants to read next lane column, read the next word data in FMPRD0 to FMPRD3 again. In Info block Row read mode, flash page address is always 4'h0, PAGE register is ignored. Moreover, MSB of flash row address is always 'b0, FMROW.ROW[2] is ignored.

The Info block and Main block Row data read mode operation can be executed only in protecting level 1. Figure 12-6 show row read operation sequence.

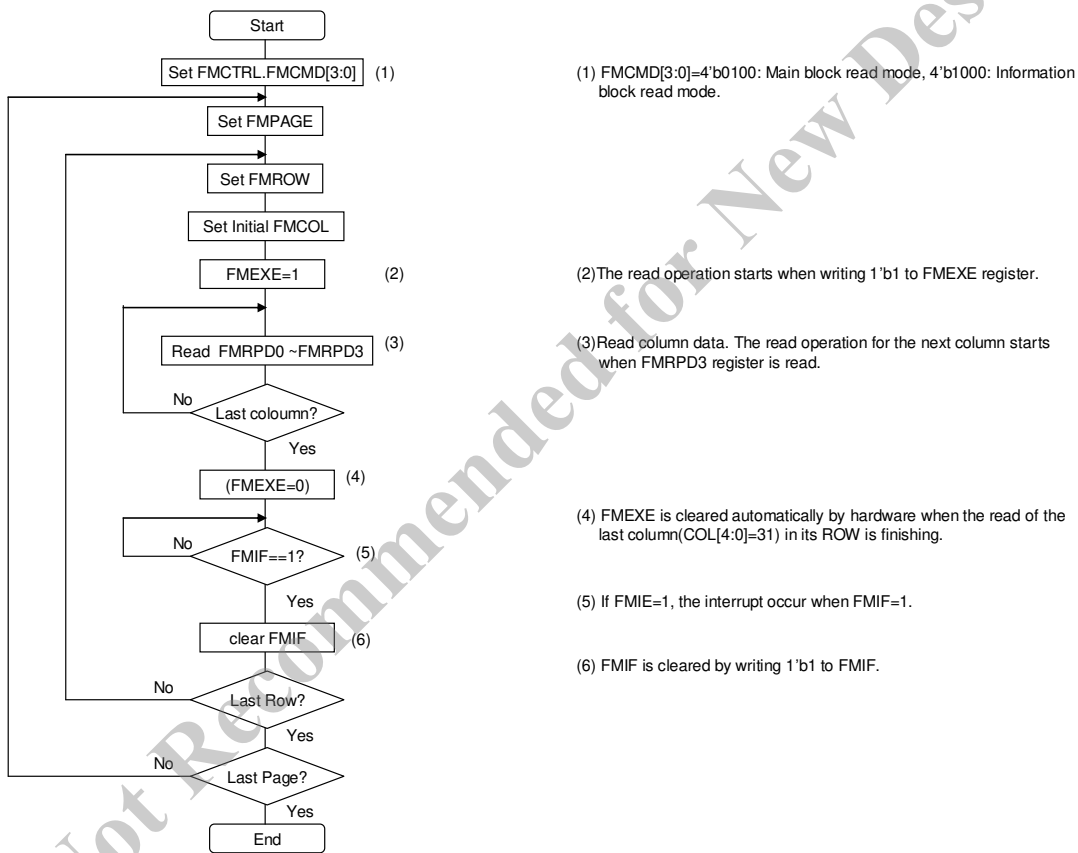


Figure 12-6 Row read operation sequence

12.4.2.5. Protecting Release

The Protecting Release operation re-configures the current protecting level. The Protecting Release operation is selected by FMCTRL.FMCMD[3:0]=b'1111. FMPRD0 to FMPRD3 register are for setting protecting code. The Protecting Release operation starts when FMEXE.FMEXE bit is set to b'1. When the current protecting level is level2, the next protecting level will be level1 if the value of FMPRD0 to FMPRD3 equal to protecting code which flash memory holds.

Figure 12-7 shows protecting release operation sequence.

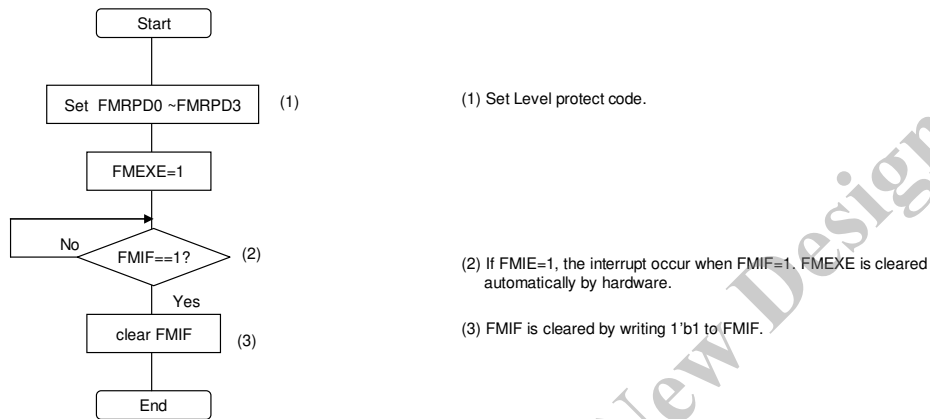


Figure 12-7 Protecting release operation sequence

12.5 Flash protecting level control

The Flash protecting level controller (PLC) manages flash program/erase/read rights to save user program from the attackers. PLC has 2 protecting levels: Level1 or Level2.

- Protect Level 1: Inhibit Erase in Information Block Area.
- Protect Level 2: Available only normal operations for user. Note that OCD can not access to Flash. And User can not access to FLASH after fetching instructions from internal RAM.

Table 12-4 shows the functions which can be executed in each protect level.

Table 12-4 Flash Protect Level

Protect Level		Mass erase (Main)	Info prog.	Info read	Main erase	Main prog.	Main read	Normal Op.
1	After Program	○	○	○	○	○	○	○
	After Mass erase (Main)	○	○	○	○	○	○	○
2	When USER uses	×	×	×	×	×	×	○
	OCD	×	×	×	×	×	×	×
	After Instruction fetch from RAM	×	×	×	×	×	×	×

According to protecting release operation, the user can change protect level. For more details, please see 12.4.2.5.

12.6 Limitation of FLC

12.6.1 Going to low power mode

Note that if the LSI goes to low power mode, ten or more NOP instructions must be added after writing to LPCTRL register.

12.6.2 Clock frequency for flash program

The clock frequency must be less than 25MHz when doing flash program, read and erase operation.

12.6.3 Row programming time

The Row programming time (during FMEXE=1) must be less than 4ms.

12.6.4 Protect function

Protect function is not guaranteed to operate as it is not tested.
Please use Protect function after evaluating by a user.

Not Recommended for New Designs

13. Tiny DSP

13.1 Overview

Tiny DSP is a dedicated processing unit for calculation of digital filter. It is independent of CPU, thus CPU and Tiny DSP can process each operation concurrently. The LSI integrates 2-sets of Tiny DSP and they can simultaneously operate.

Tiny DSP is based on 16bit fixed point calculation. User can configure its program sequence using simple instructions such as Multiply, Division, MAC (Multiply and Accumulate), Barrel-Shift, Move, Jump etc. Each Tiny DSP unit has 16 x 16bit Data Registers to store input / output data, coefficients and temporary data, and also 1x 36bit Accumulator. The Tiny DSP also supports hardware division to improve system performance.

The calculation sequence is initiated and controlled by writing Data Registers by CPU or DSAC. This scheme is fully configurable by user. For example, the DSAC can transfer data to Tiny DSP by some events occurred in the LSI such as End of A/D Conversion, so the Tiny DSP sequence can be triggered by internal hardware, that is fully independent of CPU operation.

When Tiny DSP finishes its sequence, it can generate event trigger, for example, to the DSAC, and the DSAC can transfer result data from Tiny DSP towards High-Resolution PWM as a PWM duty data. Therefore, in this whole scheme, all operation can be done without CPU.

Table 13-1 Feature of Tiny DSP

Item	Description	Note
Unit Count	2 units / LSI	
Operation	16bit Fixed Point	
Program Memory	32 steps/unit	
Data Memory	16 x 16bit Data Register + 1 x 36bit Accumulator	
Instructions	Multiply, Division, MAC, Shift, Move, Jump	
Hardware Divider	Integrated	
Sequence Control	Initiated and Controlled by Internal Events.	
Event Output	Configurable Output at any sequence step.	
Performance	3P2Z IIR: 10cycles	

13.2 Block Diagram

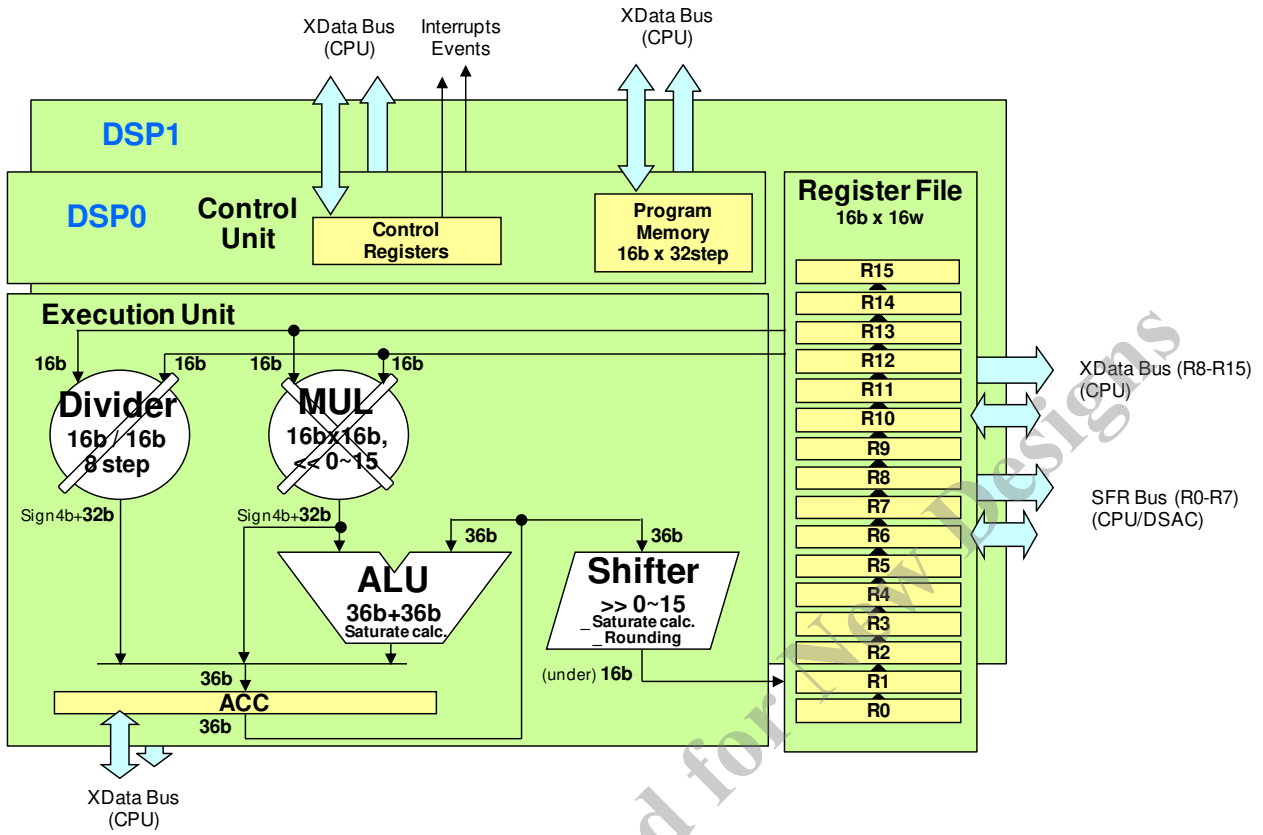


Figure 13-1 Block Diagram of Tiny DSP

Not Recommended for New Designs

13.3 Resources

(1) R0-R15 (Register File)

Each unit has register file which contains 16 x 16bit general registers Rn. The Rn can be used as coefficient storage or internal memory (delay element for digital filter). R0-R7 can be accessed via SFR bus (CPU or DSAC), whereas R8-R15 can be accessed via CPU data bus. DSAC can reach to only R0-R7, so it is recommended that input value from A/D or output value to PWM duty should be assigned in R0-R7 to enable DSAC transfer.

The Register File is connected to input ports of MUL or DIV. Also, Register File receives data from ACC through Shifter.

(2) ACC (Accumulator)

Each unit has 1 x 36bit accumulator register (ACC) to store internal calculation results. The ACC receives calculation results from ALU, MUL, or DIV. The ACC can be accessed from CPU data bus. In the calculation in ACC, overflowed result will be saturated to positive maximum value or negative minimum value.

(3) MUL (Multiplier)

Each unit has 1 multiplier which can basically execute 16bit x 16bit \rightarrow 32bit. The MUL receives data from R0-R15, and it outputs result to ALU or ACC.

(4) ALU (Arithmetic and Logical Unit)

Each unit has 1 arithmetic and logical unit ALU which can basically execute addition 36bit + 36bit \rightarrow 36bit.

(5) Shifter (SFT)

Each unit has 1 shifter which has only right shift capability. The SFT receives 36bit data from ACC, and clips 16bits from the input, and output the 16bits to R0-R15. In the clipping operation (right shift), overflow might happen. In the case, saturated result will be generated. Also in the clipping (right shift), the result (LSB) is rounded to nearest.

(6) Divider (DIV)

Each unit has 1 divider which can process $R_n(16\text{bit-precision}) / R_m(16\text{bit-precision}) \rightarrow 16\text{bit-precision} * (1 / 16\text{bit-precision}) \rightarrow 16\text{bit-precision} * 16\text{bit-precision} \rightarrow \text{Acc}(32\text{bit-precision})$. The algorithm is based on Newton-Raphson Method in which inverse number of Rm is derived first and Rn is multiplied to make final result. Internally, there is no dedicated hardware for DIV which means the DIV operation is actually processed by using internal other resources described above such as MUL, ALU, ACC, etc.

(7) Program Memory

To configure processing sequence in Tiny DSP, each unit has small program memory whose size is 16bits x 32words. Each instruction length is 16bits. This program memory stores only 32step instructions at most.

13.4 Instructions

Instructions for DSP are shown in Table13-3. User should configure program memory by storing these instructions in advance. Note that all instructions have capability for Trigger Wait and Event Output.

13.4.1 Instruction Format

DSP Instruction constitutes it as following field.

- (1) TRIG-WAIT
This TRIG-WAIT field is used for waiting the trigger. Set"1": Trigger wait, "0": No trigger wait.
- (2) TRIG-WHAT
Trigger selection field which selection selects the DSP register R0-R7 of the trigger sources shown below.

Table 13-2 TRIG-WHAT bit

Register	Bit14	Bit13	Bit12
R0	0	0	0
R1	0	0	1
R2	0	1	0
R3	0	1	1
R4	1	0	0
R5	1	0	1
R6	1	1	0
R7	1	1	1

- (3) EVENT
The Event output is controlled by setting "1" in this EVENT field. If Event field is "0", No Event output.
- (4) OPCODE
This field shows DSP OPCODE which are eight codes. Detail description is shown at 13.4.2.
- (5) FIELD A/B
These two fields are operated fields for Instruction Rn,Rm : R0~R15, #n : The number of the shift bits.

Table 13-3 Instructions

Instruction Format							Instruction	Operation	Exec Cycle	
MSB(bit15)				LSB(bit0)						
TRIG_WAIT	TRIG_WHAT	EVE_NT	OPCODE			FIELD A	FIELD B			
T	WHAT	E	0	0	0	don't care	don't care	0x0 NOP	No Operation	1
T	WHAT	E	0	0	1	next PC		0x1 JMP	Jump	1
T	WHAT	E	0	1	0	Rm	Rn	0x2 MUL	ACC←Rn x Rm	1
T	WHAT	E	0	1	1	Rm	Rn	0x3 MAC	ACC←ACC + Rn x Rm	1
T	WHAT	E	1	0	0	Rm	Rn	0x4 DIV	ACC←Rn / Rm	8
T	WHAT	E	1	0	1	Rm	#n	0x5 LSF	ACC←Rm << #n	1
T	WHAT	E	1	1	0	Rm	#n	0x6 RSF	Rm←ACC >> #n	1
T	WHAT	E	1	1	1	Rm	Rn	0x7 MVC	Chain Move (delay element) Rm←Rm-1←...←Rn+1←Rn Initial Rm is destroyed. Rn is kept same value	1

13.4.2 Instruction Set

- (1) **0x0 NOP**
No operation. Only PC is incremented.
- (2) **0x1 JMP**
Jump to specified PC position (5bit).
- (3) **0x2 MUL**
Rn(16bit) and Rm(16bit) are multiplied and the result is stored in lower 32bits of ACC. Higher 4bits of ACC will be same as signed bit of the multiplied result.
- (4) **0x3 MAC**
Rn(16bit) and Rm(16bit) are multiplied and the 36bit result (32bit with 4-bit sign extended) is accumulated onto ACC as 36bit value. In the accumulation (addition), overflow towards positive will be saturated to 0x7_FFFF_FFFF and overflow towards negative will be saturated to 0x8_0000_0000.
- (5) **0x4 DIV**
First of all, the instruction derives inverse number of Rm(16bit) and internally generate the result as 16bit precision value. Finally, the result(16bit precision) is multiplied by Rn(16bit) and generate 32bit precision value in ACC. Higher 4bits of ACC will be sign extended field.
Regarding decimal point, it resides only in programmer's thought. If its position of source value Rm is supposed between bit 0 and bit -1 (this means the Rm is integer value), decimal point of inverse number of Rm (1/Rm) is located between bit 15 (sign bit) and bit14. And if decimal point of Rn is also located between bit0 and bit -1 (it is integer), final result in ACC has decimal point located between bit15 and bit14. User can take any 16bit field in ACC and store it in Register File by using RSF instruction.
Only the DIV is multi-cycle instruction.
- (6) **0x5 LSF**
Rm is shifted left by n-bits and the value is stored to ACC. The left shifting is implemented by using multiplier (MUL) in the data path. Higher ACC field will be buried by sign extended value. Lower ACC field will be buried by zero.
- (7) **0x6 RSF**
ACC (36bit) is shifted right by n-bits and the value is stored to Register File Rm. This means that RSF instruction receives 36bit data from ACC, and clips 16bits from the input, and output the 16bits to Rm. In the clipping operation (right shift), overflow might happen. In the case, saturated result will be generated. Also in the clipping (right shift), the result (LSB) is rounded to nearest.
- (8) **0x7 MVC**
The MVC moves data in Register File like as chain-manner to implement delay element for digital filter. Targets of chain move are contiguous numbered register file. According to instruction field (m and n), Rm receives data from Rm-1, and Rm-1 receives from Rm-2, and so on. Also Rn+2 receives data from Rn+1, and Rn+1 receives from Rn. Initial value of Rm will be destroyed. And data in Rn will be kept.
If user specifies $m \leq n$, this instruction will operate as same as NOP.

13.5 Operation

- (1) In advance, user should configure the Tiny DSP as follows
 - Set program sequence in Program Memory.
 - Set initial value of R0-R15. (Coefficients or Delay Elements)
- (2) Enable the DSP by setting DSPE bit in DSPxCTRL register. Initial value of Program Counter (PC) of instruction sequence can be set by user in advance, but usually program sequence starts from PC=0x0.
- (3) DSP instruction sequence starts. But, if TRIG_WAIT flag in instruction is set, the instruction stops before its execution, and waits for a trigger. The trigger occurs when an Rn (selected from R0-R7 specified by TRIG_WHAT field in the instruction) is updated (written a value). Once the trigger is detected, the instruction executes its operation, and then goes to next PC address.
- (4) The triggers for resuming instruction are shown in the description of DSPxTRG register (refer to 13.9). For example, suppose that an instruction is waiting for updating R3 by CPU or DSAC, which means TRIG_WAIT=1 and TRIG_WHAT=3 in the instruction field as shown in Table 13-2.
- (5) If SET_R3 bit in DSPxTRG register is zero(case1), the instruction is suspended before its execution, and once CPU or DSAC write a new value to R3, SET_R3 bit is automatically set, and the instruction resumes its execution. At this time, SET_R3 bit is automatically cleared. If SET R3 bit was set when CPU or DSAC updated R3 value before the instruction (Case2), the instruction resumes its execution at once and SET_R3 bit is cleared. Note that CPU does not need to access DSPxTRG register during DSP operation, but for debugging capability or for re-initialization, this register can be accessed by CPU (Read or Write forcibly).

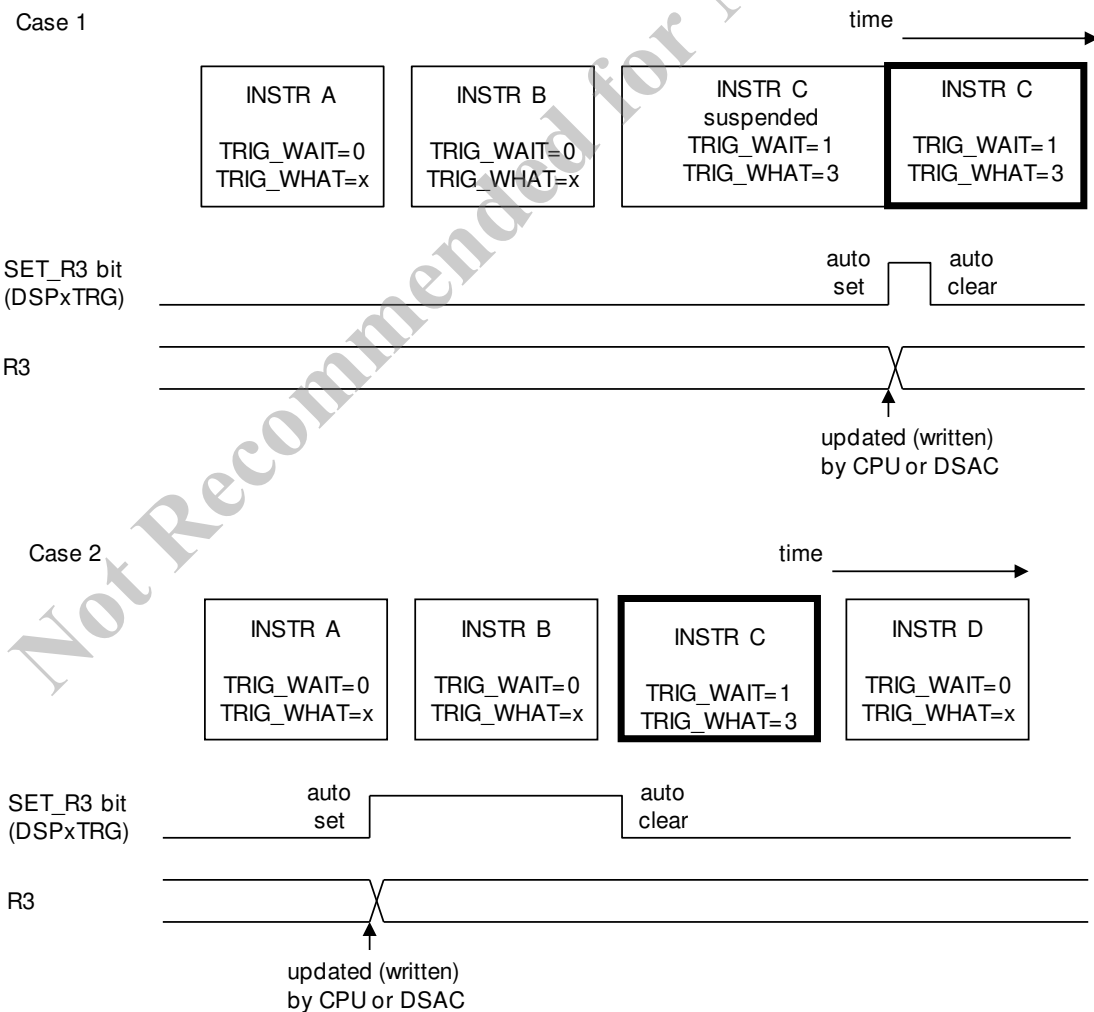


Figure 13-2 Trigger Operation of Instruction Sequence

- (6) During DSP instruction sequence, its PC reaches last address (0x1F), the PC rewinds to 0x0 and DSP continues instruction sequence.
- (7) An instruction with EVENT flag =1 is finished its operation, DSP interrupt flag (DSPIF bit in DSPxCTRL register) is set to 1. Also internal event pulse is generated toward other modules. If DSPIE bit in DSPxCTRL register is set, interrupt signal is asserted towards INTC (Interrupt Controller).
- (8) If Saturation is occurred during instruction operation, DSP_SA (for ALU) or DSP_SS (for Shifter) in DSPxCTRL register are set to 1 and inform CPU to such situation. Only the “Occurrence” is informed. Each flag can be cleared by CPU.
- (9) If DSP_DBG bit in DSPxDBG register is set, the DSP unit enters in debug mode. In debug mode, DSP executes program sequence only step by step. The initiation for step execution is done only by setting DSP_STP bit. Note that if DSP_DBG and DSP_STP are set at same time, step execution is not processed. The step execution is done by setting DSP_STP during DSP_DBG=1. Even if the TRIG_WAIT flag in instruction has been set, this step operation forces to execute the instruction. If PC designates last address, the step operation rewinds PC to 0 and repeat from first address.
- (10) Regarding Register or Storage resources which can be accessed by both CPU/DSAC and DSP itself, if CPU/DSAC and DSP access same resource at same time (access contention), CPU/DSAC has higher priority than DSP. In the case, DSP internally stalls its operation.

DSP Registers belong to the Register File are assigned in SFR area(R0-R7) and XBUS area(R8-R15), and their data width are 16bit. However, pair of Low Side (LSB Side) register and High Side (MSB Side) register for 16bit value are assigned on SAME address. In order to take the 16bit-write access, 1st writing on the address reaches to Temporary Register for Low Side and 2nd writing reaches to High Side. At this 2nd access, Temporary and High Side data are transferred to both Low Side and High Side registers. In read access, 1st access gets Low Side data to the bus and High Side data reaches to temporary register, and then 2nd read access receives High Side data from temporary register. The LSB/MSB Side is selected by CPU/DSAC access counter. When CPU reads from R0-15, CPU counter is incremented. If DSPnRST.CPUACCLA bit is set to 1'b1, Both the CPU SFR BUS access counter and the CPU XBUS access counter are cleared. After that, the LSB Side can be read by CPU. When DSAC reads from ADL/H register, DSAC counter is incremented. If DSPnRST.DSACACCLA bit is set to 1'b1, the DSAC access counter is cleared. After that, the LSB Side can be read by DSAC.

Regarding the rest of register of each peripheral assigned in XBUS area(DSPPRG*), each Low Side (LSB Side) register and High Side (MSB Side) register for 16bit value is assigned independent contiguous address. The Low Side is on lower address, the High Side is on higher address, which follows Little-Endian manner.

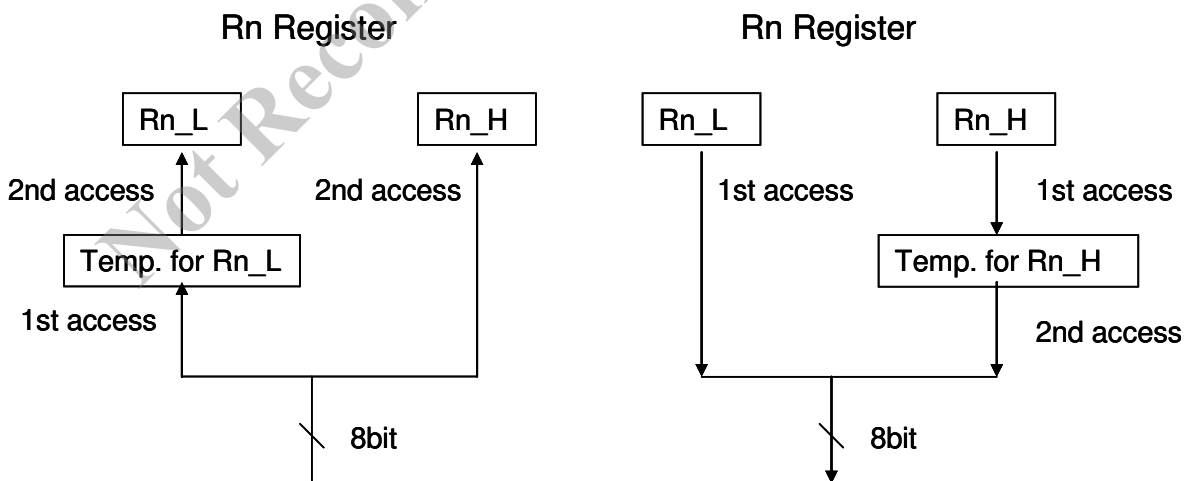


Figure 13-3 Rn Register Access

13.6 Event Outputs

Each TinyDSP can issue 2-event outputs (event0, event1) towards DSAC.

- TinyDSP0 Event 0
- TinyDSP0 Event 1
- TinyDSP1 Event 0
- TinyDSP1 Event 1

The event output can be controlled by E-field in each instruction code. Following shows how to select from event0 or event1.

```
If E==1 and WHAT != 7, then output Event0.
If E==1 and WHAT == 7, then output Event1.
```

[Note]

- (1) If T==1 in addition to above, still the DSP will wait for writing to R7.
- (2) If T==1 and E==1, the instruction will wait for register writing, and after its restart, event output should be output.
- (3) If TinyDSPx outputs event0 or event1, the DSPIF (interrupt) flag in DSPxCTRL register is set.

13.7 Program Memory

Program memory has only 32step storage size as shown in Figure 13-4.

	MSB (bit15)	LSB (bit 0)
Address (PC) (DSPx_PRG_ADDR)	Program Memory to store Instructions (16bit width) (assigned as register located in CPU data area)	
0x0~1F	DSPx_PRG_H	DSPx_PRG_L

Figure 13-4 Program Memory

13.8 Example of Application

Implementation of typical digital filter application is shown in Figure 13-5.

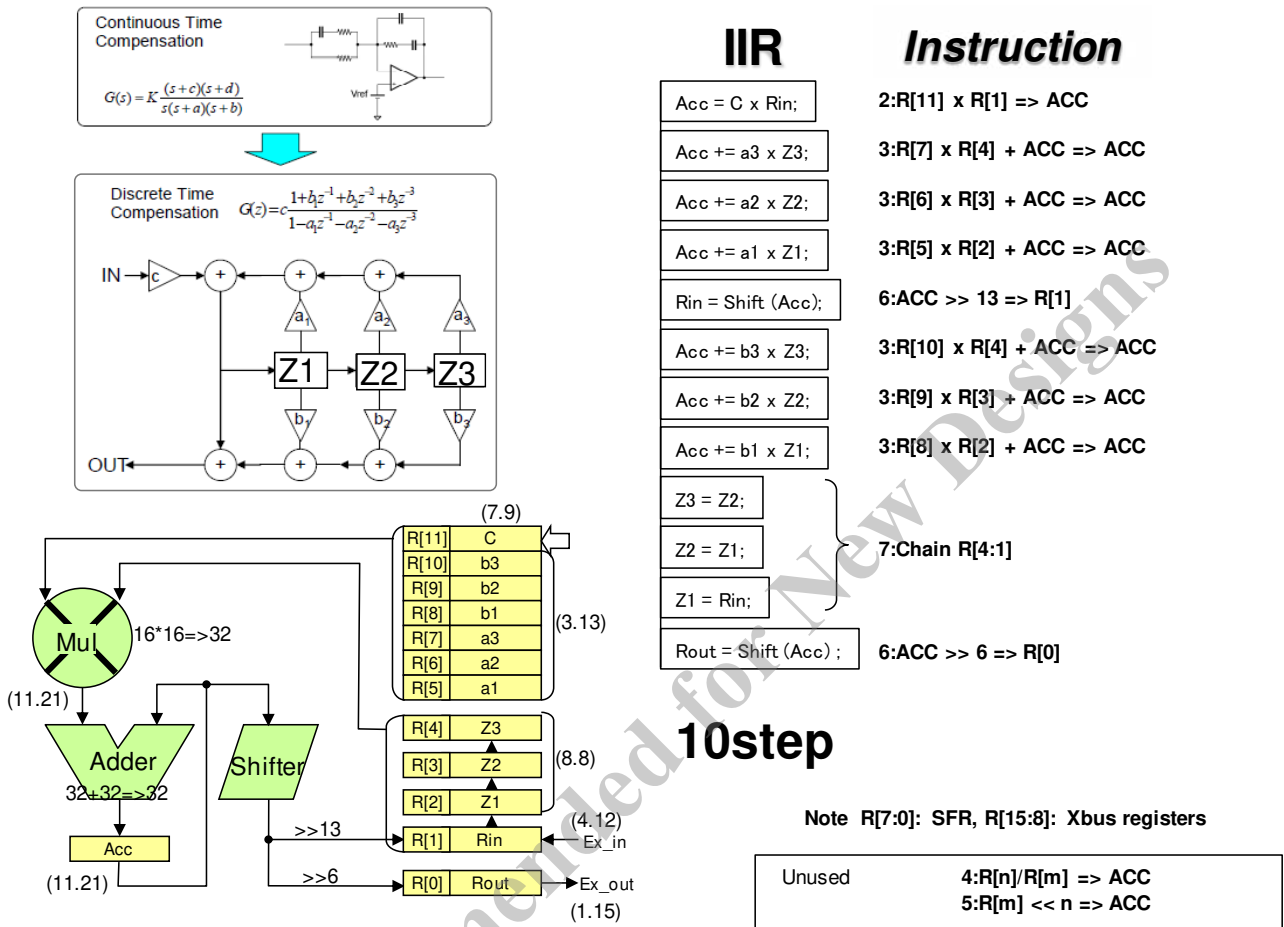


Figure 13-5 Example Application

13.9 Register Description

Table 13-4 List of Registers

Symbol	Name	Address	Initial value
DSP0CTRL	DSP0 Control Register	0xF780	0x00
DSP0EXEC	DSP0 Execution Register	0xF781	0x00
DSP0TRG	DSP0 Execution Trigger Status	0xF782	0x00
DSP0RST	DSP0 Access Counter Clear Register	0xF783	0x00
DSP0DBG	DSP0 Debug Register	0xF784	0x00
DSP0_R0_L	DSP0 R0 LSB Side	0xC4	0x00
DSP0_R0_H	DSP0 R0 MSB Side	0xC4	0x00
DSP0_R1_L	DSP0 R1 LSB Side	0xC5	0x00
DSP0_R1_H	DSP0 R1 MSB Side	0xC5	0x00
DSP0_R2_L	DSP0 R2 LSB Side	0xC6	0x00
DSP0_R2_H	DSP0 R2 MSB Side	0xC6	0x00
DSP0_R3_L	DSP0 R3 LSB Side	0xC7	0x00
DSP0_R3_H	DSP0 R3 MSB Side	0xC7	0x00
DSP0_R4_L	DSP0 R4 LSB Side	0xCC	0x00
DSP0_R4_H	DSP0 R4 MSB Side	0xCC	0x00
DSP0_R5_L	DSP0 R5 LSB Side	0xCD	0x00
DSP0_R5_H	DSP0 R5 MSB Side	0xCD	0x00
DSP0_R6_L	DSP0 R6 LSB Side	0xCE	0x00
DSP0_R6_H	DSP0 R6 MSB Side	0xCE	0x00
DSP0_R7_L	DSP0 R7 LSB Side	0xCF	0x00
DSP0_R7_H	DSP0 R7 MSB Side	0xCF	0x00
DSP0_R8_L	DSP0 R8 LSB Side	0xF788	0x00
DSP0_R8_H	DSP0 R8 MSB Side	0xF788	0x00
DSP0_R9_L	DSP0 R9 LSB Side	0xF789	0x00
DSP0_R9_H	DSP0 R9 MSB Side	0xF789	0x00
DSP0_R10_L	DSP0 R10 LSB Side	0xF78A	0x00
DSP0_R10_H	DSP0 R10 MSB Side	0xF78A	0x00
DSP0_R11_L	DSP0 R11 LSB Side	0xF78B	0x00
DSP0_R11_H	DSP0 R11 MSB Side	0xF78B	0x00
DSP0_R12_L	DSP0 R12 LSB Side	0xF78C	0x00
DSP0_R12_H	DSP0 R12 MSB Side	0xF78C	0x00
DSP0_R13_L	DSP0 R13 LSB Side	0xF78D	0x00
DSP0_R13_H	DSP0 R13 MSB Side	0xF78D	0x00
DSP0_R14_L	DSP0 R14 LSB Side	0xF78E	0x00

Symbol	Name	Address	Initial value
DSP0_R14_H	DSP0 R14 MSB Side	0xF78E	0x00
DSP0_R15_L	DSP0 R15 LSB Side	0xF78F	0x00
DSP0_R15_H	DSP0 R15 MSB Side	0xF78F	0x00
DSP0_ACC_0	DSP0 ACC[7:0]	0xF790	0x00
DSP0_ACC_1	DSP0 ACC[15:8]	0xF791	0x00
DSP0_ACC_2	DSP0 ACC[23:15]	0xF792	0x00
DSP0_ACC_3	DSP0 ACC[31:24]	0xF793	0x00
DSP0_ACC_4	DSP0 ACC[36:32]	0xF794	0x00
DSP0_PRG_DATL	DSP0 Program Memory LSB Side	0xF7A0	0x00
DSP0_PRG_DATH	DSP0 Program Memory MSB Side	0xF7A1	0x00
DSP0_PRG_ADR	DSP0 Program Memory Address	0xF7A2	0x00
DSP1CTRL	DSP1 Control Register	0xF800	0x00
DSP1EXEC	DSP1 Execution Register	0xF801	0x00
DSP1TRG	DSP1 Execution Trigger Status	0xF802	0x00
DSP1RST	DSP1 Access Counter Clear Register	0xF803	0x00
DSP1DBG	DSP1 Debug Register	0xF804	0x00
DSP1_R0_L	DSP1 R0 LSB Side	0xD4	0x00
DSP1_R0_H	DSP1 R0 MSB Side	0xD4	0x00
DSP1_R1_L	DSP1 R1 LSB Side	0xD5	0x00
DSP1_R1_H	DSP1 R1 MSB Side	0xD5	0x00
DSP1_R2_L	DSP1 R2 LSB Side	0xD6	0x00
DSP1_R2_H	DSP1 R2 MSB Side	0xD6	0x00
DSP1_R3_L	DSP1 R3 LSB Side	0xD7	0x00
DSP1_R3_H	DSP1 R3 MSB Side	0xD7	0x00
DSP1_R4_L	DSP1 R4 LSB Side	0xDC	0x00
DSP1_R4_H	DSP1 R4 MSB Side	0xDC	0x00
DSP1_R5_L	DSP1 R5 LSB Side	0xDD	0x00
DSP1_R5_H	DSP1 R5 MSB Side	0xDD	0x00
DSP1_R6_L	DSP1 R6 LSB Side	0xDE	0x00
DSP1_R6_H	DSP1 R6 MSB Side	0xDE	0x00
DSP1_R7_L	DSP1 R7 LSB Side	0xDF	0x00
DSP1_R7_H	DSP1 R7 MSB Side	0xDF	0x00
DSP1_R8_L	DSP1 R8 LSB Side	0xF808	0x00
DSP1_R8_H	DSP1 R8 MSB Side	0xF808	0x00
DSP1_R9_L	DSP1 R9 LSB Side	0xF809	0x00
DSP1_R9_H	DSP1 R9 MSB Side	0xF809	0x00
DSP1_R10_L	DSP1 R10 LSB Side	0xF80A	0x00
DSP1_R10_H	DSP1 R10 MSB Side	0xF80A	0x00

Symbol	Name	Address	Initial value
DSP1_R11_L	DSP1 R11 LSB Side	0xF80B	0x00
DSP1_R11_H	DSP1 R11 MSB Side	0xF80B	0x00
DSP1_R12_L	DSP1 R12 LSB Side	0xF80C	0x00
DSP1_R12_H	DSP1 R12 MSB Side	0xF80C	0x00
DSP1_R13_L	DSP1 R13 LSB Side	0xF80D	0x00
DSP1_R13_H	DSP1 R13 MSB Side	0xF80D	0x00
DSP1_R14_L	DSP1 R14 LSB Side	0xF80E	0x00
DSP1_R14_H	DSP1 R14 MSB Side	0xF80E	0x00
DSP1_R15_L	DSP1 R15 LSB Side	0xF80F	0x00
DSP1_R15_H	DSP1 R15 MSB Side	0xF80F	0x00
DSP1_ACC_0	DSP1 ACC[7:0]	0xF810	0x00
DSP1_ACC_1	DSP1 ACC[15:8]	0xF811	0x00
DSP1_ACC_2	DSP1 ACC[23:15]	0xF812	0x00
DSP1_ACC_3	DSP1 ACC[31:24]	0xF813	0x00
DSP1_ACC_4	DSP1 ACC[36:32]	0xF814	0x00
DSP1_PRG_DATL	DSP1 Program Memory LSB Side	0xF820	0x00
DSP1_PRG_DATH	DSP1 Program Memory MSB Side	0xF821	0x00
DSP1_PRG_ADR	DSP1 Program Memory Address	0xF822	0x00

Not Recommended for New Designs

13.9.1 DSPn Control Register (DSPnCTRL) (n=0-1)

Register		DSP0CTRL	DSP0 Control Register		Address	0xF780
		DSP1CTRL	DSP1 Control Register			0xF800
Bit	Bit Name	R/W	Initial	Description	Note	
7	DSPE	R/W	0	Enable DSP 0: Disable DSP 1: Enable DSP Even if DSP is disabled, all registers can be accessed, but start condition (event trigger etc.) for DSP sequence is ignored. Enabled DSP waits for initiation trigger (writing Rn)		
6	DSPIE	R/W	0	Enable DSP Interrupt 0: Disable DSP Interrupt 1: Enable DSP Interrupt		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	reserved	R	0	Read value is 0. Write only 0.		
2	DSP_SS	R/C	0	Saturation Detected in Shifter Read 0: Not detected Read 1: Detected Write 0: No effect Write 1: Clear this flag		
1	DSP_SA	R/C	0	Saturation Detected in ALU Read 0: Not detected Read 1: Detected Write 0: No effect Write 1: Clear this flag		
0	DSPIF	R/C	0	DSP Interrupt Flag (Event Output) Read 0: No request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: Clear this flag If event condition is met, event output pulse is generated even if DSPIE=0.	Before mask: independent from DSPIE bit	

13.9.2 DSPn Execution Register (DSPnEXEC) (n=0-1)

Register		DSP0EXEC	DSP0 Execution Register		Address	0xF781
		DSP1EXEC	DSP1 Execution Register			0xF801
Bit	Bit Name	R/W	Initial	Description	Note	
7	reserved	R	0	Read value is 0. Write only 0.		
6	reserved	R	0	Read value is 0. Write only 0.		
5	reserved	R	0	Read value is 0. Write only 0.		
4	DSP_PC4	R/W	0	DSP Program Counter PC (5bit) PC designates instruction position to be executed next. CPU can forcibly change the PC by writing PC anytime.		
3	DSP_PC3	R/W	0			
2	DSP_PC2	R/W	0			
1	DSP_PC1	R/W	0			
0	DSP_PC0	R/W	0			

13.9.3 DSPn Debug Register (DSPnDBG)

Register		DSP0DBG	DSP0 Debug Register		Address	0xF784
		DSP1DBG	DSP1 Debug Register			0xF804
Bit	Bit Name	R/W	Initial	Description	Note	
7	DSP_DBG	R/W	0	Debug Mode 0: Normal Mode 1: Debug Mode In debug mode, DSP executes program sequence only step by step. The initiation for step execution is done only by setting DSP_STP bit.		
6	DSP_STP	R/S	0	Stop Execution Read value is always 0. Write 0: No effect Write 1: If DSP_DBG=1, execute program sequence in step by step. Note that if DSP_DGB and DSP_STP are set at same time, step execution is not processed. The step execution is done by setting DSP_STP during DSP_DBG=1. Even if the TRIG_WAIT flag in instruction has been set, this step operation forces to execute its instruction. If PC designates last address, this step operation rewinds PC to 0 and repeat from first address.		
5-0	reserved	R	0	Read value is 0. Write only 0.		

13.9.4 DSPn Rx LSB Side (DSPn_Rx_L) (n=0-1, x=0-7)

Register	DSP0_R0_L	DSP0 R0 LSB Side	Address	0xC4	
	DSP0_R1_L	DSP0 R1 LSB Side	Address	0xC5	
	DSP0_R2_L	DSP0 R2 LSB Side	Address	0xC6	
	DSP0_R3_L	DSP0 R3 LSB Side	Address	0xC7	
	DSP0_R4_L	DSP0 R4 LSB Side	Address	0xCC	
	DSP0_R5_L	DSP0 R5 LSB Side	Address	0xCD	
	DSP0_R6_L	DSP0 R6 LSB Side	Address	0xCE	
	DSP0_R7_L	DSP0 R7 LSB Side	Address	0xCF	
	DSP1_R0_L	DSP1 R0 LSB Side	Address	0xD4	
	DSP1_R1_L	DSP1 R1 LSB Side	Address	0xD5	
	DSP1_R2_L	DSP1 R2 LSB Side	Address	0xD6	
	DSP1_R3_L	DSP1 R3 LSB Side	Address	0xD7	
	DSP1_R4_L	DSP1 R4 LSB Side	Address	0xDC	
	DSP1_R5_L	DSP1 R5 LSB Side	Address	0xDD	
	DSP1_R6_L	DSP1 R6 LSB Side	Address	0xDE	
DSP1_R7_L	DSP1 R7 LSB Side	Address	0xDF		
Bit	Bit Name	R/W	Initial	Description	Note
7	DSP_REG7	R/W	0	DSP Register File Low Side Data Each R0-R7 is assigned in SFR area. This register can access Low Side data of each Rn (1 st access).	
6	DSP_REG6	R/W	0		
5	DSP_REG5	R/W	0		
4	DSP_REG4	R/W	0		
3	DSP_REG3	R/W	0		
2	DSP_REG2	R/W	0		
1	DSP_REG1	R/W	0		
0	DSP_REG0	R/W	0		

13.9.5 DSPn Rx MSB Side (DSPn_Rx_H) (n=0-1,x=0-7)

Register	DSP0_R0_H	DSP0 R0 MSB Side	Address	0xC4	
Register	DSP0_R1_H	DSP0 R1 MSB Side	Address	0xC5	
Register	DSP0_R2_H	DSP0 R2 MSB Side	Address	0xC6	
Register	DSP0_R3_H	DSP0 R3 MSB Side	Address	0xC7	
Register	DSP0_R4_H	DSP0 R4 MSB Side	Address	0xCC	
Register	DSP0_R5_H	DSP0 R5 MSB Side	Address	0xCD	
Register	DSP0_R6_H	DSP0 R6 MSB Side	Address	0xCE	
Register	DSP0_R7_H	DSP0 R7 MSB Side	Address	0xCF	
Register	DSP1_R0_H	DSP1 R0 MSB Side	Address	0xD4	
Register	DSP1_R1_H	DSP1 R1 MSB Side	Address	0xD5	
Register	DSP1_R2_H	DSP1 R2 MSB Side	Address	0xD6	
Register	DSP1_R3_H	DSP1 R3 MSB Side	Address	0xD7	
Register	DSP1_R4_H	DSP1 R4 MSB Side	Address	0xDC	
Register	DSP1_R5_H	DSP1 R5 MSB Side	Address	0xDD	
Register	DSP1_R6_H	DSP1 R6 MSB Side	Address	0xDE	
Register	DSP1_R7_H	DSP1 R7 MSB Side	Address	0xDF	
Bit	Bit Name	R/W	Initial	Description	Note
7	DSP_REG7	R/W	0	DSP Register File High Side Data Each R0-R7 is assigned in SFR area. This register can access High Side data of each Rn (2 nd access).	
6	DSP_REG6	R/W	0		
5	DSP_REG5	R/W	0		
4	DSP_REG4	R/W	0		
3	DSP_REG3	R/W	0		
2	DSP_REG2	R/W	0		
1	DSP_REG1	R/W	0		
0	DSP_REG0	R/W	0		

13.9.6 DSPn Rx LSB Side (DSPn_Rx_L) (n=0-1,x=8-15)

Register	DSP0_R8_L	DSP0 R8 LSB Side	Address	0xF788	
	DSP0_R9_L	DSP0 R9 LSB Side	Address	0xF789	
	DSP0_R10_L	DSP0 R10 LSB Side	Address	0xF78A	
	DSP0_R11_L	DSP0 R11 LSB Side	Address	0xF78B	
	DSP0_R12_L	DSP0 R12 LSB Side	Address	0xF78C	
	DSP0_R13_L	DSP0 R13 LSB Side	Address	0xF78D	
	DSP0_R14_L	DSP0 R14 LSB Side	Address	0xF78E	
	DSP0_R15_L	DSP0 R15 LSB Side	Address	0xF78F	
	DSP1_R8_L	DSP1 R8 LSB Side	Address	0xF808	
	DSP1_R9_L	DSP1 R9 LSB Side	Address	0xF809	
	DSP1_R10_L	DSP1 R10 LSB Side	Address	0xF80A	
	DSP1_R11_L	DSP1 R11 LSB Side	Address	0xF80B	
	DSP1_R12_L	DSP1 R12 LSB Side	Address	0xF80C	
	DSP1_R13_L	DSP1 R13 LSB Side	Address	0xF80D	
	DSP1_R14_L	DSP1 R14 LSB Side	Address	0xF80E	
	DSP1_R15_L	DSP1 R15 LSB Side	Address	0xF80F	
Bit	Bit Name	R/W	Initial	Description	Note
7	DSP_REG7	R/W	0	DSP Register File Low Side Data	Each R8-R15 is assigned in XBUS area. This register can access Low Side data of each Rn (1 st access).
6	DSP_REG6	R/W	0		
5	DSP_REG5	R/W	0		
4	DSP_REG4	R/W	0		
3	DSP_REG3	R/W	0		
2	DSP_REG2	R/W	0		
1	DSP_REG1	R/W	0		
0	DSP_REG0	R/W	0		

13.9.7 DSPn Rx MSB Side (DSPn_Rx_H) (n=0-1,x=8-15)

Register	DSP0_R8_H	DSP0 R8 MSB Side	Address	0xF788
	DSP0_R9_H	DSP0 R9 MSB Side	Address	0xF789
	DSP0_R10_H	DSP0 R10 MSB Side	Address	0xF78A
	DSP0_R11_H	DSP0 R11 MSB Side	Address	0xF78B
	DSP0_R12_H	DSP0 R12 MSB Side	Address	0xF78C
	DSP0_R13_H	DSP0 R13 MSB Side	Address	0xF78D
	DSP0_R14_H	DSP0 R14 MSB Side	Address	0xF78E
	DSP0_R15_H	DSP0 R15 MSB Side	Address	0xF78F
	DSP1_R8_H	DSP1 R8 MSB Side	Address	0xF808
	DSP1_R9_H	DSP1 R9 MSB Side	Address	0xF809

	DSP1_R10_H		DSP1 R10 MSB Side	Address	0xF80A
	DSP1_R11_H		DSP1 R11 MSB Side	Address	0xF80B
	DSP1_R12_H		DSP1 R12 MSB Side	Address	0xF80C
	DSP1_R13_H		DSP1 R13 MSB Side	Address	0xF80D
	DSP1_R14_H		DSP1 R14 MSB Side	Address	0xF80E
	DSP1_R15_H		DSP1 R15 MSB Side	Address	0xF80F
Bit	Bit Name	R/W	Initial	Description	Note
7	DSP_REG7	R/W	0	DSP Register File High Side Data Each R8-R15 is assigned in XBUS area. This register can access High Side data of each Rn (2 nd access).	
6	DSP_REG6	R/W	0		
5	DSP_REG5	R/W	0		
4	DSP_REG4	R/W	0		
3	DSP_REG3	R/W	0		
2	DSP_REG2	R/W	0		
1	DSP_REG1	R/W	0		
0	DSP_REG0	R/W	0		

13.9.8 DSPn ACC (DSPn_ACC_x) (n=0-1,x=0-4)

Register	DSP0_ACC_0		DSP0 ACC[7:0]	Address	0xF790
	DSP0_ACC_1		DSP0 ACC[15:8]	Address	0xF791
	DSP0_ACC_2		DSP0 ACC[23:15]	Address	0xF792
	DSP0_ACC_3		DSP0 ACC[31:24]	Address	0xF793
	DSP0_ACC_4		DSP0 ACC[36:32]	Address	0xF794
	DSP1_ACC_0		DSP1 ACC[7:0]	Address	0xF810
	DSP1_ACC_1		DSP1 ACC[15:8]	Address	0xF811
	DSP1_ACC_2		DSP1 ACC[23:15]	Address	0xF812
	DSP1_ACC_3		DSP1 ACC[31:24]	Address	0xF813
	DSP1_ACC_4		DSP1 ACC[36:32]	Address	0xF814
Bit	Bit Name	R/W	Initial	Description	Note
7	DSP_ACC7	R/W	0	DSP Accumulator (ACC) These registers can access Accumulator (ACC) in each DSP. For ACC, each byte lane is assigned at independent address (Not similar to 16bit register which has Low Side and High Side assigned at same address). Lower bit lane is assigned in lower address.	
6	DSP_ACC6	R/W	0		
5	DSP_ACC5	R/W	0		
4	DSP_ACC4	R/W	0		
3	DSP_ACC3	R/W	0		
2	DSP_ACC2	R/W	0		
1	DSP_ACC1	R/W	0		
0	DSP_ACC0	R/W	0		

13.9.9 DSPn Program Memory LSB/MSB Side (DSPn_PRG_DATL/H) (n=0-1)

Register	DSP0_PRG_DATL	DSP0 Program Memory LSB Side	Address	0xF7A0	
	DSP0_PRG_DATH	DSP0 Program Memory MSB Side	Address	0xF7A1	
	DSP1_PRG_DATL	DSP1 Program Memory LSB Side	Address	0xF820	
	DSP1_PRG_DATH	DSP1 Program Memory MSB Side	Address	0xF821	
Bit	Bit Name	R/W	Initial	Description	Note
7	DSP_PRG_D7	R/W	0	DSP Program Memory Data (Low Side or High Side) Read/Write operation is performed to the program memory corresponding to DSPxPRG_ADR. E.g.) Read operation of bit[7:0] at the program memory of PC=0x10 : Read DSPx_PRG_DATL when DSPx_PRG_ADR = 0x10	
6	DSP_PRG_D6	R/W	0		
5	DSP_PRG_D5	R/W	0		
4	DSP_PRG_D4	R/W	0		
3	DSP_PRG_D3	R/W	0		
2	DSP_PRG_D2	R/W	0		
1	DSP_PRG_D1	R/W	0		
0	DSP_PRG_D0	R/W	0		

13.9.10 DSPn Program Memory Address (DSPn_PRG_ADR) (n=0-1)

Register	DSP0_PRG_ADR	DSP0 Program Memory Address	Address	0xF7A2	
	DSP1_PRG_ADR	DSP1 Program Memory Address	Address	0xF822	
Bit	Bit Name	R/W	Initial	Description	Note
7-5	reserved	R	0	Read value is 0. Write only 0.	
4	DSP_PRG_A4	R/W	0	DSP Program Memory Address Program Memory Address (PC) to access via. DSPx_PRG_DATL/H.	
3	DSP_PRG_A3	R/W	0		
2	DSP_PRG_A2	R/W	0		
1	DSP_PRG_A1	R/W	0		
0	DSP_PRG_A0	R/W	0		

13.9.11 DSPn Execution Trigger Status (DSPnTRG) (n=0-1)

Register		DSP0TRG	DSP0 Execution Trigger Status	Address	0xF782
		DSP1TRG	DSP1 Execution Trigger Status	Address	0xF802
Bit	Bit Name	R/W	Initial	Description	Note
7	SET_R7	R/W	0	DSP Execution Trigger Status Each bit shows corresponding register file (R0-R7) is written or not. When CPU or DSAC writes a value to R0-7 at DSPxCTRL.DSPE = 1, the corresponding bit is automatically set.	
6	SET_R6	R/W	0		
5	SET_R5	R/W	0		
4	SET_R4	R/W	0		
3	SET_R3	R/W	0		
2	SET_R2	R/W	0		
1	SET_R1	R/W	0		
0	SET_R0	R/W	0		

DSP instruction whose TRIG_WAIT flag is set temporary stops before its execution and watches SET_R0 - SET_R7 according to its trigger selection TRIG_WHAT and if corresponding bit in this register is set (detected update of R0-R7), the instruction will be executed and go to next sequence. At this time, corresponding SET_Rx is cleared automatically.

Note that the register basically shows only trigger status and CPU does not need to access it. But for debugging capability or for re-initialization, this register can be accessed by CPU (Read or Write forcibly).

13.9.12 DSPn Access Counter Clear Register (DSPnRST) (n=0-1)

Register		DSP0RST	DSP0 Access Counter Clear Register	Address	0xF783
		DSP1RST	DSP1 Access Counter Clear Register	Address	0xF803
Bit	Bit Name	R/W	Initial	Description	Note
7	CPUACCLA	R/C	0	Clear SFR CPU Access counter and XBUS CPU access counter. Read value is 0. Write 0: No effect Write 1: Clear Register CPU Access counter.	
6	DSACACCLA	R/C	0	Clear R0 - R7 DSAC Access Counter Read value is 0. Read : No Request Write 0: No effect Write 1: Clear Register DSAC Access counter.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0.	
0	reserved	R	0	Read value is 0. Write only 0.	

13.10 Caution of operation

13.10.1 Restriction about the TinyDSP interrupt enable bits

(1) Description

Interrupt signals from TinyDSP are always generated and are sent to interrupt controller without relation to setting of interrupt enable bits of Tiny DSP (DSPnCTRL.DSPIE) when corresponding interrupt flags are set (DSPnCTRL.DSPIF =1).

(2) Countermeasure

When interrupt from TinyDSP is not necessary, please mask interrupt by setting each interrupt enable bits in the interrupt controller to 0 (Refer to following table).

DSP Channel	Vector No.	Interrupt enable bits
0	23	INTENA2.INTE7
1	24	INTENA3.INTE0

13.10.2 DSP_SS asserted in the DIV instruction

In the DIV instruction, DSP_SS is asserted when 0x0001 is specified for Divisor Rm. The reason is that Shifter is used in calculating inverse of Rm.

Not Recommended for New Designs

14. High-Resolution PWM

14.1 Overview

This module can generate high resolution 8 (4-pairs) PWM signals. Each pair can form non-overlap PWM signals. Also, phase shift type signal can be generated by proper configuration. This module can accept internal event signals from other modules and can re-trigger the output signals or counter operations. Also this module can generate interrupts and internal event pulse according to internal compare match states.

Output PWM resolution is 1ns (min).

14.2 Block Diagram

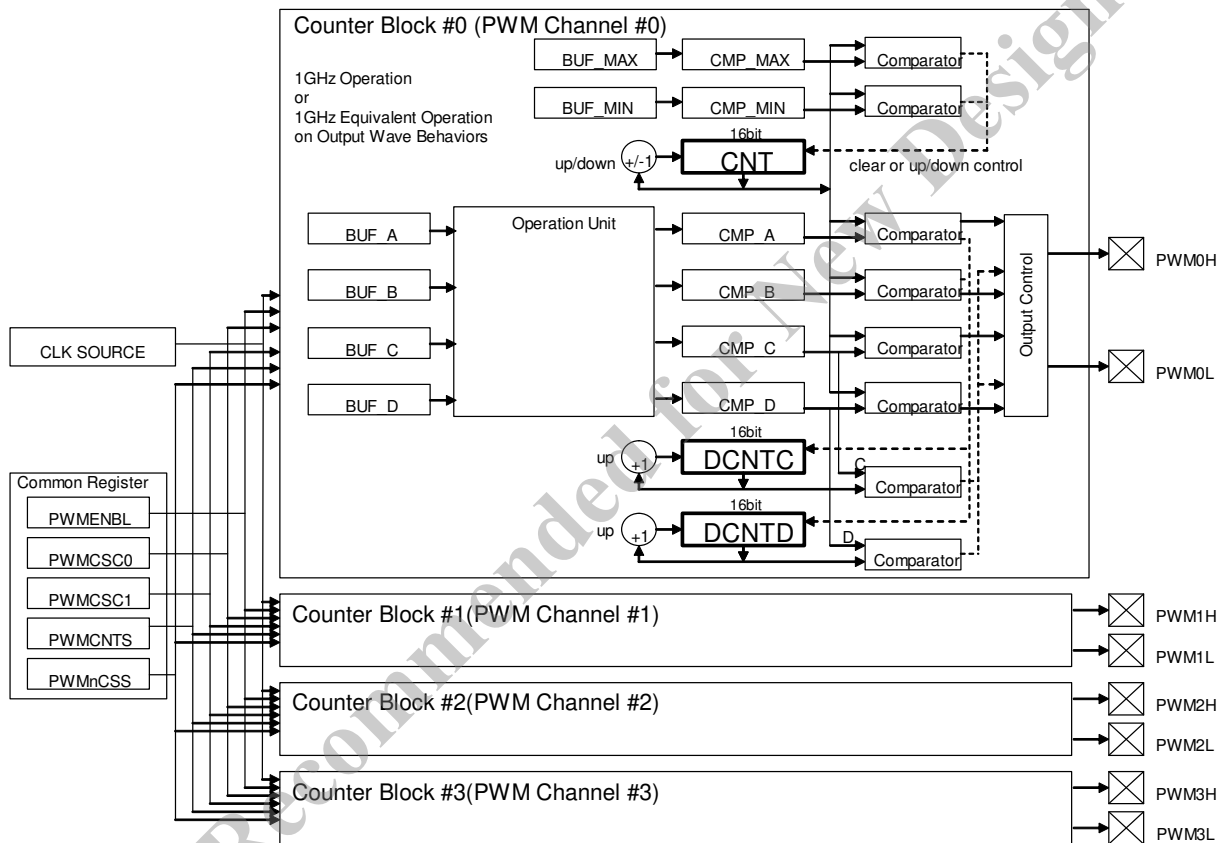


Figure 14-1 Block Diagram of High-Resolution PWM

14.3 Resources

The module has maximum 4 counter blocks according to product spec as shown in Figure 14-1.
Each block has following resources.

(1) 16bit Up/Down Counter (CNT)

Maximum frequency of each counter is 1GHz. The plural counters among counter blocks can be synchronized each other. There are 2 modes in counter operation. One is Up Mode, in which counter is always in up-count operation and is cleared when CNT matches to CMP_MAX and re-load counter value from CMP_MIN. The other is Up-Down Mode, in which counter is in up-count operation until it reaches to CMP_MAX and then the counter enters in down-count operation until it reaches to CMP_MIN, and then the counter re-enters in up-count operation again.

Note that user can assume counter value not only unsigned but also signed value because of existence of Min and Max values.

Note:

As for CH0 and CH1, you can specify any value in CMP_MIN and CMP_MAX. Whereas, as for CH2 and CH3, the lower 3bits of CMP_MIN should be 3'b000 and the lower 3bits of CMP_MAX should be 3'b111. Moreover, for all channels, distance between CMP_MIN and CMP_MAX should be 8 or more. (i.e. $CMP_MAX - CMP_MIN \geq 8$)

As a result, for CH0 and CH1, the minimum PWM cycle is 9ns and minimum resolution of PWM cycle is 1ns. As for CH2 and CH3, the minimum PWM cycle is 16ns and minimum resolution of PWM cycle is 8ns. Note that minimum resolution of PWM duty (edge position of PWMxL/PWMxH output) is 1ns for all PWM channels.

(2) Compare Register A and B (CMP_A, CMP_B)

These registers control PWMxH/PWMxL signal operation. When counter matches each compare register, output signal either PWMxH or PWMxL is set or reset according to the configuration. These registers can be changed at any time if necessary, but it is recommended to change these registers by using buffer mode.

(3) Compare Register C and D (CMP_C, CMP_D)

In PWM Mode 0 & 2, these registers control PWMxH/PWMxL signal operation.

In PWM Mode 1 & 3, these registers are compared with Dead Time counters (DCNTC & DCNTD) in order to insert Dead Time automatically.

(4) Compare Register Max and Min (CMP_MAX, CMP_MIN)

This register specifies counter cycle and range of counter value. In Up Mode, when counter value matches to CMP_MAX, the counter re-loads its value from CMP_MIN. In Up-Down Mode, when counter value matches to CMP_MAX, the counter operation is changed to down count mode from up count, and when counter value matches to CMP_MIN, the counter operation is changed to up count mode. These registers can be changed at any time if necessary, but it is recommended to change these registers by using buffer mode.

The operation of CH2 and CH3 is different from that of CH0 and CH1. In CH2 and CH3, the least 3bit of CMP_MAX register is fixed to 3'b111, and the least 3bit of CMP_MIN register is fixed to 3'b000. The PWM period is multiples of 8.

(5) Buffer Register A, B, C, D, MAX and MIN (BUF_A, BUF_B, BUF_C, BUF_D, BUF_MAX, BUF_MIN)

These registers are prepared for Buffer Mode. At some specified timing, each BUF_xx value is transferred to CMP_xx. Detail operation is described in later section.

The operation of CH2 and CH3 is different from that of CH0 and CH1. In CH2 and CH3, the least 3bit of BUF_MAX register must be fixed to 3'b111, and the least 3bit of BUF_MIN register must be fixed to 3'b000. The PWM period is multiples of 8.

(6) 16bit Dead Time Counter (DCNTC, DCNTD)

These counters are prepared to generate automatic dead time period in PWMxH and PWMxL outputs.

Dead time period is set by CMP_C and CMP_D, not DCNTC and DCNTD.

14.4 Clock Source selection

Figure 14-2 shows the clock source for PWM.

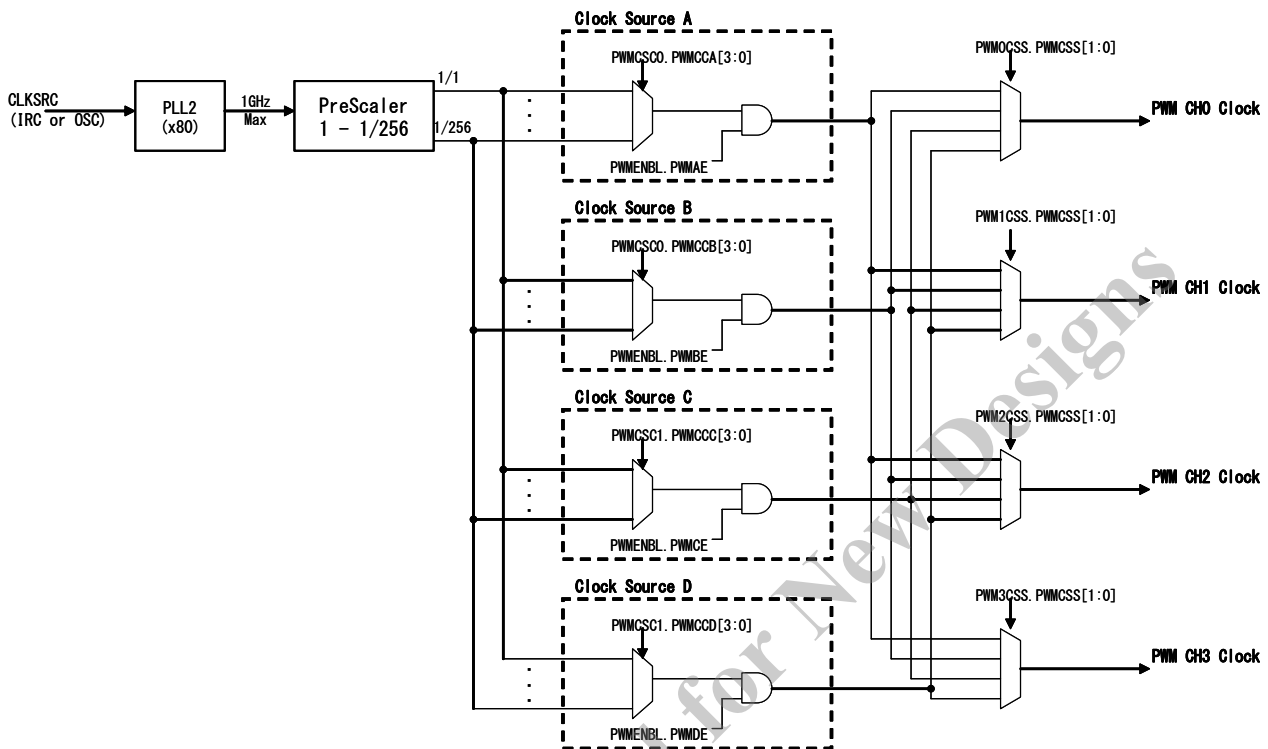


Figure 14-2 Block Diagram of PWM clock source

There are four clock sources for PWM channels, Clock source A, B, C and D. Each channel must select one of the clock sources at first. The clock selection sequence is as follows:

1. Select the input clock for the Clock source A/B/C/D by setting PWMCS0/1.PWMCCx[3:0].
2. Select Clock source A/B/C/D for each PWM CHn (n=0,1,2,3) by setting PWMxCSS.PWMCSS[1:0], (x=0,1,2,3.)
3. Enable the clock source by setting PWMENBL.PWMyE (y=A,B,C,D).

Do not read/write PWM registers except clock source selection registers (PWMENBL, PWMCS0, PWMCS1 and PWMxCSS) before doing clock source selection.

When the clock sources want to be changed, PWMENBL.PWMyE must be set to 0 at first. After that, requires idle state at least 6 COUNT CLOCK CYCLES. Then clock source can be changed by the clock source selection sequence mentioned above.

The PWM channel counters which selected the same clock source, can start simultaneously (synchronized).

14.5 Operation

Operation modes of High-Resolution PWM are shown in Table 14-1 and simple description is mentioned below

- 1) PWM mode has four modes which are mode 0,1,2 and 3
- 2) In PWM Mode 0 & 1, the registers can be changed by Direct mode writing directly

and Buffer mode via buffer. Mode 2 & 3 can operate at only Buffer mode.

3) The outline operation of four PWM Modes is as follows.

- (i) PWM Mode 0: PWM is generated without using Dead time counter.
- (ii) PWM Mode 1: PWM is generated inserting Dead time automatically with using Dead time counter(DCNTC & DCNTD).
- (iii) PWM Mode 2: Dead time counter is not used in Phase shift.
- (iv) PWM Mode 3: Dead time counter is used in Phase shift.

Ways of decision for next CMP_xx in Buffer Mode are shown in Table 14-2.

Table 14-1 Operation Mode of High-Resolution PWM

Mode Configuration			Update Timing of CMP_xx	Next CMP_xx Vaule	DCNTC Operation	DCNTD Operation	Output Level Changes to specified value at	
							PWMxH	PWMxL
PWM Mode 0	Direct Mode	Up Mode	When CPU writes to.	Immediately updated by CPU	Stop	Stop	VH0 at (CNT==CMP_C) or VH1 at (CNT==CMP_B)	VL0 at (CNT==CMP_A) or VL1 at (CNT==CMP_D)
		Up Down Mode			Stop	Stop	VH0 at (CNT(UP)==CMP_C) or VH1 at (CNT(DN)==CMP_C)	VL0 at (CNT(UP)==CMP_A) or VL1 at (CNT(DN)==CMP_A)
	Buffer Mode	Up Mode	When CNT reaches to CMP_MAX. At this moment, CNT reloads CMP_MIN.	See Table 14-2	Stop	Stop	VH0 at (CNT==CMP_C) or VH1 at (CNT==CMP_B)	VL0 at (CNT==CMP_A) or VL1 at (CNT==CMP_D)
		Up Down Mode	When count direction is changed. Selectable from both or either. That is at CNT ==CMP_MAX, or CNT ==CMP_MIN.		Stop	Stop	VH0 at (CNT(UP)==CMP_C) or VH1 at (CNT(DN)==CMP_C)	VL0 at (CNT(UP)==CMP_A) or VL1 at (CNT(DN)==CMP_A)

Mode Configuration			Update Timing of CMP_xx	Next CMP_xx Vaule	DCNTC Operation	DCNTD Operation	Output Level Changes to specified value at	
							PWMxH	PWMxL
PWM Mode 1 Auto Dead Time Mode 0	Direct Mode	Up Mode	When CPU writes to.	Immediately updated by CPU	Start at (CNT==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT==CMP_B), Stop and Clear at (DCNTD==CMP_D)	VH0 at (DCNTC==CMP_C), or VH1 at (CNT==CMP_B).	VL0 at (CNT==CMP_A), or VL1 at (DCNTD==CMP_D).
		Up Down Mode			Start at (CNT(UP)==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT(DN)==CMP_A), Stop and Clear at (DCNTD==CMP_D)	VH0 at (DCNTC==CMP_C), or VH1 at (CNT(DN)==CMP_A)	VL0 at (CNT(UP)==CMP_A), or VL1 at (DCNTD==CMP_D)
	Buffer Mode	Up Mode	When CNT reaches to CMP_MAX. At this moment, CNT reloads CMP_MIN. When count direction is changed. Selectable from both or either. That is at CNT=(CMP_MAX, or CNT==CMP_MIN.	See Table 14-2	Start at (CNT==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT==CMP_B), Stop and Clear at (DCNTD==CMP_D)	VH0 at (DCNTC==CMP_C), or VH1 at (CNT==CMP_B).	VL0 at (CNT==CMP_A), or VL1 at (DCNTD==CMP_D).
		Up Down Mode			Start at (CNT(UP)==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT(DN)==CMP_A), Stop and Clear at (DCNTD==CMP_D)	VH0 at (DCNTC==CMP_C), or VH1 at (CNT(DN)==CMP_A)	VL0 at (CNT(UP)==CMP_A), or VL1 at (DCNTD==CMP_D)

Not Recommended for New Design

Mode Configuration			Update Timing of CMP_xx	Next CMP_xx Vaule	DCNTC Operation	DCNTD Operation	Output Level Changes to specified value at...	
							PWMxH	PWMxL
PWM Mode 1 Auto Dead Time Mode 1	Direct Mode	Up Mode	When CPU writes to.	Immediately updated by CPU	Start at (CNT==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT==CMP_B), Stop and Clear at (DCNTD==CMP_D)	VH0 at (CNT==CMP_A), or VH1 at (DCNTD==CMP_D).	VL0 at (DCNTC==CMP_C), or VL1 at (CNT==CMP_B).
		Up Down Mode						
	Buffer Mode	Up Mode	When CNT reaches to CMP_MAX. At this moment, CNT reloads CMP_MIN.	See Table 14-2	Start at (CNT==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT==CMP_B), Stop and Clear at (DCNTD==CMP_D)	VH0 at (CNT==CMP_A), or VH1 at (DCNTD==CMP_D).	VL0 at (DCNTC==CMP_C), or VL1 at (CNT==CMP_B).
		Up Down Mode	When count direction is changed. Selectable from both or either. That is at CNT ==CMP_MAX, or CNT ==CMP_MIN.					

Mode Configuration			Update Timing of CMP_xx	Next CMP_xx Vaule	DCNTC Operation	DCNTD Operation	Output Level Changes to specified value at...	
							PWMxH	PWMxL
PWM Mode 2 (Phase Shift)	Direct Mode	Up Mode	Not Available					
		Up Down Mode						
	Buffer Mode	Up Mode	[CMP_B] at (CNT==CMP_A) [CMP_D] at (CNT==CMP_C) [Others] When CNT reaches to CMP_MAX. At this moment, CNT reloads CMP_MIN.	See Table 14-2	Stop	Stop	VH0 at (CNT==CMP_C) or VH1 at (CNT==CMP_B)	VL0 at (CNT==CMP_A) or VL1 at (CNT==CMP_D)
		Up Down Mode	Not Available					

Mode Configuration			Update Timing of CMP_xx	Next CMP_xx Vaule	DCNTC Operation	DCNTD Operation	Output Level Changes to specified value at...	
							PWMxH	PWMxL
PWM Mode 3 (Phase Shift)	Direct Mode	Up Mode	Not Available					
		Up Down Mode	Not Available					
	Buffer Mode	Up Mode	[CMP_B] at (CNT==CMP_A) [Others] When CNT reaches to CMP_MAX. At this moment, CNT reloads CMP_MIN.	See Table 14-2	Start at (CNT==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT==CMP_B), Stop and Clear at (DCNTD==CMP_D)	VH0 at (DCNTC==CMP_C), or VH1 at (CNT==CMP_B).	VL0 at (CNT==CMP_A), or VL1 at (DCNTD==CMP_D).
Auto Dead Time Mode 0		Up Down Mode	Not Available					

Mode Configuration			Update Timing of CMP_xx	Next CMP_xx Vaule	DCNTC Operation	DCNTD Operation	Output Level Changes to specified value at...	
							PWMxH	PWMxL
PWM Mode 3 (Phase Shift)	Direct Mode	Up Mode	Not Available					
		Up Down Mode	Not Available					
	Buffer Mode	Up Mode	[CMP_B] at (CNT==CMP_A) [Others] When CNT reaches to CMP_MAX. At this moment, CNT reloads CMP_MIN.	See Table 14-2	Start at (CNT==CMP_A), Stop and Clear at (DCNTC==CMP_C)	Start at (CNT==CMP_B), Stop and Clear at (DCNTD==CMP_D)	VH0 at (CNT==CMP_A), or VH1 at (DCNTD==CMP_D).	VL0 at (DCNTC==CMP_C), or VL1 at (CNT==CMP_B).
Auto Dead Time Mode 1		Up Down Mode	Not Available					

Not Recommended for New Designs

Table 14-2 Decision of next CMP_xx in Buffer Mode for each PWM Mode

PWM Mode	next CMP_MAX CMP_MIN	next CMP_A	next CMP_B	next CMP_C	next CMP_D
0	BUF_MAX BUF_MIN	BUF_A	BUF_B	BUF_C	BUF_D
1	BUF_MAX BUF_MIN	BUF_A	BUF_B	BUF_C	BUF_D
2	BUF_MAX BUF_MIN	BUF_A	CMP_A+BUF_B (*1)	BUF_C	CMP_C+BUF_D (*2)
3	BUF_MAX BUF_MIN	BUF_A	CMP_A+BUF_B (*1)	BUF_C	BUF_D

Note: In Buffer Mode, user should set BUF_xx registers “3 CPUCLKs + 40 COUNT CLOCK CYCLES” before update timing of CMP_xx.

Note: As for calculations shown above, if calculated result is out of range over CMP_MAX, do following adjustment.

(*1) When CMP_B is updated, following calculations are executed.

If $(\text{CMP_A} + \text{BUF_B}) > \text{CMP_MAX}$,
 next CMP_B is $(\text{CMP_A} + \text{BUF_B}) - (\text{CMP_MAX} - \text{CMP_MIN}) - 1$
 else
 next CMP_B is $(\text{CMP_A} + \text{BUF_B})$

Note that CMP_B is updated just when $\text{CNT} == \text{CMP_A}$ (at compare match A).

(*2) When CMP_D is updated, following calculations are executed.

If $(\text{CMP_C} + \text{BUF_D}) > \text{CMP_MAX}$,
 next CMP_D is $(\text{CMP_C} + \text{BUF_D}) - (\text{CMP_MAX} - \text{CMP_MIN}) - 1$
 else
 next CMP_D is $(\text{CMP_C} + \text{BUF_D})$

Note that CMP_D is updated just when $\text{CNT} == \text{CMP_C}$ (at compare match C).

14.5.1 Direct Mode and Buffer Mode

In Direct Mode, all CMP_xx registers should be directly updated by CPU. When CPU changes CMP_xx, the value is immediately used to be compared to CNT, DCNTC or DCNTD. So user should use this mode with deep care. In Direct Mode, BUF_xx registers have no meanings.

In Buffer Mode, and in Up Mode, when CNT is matched to CMP_MAX and re-load CMP_MIN, all BUF_xx contents are transferred to corresponding CMP_xx registers with pre-defined arithmetic operations shown in Table 14-2.

In Buffer Mode, and in Up-Down Mode, either when CNT is matched to CMP_MAX and just enters in down counting operation, or when CNT is matched to CMP_MIN and just enters in up counting operation, all BUF_xx contents are transferred to corresponding CMP_xx registers with pre-defined arithmetic operations shown in Table 14-2. In this case, there are possible two timings when BUF_xx is moved to CMP_xx, and user can select one of the two or both.

Usually, user uses Buffer Mode rather than Direct Mode. Even in Buffer Mode, user can directly change CMP_xx registers and the values are immediately used to be compared to CNT as same as Direct Mode.

14.5.2 PWM Mode 0

All PWM output wave timings should be specified by user. This mode can be operated in both Direct Mode and Buffer Mode without using the Dead Time counter

(1) PWM Mode0 + Up Mode

CNT starts counting from it's initial value to the CMP_MAX value. After CNT and CMP_MAX are matched, CNT reloads the CMP_MIN value and starts counting from this value to the CMP_MAX value.

- If CNT and CMP_A are matched, PWMxL is changed to specified level VL0.
 - If CNT and CMP_C are matched, PWMxH is changed to specified level VH0.
 - If CNT and CMP_B are matched, PWMxH is changed to specified level VH1.
 - If CNT and CMP_D are matched, PWMxL is changed to specified level VL1.
- Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

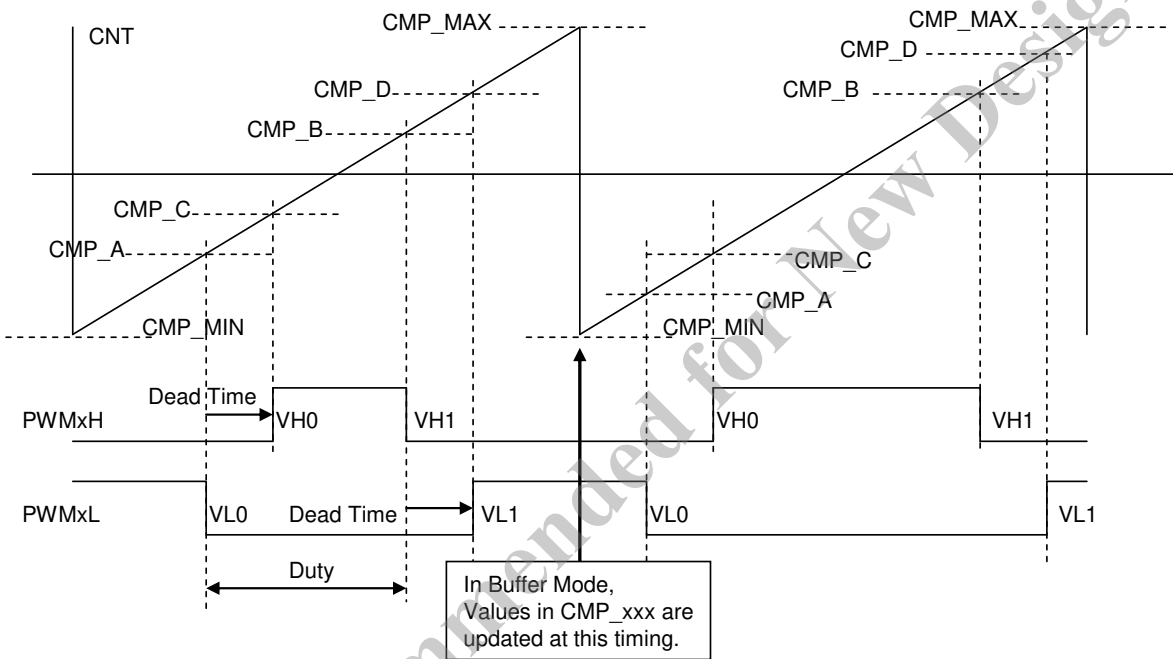


Figure 14-3 PWM Mode0 (Up Mode)

(2) PWM Mode0 + Up-Down Mode

CNT starts Up-counting from it's initial value to the CMP_MAX value. When CNT and CMP MAX are matched, CNT starts Down-counting to the CMP_MIN value. When CNT and CMP_MIN are matched, starts CNT return Up-counting to the CMP_MAX. CNT restarts Up-counting regardless of count direction when CNT stops by writing PWMCNTS.PWMCSSy = 0.

- If CNT(UP) and CMP_A are matched, PWMxL is changed to specified level VL0.
 - If CNT(UP) and CMP_C are matched, PWMxH is changed to specified level VH0.
 - If CNT(DOWN) and CMP_C are matched, PWMxH is changed to specified level VH1.
 - If CNT(DOWN) and CMP_A are matched, PWMxL is changed to specified level VL1.
- Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

In Up-Down mode and Buffer mode, there are possible two timings when BUF_xx is transferred to CMP_xx, and user can select one of the two or both.

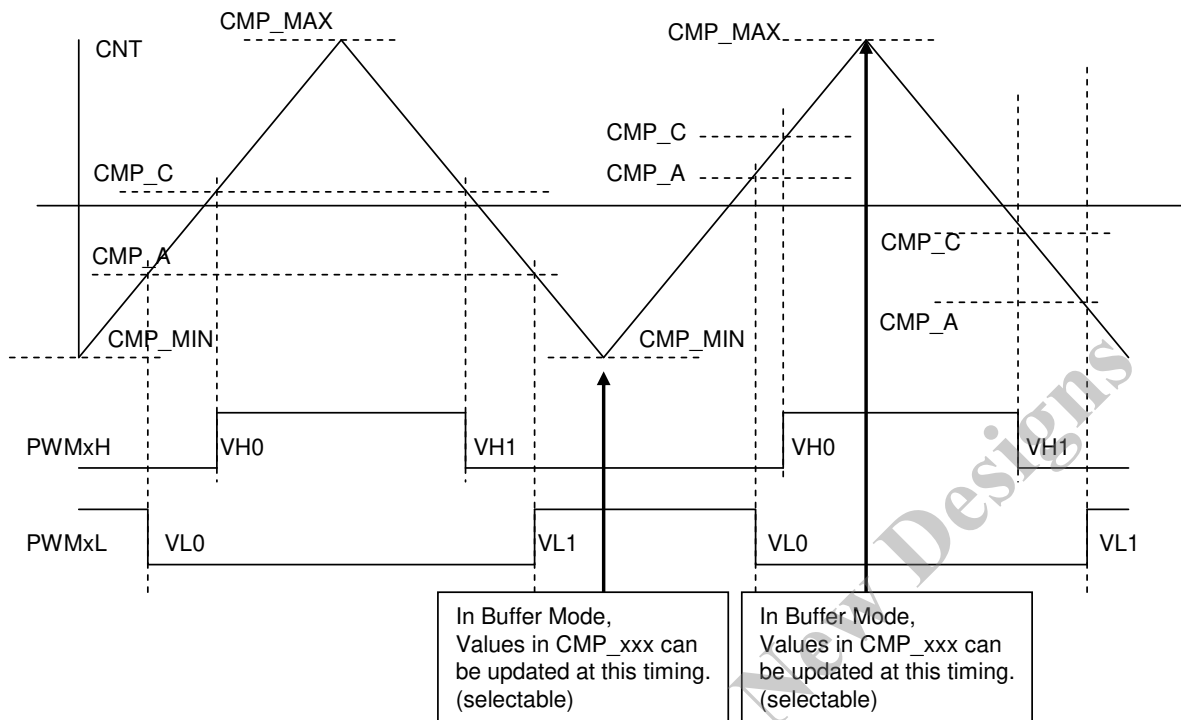


Figure 14-4 PWM Mode 0 (Up-Down Mode)

14.5.3 PWM Mode 1 (Auto Dead Time)

Dead Time is automatically measured by using Dead Time counter (DCNTC & DCNTD).

It is necessary to set Dead Time into CMP_C and CMP_D. CMP_C and CMP_D setting method are different from mode 0. There are two Dead Time Modes by changing PWMxH and PWMxL.

These are Auto Dead Time Mode 0 and Mode 1.

(1) PWM Mode1 + Up Mode + Auto Dead Time Mode 0

CNT starts counting from its initial value to the CMP_MAX value. After CNT and CMP_MAX are matched, CNT reloads the CMP_MIN value and starts counting from this value to the CMP_MAX value.

If CNT and CMP_A are matched, PWMxL is changed to specified level VL0.
DCNTC starts up-counting from "0".

If DCNTC and CMP_C are matched, PWMxH is changed to specified level VH0.
DCNTC is cleared to "0" and stop.

If CNT and CMP_B are matched, PWMxH is changed to specified level VH1.
DCNTD starts up-counting from "0".

If DCNTD and CMP_D are matched, PWMxL is changed to specified level VL1.
DCNTD is cleared to "0" and stop.

In Direct mode, it is necessary to change CMP_XX register in advance of 3CPUCLKs+40count cycles or more. DCNTC will be cleared if matching of CNT and CMP_A occurs before matching of DCNTC and CMP_C. In the same way, DCNTD will be cleared if matching of CNT and CMP_B occurs before matching of DCNTD and CMP_D.

In Buffer mode, the change of each CMP_XX occurs when CMP reloads the value of CMP_MIN.

(2) PWM Mode1 + Up Mode + Auto Dead Time Mode 1

CNT starts counting from its initial value to the CMP_MAX value. After CNT and CMP_MAX are matched, CNT reloads the CMP_MIN value and starts counting from this value to the CMP_MAX value.

If CNT and CMP_A are matched, PWMxH is changed to specified level VH0.
DCNTC starts up-counting from "0".

If DCNTC and CMP_C are matched, PWMxL is changed to specified level VL0. DCNTC is cleared to "0" and stop.

If CNT and CMP_B are matched, PWMxL is changed to specified level VL1. DCNTD starts up-counting from "0".

If DCNTD and CMP_D are matched, PWMxH is changed to specified level VH1.
DCNTD is cleared to "0" and stop.

Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

In Direct mode, it is necessary to change CMP_XX register in advance of 3CPUCLKs+40count cycles or more.

Note: During DCNTx is incrementing, if corresponding CMP_A/B (which is start trigger of DCNTx) is happened, the DCNTx re-starts from 0. And as the result, the dead time is stretched.

Note: If CMP_C=0 or CMP_D=0, corresponding dead time period is 1-counter-cycle.

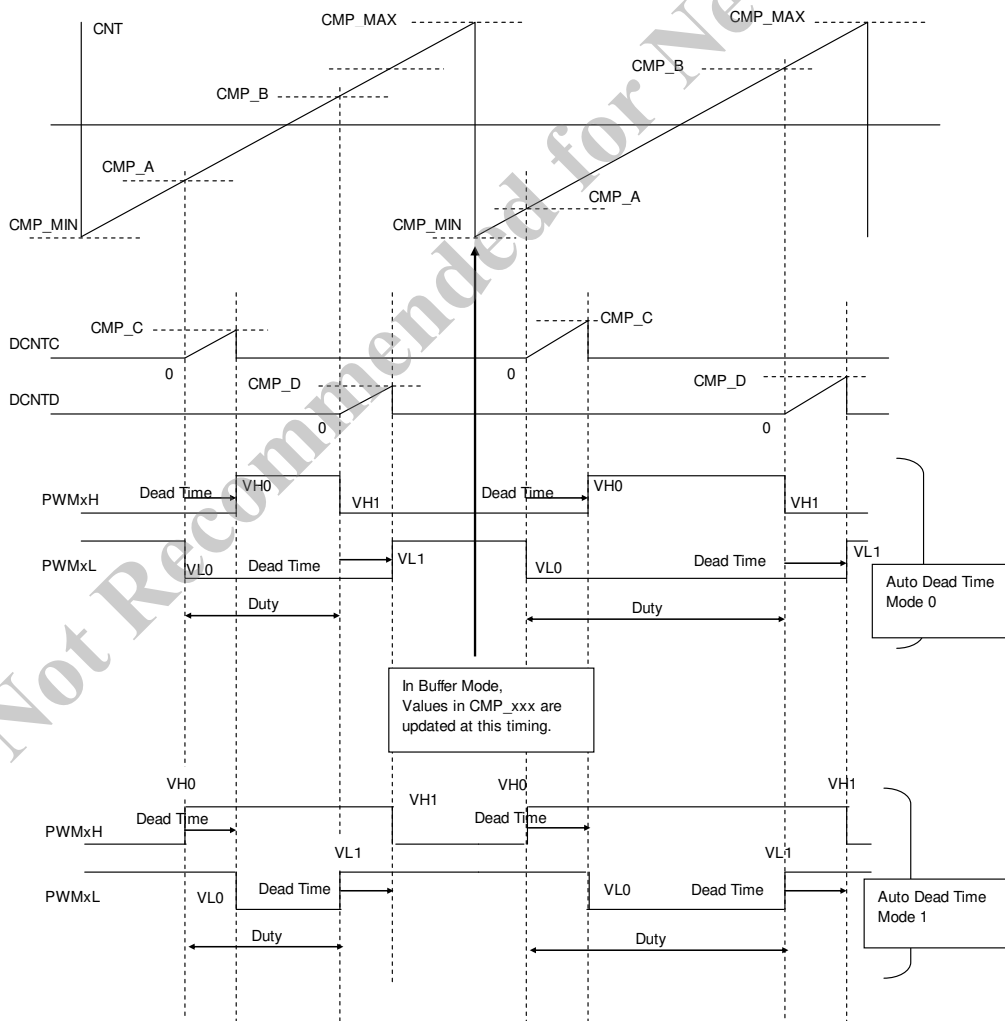


Figure 14-5 PWM Mode1 + Up Mode

(3) PWM Mode1 + Up-Down Mode + Auto Dead Time Mode 0

CNT starts Up-counting from its initial value to the CMP_MAX value. When CNT and CMP_MAX are matched, CNT starts Down-counting to the CMP_MIN value. When CNT and CMP_MIN are matched, starts CNT return Up-counting to the CMP_MAX. CNT restarts Up-counting regardless of count direction when CNT stops by writing PWMCNTS.PWMCSy = 0.

If CNT(UP) and CMP_A are matched, PWMxL is changed to specified level VL0.
DCNTC starts up-counting from "0"

If DCNTC and CMP_C are matched, PWMxH is changed to specified level VH0.
DCNTC is cleared to "0" and stop.

If CNT(DN) and CMP_A are matched, PWMxH is changed to specified level VH1.
DCNTD starts up-counting from "0".

If DCNTD and CMP_D are matched, PWMxL is changed to specified level VL1.
DCNTD is cleared to "0" and stop.

Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

In Direct mode, it is necessary to change CMP_XX register in advance of 3CPUCLKs+40count cycles or more.

In Buffer mode, all BUF_xx contents are transferred to corresponding CMP_xx registers with pre-defined arithmetic operations shown in Table 14-2. In this case, there are possible two timings when BUF_xx is moved to CMP_xx, and user can select one of the two or both.

Note: During DCNTx is incrementing, if corresponding CMP_A (which is start trigger of DCNTx) is happened, the DCNTx re-starts from 0. And as the result, the dead time is stretched.

Note: If CMP_C=0 or CMP_D=0, corresponding dead time period is 1-counter-cycle.

(4) PWM Mode1 + Up-Down Mode + Auto Dead Time Mode 1

CNT starts Up-counting from its initial value to the CMP_MAX value. When CNT and CMP_MAX are matched, CNT starts Down-counting to the CMP_MIN value. When CNT and CMP_MIN are matched, starts CNT return Up-counting to the CMP_MAX. CNT restarts Up-counting regardless of count direction when CNT stops by writing PWMCNTS.PWMCSy = 0.

If CNT(UP) and CMP_A are matched, PWMxH is changed to specified level VH0.
DCNTC starts up-counting from "0"

If DCNTC and CMP_C are matched, PWMxL is changed to specified level VL0.
DCNTC is cleared to "0" and stop.

If CNT(DN) and CMP_A are matched, PWMxL is changed to specified level VL1.
DCNTD starts up-counting from "0".

If DCNTD and CMP_D are matched, PWMxH is changed to specified level VH1.
DCNTD is cleared to "0" and stop.

Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

In Direct mode, it is necessary to change CMP_XX register in advance of 3CPUCLKs+40count cycles or more.

In Buffer mode, all BUF_xx contents are transferred to corresponding CMP_xx registers with pre-defined arithmetic operations shown in Table 14-2. In this case, there are possible two timings when BUF_xx is moved to CMP_xx, and user can select one of the two or both.

Note: During DCNTx is incrementing, if corresponding CMP_A (which is start trigger of DCNTx) is happened, the DCNTx re-starts from 0. And as the result, the dead time is stretched.

Note: If CMP_C=0 or CMP_D=0, corresponding dead time period is 1-counter-cycle.

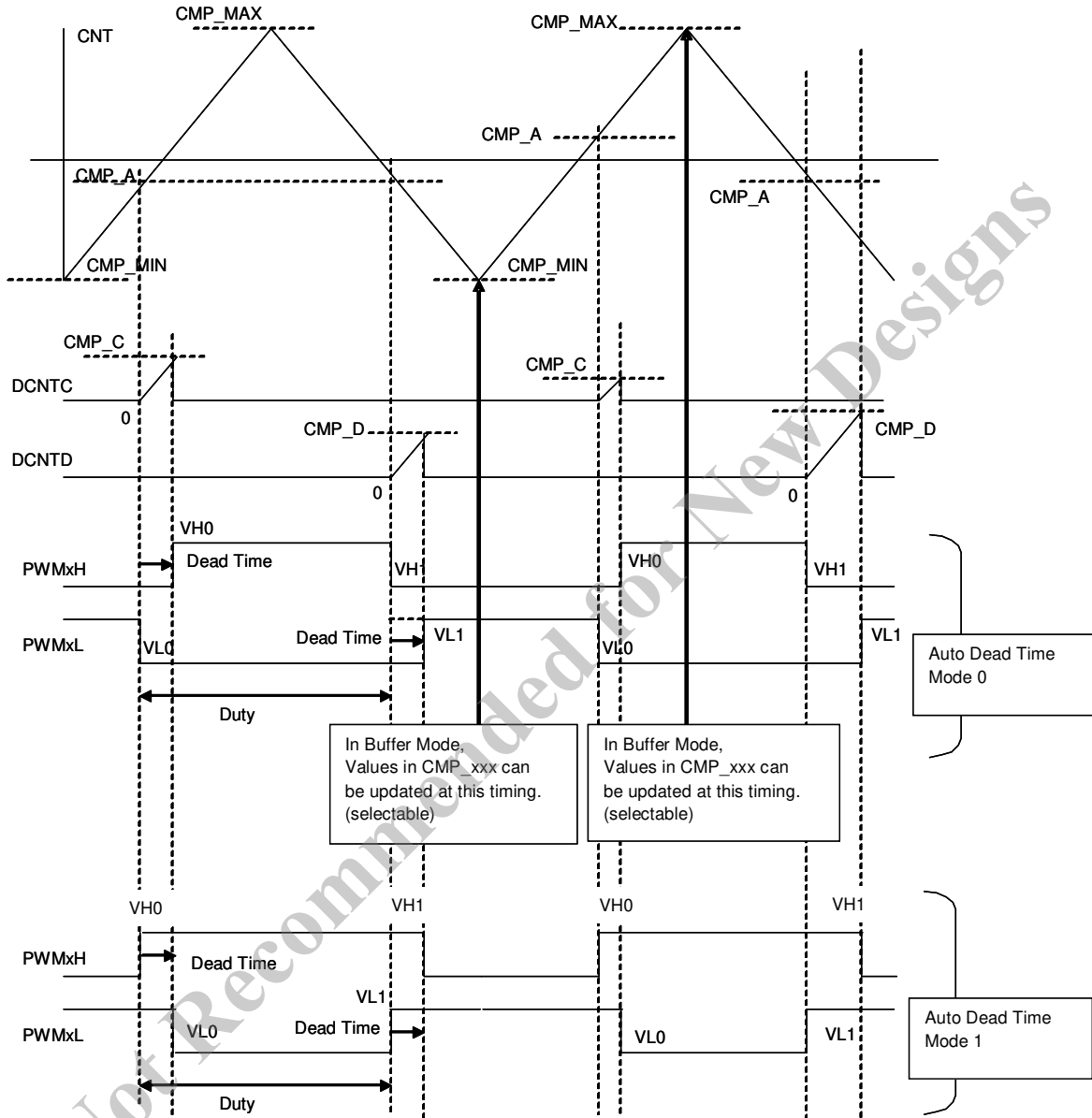


Figure 14-6 PWM Mode1 + Up-Down Mode

14.5.4 PWM Mode 2 (Phase Shift)

This mode can generate phase shift wave, and available only in Up Mode and Buffer Mode.

As for transfer timings and transfer operations of BUFxx to CMPxx are slightly changed from Buffer Mode in PWM Mode0 and 1.

BUF_xx contents are transferred to corresponding CMP_xx registers except CMP_B & CMP_D when CNT is matched to CMP_MAX and re-load CMP_MIN.

The timing and operation of transference of CMP_B and CMP_D are mentioned below.

CNT starts counting from it's initial value to the CMP_MAX value. After CNT and CMP_MAX are matched, CNT reloads the CMP_MIN value and starts counting from this value to the CMP_MAX value.

- If CNT and CMP_A are matched, PWMxL is changed to specified level VL0, $CMP_A+BUF_B \rightarrow CMP_B$
- If CNT and CMP_C are matched, PWMxH is changed to specified level VH0, $CMP_C+BUF_D \rightarrow CMP_D$
- If CNT and CMP_B are matched, PWMxH is changed to specified level VH1.
- If CNT and CMP_D are matched, PWMxL is changed to specified level VL1.
- Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

When CMP_B is updated, following calculations are executed.

```

If (CMP_A+BUF_B) > CMP_MAX,
    next CMP_B is (CMP_A+BUF_B)-(CMP_MAX- CMP_MIN) -1
else
    next CMP_B is (CMP_A+BUF_B)
    
```

Note that CMP_B is updated just when $CNT==CMP_A$ (at compare match A).

When CMP_D is updated, following calculations are executed.

```

If (CMP_C+BUF_D) > CMP_MAX,
    next CMP_D is (CMP_C+BUF_D)-(CMP_MAX- CMP_MIN)- 1
else
    next CMP_D is (CMP_C+BUF_D)
    
```

Note that CMP_D is updated just when $CNT==CMP_C$ (at compare match C).

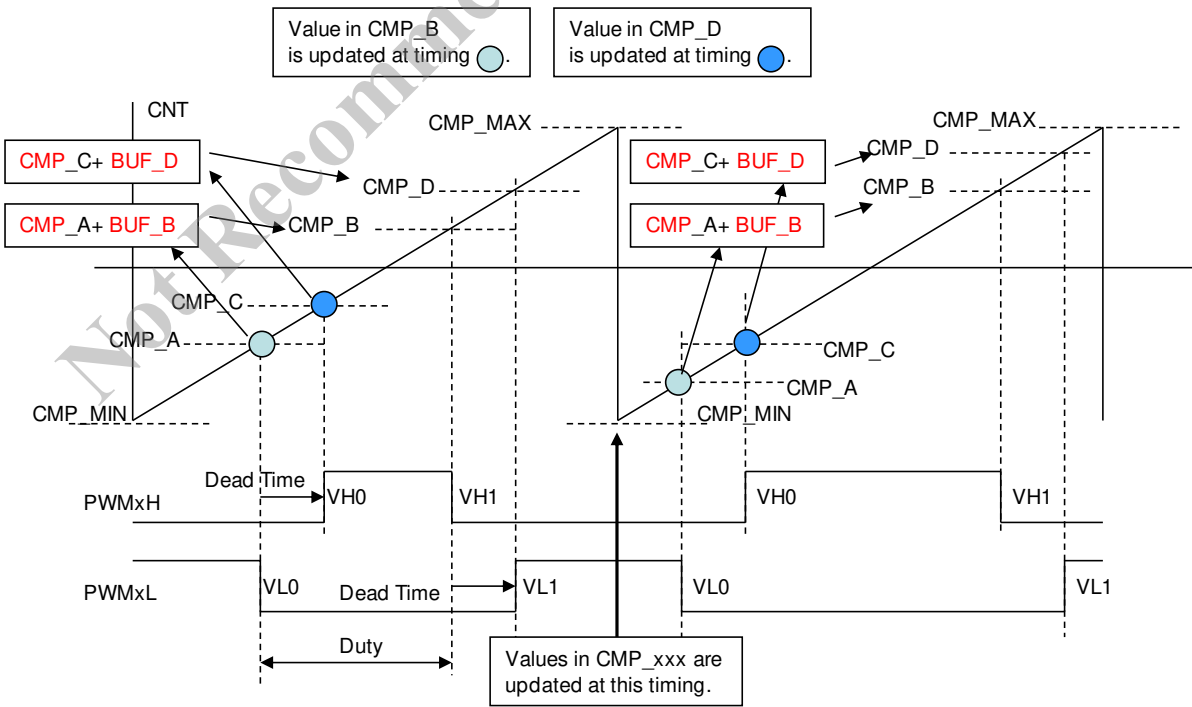


Figure 14-7 PWM Mode 2 (Phase Shift)

14.5.5 PWM Mode 3 (Phase Shift + Auto Dead Time)

This mode can generate phase shift wave with auto dead time, and available only in Up Mode and Buffer Mode. The CNT is compared with CMP_A and CMP_B.

This mode uses Dead Time Counter DCNTC and DCNTD. All counters (CNT, DCNTC and DCNTD) use same count up/down clock.

There are two modes in Auto Dead Time generation; Auto Dead Time Mode0 and Auto Dead Time Mode1.

(1) PWM Mode3 + Auto Dead Time Mode 0

CNT starts counting from its initial value to the CMP_MAX value. After CNT and CMP_MAX are matched, CNT reloads the CMP_MIN value and starts counting from this value to the CMP_MAX value.

As for transfer timings and transfer operations of BUFxx to CMPxx are slightly changed from Buffer Mode in PWM Mode0 and 1.

If CNT and CMP_A are matched, PWMxL is changed to specified level VL0, CMP_A+BUF_B->CMP_B
DCNTC starts up-counting from "0"

If CNT and CMP_C are matched, PWMxH is changed to specified level VH0,
DCNTC is cleared to "0" and stop.

If CNT and CMP_B are matched, PWMxH is changed to specified level VH1.
DCNTD starts up-counting from "0".

If CNT and CMP_D are matched, PWMxL is changed to specified level VL1.
DCNTD is cleared to "0" and stop.

Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

Note: During DCNTx is incrementing, if corresponding CMP_A/B (which is start trigger of DCNTx) is happened, the DCNTx re-starts from 0. And as the result, the dead time is stretched.

Note: If CMP_C=0 or CMP_D=0, corresponding dead time period is 1-counter-cycle.

When CMP_B is updated, following calculations are executed.

If (CMP_A+BUF_B) > CMP_MAX,
next CMP_B is (CMP_A+BUF_B)-(CMP_MAX- CMP_MIN) - 1
else
next CMP_B is (CMP_A+BUF_B)

Note that CMP_B is updated just when CNT==CMP_A (at compare match A).

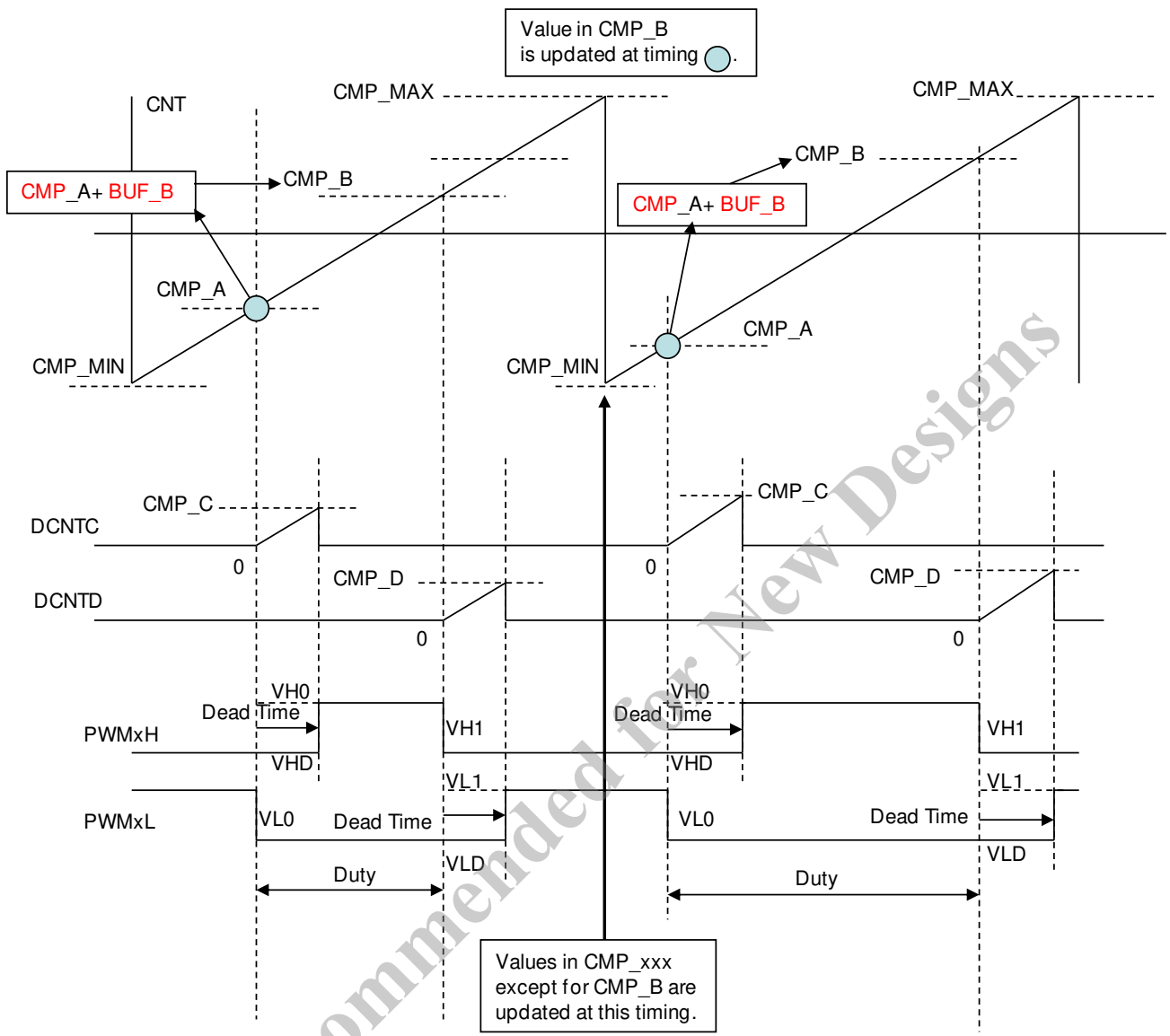


Figure 14-8 PWM Mode 3 (Phase Shift, Auto Dead Time Mode 0)

(2) PWM Mode3 + Auto Dead Time Mode 1

CNT starts counting from its initial value to the CMP_MAX value. After CNT and CMP_MAX are matched, CNT reloads the CMP_MIN value and starts counting from this value to the CMP_MAX value.

As for transfer timings and transfer operations of BUFxx to CMPxx are slightly changed from Buffer Mode in PWM Mode0 and 1.

If CNT and CMP_A are matched, PWMxH is changed to specified level VH0, CMP_A+BUF_B->CMP_B
DCNTC starts up-counting from "0"

If CNT and CMP_C are matched, PWMxL is changed to specified level VL0,
DCNTC is cleared to "0" and stop.

If CNT and CMP_B are matched, PWMxL is changed to specified level VL1.
DCNTD starts up-counting from "0".

If CNT and CMP_D are matched, PWMxH is changed to specified level VH1.
DCNTD is cleared to "0" and stop.

Each level VH0, VH1, VL0, VL1 is selected from NOP, Low, High or Toggle.

Note: During DCNTx is incrementing, if corresponding CMP_A/B (which is start trigger of DCNTx) is happened, the DCNTx re-starts from 0. And as the result, the dead time is stretched.

Note: If CMP_C=0 or CMP_D=0, corresponding dead time period is 1-counter-cycle.

When CMP_B is updated, following calculations are executed.

If (CMP_A+BUF_B) > CMP_MAX,
next CMP_B is (CMP_A+BUF_B)-(CMP_MAX-CMP_MIN) - 1
else
next CMP_B is (CMP_A+BUF_B)

Note that CMP_B is updated just when CNT==CMP_A (at compare match A).

Not Recommended for New Designs

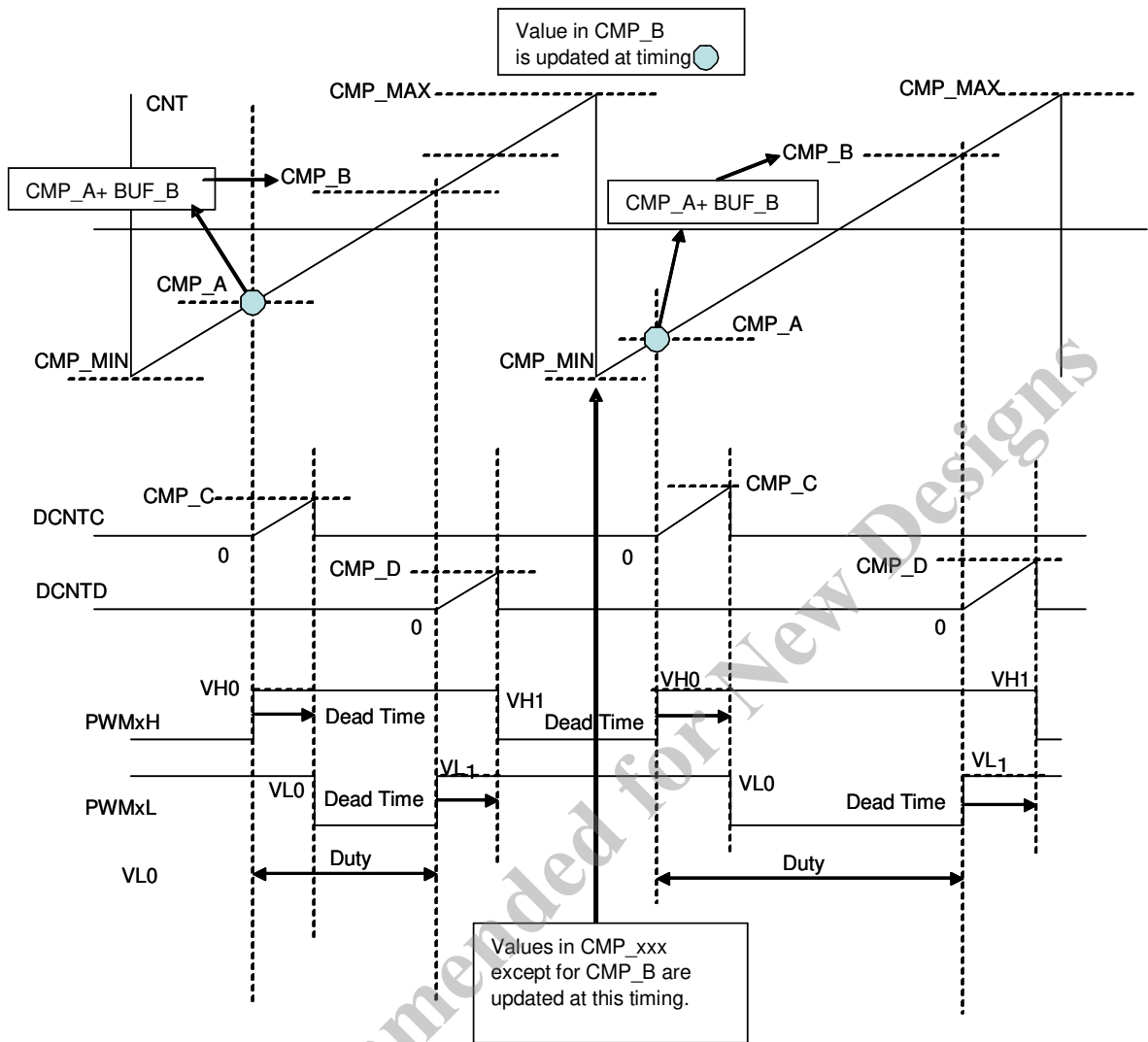


Figure 14-9 PWM Mode 3 (Phase Shift, Auto Dead Time Mode 1)

14.6 Contentions or Output Control Conditions

Output Control Operations, when plural Compare matches are happened at same time, are shown in Table 14-3. In each Auto Dead Time Mode, even if such contentions are happened, DCNTC and DCNTD will normally start by defined conditions.

Table 14-3 Contentions or Output Control Conditions

Mode	Priority in PWMxH output control		Priority in PWMxL output control		Note
PWM Mode 0 + Up Mode	Lowest		Lowest		
		CMP_MAX for PWMxH		CMP_MAX for PWMxL	
		VH0 event		VL0 event	
	Highest	VH1 event	VL1 event		
		VTH event	VTL event		
PWM Mode 0 + Up-Down Mode	Lowest	CMP_MIN for PWMxH	Lowest	CMP_MIN for PWMxL	
		CMP_MAX for PWMxH		CMP_MAX for PWMxL	
		VH0 event		VL0 event	
	Highest	VH1 event	VL1 event		
		VTH event	VTL event		
PWM Mode 1 + Up Mode	Lowest		Lowest		
		CMP_MAX for PWMxH		CMP_MAX for PWMxL	
		VH0 event		VL0 event	
	Highest	VH1 event	VL1 event		
		VTH event	VTL event		
PWM Mode 1 + Up-Down Mode	Lowest	CMP_MIN for PWMxH	Lowest	CMP_MIN for PWMxL	
		CMP_MAX for PWMxH		CMP_MAX for PWMxL	
		VH0 event		VL0 event	
	Highest	VH1 event	VL1 event		
		VTH event	VTL event		
PWM Mode 2	Lowest		Lowest		
		CMP_MAX for PWMxH		CMP_MAX for PWMxL	
		VH0 event		VL0 event	
	Highest	VH1 event	VL1 event		
		VTH event	VTL event		
PWM Mode 3	Lowest		Lowest		
	Highest		Highest		
		CMP_MAX for PWMxH		CMP_MAX for PWMxL	
		VH0 event		VL0 event	
		VH1 event		VL1 event	
	VTH event	VTL event			
Common	Just when Compare Match, CMP_x is changed to another value. → old CMP_x operation is taken.				
	Just when CMP_x is changed, Compare Match happens by new value. → new CMP_x operation is NOT taken.				
	Just when Compare Match, CNT is forcibly changed to another value. → old CMP_x operation is taken.				
	Just when CNT is forcibly changed, Compare Match happens by new value. → new CMP_x operation is NOT taken				

14.7 Operation Timing

(1) Compare Match Timing

Compare Match Timing is shown in Figure 14-10. Conditions of this example are

- (i) Module System clock :1GHz
- (ii) Count Up/Down Timing:1GHz

The CNT is changed by the Count Up/Down timing:1GHz, and Compare match is occurred at the end of the CNT value which same as CMP_X

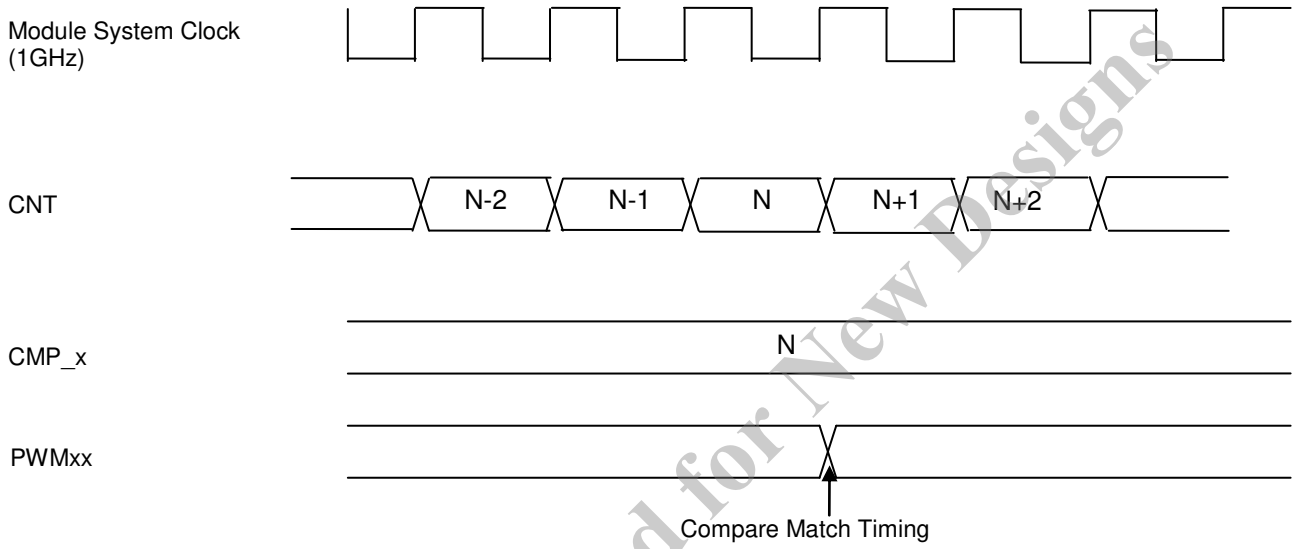


Figure 14-10 Compare Match Timing

(2) CNT Clear Timing in Up-Down Mode

The CNT Clear Timing in Up-Down Mode is shown in Figure 14-11. Conditions of this example are

- (i) Module System clock :1GHz
- (ii) Count Up/Down Timing:1GHz

The CNT is reloaded to the CMP_MIN value at the next CNT cycle of CMP_MAX value

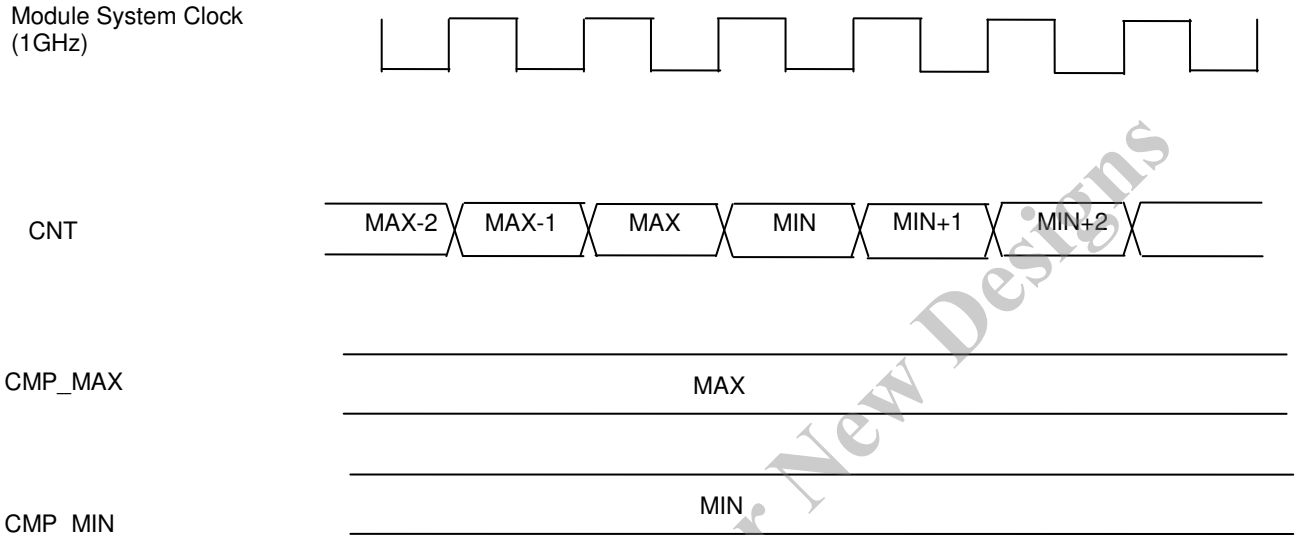


Figure 14-11 Counter Clear Timing in Up-Count Mode

(3) CNT Up to Down changing Timing in Up-Down Mode

The CNT Changing Timing from Up count to Down count is shown in Figure 14-12. Conditions of this example are

- (i) Module System clock :1GHz
- (ii) Count Up/Down Timing:1GHz

The CNT first value in countdown operation is same as the CNT last value in count up operation. This means CMP_MAX value is kept in two cycles of the CNT Count Up/Down Timing.

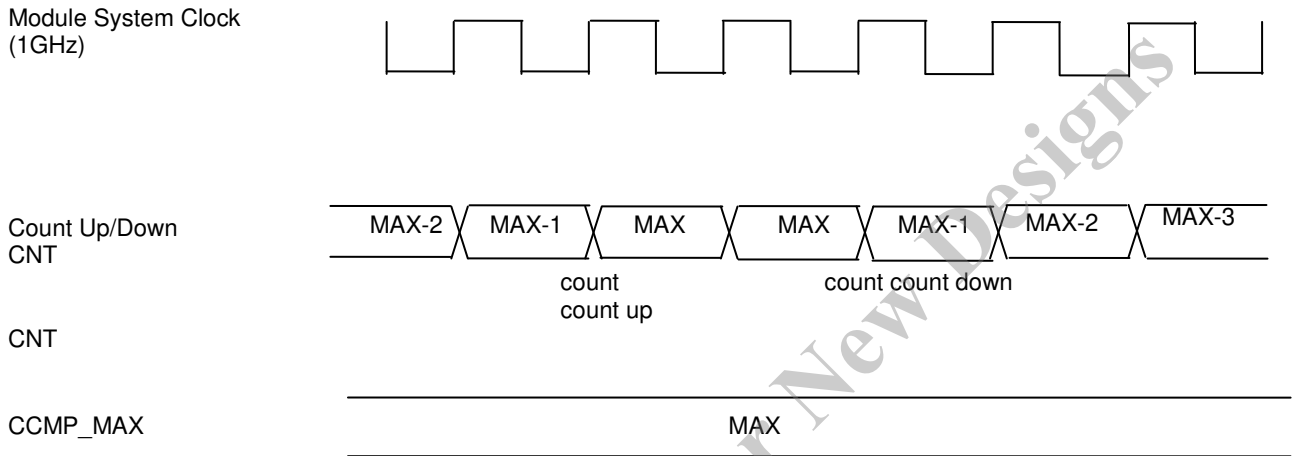


Figure 14-12 Counter Up to Down Change Timing in Up-Down Mode

Not Recommended for New Designs

(4) CNT Down to Up changing Timing in Up-Down Mode

The CNT Changing Timing from Down count to Up count is shown in Figure 14-13. Conditions of this example are

- (i) Module System clock :1GHz
- (ii) Count Up/Down Timing:1GHz

The CNT first value in count up operation is same as the CNT last value in countdown operation. This means CMP_MIN value is kept in two cycles of the CNT Count Up/Down Timing.

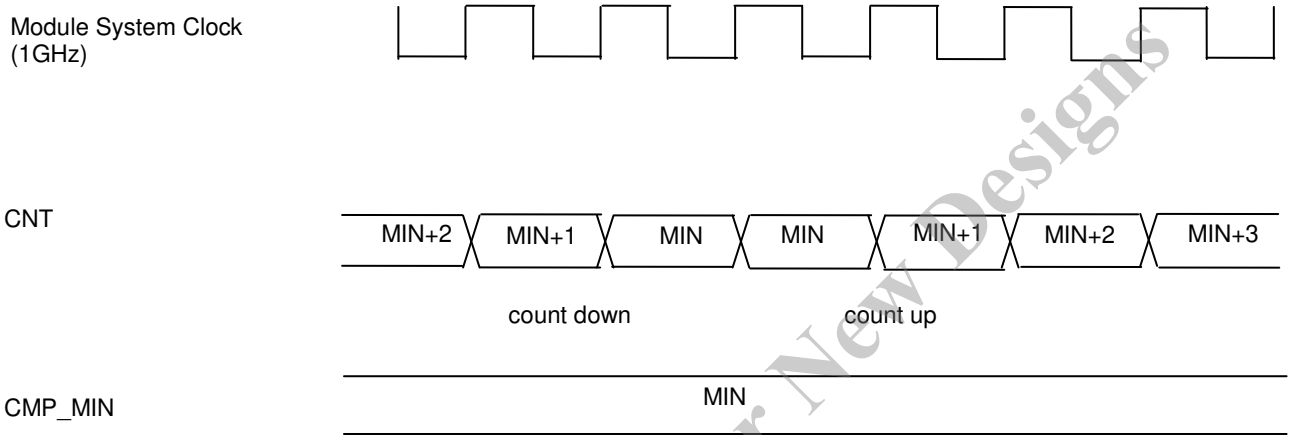


Figure 14-13 Counter Down to Up Change Timing in Up-Down Mode

Not Recommended for New Designs

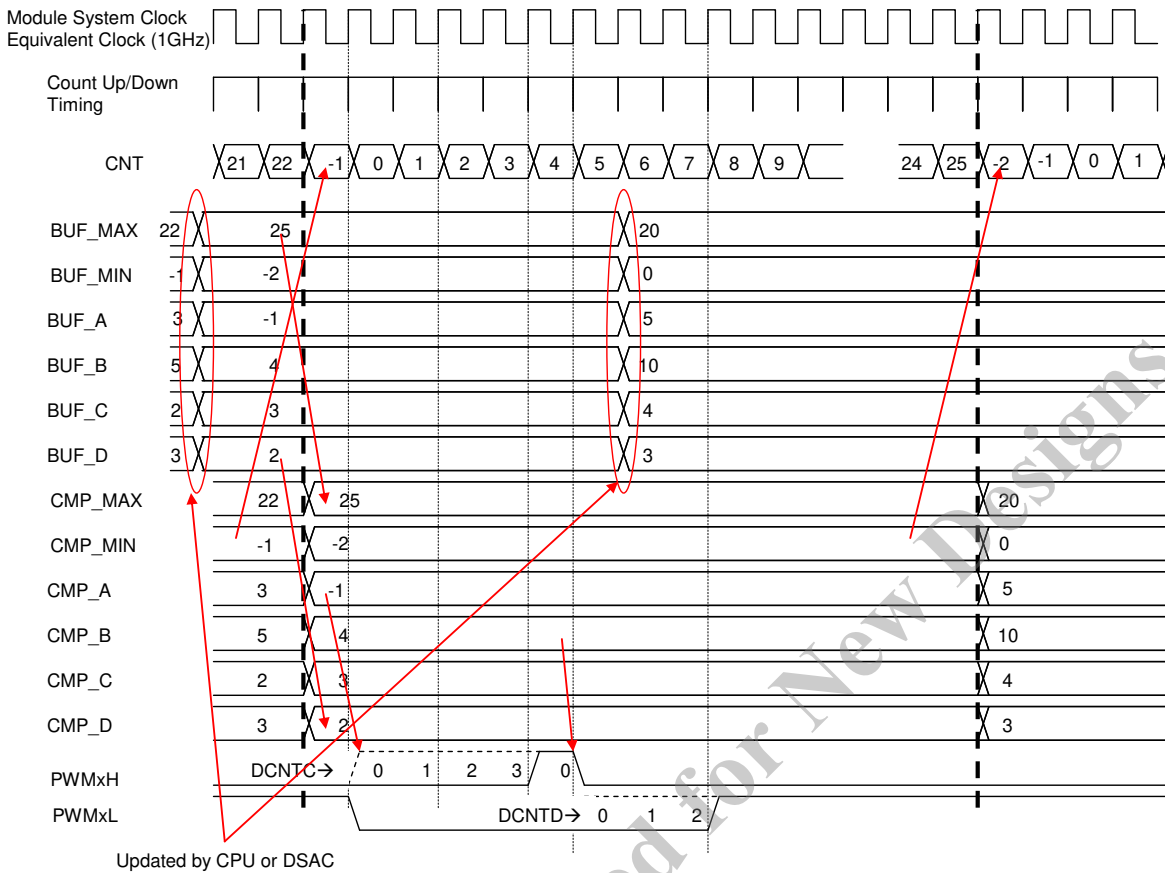


Figure 14-14 Example Operation (PWM Mode 1 + Auto Dead Time Mode 0 + Up Mode + Buffer Mode)

NOTE1: Compare Match Judges should be executed every time, even just after re-load CNT.

NOTE2: Minimum Pulse width should be a period of counter updating (+/-1) clock (1ns at 1GHz). Very narrow pulse width might be disappeared due to rise/fall time.

NOTE3: Actual toggling on PWMxH and PWMxL has latency delay from internal compare match events.

14.8 Re-Trigger Operations

Each counter block can be configured as Re-Trigger operation Mode. Each Output Signal or Counter value can be retriggered by specified events. There are five Re-trigger operations, Mode A/B/C/D and Mask operation, which can control output levels of both PWMxH and PWMxL.

14.8.1 Events for re-trigger

There are sixteen Events for re-trigger as shown in Table 14-4.

Table 14-4 Events for Re-trigger

No.	Source	Note
0	CPU Access	
1	reserved	
2	Trigger Pulse from Timer0_CMA	
3	Trigger Pulse from Timer1_CMA	
4	Trigger Pulse from Comparator 0	
5	Trigger Pulse from Comparator 1	
6	Trigger Pulse from Comparator 2	
7	Trigger Pulse from Comparator 3	
8	Event Positive Edge Signal from GPIO0	
9	Event Positive Edge Signal from GPIO1	
10	Event Positive Edge Signal from GPIO2	
11	Event Positive Edge Signal from GPIO3	
12	Event Negative Edge Signal from GPIO0	
13	Event Negative Edge Signal from GPIO1	
14	Event Negative Edge Signal from GPIO2	
15	Event Negative Edge Signal from GPIO3	

14.8.2 Re-Trigger Operation Mode A

In Re-Trigger Operation Mode A, the counter block operation will be as follows.

When specified event is detected, each PWM output signal will be changed to specified level, detail description of changing method is described in 14.8.7. And this status will continue without comparison operation until user stops the counter (CNT).

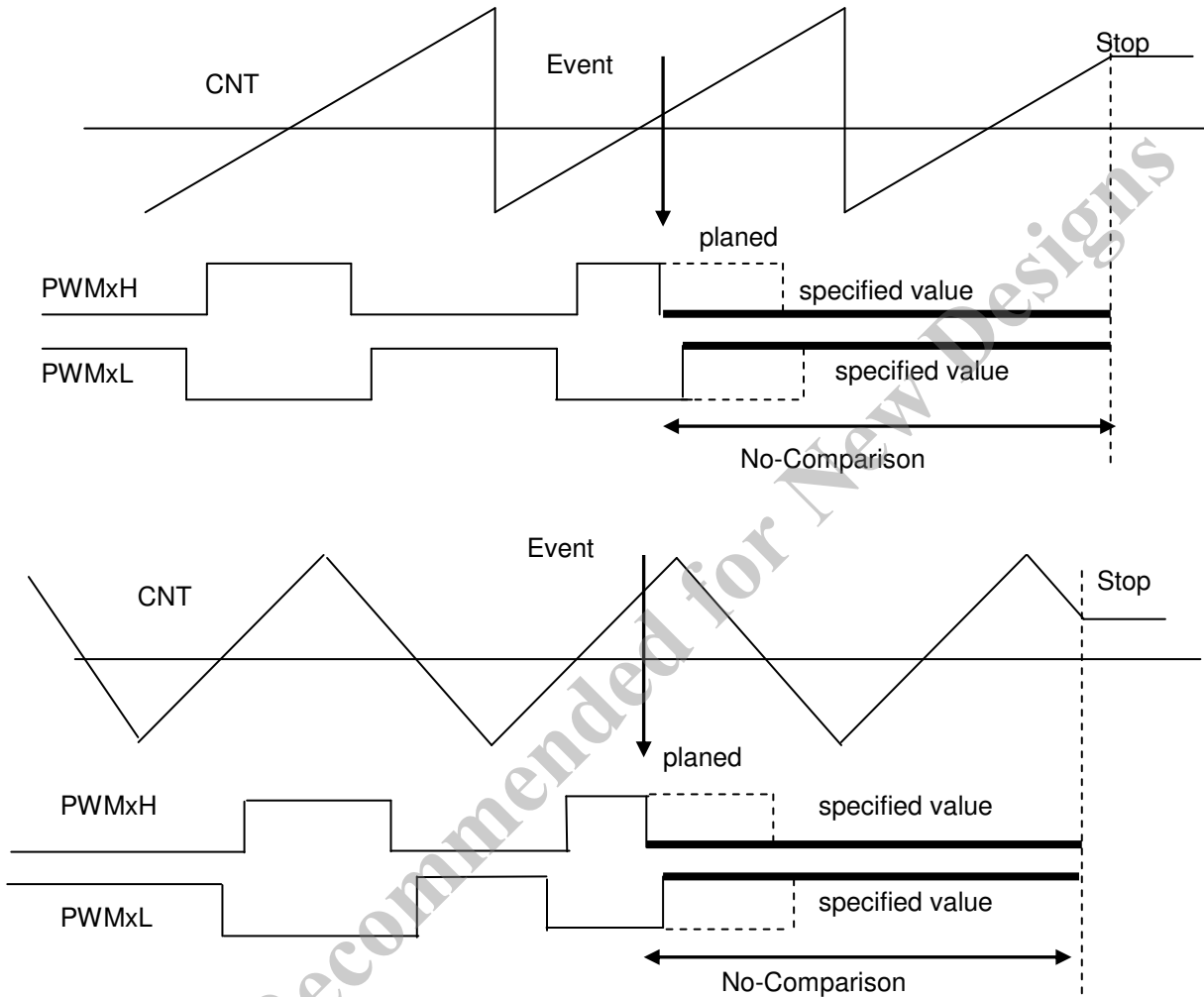


Figure 14-15 Re-Trigger Operation Mode A

14.8.3 Re-Trigger Operation Mode B

In Re-Trigger Operation Mode B, the counter block operation will be as follows.

When specified event is detected, each PWM output signal will be changed to specified level, detail description of changing method is described in 14.8.7. And this status will continue without comparison operation until the counter (CNT) reaches CMP_MIN. From the timing at $CNT == CMP_MIN$, the normal comparison operation starts again.

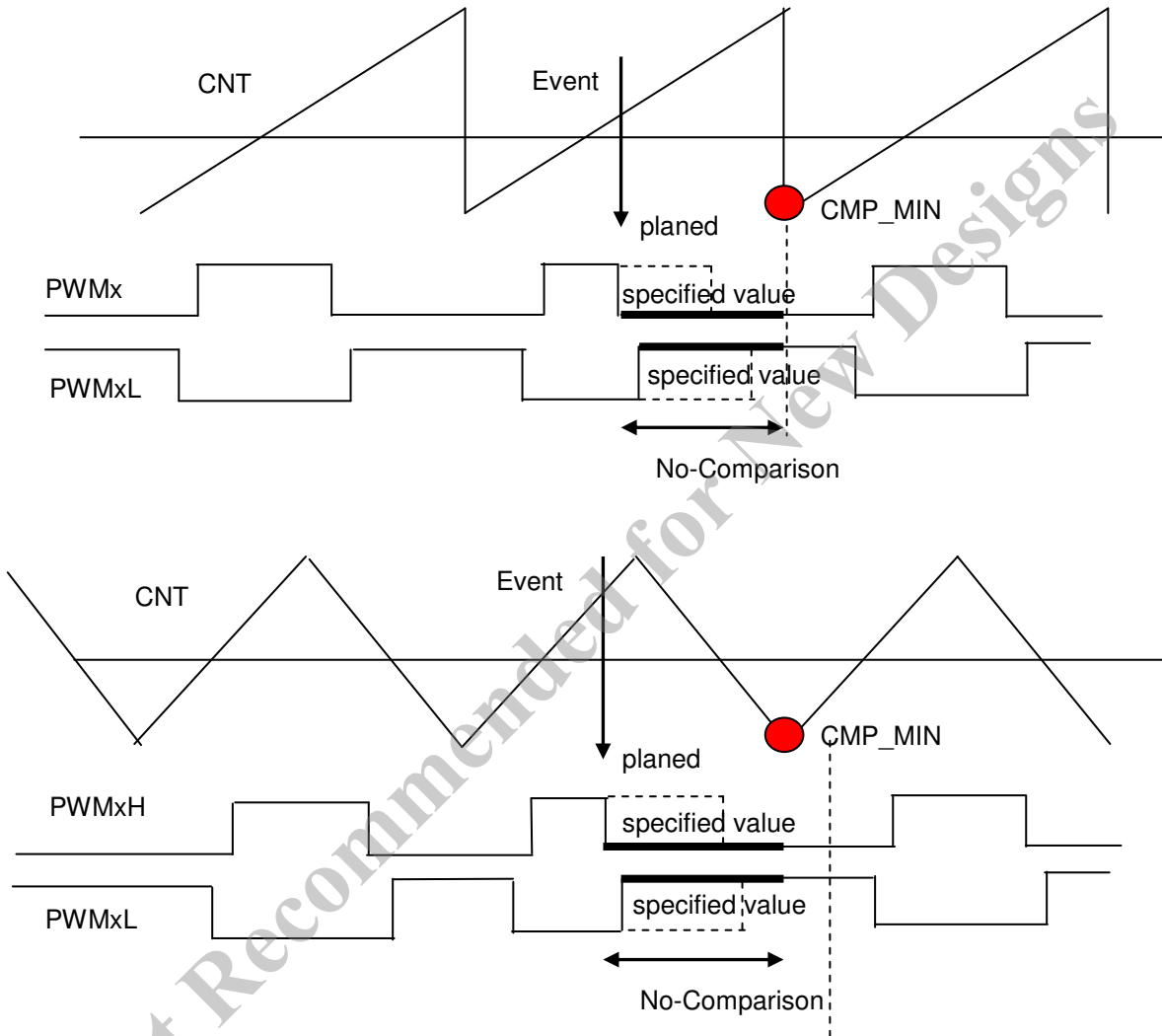


Figure 14-16 Re-Trigger Operation Mode B

14.8.4 Re-Trigger Operation Mode C

In Re-Trigger Operation Mode C, the counter block operation will be as follows.

When specified event is detected, each PWM output signal will be changed to specified level. And the counter (CNT) is immediately changed to as follows.

- (1) Up-Mode: Changed to CMP_MIN.
- (2) Up-Down Mode and during Up-Counting: Changed to CMP_MAX.
- (3) Up-Down Mode and during Down-Counting: Changed to CMP_MIN.

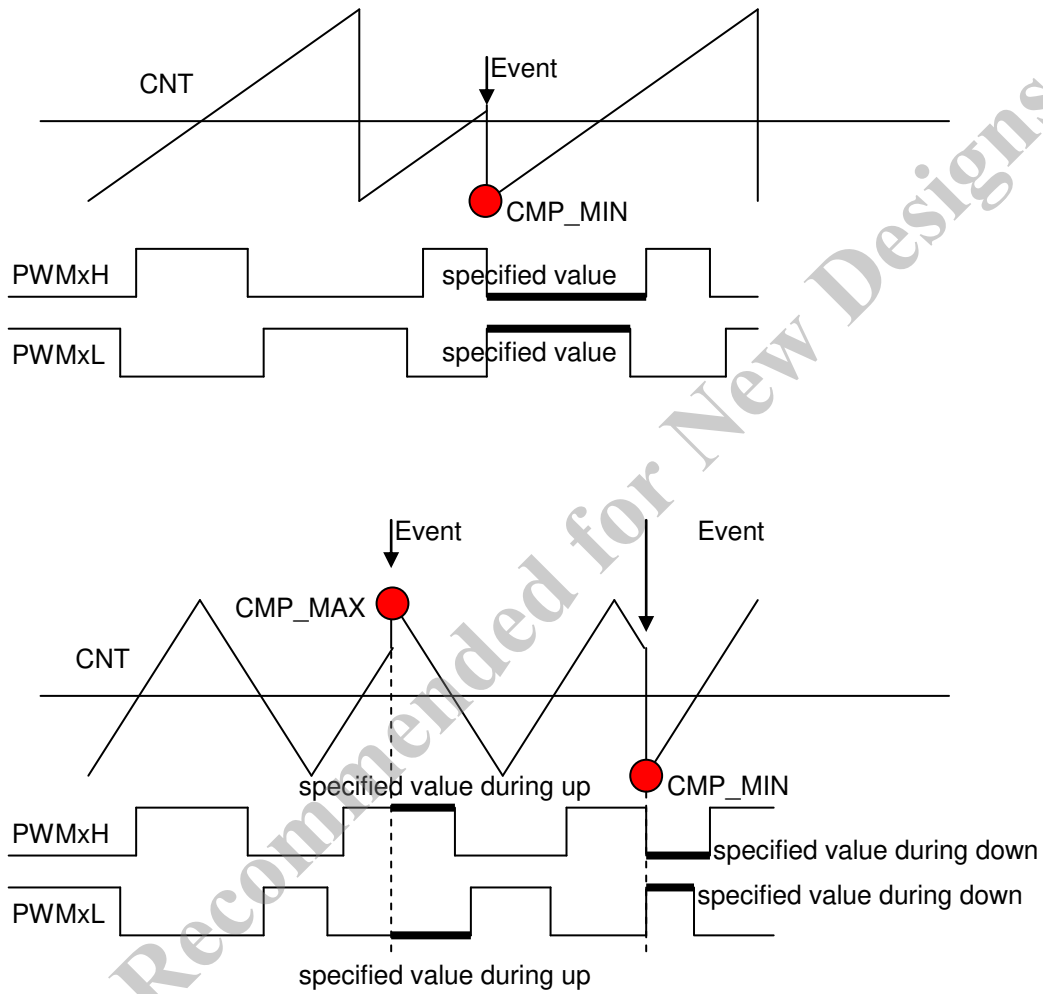
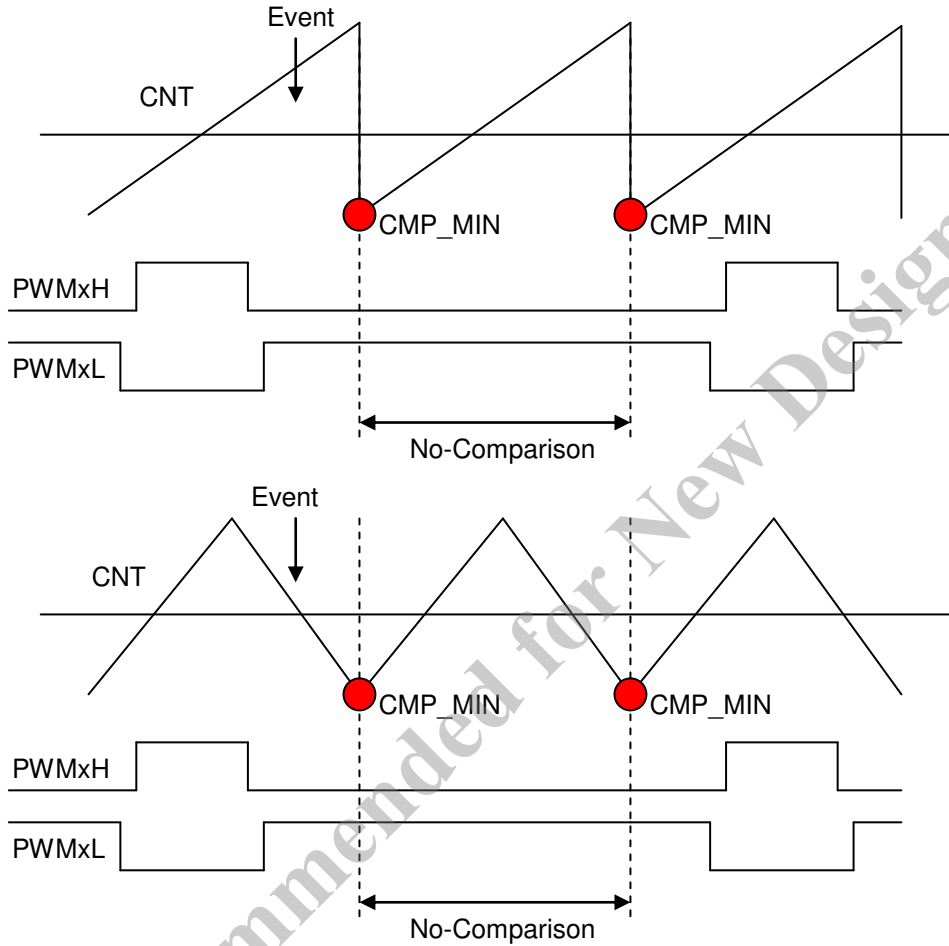


Figure 14-17 Re-Trigger Operation C

14.8.5 Re-Trigger Operation D

In Re-Trigger Operation Mode D, the counter block operation will be as follows.

When specified event is detected, during next counter (CNT) cycle from CMP_MIN to next CMP_MIN will not have comparison operation.



*When Event occurs during No-Comparison period, No-Comparison period will be extended.

Figure 14-18 Re-Trigger Operation D

14.8.6 Re-Trigger Mask Operation

Re-Trigger event can be masked (ignored) if user desires. Start point of mask period is selected from output signal edges (PWMxH or PWMxL, rise or fall). Length of mask period is defined as Cycles of [Count Clock Frequency / 8] [Count Clock Frequency / 16] or [Count Clock Frequency / 32].

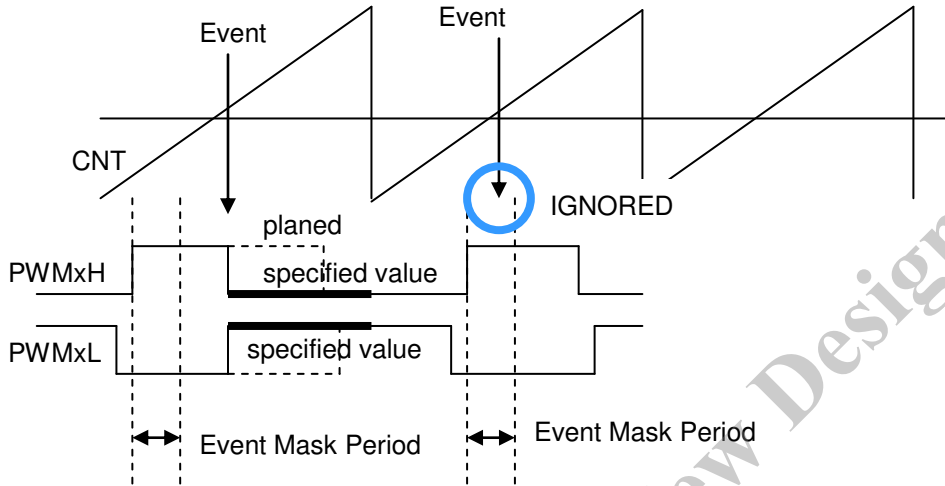


Figure 14-19 Re-Trigger Operation D

14.8.7 Detail method to change Waveform Level by Re-Trigger

According to PWM Mode, the Waveform Levels are changed by following manner.
 Specified value VTH is fix level for PWMxH and is determined by setting PWMnRTL.
 Specified value VTL is fix level for PWMxL and is determined by setting PWMnRTL.

Table 14-5 Method to change Waveform Level by Re-Trigger

Mode	PWMxH	PWMxL	Note
PWM Mode 0	Immediately Changed to specified value VTH.	Immediately Changed to specified value VTL.	
PWM Mode 1 Auto Dead Time Mode 0	Immediately Changed to specified value VTH. Start DCNTD from 0 until CMP_D, and clear it.	If DCND is matched to CMP_D, changed to VTL.	
PWM Mode 1 Auto Dead Time Mode 1	If DCND is matched to CMP_D, changed to VTH.	Immediately Changed to specified value VTL. Start DCNTD from 0 until CMP_D, and clear it.	
PWM Mode 2	Immediately Changed to specified value VTH.	Immediately Changed to specified value VTL.	
PWM Mode 3 Auto Dead Time Mode 0	Immediately Changed to specified value VTH. Start DCNTD from 0 until CMP_D, and clear it.	If DCND is matched to CMP_D, changed to VTL.	
PWM Mode 3 Auto Dead Time Mode 1	If DCND is matched to CMP_D, changed to VTH.	Immediately Changed to specified value VTL. Start DCNTD from 0 until CMP_D, and clear it.	

Note: For both Up-Mode and Up-Down-Mode.

14.9 Event Output

Each counter block has 3 event outputs.

- PWMn EVENT0
- PWMn EVENT1
- PWMn TIMERSYNC (which resets Timer's Counter Value)

Each event can be selected from compare matches shown below.

- CMP_MIN
- CMP_MAX
- VH1 match
- VH0 match
- VL1 match
- VL0 match
- Re-trigger(T)

CMP_MIN event does not occur when UP count mode.

14.10 Interrupt Output

Each counter block has 2 interrupt outputs.

- PWMnINT0
- PWMnINT1

Each interrupt can be selected from compare matches shown below.

- CMP_MIN
- CMP_MAX
- VH1 match
- VH0 match
- VL1 match
- VL0 match
- Re-trigger(T)

CMP_MIN interrupt does not occur when UP count mode.

14.11 Register Access

In the module, there are several 16bit registers such as BUF_xx, CMP_xx and CNT. When CPU or DSAC writes to these register, it should write LSB side register first. In the Low side write operation, the write value is stored in a dedicated temporary register, and when High side register is written next, the value in temporary register is transferred to Low side simultaneously. By this scheme, the entire bits in 16bit register are updated at same time.

Regarding 16bit width register of PWM assigned in SFR area, each Low Side (LSB Side) register and High Side (MSB Side) register for 16bit value is assigned on SAME address.

Regarding 16bit width register of PWM assigned in XDATA-Bus area, each Low Side (LSB Side) register and High Side (MSB Side) register for 16bit value is assigned independent contiguous address. The Low Side is on lower address, the High Side is on higher address, which follows Little-Endian manner.

Following operation is still important in Timer Function.

Regarding 16bit width register of PWM assigned in not only SFR area but also Data Area, in write access, 1st writing on the address reaches to Temporary Register for Low Side and 2nd writing reaches to High Side. At this 2nd access, Temporary and High Side data are transferred to both Low Side and High Side registers. In read access, 1st access gets Low Side data to the bus and High Side data to temporary register, and then 2nd read access receives High Side data from temporary register.

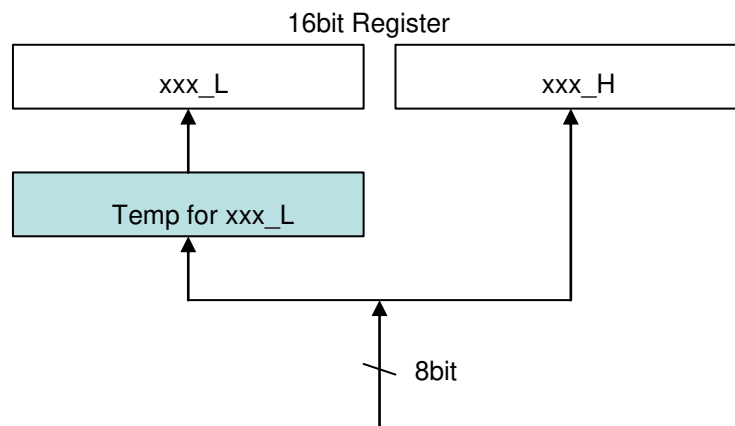


Figure 14-20 Scheme for writing 16 bit register

PWMnACSTS.XREGACS bit is the write access flag for XBUS register.

When PWMnACSTS.XREGACS=1, the XDATA-Bus register write operation is on-going. The next new write operation cannot be accepted. PWMnACSTS.XREGACS is set to 1'b1 when one of the PWMnH/LCR0/1, PWMnMODE, PWMnRTx and the High Side of CNTn, CMP_xxx and BUF_MIN/MAX is written. Please write these register when PWMnACSTS.XREGACS=0.

PWMnACSTS.SFRACS bit is the write access flag for SFRs. When PWMnACSTS.SFRACS=1, the SFR write operation is on-going. PWMnACSTS.XREGACS is set to 1'b1 when the High Side of BUF_A/B/C/D register is written. BUF_A/B/C/D registers can be written sequentially only once when PWMnACSTS.SFRACS=1. For example, writing BUF_Ax_L -> BUF_Ax_H -> BUF_Bx_L -> BUF_Bx_H -> BUF_Cx_L -> BUF_Cx_H -> BUF_Dx_L -> BUF_Dx_H can be accepted. The re-writing BUF_A/B/C/D register after previous BUF_A/B/C/D register write operation must be executed after confirming PWMnACSTS.SFRACS=0.

The previous XDATA-Bus register and SFR write operation spends 6 CPUCLKs + 24 PWM counter clocks.

14.12 Register Description

Table 14-6 XDATA-Bus common registers

Symbol	Address	Initial value
PWMENBL	0xF900	0x00
PWMCSC0	0xF901	0x33
PWMCSC1	0xF902	0x33
PWMCNTS	0xF903	0x00

Table 14-7 XDATA-Bus registers (each channel)

Symbol (CH n)	Address (CH 0)	Address (CH 1)	Address (CH 2)	Address (CH 3)	Initial value
PWMnCSS	0xF904	0xF944	0xF984	0xF9C4	0x00
PWMnEVO0	0xF905	0xF945	0xF985	0xF9C5	0x00
PWMnEVO1	0xF906	0xF946	0xF986	0xF9C6	0x00
PWMnCVOT	0xF907	0xF947	0xF987	0xF9C7	0x00
PWMnINTS0	0xF908	0xF948	0xF988	0xF9C8	0x00
PWMnINTS1	0xF909	0xF949	0xF989	0xF9C9	0x00
PWMnINTF	0xF90A	0xF94A	0xF98A	0xF9CA	0x00
PWMnACCLR	0xF90B	0xF94B	0xF98B	0xF9CB	0x00
PWMnACSTS	0xF90C	0xF94C	0xF98C	0xF9CC	0x00
CNTn_L	0xF910	0xF950	0xF990	0xF9D0	0x00
CNTn_H	0xF911	0xF951	0xF991	0xF9D1	0x00
CMP_An_L	0xF912	0xF952	0xF992	0xF9D2	0x00
CMP_An_H	0xF913	0xF953	0xF993	0xF9D3	0x00
CMP_Bn_L	0xF914	0xF954	0xF994	0xF9D4	0x00
CMP_Bn_H	0xF915	0xF955	0xF995	0xF9D5	0x00
CMP_Cn_L	0xF916	0xF956	0xF996	0xF9D6	0x00
CMP_Cn_H	0xF917	0xF957	0xF997	0xF9D7	0x00
CMP_Dn_L	0xF918	0xF958	0xF998	0xF9D8	0x00

Symbol (CH n)	Address (CH 0)	Address (CH 1)	Address (CH 2)	Address (CH 3)	Initial value
CMP_Dn_H	0xF919	0xF959	0xF999	0xF9D9	0x00
CMP_MINn_L	0xF91A	0xF95A	0xF99A	0xF9DA	0x00
CMP_MINn_H	0xF91B	0xF95B	0xF99B	0xF9DB	0x00
CMP_MAXn_L	0xF91C	0xF95C	0xF99C	0xF9DC	0x00
CMP_MAXn_H	0xF91D	0xF95D	0xF99D	0xF9DD	0x00
PWMnCNTMD	0xF920	0xF960	0xF9A0	0xF9E0	0x00
PWMnHCR0	0xF921	0xF961	0xF9A1	0xF9E1	0x00
PWMnLCR0	0xF922	0xF962	0xF9A2	0xF9E2	0x00
PWMnHCR1	0xF923	0xF963	0xF9A3	0xF9E3	0x00
PWMnLCR1	0xF924	0xF964	0xF9A4	0xF9E4	0x00
PWMnMODE	0xF925	0xF965	0xF9A5	0xF9E5	0x00
PWMnRTRG	0xF926	0xF966	0xF9A6	0xF9E6	0x00
PWMnRTRS	0xF927	0xF967	0xF9A7	0xF9E7	0x00
PWMnRTGC	0xF928	0xF968	0xF9A8	0xF9E8	0x00
PWMnRTL	0xF929	0xF969	0xF9A9	0xF9E9	0x00
PWMnRTMC	0xF92A	0xF96A	0xF9AA	0xF9EA	0x00
PWMnRTMP	0xF92B	0xF96B	0xF9AB	0xF9EB	0x00
BUF_MINn_L	0xF92C	0xF96C	0xF9AC	0xF9EC	0x00
BUF_MINn_H	0xF92D	0xF96D	0xF9AD	0xF9ED	0x00
BUF_MAXn_L	0xF92E	0xF96E	0xF9AE	0xF9EE	0x00
BUF_MAXn_H	0xF92F	0xF96F	0xF9AF	0xF9EF	0x00

Table 14-8 SFRs (each channel)

Symbol (CH n)	Address (CH 0)	Address (CH 1)	Address (CH 2)	Address (CH 3)	Initial value
BUF_An_L	0xE4	0xEC	0xF4	0xFC	0x00
BUF_An_H	0xE4	0xEC	0xF4	0xFC	0x00
BUF_Bn_L	0xE5	0xED	0xF5	0xFD	0x00
BUF_Bn_H	0xE5	0xED	0xF5	0xFD	0x00
BUF_Cn_L	0xE6	0xEE	0xF6	0xFE	0x00
BUF_Cn_H	0xE6	0xEE	0xF6	0xFE	0x00
BUF_Dn_L	0xE7	0xEF	0xF7	0xFF	0x00
BUF_Dn_H	0xE7	0xEF	0xF7	0xFF	0x00

14.12.1 PWMENBL

Register		PWMENBL		PWM Enable Control		Address	0xF900
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	PWMDE	R/W	0	Enable Counter Clock Source A~D 0: Disable 1: Enable			
2	PWMCE	R/W	0				
1	PWMBE	R/W	0				
0	PWMAE	R/W	0				

14.12.2 PWMCS0

Register		PWMCS0		PWM Clock Source Control 0		Address	0xF901
Bit	Bit Name	R/W	Initial	Description		Note	
7	PWMCCB[3]	R/W	0	Clock source B Clock select			
6	PWMCCB[2]	R/W	0	Counter Clock Frequency = PLL2 Clock / (2 ^ PWMCCB[3:0]) (Max 1GHz)			
5	PWMCCB[1]	R/W	1				
4	PWMCCB[0]	R/W	1			Note: PWMCCB[3:0] should be 0x0~0x8. Do not set 0x9~0xF.	
3	PWMCCA[3]	R/W	0	Clock source A Clock select			
2	PWMCCA[2]	R/W	0	Counter Clock Frequency = PLL2 Clock / (2 ^ PWMCCA[3:0]) (Max 1GHz)			
1	PWMCCA[1]	R/W	1				
0	PWMCCA[0]	R/W	1	Note: PWMCCA[3:0] should be 0x0~0x8. Do not set 0x9~0xF.			

14.12.3 PWMCS1

Register		PWMCS1		PWM Clock Source Control 1		Address	0xF902
Bit	Bit Name	R/W	Initial	Description		Note	
7	PWMCCD[3]	R/W	0	Clock source D Clock select Counter Clock Frequency = PLL2 Clock / (2 ^ PWMCCD[3:0]) (Max 1GHz) Note: PWMCCD[3:0] should be 0x0~0x8. Do not set 0x9~0xF.			
6	PWMCCD[2]	R/W	0				
5	PWMCCD[1]	R/W	1				
4	PWMCCD[0]	R/W	1				
3	PWMCCC[3]	R/W	0	Clock source C Clock select Counter Clock Frequency = PLL2 Clock / (2 ^ PWMCCC[3:0]) (Max 1GHz) Note: PWMCCC[3:0] should be 0x0~0x8. Do not set 0x9~0xF.			
2	PWMCCC[2]	R/W	0				
1	PWMCCC[1]	R/W	1				
0	PWMCCC[0]	R/W	1				

Note:

If PWMCCx[3:0] == 0x0, Counter Clock is PLL2 Clock (Max 1GHz).

If PWMCCx[3:0] == 0x1, Counter Clock is PLL2 Clock / 2

If PWMCCx[3:0] == 0x2, Counter Clock is PLL2 Clock / 4

...

If PWMCCx[3:0] == 0x7, Counter Clock is PLL2 Clock / 128

If PWMCCx[3:0] == 0x8, Counter Clock is PLL2 Clock / 256

If PWMCCx[3:0] == 0x9, Counter Clock is PLL2 Clock / 256

...

If PWMCCx[3:0] == 0xF, Counter Clock is PLL2 Clock / 256

14.12.4 PWMCNTS

Register	PWMCNTS		PWM Counter Start		Address	0xF903
Bit	Bit Name	R/W	Initial	Description	Note	
7	reserved	R	0	Read value is 0. Write only 0.		
6	reserved	R	0	Read value is 0. Write only 0.		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	PWMCSD	R/W	0	Source Clock Group D Counter Start/Stop 0: Stop 1: Start		
2	PWMCSC	R/W	0	Source Clock Group C Counter Start/Stop 0: Stop 1: Start		
1	PWMCSE	R/W	0	Source Clock Group B Counter Start/Stop 0: Stop 1: Start		
0	PWMCSE	R/W	0	Source Clock Group A Counter Start/Stop 0: Stop 1: Start		

The PWM channel counters which select the same clock source, can start simultaneously (synchronized). All of counters which select the same Clock source x(A/B/C/D) start by writing PWMCSx bit.

14.12.5 PWMnCSS (n=0~3)

Register	PWM0CSS	PWM Clock Source Select for Block0		Address	0xF904
Register	PWM1CSS	PWM Clock Source Select for Block1		Address	0xF944
Register	PWM2CSS	PWM Clock Source Select for Block2		Address	0xF984
Register	PWM3CSS	PWM Clock Source Select for Block3		Address	0xF9C4
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	PWMCSS1	R/W	0	Clock Source Select 00: Clock Source A 01: Clock Source B 10: Clock Source C 11: Clock Source D	
0	PWMCSS0	R/W	0		

14.12.6 PWMnEVO0/1/T (n=0~3)

Register	PWM0EVO0	PWM Event0 Output for Block 0	Address	0xF905	
Register	PWM1EVO0	PWM Event0 Output for Block 1	Address	0xF945	
Register	PWM2EVO0	PWM Event0 Output for Block 2	Address	0xF985	
Register	PWM3EVO0	PWM Event0 Output for Block 3	Address	0xF9C5	
Register	PWM0EVO1	PWM Event1 Output for Block 0	Address	0xF906	
Register	PWM1EVO1	PWM Event1 Output for Block 1	Address	0xF946	
Register	PWM2EVO1	PWM Event1 Output for Block 2	Address	0xF986	
Register	PWM3EVO1	PWM Event1 Output for Block 3	Address	0xF9C6	
Register	PWM0EVOT	PWM Event to Timer for Block 0	Address	0xF907	
Register	PWM1EVOT	PWM Event to Timer for Block 1	Address	0xF947	
Register	PWM2EVOT	PWM Event to Timer for Block 2	Address	0xF987	
Register	PWM3EVOT	PWM Event to Timer for Block 3	Address	0xF9C7	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	EVT_T	R/W	0	Event Output Source The Event Output is generated from ORed compare match events of CMP_xx. These bits set to 1 select corresponding event source to be ORed. Output event signal is pulse shape.	
5	EVT_VH1	R/W	0		
4	EVT_VH0	R/W	0		
3	EVT_VL1	R/W	0		
2	EVT_VL0	R/W	0		
1	EVT_MAX	R/W	0		
0	EVT_MIN	R/W	0		

14.12.7 PWMnINTS0/1(n=0~3)

Register	PWM0INTS0	PWM Interrupt 0 Select for Block 0	Address	0xF908	
Register	PWM1INTS0	PWM Interrupt 0 Select for Block 1	Address	0xF948	
Register	PWM2INTS0	PWM Interrupt 0 Select for Block 2	Address	0xF988	
Register	PWM3INTS0	PWM Interrupt 0 Select for Block 3	Address	0xF9C8	
Register	PWM0INTS1	PWM Interrupt 1 Select for Block 0	Address	0xF909	
Register	PWM1INTS1	PWM Interrupt 1 Select for Block 1	Address	0xF949	
Register	PWM2INTS1	PWM Interrupt 1 Select for Block 2	Address	0xF989	
Register	PWM3INTS1	PWM Interrupt 1 Select for Block 3	Address	0xF9C9	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	INT_T	R/W	0	Interrupt Source The Interrupt Flag is set from ORed compare match events of CMP_xx. These bits set to 1 select corresponding interrupt source to be ORed.	
5	INT_VH1	R/W	0		
4	INT_VH0	R/W	0		
3	INT_VL1	R/W	0		
2	INT_VL0	R/W	0		
1	INT_MAX	R/W	0		
0	INT_MIN	R/W	0		

Not Recommended for New Designs

14.12.8 PWMnINTF(n=0~3)

Register	PWM0INTF	PWM Interrupt Flag for Block 0		Address	0xF90A
Register	PWM1INTF	PWM Interrupt Flag for Block 1		Address	0xF94A
Register	PWM2INTF	PWM Interrupt Flag for Block 2		Address	0xF98A
Register	PWM3INTF	PWM Interrupt Flag for Block 3		Address	0xF9CA
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	PWMIE1	R/W	0	Enable PWM Interrupt 1 0: Disable PWM Interrupt 1 1: Enable PWM Interrupt 1 (If both PWMIE1 and PEMIF1 are set, the interrupt request is generated.)	
4	PWMIE0	R/W	0	Enable PWM Interrupt 0 0: Disable PWM Interrupt 0 1: Enable PWM Interrupt 0 (If both PWMIE0 and PEMIF0 are set, the interrupt request is generated.)	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	PWMIF1	R/C	0	PWM Interrupt Flag 1 Read 0: No request Read 1: Interrupt event selected by PWMxINTS1 is detected. Write 0: No effect Write 1: Clear the flag.	
0	PWMIF0	R/C	0	PWM Interrupt Flag 0 Read 0: No request Read 1: Interrupt event selected by PWMxINTS0 is detected. Write 0: No effect Write 1: Clear the flag.	

14.12.9 PWMnACCLR (n=0~3)

Register	PWM0ACCLR		PWM Access Counter Clear Register for Block0	Address	0xF90B
Register	PWM1ACCLR		PWM Access Counter Clear Register for Block1	Address	0xF94B
Register	PWM2ACCLR		PWM Access Counter Clear Register for Block2	Address	0xF98B
Register	PWM3ACCLR		PWM Access Counter Clear Register for Block3	Address	0xF9CB
Bit	Bit Name	R/W	Initial	Description	Note
7	CLRCPUACC	W	0	Clear SFR Access counter for CPU 0: No effect 1: Register CPU Access counter clear Read : No Request Write 0: No effect Write 1: Clear Register CPU Access counter. (Clear SFR access counter for CPU.)	
6	CLRDSAACC	W	0	Clear SFR Access counter for DSAC 0: No effect 1: Register DSAC Access counter clear Read : No Request Write 0: No effect Write 1: Clear Register DSAC Access counter. (Clear SFR access counter for DSAC.)	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0.	
0	reserved	R	0	Read value is 0. Write only 0.	

14.12.10 PWMnACSTS (n=0~3)

Register	PWM0ACSTS	PWM Access Status Register for Block0	Address	0xF90C	
Register	PWM1ACSTS	PWM Access Status Register for Block1	Address	0xF94C	
Register	PWM2ACSTS	PWM Access Status Register for Block2	Address	0xF98C	
Register	PWM3ACSTS	PWM Access Status Register for Block3	Address	0xF9CC	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	SFRACS	R	0	SFR Access flag 0: Not accessing a SFR 1: Writing a SFR In case of writing the same SFR sequentially, the following write access must be issued after confirming SFRACS=0.	
0	XREGACS	R	0	REG Access flag 0: Not accessing a SFR 1: Writing a SFR Please confirm XREGACS=0 before writing to XBUS register.	

14.12.11 CNTn(n=0~3)

Register	CNT0_L	Counter 0 LSB Side	Address	0xF910	
Register	CNT1_L	Counter 1 LSB Side	Address	0xF950	
Register	CNT2_L	Counter 2 LSB Side	Address	0xF990	
Register	CNT3_L	Counter 3 LSB Side	Address	0xF9D0	
Bit	Bit Name	R/W	Initial	Description	Note
7:0	CNT[7:0]	R/W	0	Counter LSB Side	

Register	CNT0_H	Counter 0 MSB Side	Address	0xF911	
Register	CNT1_H	Counter 1 MSB Side	Address	0xF951	
Register	CNT2_H	Counter 2 MSB Side	Address	0xF991	
Register	CNT3_H	Counter 3 MSB Side	Address	0xF9D1	
Bit	Bit Name	R/W	Initial	Description	Note
7:0	CNT[15:8]	R/W	0	Counter MSB Side	

Note: Address assignment for xxx_H and xxx_L should be based on “14.11 Register Access”. Other registers should follow same manner.

Do not write this register during PWMnACSTS.XREGACS=1.

Not Recommended for New Designs

14.12.12 CMP_xxxn(n=0~3)

Register	CMP_MIN0_L	CMP_MIN for Block 0 LSB Side		Address	0xF91A
Register	CMP_MIN1_L	CMP_MIN for Block 1 LSB Side		Address	0xF95A
Register	CMP_MIN2_L	CMP_MIN for Block 2 LSB Side		Address	0xF99A
Register	CMP_MIN3_L	CMP_MIN for Block 3 LSB Side		Address	0xF9DA
Register	CMP_MAX0_L	CMP_MAX for Block 0 LSB Side		Address	0xF91C
Register	CMP_MAX1_L	CMP_MAX for Block 1 LSB Side		Address	0xF95C
Register	CMP_MAX2_L	CMP_MAX for Block 2 LSB Side		Address	0xF99C
Register	CMP_MAX3_L	CMP_MAX for Block 3 LSB Side		Address	0xF9DC
Register	CMP_A0_L	CMP_A for Block 0 LSB Side		Address	0xF912
Register	CMP_A1_L	CMP_A for Block 1 LSB Side		Address	0xF952
Register	CMP_A2_L	CMP_A for Block 2 LSB Side		Address	0xF992
Register	CMP_A3_L	CMP_A for Block 3 LSB Side		Address	0xF9D2
Register	CMP_B0_L	CMP_B for Block 0 LSB Side		Address	0xF914
Register	CMP_B1_L	CMP_B for Block 1 LSB Side		Address	0xF954
Register	CMP_B2_L	CMP_B for Block 2 LSB Side		Address	0xF994
Register	CMP_B3_L	CMP_B for Block 3 LSB Side		Address	0xF9D4
Register	CMP_C0_L	CMP_C for Block 0 LSB Side		Address	0xF916
Register	CMP_C1_L	CMP_C for Block 1 LSB Side		Address	0xF956
Register	CMP_C2_L	CMP_C for Block 2 LSB Side		Address	0xF996
Register	CMP_C3_L	CMP_C for Block 3 LSB Side		Address	0xF9D6
Register	CMP_D0_L	CMP_D for Block 0 LSB Side		Address	0xF918
Register	CMP_D1_L	CMP_D for Block 1 LSB Side		Address	0xF958
Register	CMP_D2_L	CMP_D for Block 2 LSB Side		Address	0xF998
Register	CMP_D3_L	CMP_D for Block 3 LSB Side		Address	0xF9D8
Bit	Bit Name	R/W	Initial	Description	Note
7:0	CMP_xxx [7:0]	R/W	0	CMP_xxx LSB Side	

Do not write this register during PWMnACSTS.XREGACS=1.

Register	CMP_MIN0_H	CMP_MIN for Block 0 MSB Side		Address	0xF91B
Register	CMP_MIN1_H	CMP_MIN for Block 1 MSB Side		Address	0xF95B
Register	CMP_MIN2_H	CMP_MIN for Block 2 MSB Side		Address	0xF99B
Register	CMP_MIN3_H	CMP_MIN for Block 3 MSB Side		Address	0xF9DB
Register	CMP_MAX0_H	CMP_MAX for Block 0 MSB Side		Address	0xF91D
Register	CMP_MAX1_H	CMP_MAX for Block 1 MSB Side		Address	0xF95D
Register	CMP_MAX2_H	CMP_MAX for Block 2 MSB Side		Address	0xF99D
Register	CMP_MAX3_H	CMP_MAX for Block 3 MSB Side		Address	0xF9DD
Register	CMP_A0_H	CMP_A for Block 0 MSB Side		Address	0xF913
Register	CMP_A1_H	CMP_A for Block 1 MSB Side		Address	0xF953
Register	CMP_A2_H	CMP_A for Block 2 MSB Side		Address	0xF993
Register	CMP_A3_H	CMP_A for Block 3 MSB Side		Address	0xF9D3
Register	CMP_B0_H	CMP_B for Block 0 MSB Side		Address	0xF915
Register	CMP_B1_H	CMP_B for Block 1 MSB Side		Address	0xF955
Register	CMP_B2_H	CMP_B for Block 2 MSB Side		Address	0xF995
Register	CMP_B3_H	CMP_B for Block 3 MSB Side		Address	0xF9D5
Register	CMP_C0_H	CMP_C for Block 0 MSB Side		Address	0xF917
Register	CMP_C1_H	CMP_C for Block 1 MSB Side		Address	0xF957
Register	CMP_C2_H	CMP_C for Block 2 MSB Side		Address	0xF997
Register	CMP_C3_H	CMP_C for Block 3 MSB Side		Address	0xF9D7
Register	CMP_D0_H	CMP_D for Block 0 MSB Side		Address	0xF919
Register	CMP_D1_H	CMP_D for Block 1 MSB Side		Address	0xF959
Register	CMP_D2_H	CMP_D for Block 2 MSB Side		Address	0xF999
Register	CMP_D3_H	CMP_D for Block 3 MSB Side		Address	0xF9D9
Bit	Bit Name	R/W	Initial	Description	Note
7:0	CMP_XXX [15:8]	R/W	0	CMP_XXX MSB Side	

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.13 PWMnCNTMD(n=0~3)

Register	PWM0CNTMD	PWM Counter Mode for Block0	Address	0xF920	
Register	PWM1CNTMD	PWM Counter Mode for Block1	Address	0xF960	
Register	PWM2CNTMD	PWM Counter Mode for Block2	Address	0xF9A0	
Register	PWM3CNTMD	PWM Counter Mode for Block3	Address	0xF9E0	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0.	
0	PWMCM	R/W	0	Counter Block 3~0 Mode 0: Up Mode 1: Up-Down Mode	

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.14 PWMnHCR0(n=0~3)

Register	PWM0HCR0	PWM0H Output Control 0	Address	0xF921	
Register	PWM1HCR0	PWM1H Output Control 0	Address	0xF961	
Register	PWM2HCR0	PWM2H Output Control 0	Address	0xF9A1	
Register	PWM3HCR0	PWM3H Output Control 0	Address	0xF9E1	
Bit	Bit Name	R/W	Initial	Description	Note
7	PWM_MAX1	R/W	0	Output Control at CMP_MAX match for PWMxH 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
6	PWM_MAX0	R/W	0		
5	PWM_MIN1	R/W	0	Output Control at CMP_MIN match for PWMxH. Effective only in up-down counter mode. 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
4	PWM_MIN0	R/W	0		
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	PWM_SET1	W	0	Initialize Output Level for PWMxH 00: No Change (NOP) 01: Set Low 10: Set High 11: do not write Write to these bits will change output level with the higher priority than any other compare matches which change output level. Read values of these bits are always Zero.	
0	PWM_SET0	W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.15 PWMnLCR0(n=0~3)

Register	PWM0LCR0	PWM0L Output Control 0	Address	0xF922	
Register	PWM1LCR0	PWM1L Output Control 0	Address	0xF962	
Register	PWM2LCR0	PWM2L Output Control 0	Address	0xF9A2	
Register	PWM3LCR0	PWM3L Output Control 0	Address	0xF9E2	
Bit	Bit Name	R/W	Initial	Description	Note
7	PWM_MAX1	R/W	0	Output Control at CMP_MAX match for PWMxL 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
6	PWM_MAX0	R/W	0		
5	PWM_MIN1	R/W	0	Output Control at CMP_MIN match for PWMxL. Effective only in up-down counter mode. 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
4	PWM_MIN0	R/W	0		
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	PWM_SET1	W	0	Initialize Output Level for for PWMxL 00: No Change (NOP) 01: Set Low 10: Set High 11: do not write Write to these bits will change output level with the higher priority than any other compare matches which change output level. Read values of these bits are always Zero.	
0	PWM_SET0	W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.16 PWMnHCR1 (n=0~3)

Register	PWM0HCR1	PWM0H Output Control 1	Address	0xF923	
Register	PWM1HCR1	PWM1H Output Control 1	Address	0xF963	
Register	PWM2HCR1	PWM2H Output Control 1	Address	0xF9A3	
Register	PWM3HCR1	PWM3H Output Control 1	Address	0xF9E3	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	VH1[1]	R/W	0	Output Level VH1 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
2	VH1[0]	R/W	0		
1	VH0[1]	R/W	0	Output Level VH0 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
0	VH0[0]	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.17 PWMnLCR1 (n=0~3)

Register	PWM0LCR1	PWM0L Output Control 1	Address	0xF924	
Register	PWM1LCR1	PWM1L Output Control 1	Address	0xF964	
Register	PWM2LCR1	PWM2L Output Control 1	Address	0xF9A4	
Register	PWM3LCR1	PWM3L Output Control 1	Address	0xF9E4	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	VL1[1]	R/W	0	Output Level VL1 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
2	VL1[0]	R/W	0		
1	VL0[1]	R/W	0	Output Level VL0 00: No Change (NOP) 01: Set Low 10: Set High 11: Toggle	
0	VL0[0]	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.18 PWMnMODE (n=0~3)

Register	PWM0MODE	PWM0 Operation Mode	Address	0xF925	
Register	PWM1MODE	PWM1 Operation Mode	Address	0xF965	
Register	PWM2MODE	PWM2 Operation Mode	Address	0xF9A5	
Register	PWM3MODE	PWM3 Operation Mode	Address	0xF9E5	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADM	R/W	0	Auto Dead Time Mode 0: Auto Dead Time Mode 0 1: Auto Dead Time Mode 1 (Effective only in PWM Mode 1, 3)	
6	BUFM	R/W	0	Buffer Mode 0: Direct Mode 1: Buffer Mode (Effective only in PWM Mode 0, 1) (PWM Mode 2, 3 are usually in Buffer Mode regardless of this bit.)	
5	UDMB1	R/W	0	Buffering Timing in Up-Down Mode In Up-Down Mode, specify which timings are the transfer timing from BUFxx to CMPxx. {PWMxBT1:PWMxBT0} 00: reserved 01: Top Timing 10: Bottom Timing 11: Both Top and Bottom Timing This field has its meaning only in Up-Down Mode and Buffer Mode. Note: In Up Mode, transfer timing from BUFxx to CMPxx is only at the counter clear timing.	
4	UDBM0	R/W	0		
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	PWMMD1	R/W	0	PWM Mode 00: PWM Mode 0 01: PWM Mode 1 10: PWM Mode 2 11: PWM Mode 3	
0	PWMMD0	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.19 PWMnRTRG(n=0~3)

Register	PWM0RTRG	PWM Re-Trigger Mode for Block 0		Address	0xF926
Register	PWM1RTRG	PWM Re-Trigger Mode for Block 1		Address	0xF966
Register	PWM2RTRG	PWM Re-Trigger Mode for Block 2		Address	0xF9A6
Register	PWM3RTRG	PWM Re-Trigger Mode for Block 3		Address	0xF9E6
Bit	Bit Name	R/W	Initial	Description	Note
7	PWMRTE	R/W	0	Re-Trigger Enable 0: Disable 1: Enable	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	PWMRTM1	R/W	0	Re-Trigger Mode 00: Re-Trigger Mode A 01: Re-Trigger Mode B 10: Re-Trigger Mode C 11: Re-Trigger Mode D	
0	PWMRTM0	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.20 PWMnRTRS (n=0~3)

Register	PWM0RTRS	PWM Re-Trigger Select for Block 0		Address	0xF927
Register	PWM1RTRS	PWM Re-Trigger Select for Block 1		Address	0xF967
Register	PWM2RTRS	PWM Re-Trigger Select for Block 2		Address	0xF9A7
Register	PWM3RTRS	PWM Re-Trigger Select for Block 3		Address	0xF9E7
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	PWMRTS3	R/W	0	Re-Trigger Event Select 0000: Event No.0 ~ 1111: Event No.15 See Table 14-4.	
2	PWMRTS2	R/W	0		
1	PWMRTS1	R/W	0		
0	PWMRTS0	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.21 PWMnRTGC (n=0~3)

Register	PWM0RTGC	PWM Re-Trigger by CPU for Block 0	Address	0xF928	
Register	PWM1RTGC	PWM Re-Trigger by CPU for Block 1	Address	0xF968	
Register	PWM2RTGC	PWM Re-Trigger by CPU for Block 2	Address	0xF9A8	
Register	PWM3RTGC	PWM Re-Trigger by CPU for Block 3	Address	0xF9E8	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0.	
0	PWMRTGC	R/S	0	CPU Re-Trigger Read Value is 0. Write 0 is NOP Write 1: Issue Re-trigger is PWMRTS is configured as Re-Trigger by CPU.	

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.22 PWMnRTL (n=0~3)

Register	PWM0RTL	PWM0 Re-Trigger Output Control	Address	0xF929	
Register	PWM1RTL	PWM1 Re-Trigger Output Control	Address	0xF969	
Register	PWM2RTL	PWM2 Re-Trigger Output Control	Address	0xF9A9	
Register	PWM3RTL	PWM3 Re-Trigger Output Control	Address	0xF9E9	
Bit	Bit Name	R/W	Initial	Description	Note
7	VTH_MAX[1]	R/W	0	PWMxH Output Control at Re-Trigger mode C for CMP_MAX 00: No Change (NOP) 01: Set Low 10: Set High 11: Don't set	
6	VTH_MAX[0]	R/W	0		
5	VTL_MAX[1]	R/W	0	PWMxL Output Control at Re-Trigger mode C for CMP_MAX 00: No Change (NOP) 01: Set Low 10: Set High 11: Don't set	
4	VTL_MAX[0]	R/W	0		
3	VTH[1]	R/W	0	PWMxH Output Control at Re-Trigger mode A and B PWMxH Output Control at Re-Trigger mode C for CMP_MIN 00: No Change (NOP) 01: Set Low 10: Set High 11: Don't set	
2	VTH[0]	R/W	0		
1	VTL[1]	R/W	0	PWMxL Output Control at Re-Trigger mode A and B PWMxL Output Control at Re-Trigger mode C for CMP_MIN 00: No Change (NOP) 01: Set Low 10: Set High 11: Don't set	
0	VTL[0]	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.23 PWMnRTMC (n=0~3)

Register	PWM0RTMC	PWM0 Re-Trigger Mask Control	Address	0xF92A	
Register	PWM1RTMC	PWM1 Re-Trigger Mask Control	Address	0xF96A	
Register	PWM2RTMC	PWM2 Re-Trigger Mask Control	Address	0xF9AA	
Register	PWM3RTMC	PWM3 Re-Trigger Mask Control	Address	0xF9EA	
Bit	Bit Name	R/W	Initial	Description	Note
7	RTME	R/W	0	Re-Trigger Mask Enable 0: Disable, 1: Enable	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	RTMC1	R/W	0	Re-Trigger Period Clock Source 00: [Count Clock Frequency / 8] 01: [Count Clock Frequency / 16] 10: [Count Clock Frequency / 32] 11: Reserved	
2	RTMC0	R/W	0		
1	RTMS1	R/W	0	Re-Trigger Mask Start Point 00: from PWMxH Rising Edge 01: from PWMxH Falling Edge 10: from PWMxL Rising Edge 11: from PWMxL Falling Edge	
0	RTMS0	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.24 PWMnRTMP (n=0~3)

Register	PWM0RTMP	PWM0 Re-Trigger Mask Period	Address	0xF92B	
Register	PWM1RTMP	PWM1 Re-Trigger Mask Period	Address	0xF96B	
Register	PWM2RTMP	PWM2 Re-Trigger Mask Period	Address	0xF9AB	
Register	PWM3RTMP	PWM3 Re-Trigger Mask Period	Address	0xF9EB	
Bit	Bit Name	R/W	Initial	Description	Note
7	RTMP7	R/W	0	Re-Trigger Mask Period Period = Cycle of Clock Source (specified by RTMC[1:0]) x (RTMP[7:0] + 1)	
6	RTMP6	R/W	0		
5	RTMP5	R/W	0		
4	RTMP4	R/W	0		
3	RTMP3	R/W	0		
2	RTMP2	R/W	0		
1	RTMP1	R/W	0		
0	RTMP0	R/W	0		

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.25 BUF_MIN/MAX_n(n=0~3)

Register	BUF_MIN0_L		BUF_MIN for Block 0 LSB Side	Address	0xF92C
Register	BUF_MIN1_L		BUF_MIN for Block 1 LSB Side	Address	0xF96C
Register	BUF_MIN2_L		BUF_MIN for Block 2 LSB Side	Address	0xF9AC
Register	BUF_MIN3_L		BUF_MIN for Block 3 LSB Side	Address	0xF9EC
Register	BUF_MAX0_L		BUF_MAX for Block 0 LSB Side	Address	0xF92E
Register	BUF_MAX1_L		BUF_MAX for Block 1 LSB Side	Address	0xF96E
Register	BUF_MAX2_L		BUF_MAX for Block 2 LSB Side	Address	0xF9AE
Register	BUF_MAX3_L		BUF_MAX for Block 3 LSB Side	Address	0xF9EE
Bit	Bit Name	R/W	Initial	Description	Note
7:0	BUF_XXX [7:0]	R/W	0	BUF_XXX LSB Side	

Do not write this register during PWMnACSTS.XREGACS=1.

Register	BUF_MIN0_H		BUF_MIN for Block 0 MSB Side	Address	0xF92D
Register	BUF_MIN1_H		BUF_MIN for Block 1 MSB Side	Address	0xF96D
Register	BUF_MIN2_H		BUF_MIN for Block 2 MSB Side	Address	0xF9AD
Register	BUF_MIN3_H		BUF_MIN for Block 3 MSB Side	Address	0xF9ED
Register	BUF_MAX0_H		BUF_MAX for Block 0 MSB Side	Address	0xF92F
Register	BUF_MAX1_H		BUF_MAX for Block 1 MSB Side	Address	0xF96F
Register	BUF_MAX2_H		BUF_MAX for Block 2 MSB Side	Address	0xF9AF
Register	BUF_MAX3_H		BUF_MAX for Block 3 MSB Side	Address	0xF9EF
Bit	Bit Name	R/W	Initial	Description	Note
7:0	BUF_XXX [15:8]	R/W	0	BUF_XXX MSB Side	

Do not write this register during PWMnACSTS.XREGACS=1.

14.12.26 BUF_A/B/C/Dn (n=0~3)

Register	BUF_A0_L	BUF_A for Block 0 LSB Side		Address	0xE4
Register	BUF_A1_L	BUF_A for Block 1 LSB Side		Address	0xEC
Register	BUF_A2_L	BUF_A for Block 2 LSB Side		Address	0xF4
Register	BUF_A3_L	BUF_A for Block 3 LSB Side		Address	0xFC
Register	BUF_B0_L	BUF_B for Block 0 LSB Side		Address	0xE5
Register	BUF_B1_L	BUF_B for Block 1 LSB Side		Address	0xED
Register	BUF_B2_L	BUF_B for Block 2 LSB Side		Address	0xF5
Register	BUF_B3_L	BUF_B for Block 3 LSB Side		Address	0xFD
Register	BUF_C0_L	BUF_C for Block 0 LSB Side		Address	0xE6
Register	BUF_C1_L	BUF_C for Block 1 LSB Side		Address	0xEE
Register	BUF_C2_L	BUF_C for Block 2 LSB Side		Address	0xF6
Register	BUF_C3_L	BUF_C for Block 3 LSB Side		Address	0xFE
Register	BUF_D0_L	BUF_D for Block 0 LSB Side		Address	0xE7
Register	BUF_D1_L	BUF_D for Block 1 LSB Side		Address	0xEF
Register	BUF_D2_L	BUF_D for Block 2 LSB Side		Address	0xF7
Register	BUF_D3_L	BUF_D for Block 3 LSB Side		Address	0xFF
Bit	Bit Name	R/W	Initial	Description	Note
7:0	BUF_xxx [7:0]	R/W	0	BUF_xxx LSB Side	

Register	BUF_A0_H	BUF_A for Block 0 MSB Side	Address	0xE4	
Register	BUF_A1_H	BUF_A for Block 1 MSB Side	Address	0xEC	
Register	BUF_A2_H	BUF_A for Block 2 MSB Side	Address	0xF4	
Register	BUF_A3_H	BUF_A for Block 3 MSB Side	Address	0xFC	
Register	BUF_B0_H	BUF_B for Block 0 MSB Side	Address	0xE5	
Register	BUF_B1_H	BUF_B for Block 1 MSB Side	Address	0xED	
Register	BUF_B2_H	BUF_B for Block 2 MSB Side	Address	0xF5	
Register	BUF_B3_H	BUF_B for Block 3 MSB Side	Address	0xFD	
Register	BUF_C0_H	BUF_C for Block 0 MSB Side	Address	0xE6	
Register	BUF_C1_H	BUF_C for Block 1 MSB Side	Address	0xEE	
Register	BUF_C2_H	BUF_C for Block 2 MSB Side	Address	0xF6	
Register	BUF_C3_H	BUF_C for Block 3 MSB Side	Address	0xFE	
Register	BUF_D0_H	BUF_D for Block 0 MSB Side	Address	0xE7	
Register	BUF_D1_H	BUF_D for Block 1 MSB Side	Address	0xEF	
Register	BUF_D2_H	BUF_D for Block 2 MSB Side	Address	0xF7	
Register	BUF_D3_H	BUF_D for Block 3 MSB Side	Address	0xFF	
Bit	Bit Name	R/W	Initial	Description	Note
7:0	BUF_xxx [15:8]	R/W	0	BUF_xxx MSB Side	

BUF_xn_H/L registers are mapped same address. The first access to its address is for BUF_xn_L, the second access is for BUF_xn_H.

In case of writing the same SFR sequentially, the following write access must be issued after confirming SFRACS=0. PWMnACSSTS.SFRSTS does not become 1 by writing to BUF_xn_L register.

14.13 Caution of Operation

14.13.1 Restrictions about Auto Dead Time Mode of PWM

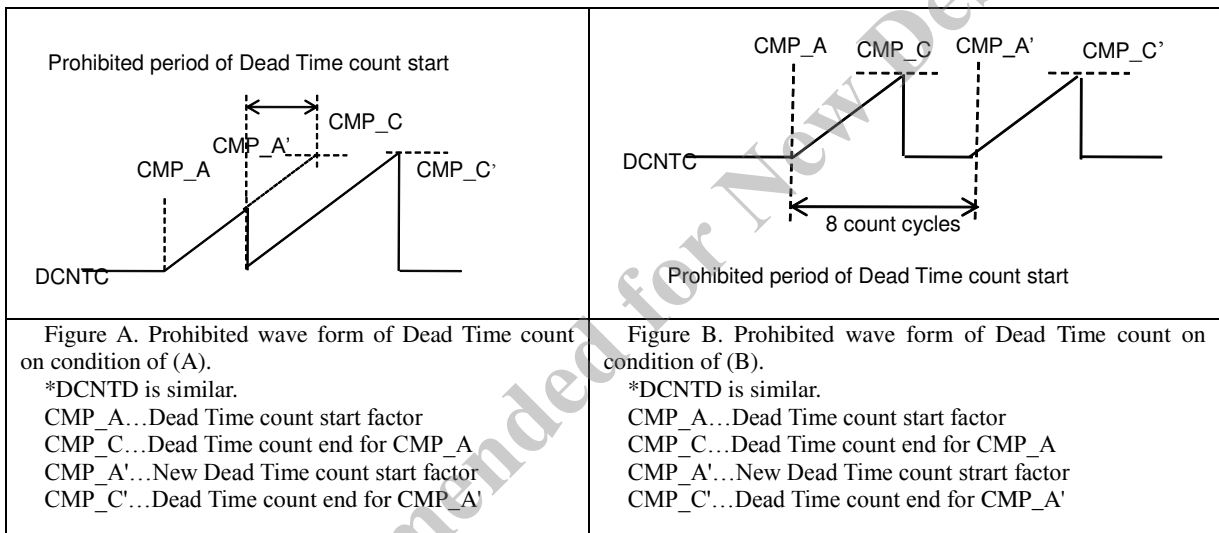
(1) Description

When PWM is operating in Auto Dead Time Mode(PWMnMODE.PWMMD[1: 0]='b01 or 'b11), the count operation of the Dead Time counter is not performed correctly when one of the following conditions is satisfied. As a result, Compare match is not detected correctly between Dead Time counter and Compare Match registers. So, Output waveform of PWM, interrupt signal from PWM and an event from PWM by compare match of the above operation are not generated correctly.

(2) Conditions

(Case A) While Dead Time counter is operating, another event, which starts Dead Time Counting again, exists within a 1-8 count cycles earlier than end timing of Dead Time Counting (Figure A) :

(Case B) When PWM Counter is in Up mode(PWMnCNTMD.PWMCM='b0), start timings of same Dead Time Counter exist more than two times within 8 count cycles (Figure B) :



(3) Countermeasure

(A) As a countermeasure of condition A, please apply either of following two methods.

- Do not start Dead Time count again, during it is still incrementing.
- If Dead Time Counter should start again during it is still incrementing, Dead Time counter should be started again earlier than 8 count cycles before Dead Time counting would be finished.

(B) As a countermeasure of condition B, please take interval between first Dead Time count start timing and a second count start timing of Dead Time Counter more than 8 count cycles.

14.13.2 Restriction about PWM Mode 2/3 (Phase Shift Mode)

(1) Description

When PWM is used in Mode 2 or 3 (PWMnMODE.PWMMD[1:0] = 'b01 or 'b11), Update of CMP_B by CMP_A match and Update of CMP_D by CMP_C may not be expected if the following conditions are met.

(2) Conditions

(A) When the differences between CMP_MIN register and CMP_A/C register are smaller than 8 counts;
 $CMP_A/C - CMP_MIN < 8$

(B) When the value of CMP_A and BUF_A register are not equal, or the value of CMP_C register and BUF_C register are not equal.

$(CMP_A \neq BUF_A) \text{ or } (CMP_C \neq BUF_C)$

(3) Countermeasure

Please configure that CMP_A and CMP_C register meet the following conditions.

- i) $CMP_A - CMP_MIN \geq 8$
- ii) $CMP_C - CMP_MIN \geq 8$

PWM Mode2 and 3 work in Buffer Mode. Therefore, it is necessary for the BUF_A and BUF_C register to meet the following conditions.

- iii) $BUF_A - CMP_MIN \geq 8$
- iv) $BUF_C - CMP_MIN \geq 8$

The value of BUF_MIN register is copied to CMP_MIN register when $CNT == CMP_MAX$. Therefore, please also set the BUF_MIN with satisfying above conditions (i~iv) while PWM is operating.

Not Recommended for New Designs

14.13.3 Restriction about PWM Re-Trigger Mode

(1) Description

(A) During “No-Comparison” period of Re-Trigger Mode A/B/D;

- Each pin level of PWMxL/H is not changed by each compare match.
- Each event output is not generated by each compare match.
- Each Interrupt Flag(PWMINTF.PWMIF0/1) is not set by each compare match.
- Each Dead Time counter starts normally even in the period of “No-Comparison”.
- Each CMP-x register in buffer mode are updated normally in the period of “No-Comparison”

(B) During “No-Comparison” period of Re-Trigger B;

- End timing of “No-Comparison” period delays maximum 8count cycles from CMP_MIN.
- CMP_MIN event during “No-Comparison” period is not detected.

(C) During “No-Comparison” period of Re-Trigger D;

- Start timing of “No-Comparison” period delays maximum 8count cycles from CMP_MIN.
- End timing of “No-Comparison” period delays maximum 8count cycles from CMP_MIN.
- While CMP_MIN event at start timing of “No-Comparison” period is detected, CMP_MIN event at end timing of “No-Comparison” period is NOT detected.

Figure 14-21 shows “No-Comparison” period of retrigger mode B/D.

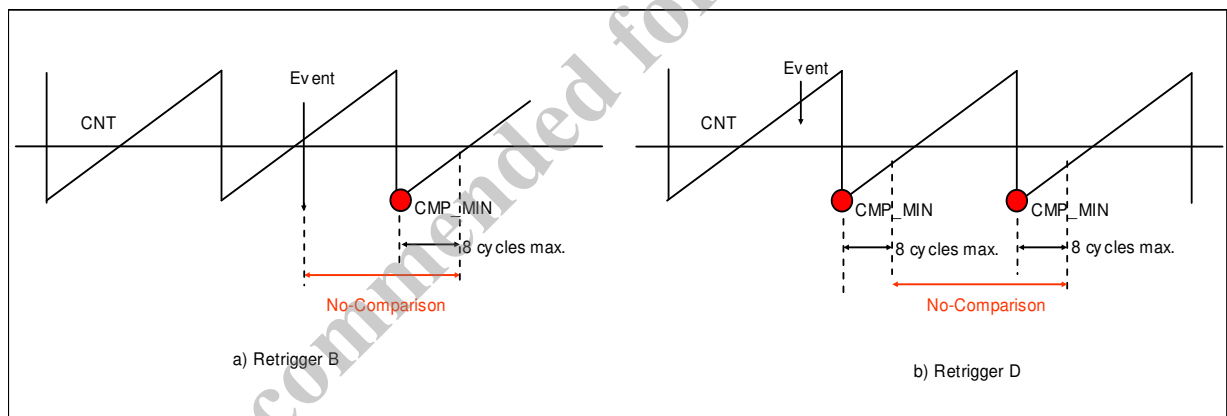


Figure 14-21 No-Comparison period

14.13.4 Restriction about PWM Re-Trigger Mask

(1) Description

The start timing of Re-Trigger Mask is 4-20 count cycles earlier than toggle timing of PWM output pin which is selected by PWMxRTMC.RTMS[1:0] bit.

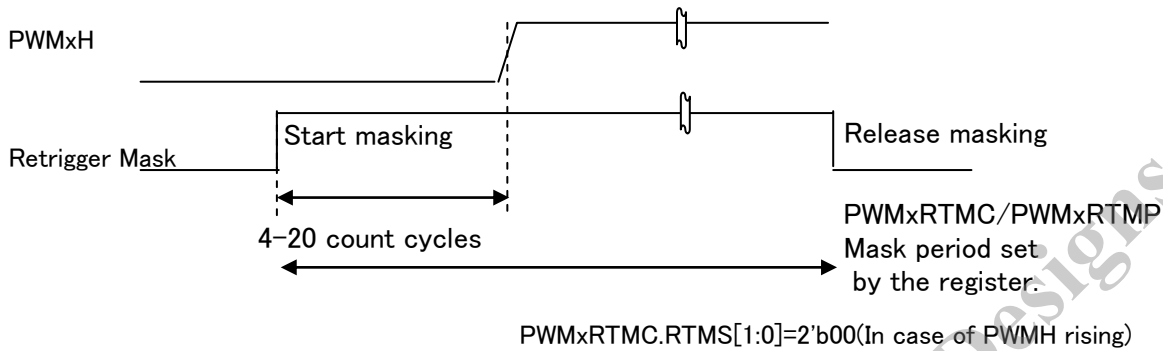


Figure 14-22 Retrigger Mask Timing

Control logic which judges the start of Re-Trigger Mask does not directly watch toggle operation of PWM output terminal itself, but watches internal state of PWM module.

This internal state reflects PWM output terminal after more than 4 count cycles at least.

The maximum delay between the internal state for PWM toggle control and start timing of Re-Trigger Mask is about 20 count cycles, which depends on semiconductor process, power supply voltage and ambient temperature, though.

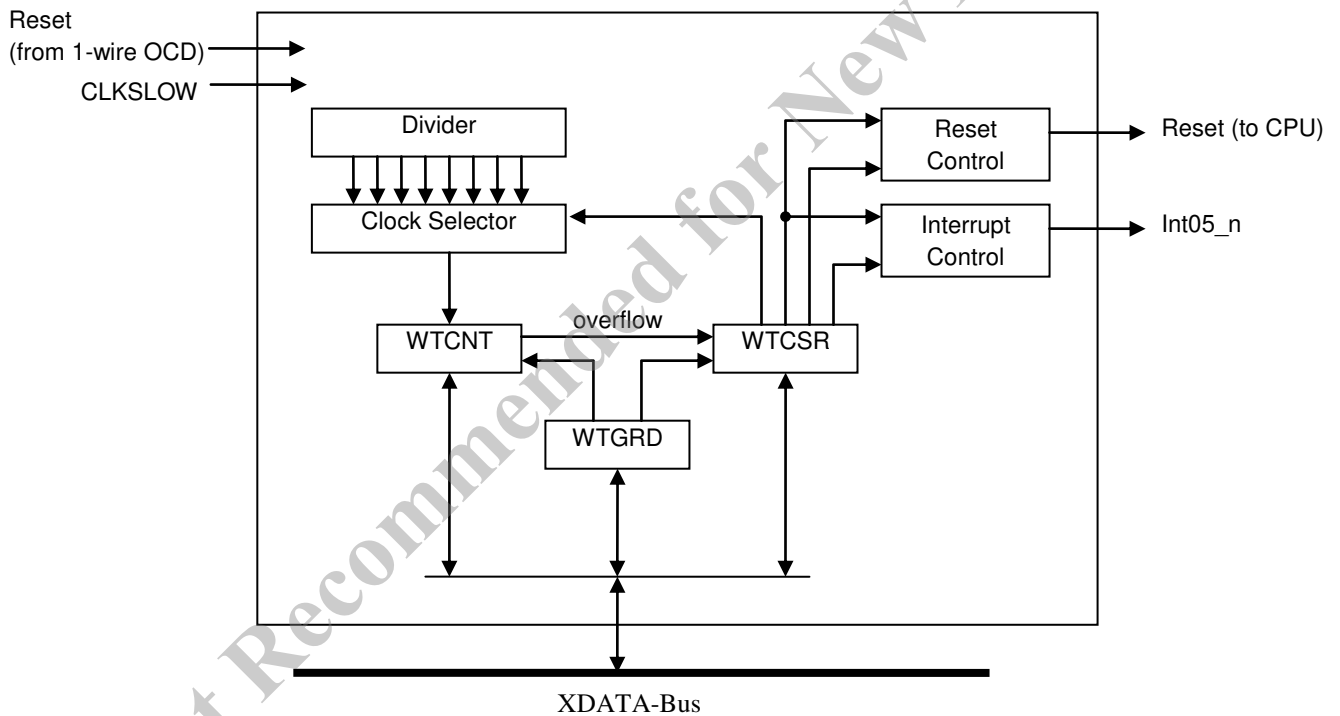
Please set the Re-Trigger Mask procedure with considering above.

15. Watch Dog Timer

15.1 Overview

Overview of the WDT module is described below.

- WDT is a timer that monitors timer counter to prevent system from crash.
- There is the watchdog timer mode and interval timer mode.
- In watchdog timer mode, if timer overflows, internal modules are reset.
- In interval timer mode, if timer overflows, interval timer interrupt is generated.
- It is necessary for WDT to set a predetermined value to the guard register, because the register will not be rewritten easily.
- Maximum time to overflow the counter takes about 11 seconds at CLK_SLOW = 25MHz.



*Resets refer to Figure 4-1

Figure 15-1 WDT Block Diagram

15.2 Register Description

Table 15-1 WDT Control Registers

Symbol	Name	Address	initial value
WTCNT	Watchdog Timer Counter	0xFE80	0x00
WTCSR	Watchdog Timer Control/Status	0xFE81	0x00
WTGRD	Watchdog Timer Reg. access GUARD	0xFE82	0x00

15.2.1 WDT Control register

Register		WTCNT		Watchdog Timer Counter		Address	0xFE80
Bit	Bit Name	R/W	Initial	Description		Note	
7	WTCNT[7:0]	R/W	0	Set WDT counter start value. When an overflow occurs, it generates a reset in watchdog timer mode and an interrupt in interval time mode.			
6							
5							
4							
3							
2							
1							
0							

When TME is set to 1, WTCNT starts counting by the internal clock being selected in CKS[2:0] bits of WTCR. When TME is set to 0, WTCR holds the counter value and WTCNT stops counting.

When the instruction execution of CPU is stopped by the OCD(e.g. STOP or the resource access of the LSI command is issued by OCD), WTCNT stops counting.

Register		WTCR		Watchdog Timer Control/Status		Address	0xFE81
Bit	Bit Name	R/W	Initial	Description		Note	
7	TME	R/W	0	Timer enable 0: Count-up stops and WTCNT value is retained. 1: Timer enabled			
6	TM	R/W	0	Timer Mode 0: Used as Interval timer 1: Used as Watchdog timer			
5	Reserved	R	0	Read value is 0. Write only 0.			
4	WOVF	R/C	0	Watchdog Timer Overflow Read 0: No overflow 1: WTCNT has overflowed in watchdog timer mode Write 0: not clear 1: this bit clear			
3	IOVF	R/C	0	Interval Timer Overflow Read 0: No overflow 1: WTCNT has overflowed in interval timer mode Write 0: not clear 1: Clear this bit			
2-0	CKS[2:0]	R/W	0	WTCNT Clock Select Division Ratio Period(CLKSLOW=25MHz) 000: 1/(2 ¹³) 328us 001: 1/(2 ¹⁴) 655us 010: 1/(2 ¹⁵) 1.31ms 011: 1/(2 ¹⁶) 2.62ms 100: 1/(2 ¹⁷) 5.24ms 101: 1/(2 ¹⁸) 10.5ms 110: 1/(2 ¹⁹) 21.0ms 111: 1/(2 ²⁰) 41.9ms			

- Before switching the CKS[2:0], TME is cleared to 0, and WTCNT is stops counting.
- When WTCNT overflows, xOVF is not initialized by the FLC_RST_N(WDT_INT_N). Therefore, WOVF(IOVF) must be cleared after FLC_RST_N(WDT_INT_N) negated.

Register	WTGRD		Watchdog Timer Reg. access GUARD		Address	0xFE82
Bit	Bit Name	R/W	Initial	Description	Note	
7	WTGRD[7:0]	R/W	0	Key code should be written into WTGRD in order to write value into WTCNT/WTCSR. Initial value 00 or other should be written into WTCNT. Setting data for operation mode should be written into WTCSR. After written into WTCNT/WTCSR, WTGRD should be cleared. key code WTCNT : 0x5A WTCSR : 0xA5		
6						
5						
4						
3						
2						
1						
0						

15.3 Reset diagram

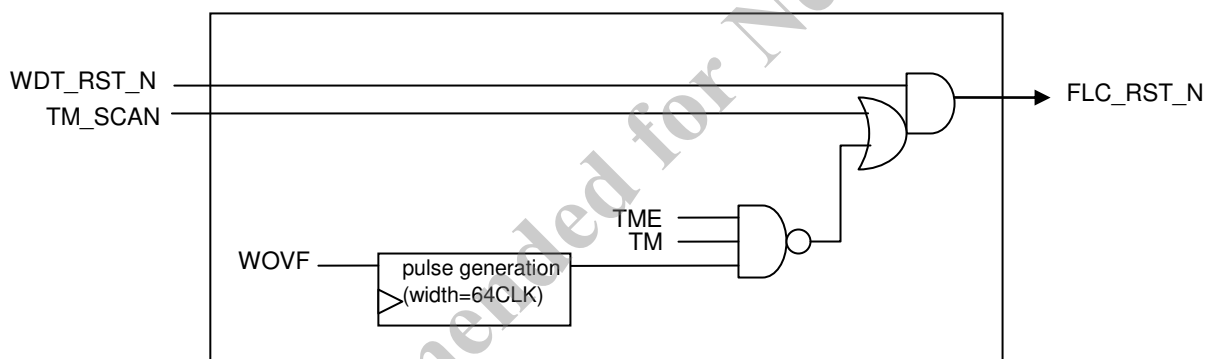


Figure 15-2 Reset diagram

15.4 Interrupt diagram

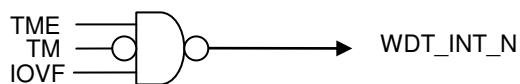


Figure 15-3 Interrupt diagram

15.5 Prescaler

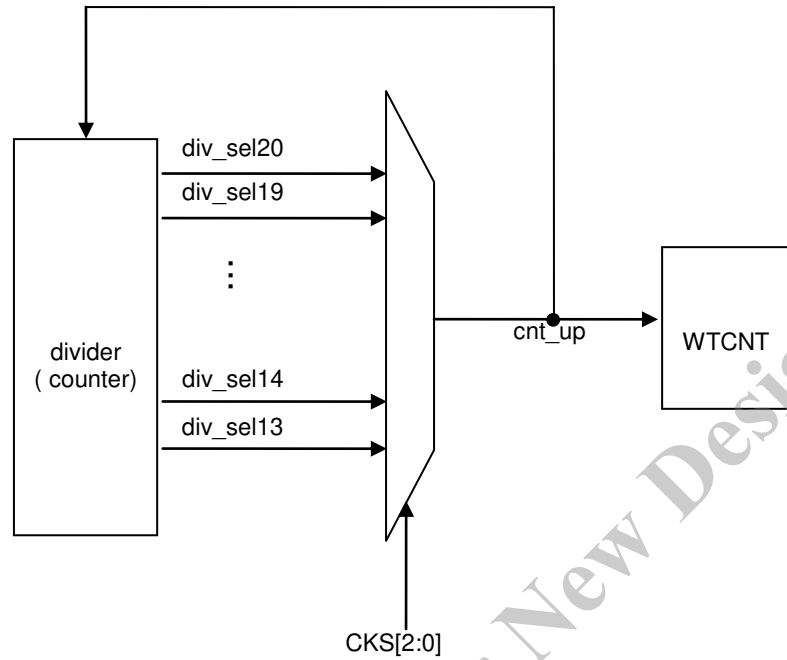


Figure 15-4 Time Chart of Prescaler

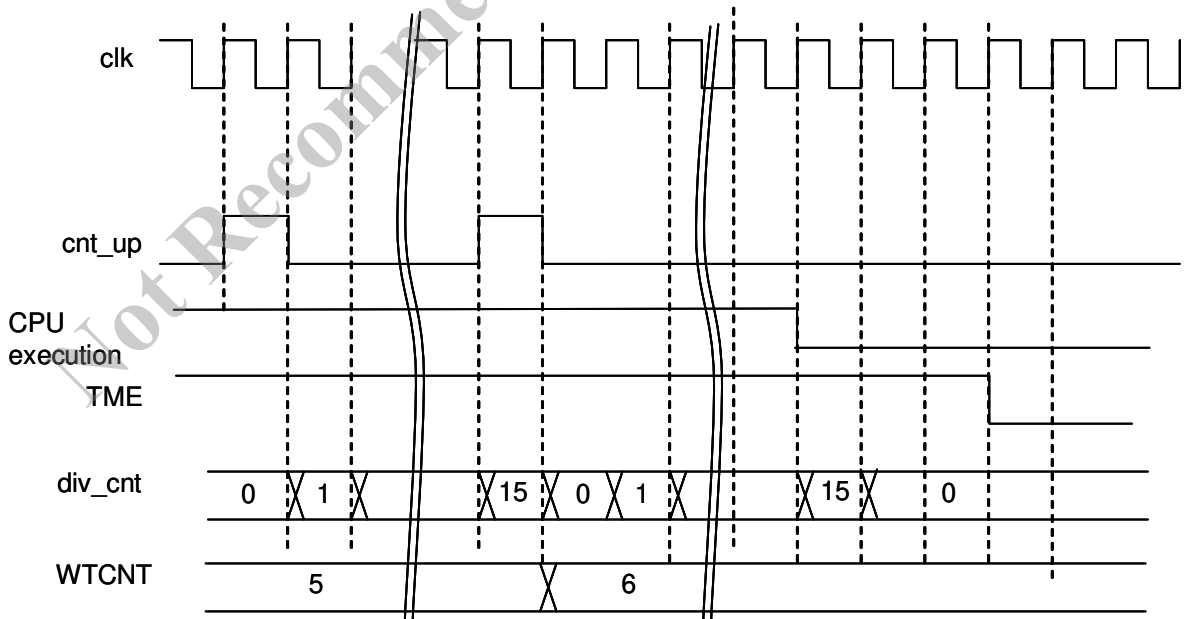


Figure 15-5 Prescaler operation

15.6 Operation

15.6.1 How to write into WTCNT and WTCSR

- While WTGRDs' value is not either 0x5A or 0xA5, WTCNT and WTCSR are not changed by operation to write.
- If 0x5A is written into WTGRD, it is able to be written value into WTCNT. In Figure 15-6, 0x00 is written into WTCNT.
- If 0xA5 is written into WTGRD, it is able to be written value into WTCSR. In Figure 15-6, WTCSR.TM is written to 1 and WTCSR.TME is written to 1.

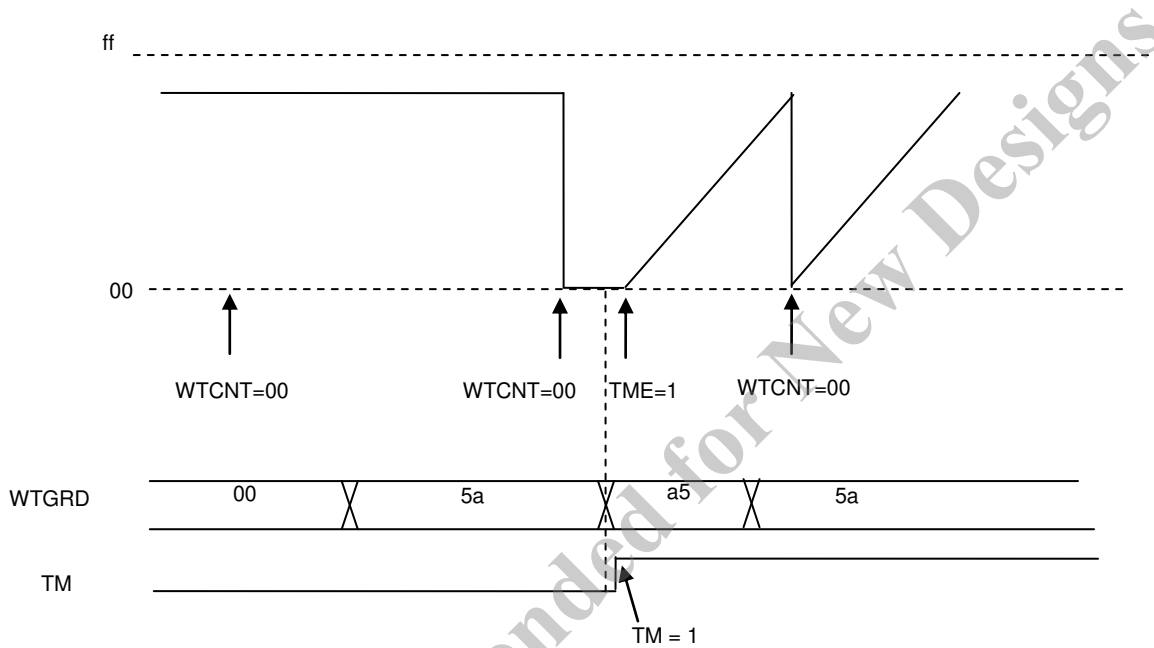


Figure 15-6 How to write into WTCNT and WTCSR

15.6.2 Watch dog timer mode

- When TME is set to 1, the timer starts up-count.
- During the normal operation, it is necessary to write 0x5A into WTGRD register regularly in the time when WTCNT does not overflow and avoid reset “FLC_RST_N” occurrence.
- When the timer overflows, it continues up-counting and the internal reset "FLC_RST_N" occur.
Reset term takes 64clk ($2.56\mu\text{s}$: $\text{CLKSLOW} = 25\text{MHZ}$).
- After reset is finished, please clear a flag by writing WOVF to 1.
If WOVF is not cleared, the next watch dog timer resets “FLC_RST_N” will not be generated.
- When TME is set to 0, the timer stops counting and holds the counter value. If TME is set to 1, the timer starts again from the held value.
- If the value is written into WTCNT while counting, the timer starts upcount from this value.

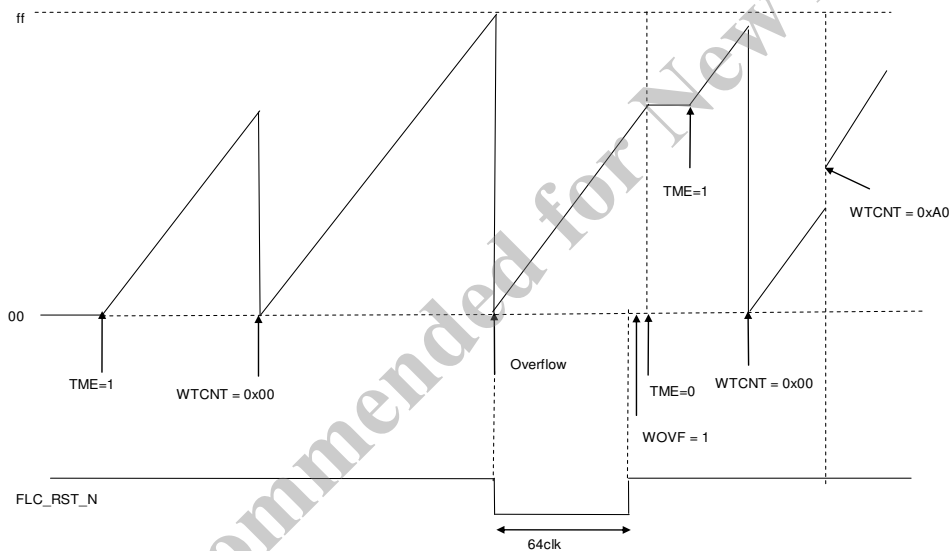


Figure 15-7 Watch Dog Timer Operation

15.6.3 Interval Timer Mode

- Interval timer generates an interrupt request for interval interrupt.
- Initial interval period is the time which WTCNT up-counts from 0x00 to overflow.
- Method to change the interval period is to change setting of WTCSR.CKS[2:0].
- If interrupt is generated every term which is shorter than the initial period, initial value should be written into WTCNT on entering interrupt routine. The time to write initial value is very shorter than the count unit of WTCNT
- When TME is set to 1, the timer starts up-count.
- When the counter overflows, the interrupt is generated and WTCNT is reset.
- The interrupt flag should be cleared to write “1” into IOVF in interrupt routine.

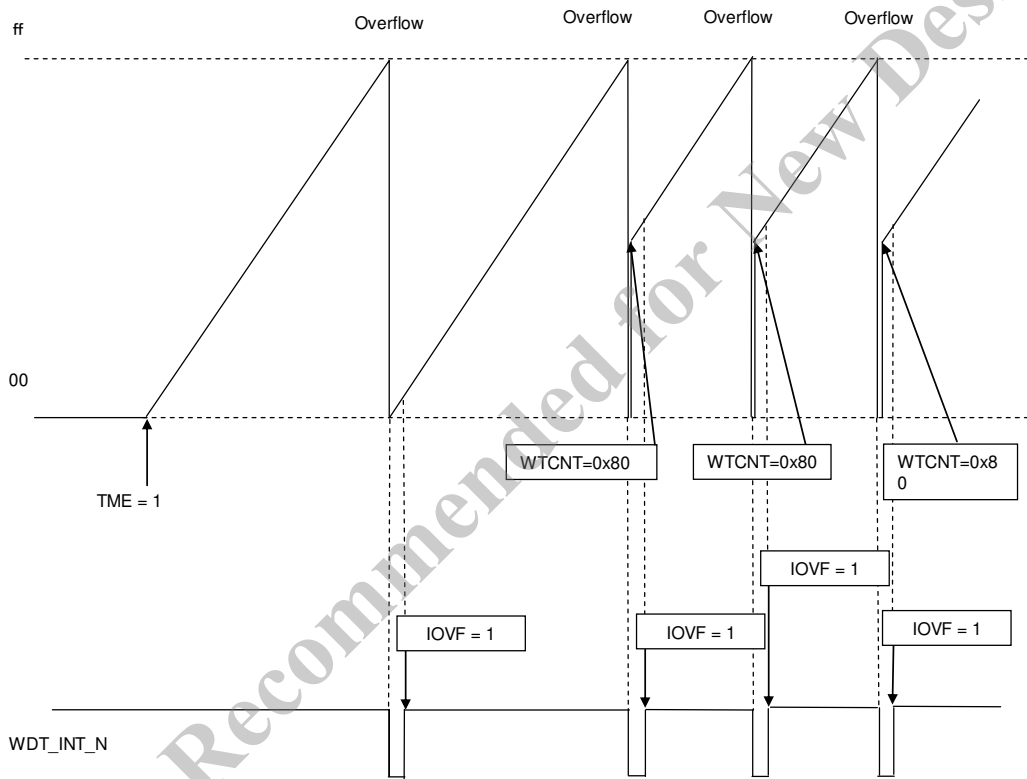


Figure 15-8 Interval Timer Operation

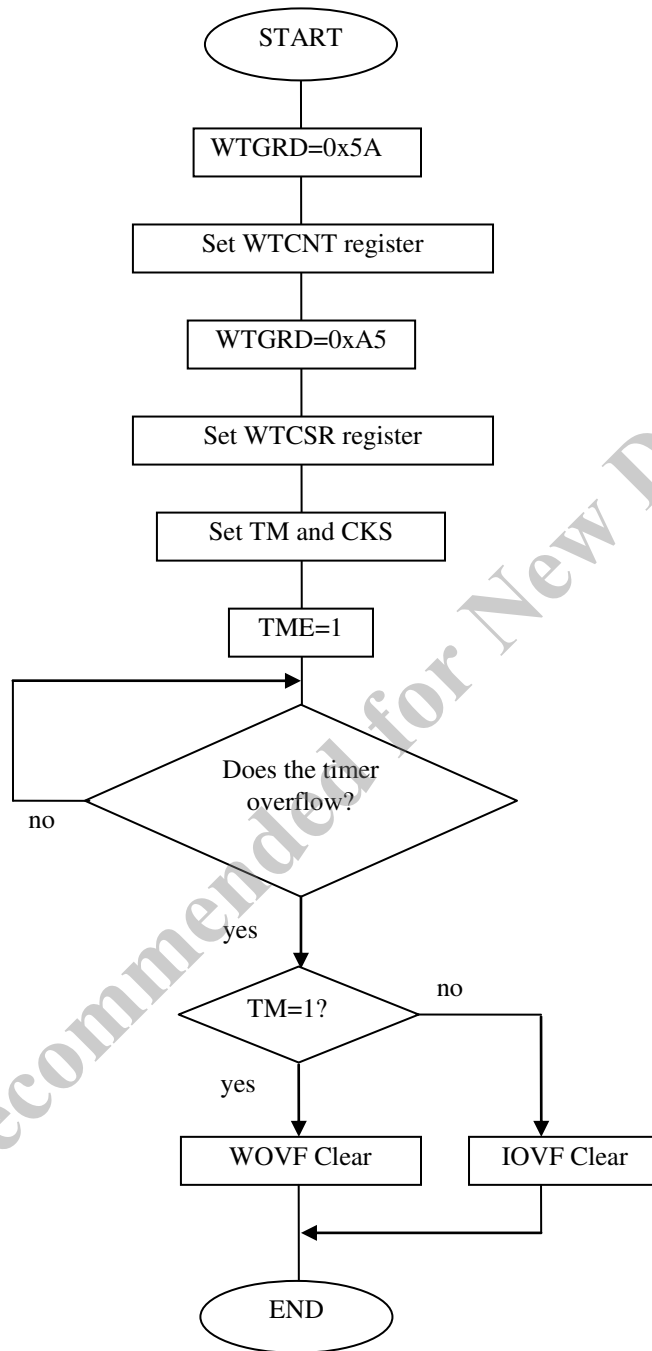


Figure 15-9 WDT Operation Concept

16. 16 bit Timer (TMR)

16.1 Overview

This LSI has an on-chip 16 bit timer module (TMR0 and TMR1) with two channels operating on the basis of a 16 bit counter. The 16 bit timer module can be used as an interrupt timer of applications, such as generation of interrupt requests using a compare-match signal.

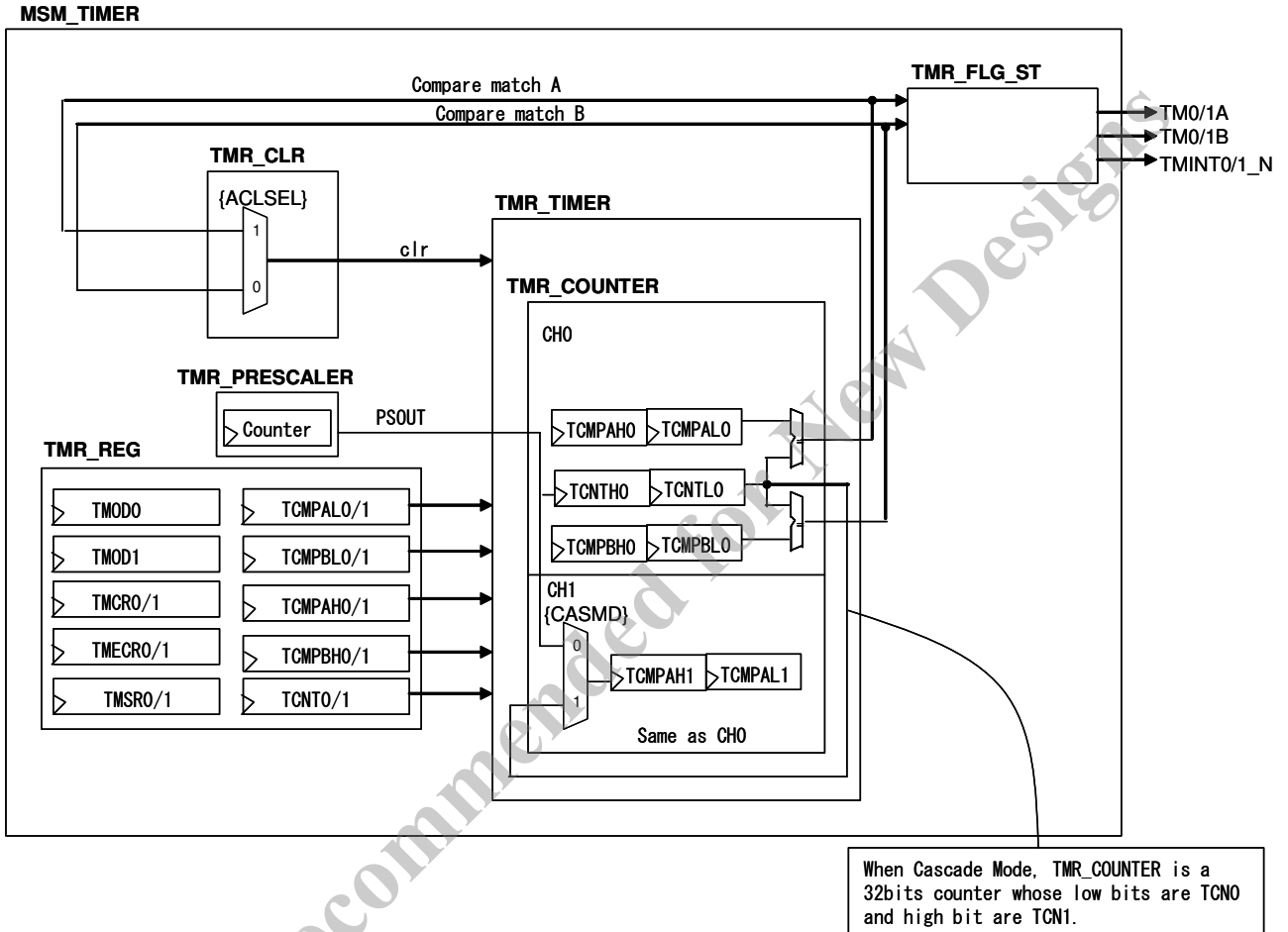


Figure 16-1 Block Diagram of TMR

16.2 Register Description

Table 16-1 List of Registers

Symbol	Name	Address	Initial value
TMOD0	Timer control Mode Register	0xFA00	0x00
TMOD1	Timer control Mode Register	0xFA01	0x00
TMSR0	Timer 0 Status Register	0xFA02	0x00
TMSR1	Timer 1 Status Register	0xFA03	0x00
TMCR0	Timer 0 Control register	0xFA04	0x00
TMCR1	Timer 1 Control register	0xFA05	0x00
TMECR0	Timer 0 event clear register	0xFA06	0x00
TMECR1	Timer 1 event clear register	0xFA07	0x00
TCMPAL0	Timer 0 compare match A-L	0xFA10	0x00
TCMPAL1	Timer 1 compare match A-L	0xFA12	0x00
TCMPAH0	Timer 0 compare match A-H	0xFA11	0x00
TCMPAH1	Timer 1 compare match A-H	0xFA13	0x00
TCMPBL0	Timer 0 compare match B-L	0xFA14	0x00
TCMPBL1	Timer 1 compare match B-L	0xFA16	0x00
TCMPBH0	Timer 0 compare match B-H	0xFA15	0x00
TCMPBH1	Timer 1 compare match B-H	0xFA17	0x00
TCNTL0	Timer 0 counter L	0xFA18	0x00
TCNTL1	Timer 1 counter L	0xFA1A	0x00
TCNTH0	Timer 0 counter H	0xFA19	0x00
TCNTH1	Timer 1 counter H	0xFA1B	0x00

16.2.1 Timer control Mode Register (TMOD0)

When writing a 16 bit registers (paired with H / L), Must access in the order of L to H.

Register		TMOD0		Timer control Mode Register	Address	0xFA00
Bit	Bit Name	R/W	Initial	Description	Note	
7	TMREN	R/W	0	Timer enable 0: disable 1: enable		
6	TMRIE	R/W	0	Timer interrupt master enable 0: disable 1: enable		
5	CMPAEN	R/W	0	Compare Match A enable 0: disable 1: enable		
4	CMPBEN	R/W	0	Compare Match B enable 0: disable 1: enable		
3	Reserved	R	0	Read value '0'. Write only '0'.		
2	PRSCCL	R/W	0	Prescaler 000: 1/1 001: 1/4 010: 1/16 011: 1/64 100: 1/256 101: 1/1024 110: 1/4096 111: 1/16384		
1		R/W	0			
0		R/W	0			

When set TMOD1.CASMD = 1, the counter operates as a timer, Timer1 is the upper 16 bit and Timer0 is lower 16 bit, of 32bit × 1 channel. In this mode, the timer operation is controlled by the registers of the Timer0.

16.2.2 Timer control Mode Register (TMOD1)

Register		TMOD1		Timer control Mode Register	Address	0xFA01
Bit	Bit Name	R/W	Initial	Description	Note	
7	TMREN	R/W	0	Timer enable 0: disable 1: enable		
6	TMRIE	R/W	0	Timer interrupt master enable 0: disable 1: enable		
5	CMPAEN	R/W	0	Compare Match A enable 0: disable 1: enable		
4	CMPBEN	R/W	0	Compare Match B enable 0: disable 1: enable		
3	CASMD	R/W	0	Cascade Mode 0: disable 1: enable		
2	PRSCLE	R/W	0	Prescaler 000: 1/1 001: 1/4 010: 1/16 011: 1/64 100: 1/256 101: 1/1024 110: 1/4096 111: 1/16384		
1		R/W	0			
0		R/W	0			

When TMOD1.CASMD = "1", TMR works with the set value of TMOD0 register regardless of the setting of the TMOD1 register.

16.2.3 Timer n Status Register (TMSRn) (n=0-1)

Register	TMSR0	Timer 0 Status Register	Address	0xFA02	
Register	TMSR1	Timer 1 Status Register	Address	0xFA03	
Bit	Bit Name	R/W	Initial	Description	Note
7	Reserved	R	0	Read value '0'. Write only '0'.	
6	Reserved	R	0	Read value '0'. Write only '0'.	
5	Reserved	R	0	Read value '0'. Write only '0'.	
4	Reserved	R	0	Read value '0'. Write only '0'.	
3	Reserved	R	0	Read value '0'. Write only '0'.	
2	OVF	R/C	0	Overflow flag Read operation 0: No overflow 1: Overflow Write operation 0: No effect 1: '0' clear	
1	CMBF	R/C	0	Compare match B flag Read operation 0: No compare match B 1: Compare match B Write operation 0: No effect 1: '0' clear	
0	CMAF	R/C	0	Compare match A flag Read operation 0: No compare match A 1: Compare match A Write operation 0: No effect 1: '0' clear	

When TMOD1.CASMD = "1", TMR works with the set value of TMOD0 register regardless of the setting of the TMOD1 register.

16.2.4 Timer n Control register (TMCRn) (n=0-1)

Register	TMCR0	Timer 0 Control register	Address	0xFA04	
Register	TMCR1	Timer 1 Control register	Address	0xFA05	
Bit	Bit Name	R/W	Initial	Description	Note
7	Reserved	R	0	Read value '0'. Write only '0'.	
6	OVIEN	R/W	0	Overflow interrupt enable 0: disable 1: enable	
5	CMAIEN	R/W	0	Compare Match A interrupt enable 0: disable 1: enable	
4	CMBIEN	R/W	0	Compare Match B interrupt enable 0: disable 1: enable	
3	EOAEN	R/W	0	Compare Match A event out enable 0: disable 1: enable	
2	EOBEN	R/W	0	Compare Match B event out enable 0: disable 1: enable	
1	ACLEN	R/W	0	Timer auto clear enable 0:auto clear disable 1:auto clear enable	
0	ACLSEL	R/W	0	Timer clear select 0:Compare Match A 1:Compare Match B When ACLEN has been set and enabled, the counter be cleared in either of these conditions.	

When TMOD1.CASMD = "1", TMR works with the set value of TMOD0 register regardless of the setting of the TMOD1 register.

16.2.5 Timer n event clear register (TMECRn) (n=0-1)

Register	TMECR0	Timer 0 event clear register	Address	0xFA06	
Register	TMECR1	Timer 1 event clear register	Address	0xFA07	
Bit	Bit Name	R/W	Initial	Description	Note
7	Reserved	R	0	Read value '0'. Write only '0'.	
6	Reserved	R	0	Read value '0'. Write only '0'.	
5	Reserved	R	0	Read value '0'. Write only '0'.	
4	Reserved	R	0	Read value '0'. Write only '0'.	
3	P3CLRS	R/W	0	Use PWM3 event to clear counter 0: Not use 1: Use	
2	P2CLRS	R/W	0	Use PWM2 event to clear counter 0: Not use 1: Use	
1	P1CLRS	R/W	0	Use PWM1 event to clear counter 0: Not use 1: Use	
0	P0CLRS	R/W	0	Use PWM0 event to clear counter 0: Not use 1: Use	

When TMOD1.CASMD = "1", TMR works with the set value of TMOD0 register regardless of the setting of the TMOD1 register.

16.2.6 Timer n compare match A-L (TCMPALn) (n=0-1)

Register	TCMPAL0	Timer 0 compare match A-L	Address	0xFA10	
Register	TCMPAL1	Timer 1 compare match A-L	Address	0xFA12	
Bit	Bit Name	R/W	Initial	Description	Note
7	CMPAL	R/W	0	Compare match-A Lower 8bit value	
6		R/W	0		
5		R/W	0		
4		R/W	0		
3		R/W	0		
2		R/W	0		
1		R/W	0		
0		R/W	0		

16.2.7 Timer n compare match A-H (TCMPAHn) (n=0-1)

Register	TCMPAH0	Timer 0 compare match A-H	Address	0xFA11	
Register	TCMPAH1	Timer 1 compare match A-H	Address	0xFA13	
Bit	Bit Name	R/W	Initial	Description	Note
7	CMPAH	R/W	0	Compare match-A Upper 8bit value	
6		R/W	0		
5		R/W	0		
4		R/W	0		
3		R/W	0		
2		R/W	0		
1		R/W	0		
0		R/W	0		

16.2.8 Timer n compare match B-L (TCMPBLn) (n=0-1)

Register	TCMPBL0	Timer 0 compare match B-L	Address	0xFA14	
Register	TCMPBL1	Timer 1 compare match B-L	Address	0xFA16	
Bit	Bit Name	R/W	Initial	Description	Note
7	CMPBL	R/W	0	Compare match-B Lower 8bit value	
6		R/W	0		
5		R/W	0		
4		R/W	0		
3		R/W	0		
2		R/W	0		
1		R/W	0		
0		R/W	0		

16.2.9 Timer n compare match B-H (TCMPBHn) (n=0-1)

Register	TCMPBH0	Timer 0 compare match B-H	Address	0xFA15	
Register	TCMPBH1	Timer 1 compare match B-H	Address	0xFA17	
Bit	Bit Name	R/W	Initial	Description	Note
7	CMPBH	R/W	0	Compare match-B Upper 8bit value	
6		R/W	0		
5		R/W	0		
4		R/W	0		
3		R/W	0		
2		R/W	0		
1		R/W	0		
0		R/W	0		

16.2.10 Timer n counter L (TCNTLn) (n=0-1)

Register	TCNTL0	Timer 0 counter L	Address	0xFA18	
Register	TCNTL1	Timer 1 counter L	Address	0xFA1A	
Bit	Bit Name	R/W	Initial	Description	Note
7	TCNTL	R/W	0	Timer/Counter Lower 8bit value	
6		R/W	0		
5		R/W	0		
4		R/W	0		
3		R/W	0		
2		R/W	0		
1		R/W	0		
0		R/W	0		

16.2.11 Timer n counter H (TCNTHn) (n=0-1)

Register	TCNTH0	Timer 0 counter H	Address	0xFA19	
Register	TCNTH1	Timer 1 counter H	Address	0xFA1B	
Bit	Bit Name	R/W	Initial	Description	Note
7	TCNTH	R/W	0	Timer/Counter Upper 8bit value	
6		R/W	0		
5		R/W	0		
4		R/W	0		
3		R/W	0		
2		R/W	0		
1		R/W	0		
0		R/W	0		

16.3 Operation

16.3.1 16 bit Register access

TCNT** Register

Write Operation: The data written to the L side of the TCNT is buffered temporarily, and is written to the counter at the same time to write the data side H.

Read Operation: When reading to the L side of the TCNT, the H side data is buffered. The buffered data can be read when reading the data value of the H side of TCNT.

TCMP** Register

Write Operation: The data written to the L side of the TCMP is buffered temporarily, and is written to the counter at the same time to write the data side H.

Read Operation: When reading to the L/H side of the TCMP, read data is not buffered and can be read as well as the register of 8bit access.

16.3.2 Counter Operation

If set to TMREN = 1, 16 bit counter starts counting from the value set in the TCNTH / L.
 The initial value of the TCNTH / L is 0x0000.
 If write access and overflow happen at the same time, write access is prior to another.

16.3.3 Compare match operation

16 bit counter (TCNTH/L) starts counting from 0x0000. When the Compare match occurs, CMPAH/L and / or CMPBH/L compare match with TCNTH/L, CMAF bit and / or CMBF bit are set during CMPAEN and /or CMPBEN are enable. Also the Interrupt output TMINT_N asserts if CMPAIEN and / or CMPBIEN are enable. If EOAEN and /or EOEN are enable, Event output, TM_A and / or TM_B pulse are generated.

If write access and compare match happen at the same time, compare match is prior to another.

16.3.4 Auto Clear

When the compare match occurs, it is possible to clear the 16 bit counters.

If the TCNTH/L will be cleared by compare match automatically, must set to ACLEN = 1.

Auto clear condition of the TCNH/L is selected by setting ACLSEL (Select Compare match A or B).

By disable the auto clear, the counter counts up until 0xFFFF. Then, counter returns to 0x0000. When the counter returns to 0x0000 from 0xFFFF, TMSR*OVF indicates that the overflow occurred.

16.3.5 PWM Event Clear

When set PxCLRS = 1, the 16 bit counter can be cleared by the selected event of PWM.

16.3.6 32bit Counter Mode

When set TMOD1.CASMD = 1, the counter operates as a timer ,Timer1 is the upper 16 bit and Timer0 is lower 16 bit, of 32bit x 1 channel.

16.3.7 Compare match timing

The Compare match timing is shown in Figure 16-2.

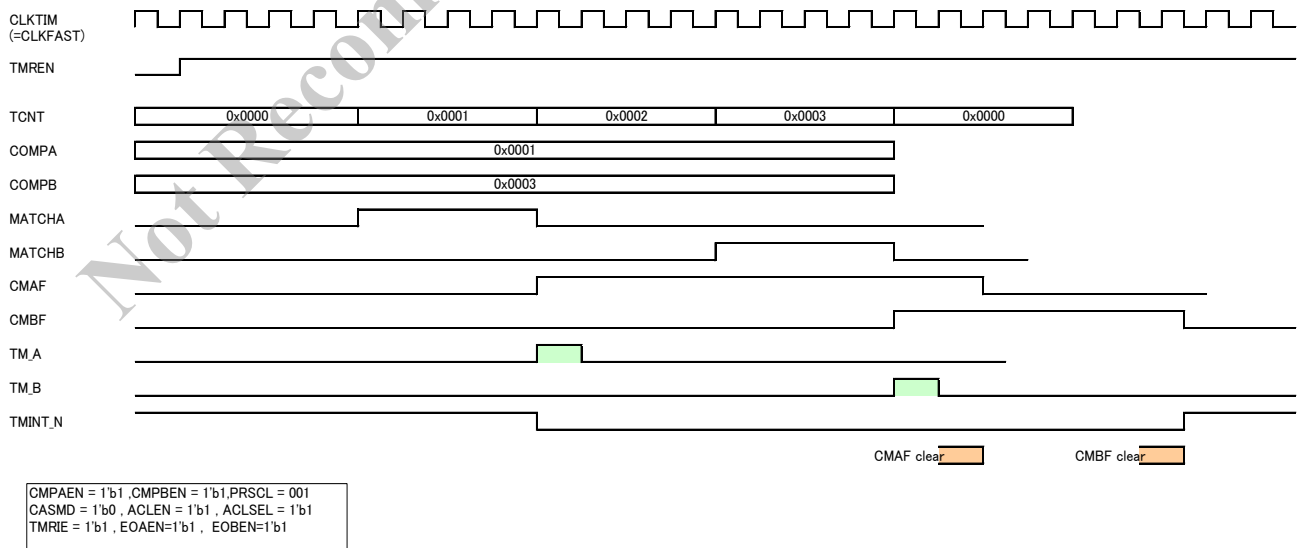


Figure 16-2 Compare match timing Chart

- When the TMREN is set to 1, the TCNT starts to count-up from the held value in the TCNTH/L. The initial value of the TCNTH/L is 0x0000.
- The CLKTIM for TCNT can be divided by setting TMODn.PRSCl[2:0]. This figure shows one of the example of setting PRSCl, and the division into four of CLKTIM is use for counting for TCNT.
- If TCNT and COMPA/COMPB are matched, CMAF/CMBF will be set at next TCNT cycle.
- At the same time, compare match interrupt occurs and TMINT_N assert.
- If ACLAEN and ACLSEL are set to 1'b1, TCNTH/L will be cleared at next TNCT cycle when TCNT and COMPB are matched.
- If EOAEN and / or EOEN are set to 1'b1, the Event outputs , TM_A and /or TM_B, are generated when CMAF and /or CMBF are set/

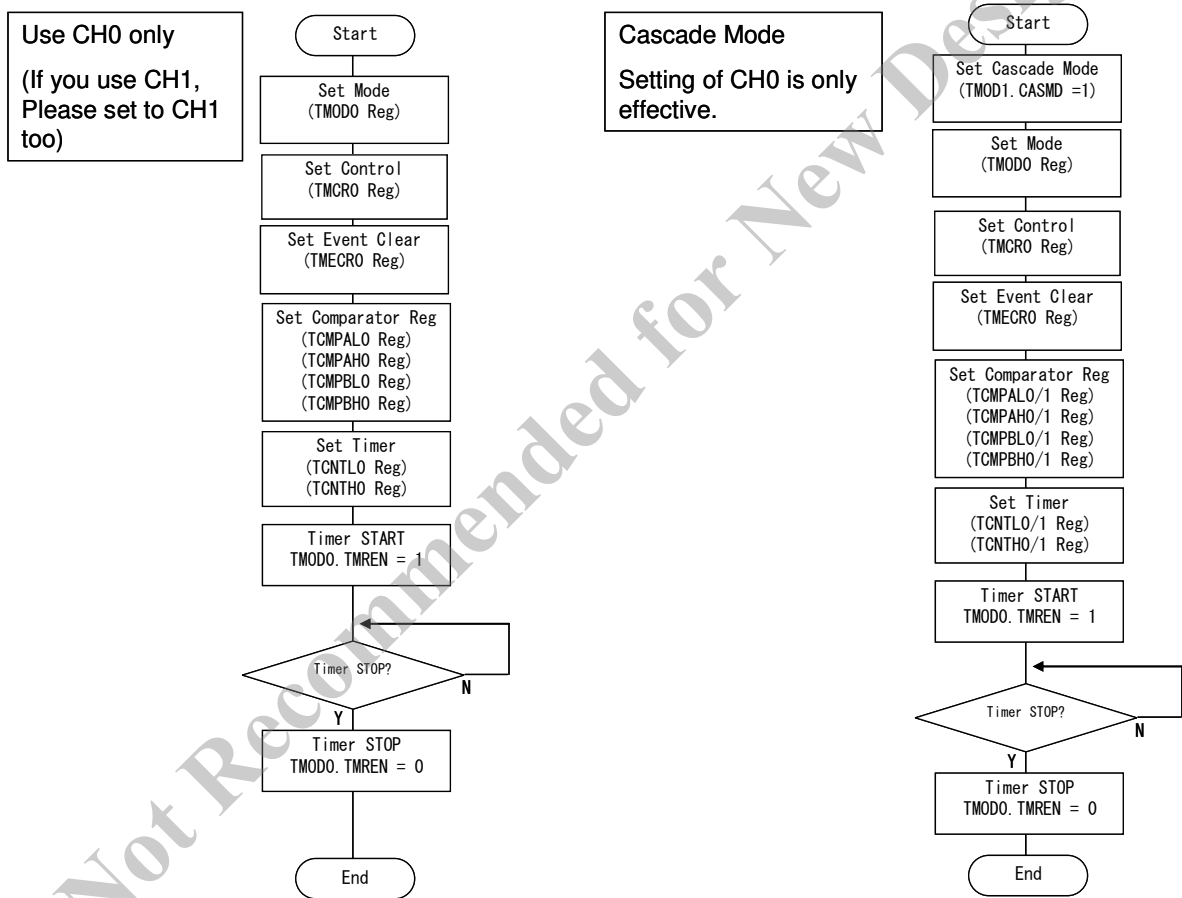


Figure 16-3 Flow Chart

17. SPI

17.1 Overview

The SPI channel is capable of full-duplex serial communications with external processors and peripheral devices.

Table 17-1 Feature of SPI

Item	Description
Tx/Rx Function	<ul style="list-style-type: none"> - Capable of serial communications in Master mode or Slave mode. - MOSI (master out/slave in), MISO (master in/slave out), and SCK (SPI clock) signals allow serial communications through SPI operation. - SPI/SS_N signal for Master Mode is generated by GPIO out. - SPI/SS_N signal for Slave Mode is assigned to GPIO00. - Support either SPI clock edge (rising or falling) on which the SPI data changes. - Support clock polarity which keeps high or low when idles. - Both TXFIFO and RXFIFO have two stages.
Data Format	<ul style="list-style-type: none"> - Support MSB-first or LSB first selectable. - Transfer data length is 6 ~ 16 bits. - 16 bits transfer and receive buffers
SPI Clock	<ul style="list-style-type: none"> - Supported SPI clock frequency: $f/4 \sim f/1024$.
Error Detection	<ul style="list-style-type: none"> - Overrun Error Detection
Interrupt Source	<ul style="list-style-type: none"> - Maskable interrupt sources (TXENDIE, TXERRIE, RXERRIE, TXFIFOIE, RXFIFOIE) - SPI receive interrupt: receive buffer not empty (~EMPTY & RXFIFOIE) or FIFO error ((RUDF ROVF)&RXERRIE). - SPI transmit interrupt: transmit buffer not full (~TFFULL & TXFIFOIE), transmit end (TXEND & TXENDIE) or FIFO error ((TUDF TOVF) & TXERRIE).
Notes	<ul style="list-style-type: none"> - When SPI unit is set as a master device, where the SPI module is being used to receive data only, it only outputs receive clock. - SS_N pin is used to select the SPI module when the SPI is configured as a slave.

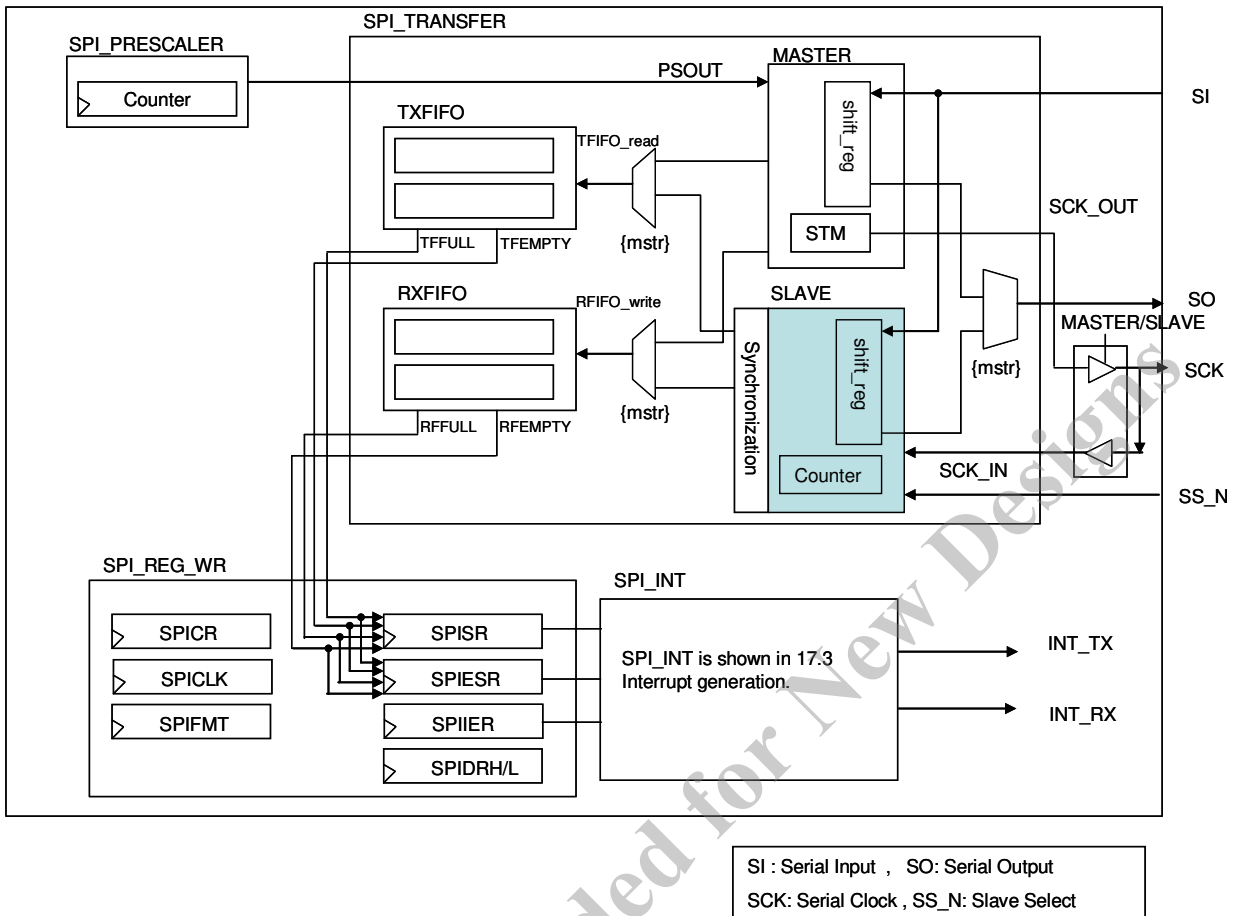


Figure 17-1 Block Diagram of SPI

17.2 Register Description

Table 17-2 List of Registers

Symbol	Name	Address	Initial value
SPICR	SPI Control Register	0xFB80	0x00
SPICLK	SPI CLOCK DIV Register	0xFB81	0x00
SPIFMT	SPI data format Register	0xFB82	0x00
SPISR	SPI Status register	0xFB84	0x05
SPIESR	SPI Error Status register	0xFB85	0x00
SPIIER	SPI Interrupt Enable Register	0xFB86	0x00
SPIDRL	SPI Data Register L	0xFB88	0x00
SPIDRH	SPI Data Register H	0xFB89	0x00

17.2.1 SPI Control Register (SPICR)

Register		SPICR		SPI Control Register		Address	0xFB80
Bit	Bit Name	R/W	Initial	Description		Note	
7-6	Reserved	R	0	Read value is '0'. Write only '0'.			
5	SPE	R/W	0	Serial Peripheral Enable When the Serial Peripheral Enable bit is set to '1', the core is enabled. When it is cleared to '0', the core is disabled. The core only transfers data when the core is enabled. '0' = SPI core disabled '1' = SPI core enabled			
4	MSTR	R/W	0	Master Mode Select When the Master Mode Select bit is set to '1', the core is a master device. When it is cleared to '0', it is a slave device. '0' = Slave mode '1' = Master mode			
3	CPOL	R/W	0	Clock Polarity The Clock Polarity bit, together with the Clock Phase bit, determines the transfer mode.			
2	CPHA	R/W	0	Clock Phase The Clock Phase bit and the Clock Polarity bit, determine the transfer mode. In slave mode, SPI operates in mode 1 or 3 regardless of this bit (as CPHA = 1).			
1	TXEN	R/W	0	TX enable When TXEN bit is set to '1', the core is a TX operation enable. When TXEN bit is cleared to '0', the core is a TX operation disable.			
0	RXEN	R/W	0	RX enable When RXEN bit is set to '1', the core is a RX operation enable. When RXEN bit is cleared to '0', the core is a RX operation disable.			

TXEN and RXEN:

TXEN, RXEN is different from the master/slave mode as shown below.

Transmission:

When SPI is in the master mode, if RXEN or TXEN is enabled, SPI can transmit. Even if RXEN is only set to '1', the transmission data is the data written to the TXFIFO.

In case of the slave mode, if TXFIFO has started sending in an empty state and TXEN = 1, TXFIFO underflow flag is set to '1'. If RXEN is only set to '1', for no data is read from TXFIFO, the underflow flag is not set to '1'.

Receive:

If enable the RXEN to both master and slave, the received data is written to the RXFIFO. (if RXFIFO is in full and has completed send and receive in the state of RXEN = 1, RXFIFO overflow flag is set to '1').

CPOL and CPHA

The Clock Polarity bit and the Clock Phase bit are for determining the SPI mode

There are four SPI modes, and each SPI mode has the different data-setup timing and data-sample timing. Setting information of these CPOL bit and CPHA bit are shown in Table 17-3 and the Timing chart is shown in Figure 17-2.

Table 17-3 CPOL, CPHA setting

CPOL	CPHA	Leading Edge	Trailing Edge	SPI mode
0	0	Sample ↑	Setup ↓	0
0	1	Setup ↑	Sample ↓	1
1	0	Sample ↓	Setup ↑	2
1	1	Setup ↓	Sample ↑	3

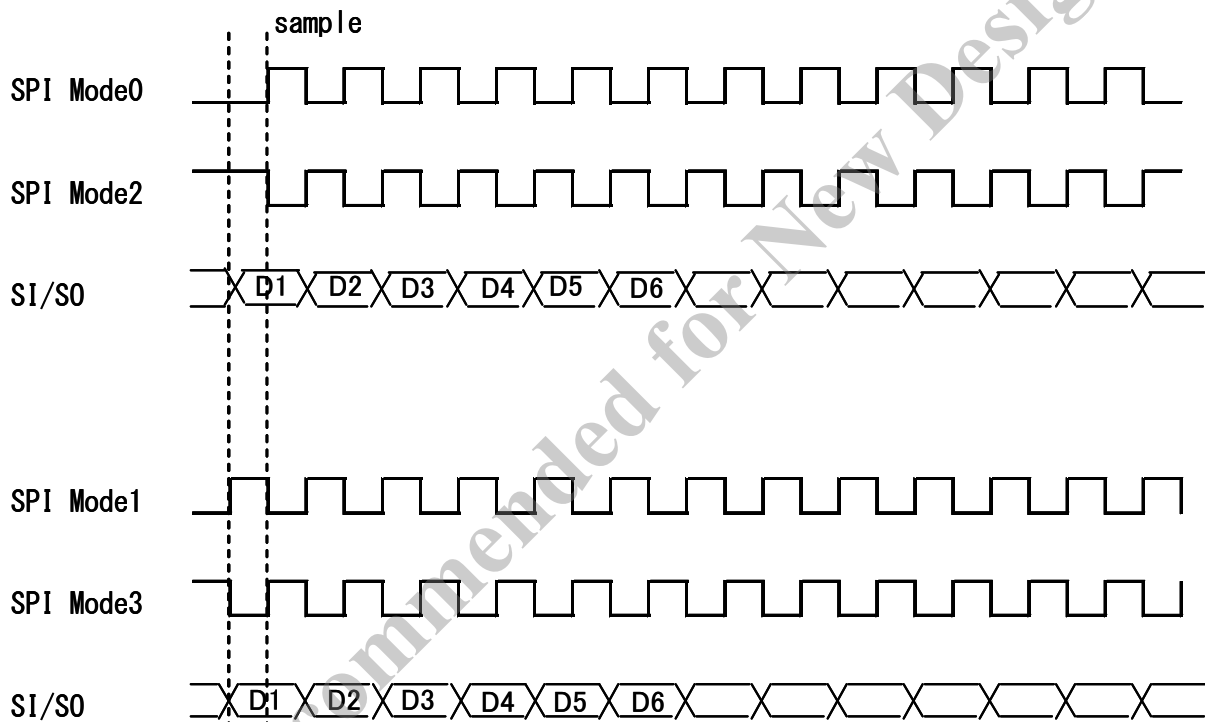


Figure 17-2 Timing chart of each SPI mode

17.2.2 SPI CLOCK DIV Register (SPICLK)

Register		SPICLK		SPI CLOCK DIV Register		Address	0xFB81
Bit	Bit Name	R/W	Initial	Description		Note	
7	CLKDIV	R/W	0	SPI clock rate (Master mode only) SCK = CLK/4(CLKDIV+1)			
6		R/W	0				
5		R/W	0				
4		R/W	0				
3		R/W	0				
2		R/W	0				
1		R/W	0				
0		R/W	0				

17.2.3 SPI data format Register (SPIFMT)

Register		SPIFMT		SPI data format Register		Address	0xFB82
Bit	Bit Name	R/W	Initial	Description		Note	
7	LSB	R/W	0	First transfer bit select 0 : MSB first 1 : LSB first			
6-3	Reserved	R	0	Read value is '0'. Write only '0'.			
2	WORD[2:0]	R/W	0	Transfer word size These bits select the SPI transfer word size. 000 : 6bits 001 : 7bits 010 : 8bits 011 : 9bits 100 : 12bits 101 : 14bits 110 : 16bits 111 : reserved			
1		R/W	0				
0		R/W	0				

17.2.4 SPI Status register (SPISR)

Register		SPISR		SPI Status register		Address	0xFB84
Bit	Bit Name	R/W	Initial	Description		Note	
7	TEND	R/C	0	Transfer END flag The Transfer END flag is set upon completion of a transfer block when TXFIFO is empty. If TEND is asserted ('1') and TXENDIE is set, an interrupt is generated. To clear the interrupt write this bit to ('1').			
6-4	Reserved	R	0	Read value is '0'. Write only '0'.			
3	TFFULL	R	0	TXFIFO Full The TXFIFO is Full.			
2	TFEMPTY	R	1	TXFIFO Empty The TXFIFO is Empty.			
1	RFFULL	R	0	RXFIFO Full The RXFIFO is Full.			
0	RFEMPTY	R	1	RXFIFO Empty The RXFIFO is Empty.			

17.2.5 SPI Error Status register (SPIESR)

Register		SPIESR		SPI Error Status register		Address	0xFB85
Bit	Bit Name	R/W	Initial	Description		Note	
7-4	Reserved	R	0	Read value is '0'. Write only '0'.			
3	TOVF	R/C	0	TXFIFO overflow The TXFIFO overflow flag is set when the Serial Peripheral Data register is written to while the TXFIFO is full. To clear the TXFIFO overflow flag, write this bit to '1'.			
2	TUDF	R/C	0	TXFIFO underflow The TXFIFO underflow flag is set when the Serial Peripheral Data register is transferred to while the TXFIFO is empty. To clear the TXFIFO flag, write this bit to '1'.			
1	ROVF	R/C	0	RXFIFO overflow RXFIFO overflow flag is set when the Serial Peripheral Data register is transferred to while RXFIFO is full. To clear RXFIFO overflow flag, write this bit to '1'.			
0	RUDF	R/C	0	RXFIFO underflow RXFIFO underflow flag is set when the Serial Peripheral Data register is read to while RXFIFO is empty. To clear RXFIFO overflow flag, write this bit to '1'.			

17.2.6 SPI Interrupt Enable Register (SPIIER)

Register		SPIIER		SPI Interrupt Enable Register		Address	0xFB86
Bit	Bit Name	R/W	Initial	Description		Note	
7-5	Reserved	R	0	Read value is '0'. Write only '0'.			
4	TXENDIE	R/W	0	TX END Interrupt Enable When the TXENDIE is set ('1') and the Transfer END flag in the status register is set, TX interrupt occurs. '0' = TXEND interrupts disabled '1' = TXEND interrupts enabled			
3	TXERRIE	R/W	0	TX ERRor Interrupt Enable When the TXERRIE is set ('1') and the TOVF/TUDF Flag in the error status register is set, TX interrupt occurs. '0' = TXERR interrupts disabled '1' = TXERR interrupts enabled			
2	RXERRIE	R/W	0	RX ERRor Interrupt Enable When the RXERRIE is set ('1') and the ROVF/RUDF Flag in the error status register is set, RX interrupt occurs. '0' = RXERR interrupts disabled '1' = RXERR interrupts enabled			
1	TXFIFOIE	R/W	0	TXFIFO Interrupt Enable When the TXFIFOIE is set ('1') and the TFFULL Flag in the status register is 0, TX interrupt occurs. '0' = TXFIFO interrupts disabled '1' = TXFIFO interrupts enabled			
0	RXFIFOIE	R/W	0	RXFIFO Interrupt Enable When the RXFIFOIE is set ('1') and the RFEMPTY Flag in the status register is 0, RX interrupt occurs. '0' = RXFIFO interrupts disabled '1' = RXFIFO interrupts enabled			

17.2.7 SPI Data Register L (SPIDRL)

Register		SPIDRL		SPI Data Register L		Address	0xFB88
Bit	Bit Name	R/W	Initial	Description		Note	
7	SPIDRL	R/W	0	SPI TX/RX Data Lower Byte			
6		R/W	0				
5		R/W	0				
4		R/W	0				
3		R/W	0				
2		R/W	0				
1		R/W	0				
0		R/W	0				

17.2.8 SPI Data Register H (SPIDRH)

Register		SPIDRH		SPI Data Register H		Address	0xFB89
Bit	Bit Name	R/W	Initial	Description		Note	
7	SPIDRH	R/W	0	SPI TX/RX Data Upper Byte			
6		R/W	0				
5		R/W	0				
4		R/W	0				
3		R/W	0				
2		R/W	0				
1		R/W	0				
0		R/W	0				

When the Data length is less than or equal to 8bit, SPI uses SPIDRL register only, and SPIDRH register is not used. When the Data length is more than 9bit, it is necessary to access both in the order from SPIDRL to SPIDRH Write / Read.

In case the Data length is more than 9bit, FIFO status is changed as follows.

- TXFIFO
TFEMPTY and TFFULL are changed when writing to SPIDRH.
- RXFIFO
RFFULL and RFEMPTY are changed when reading to SPIDRH.

17.3 Interrupt generation

17.3.1 INT_TX

Refer to a logical expression of INT_TX as below and a logical diagram as shown in Figure 17-3

$$\text{INT_TX} = (\sim\text{TFFULL} \& \text{TXFIFOIE}) \mid (\text{TEND} \& \text{TXENDIE}) \mid (\text{TUDF} \mid \text{TOVF}) \& \text{TXERRIE};$$

TFFULL (SPIISR[3])

TFFULL is set to 1'b1 when TXFIFO is full. TFFULL is cleared to 1'b0 at the start of transmission.

TUDF (SPIESR[2])

TUDF is set when transmission is started while TXFIFO is empty. TUDF can be cleared by writing 1'b1 to this bit.

TOVF (SPIESR[3])

TOVF is set when write operation occurs while TXFIFO is FULL. TOVF can be cleared by writing 1'b1 to this bit.

TEND (SPIISR[7])

TEND is set when transmission is complete while TXFIFO is empty. TEND can be cleared by writing 1'b1 to this bit.

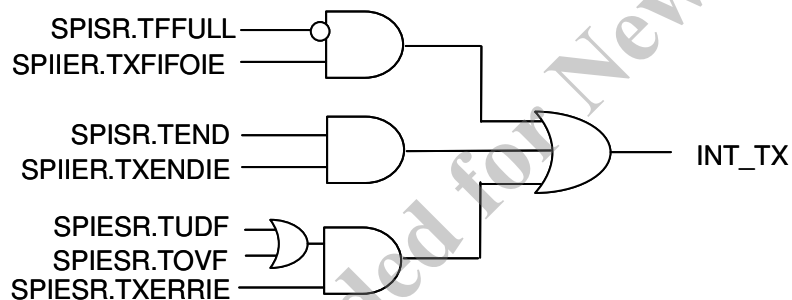


Figure 17-3 INT_TX Logical diagram

17.3.2 INT_RX

Refer to a logical expression of INT_RX as below and a logical diagram as shown in Figure 17-4.

$$INT_RX = (\sim RFEMPTY \& RXFIFOIE) | (RUDF | ROVF) \& RXERRIE;$$

RFEMPTY (SPISR[0])

RXFIFO empty is cleared to 0 when completed to receive and set to 1'b1 when reading the All RXFIFO data.

RUDF (SPIESR[0])

RXFIFO underflow is set when reading SPIDRL when RXFIFO is empty. RUDF can be cleared by writing this bit to 1'b1.

ROVF (PIESR[1])

RXFIFO overflow is set when data receive completed at when RXFIFO is full. ROVF can be cleared by writing this bit to 1'b1.

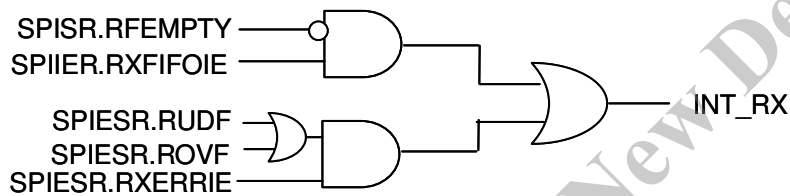


Figure 17-4 INT_RX Logical diagram

Not Recommended for New Designs

17.4 Timing chart and Connection

17.4.1 Master mode

Timing chart of SPI mode 0 is shown in Figure 17-5. Timing chart of SPI mode 1 is shown in Figure 17-6. (Both Setting condition: WORD8bit, SPICLK = 8'h00)

Connection between the master device (: this LSI) and the slave device is shown in Figure 17-7 and Figure 17-8.

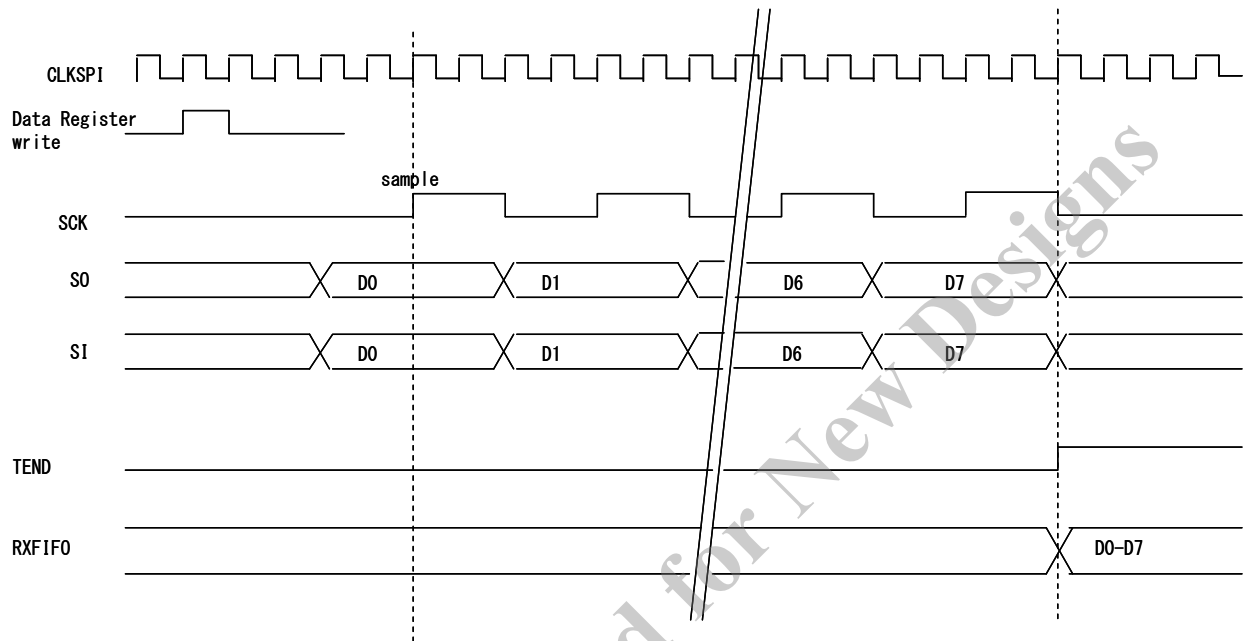


Figure 17-5 Timing chart of SPI mode 0 in Master mode

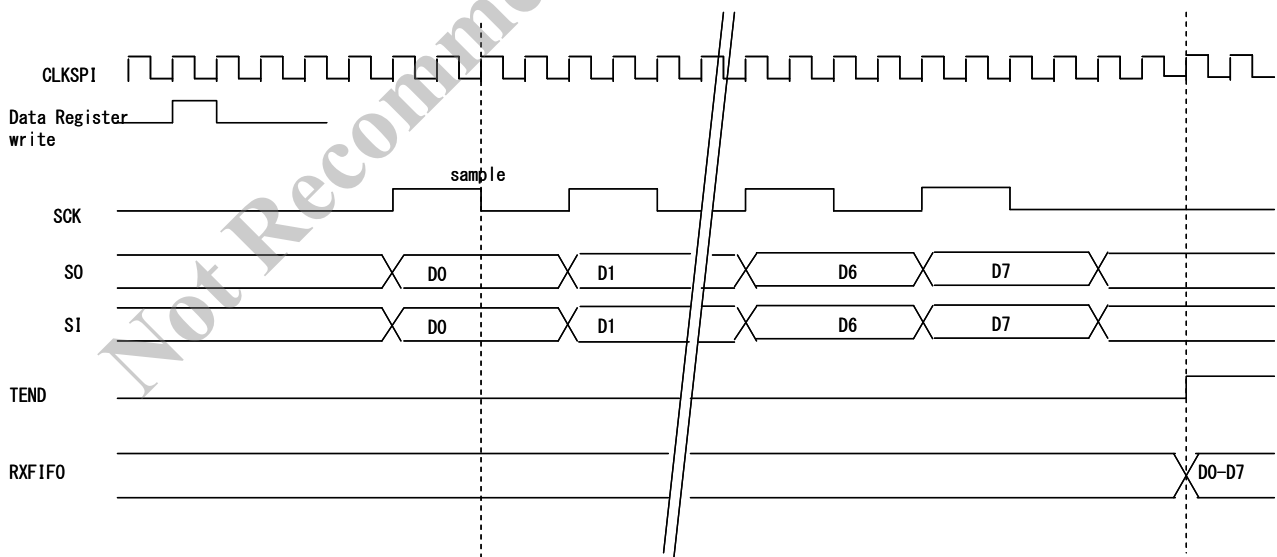


Figure 17-6 Timing chart of SPI mode 1 in Master mode

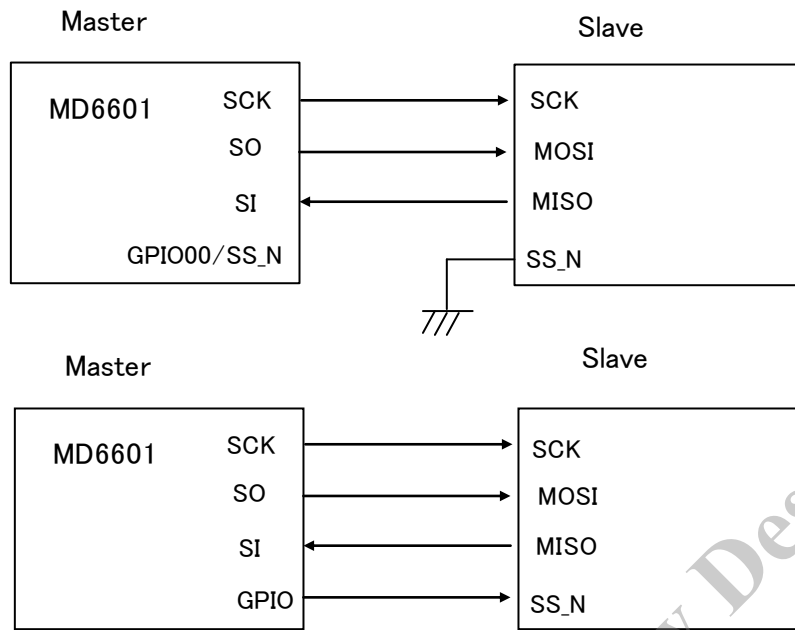


Figure 17-7 Connection Single Master to Single Slave (MD6601 is Master)

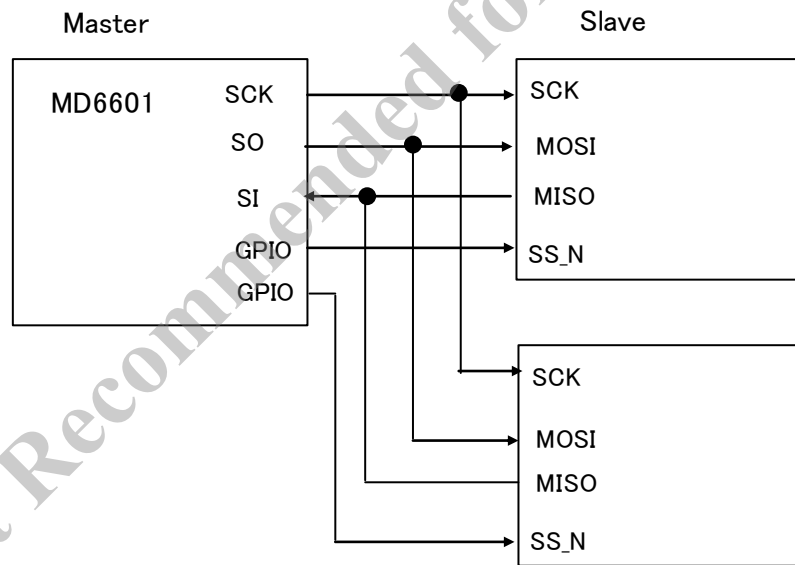


Figure 17-8 Connection single Master to multi-Slave (MD6601 is Master)

If Slave needs SS_N, Slaves' SS_N should be asserted (made "LOW") by GPIO in being used it. Please control by software. At case of multiple slave, multi-Slaves' SS_N should be made "LOW" by plural GPIO at the time of each choice. Please control by software. MD6601s' SO is connected with Slaves' MOSI and MD6601s' SI is connected with Slaves' MISO.

17.4.2 Slave Mode

Timing chart of SPI mode 1 is shown in Figure 17-9. (Both Setting condition: WORD8bit, SPICLK = 8'h00)

Connection between the master device and the slave device (: this LSI) is shown in Figure 17-10

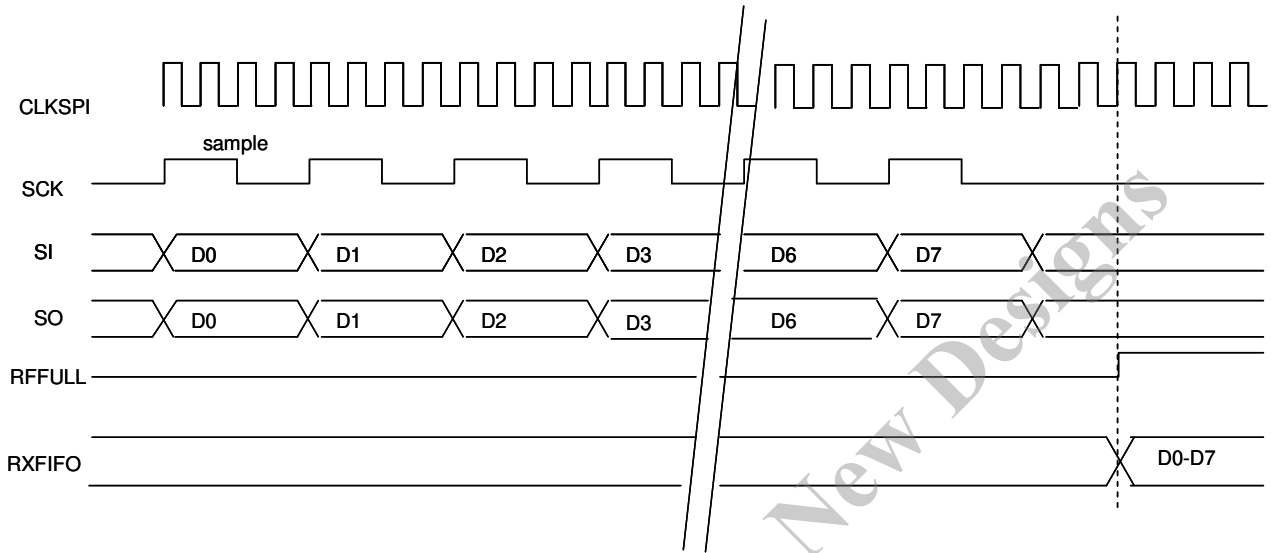


Figure 17-9 Timing chart of SPI mode 1 in Slave mode

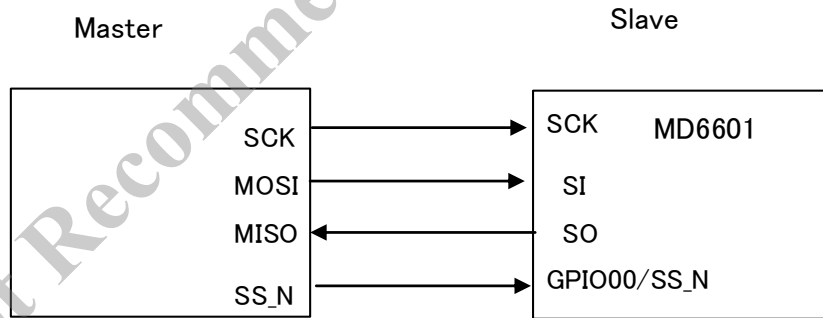


Figure 17-10 Connection in Slave mode (MD6601 is Slave).

GPIO/SS_N is connected with SS_N from Master.
 MD6601s' SI is connected with Masters' MOSI and MD6601s' SO is connected with Masters' MISO.
 SCK becomes input.

17.5 Operation

17.5.1 Master mode

Transmission start

In master mode, when TXFIFO is empty (SPISR.TFEMPTY=1), and SPIDRL/H was written data*1, the transmit data is transferred to the shift register via TXFIFO and transfer is started as shown in Figure 17-11.

And TXFIFO status becomes full (SPISR.TFFULL=1'b1) when two data are written to TXFIFO to write to SPIDRL / H continuously.

Receive start

RXFIFO is empty (SPISR.RFEMPTY=1), and write the dummy data into SPIDRL/H in order to generate the SCK, then the receive operation starts. Receive data will be sampled by the SCK and latched into the Shift register as shown in Figure 17-12.

- *1) When the data length is less than or equal to 8bit, it switches the status of the TXFIFO when writing to SPIDRL. When the data length is more than 9bit, it switches the status of the TXFIFO when writing to SPIDRH.

Completion of transmission

SPI transfer is completed at the corresponding SCK edge of the CPHA and CPOL setting and SPIF of SPISR is changed to 1'b1. Last sampling timing depends on the bit length of data.

Completion of reception

When RXFIFO is written to the received data, status of RXFIFO is changed to not empty. (SPISR.REMPTY = 0). By reading SPIDRL / H*2, data can be read from RXFIFO. The status of RXFIFO shows the number of received data and change.

- *2) When the data length is less than or equal to 8bit, it switches the status of the RXFIFO when SPIDRL has been read. When the data length is more than 9 bit, it switches the status of the RXFIFO when data read from SPIDRH.

The flow of transmit/receive operation of master mode is described below.

Transmission

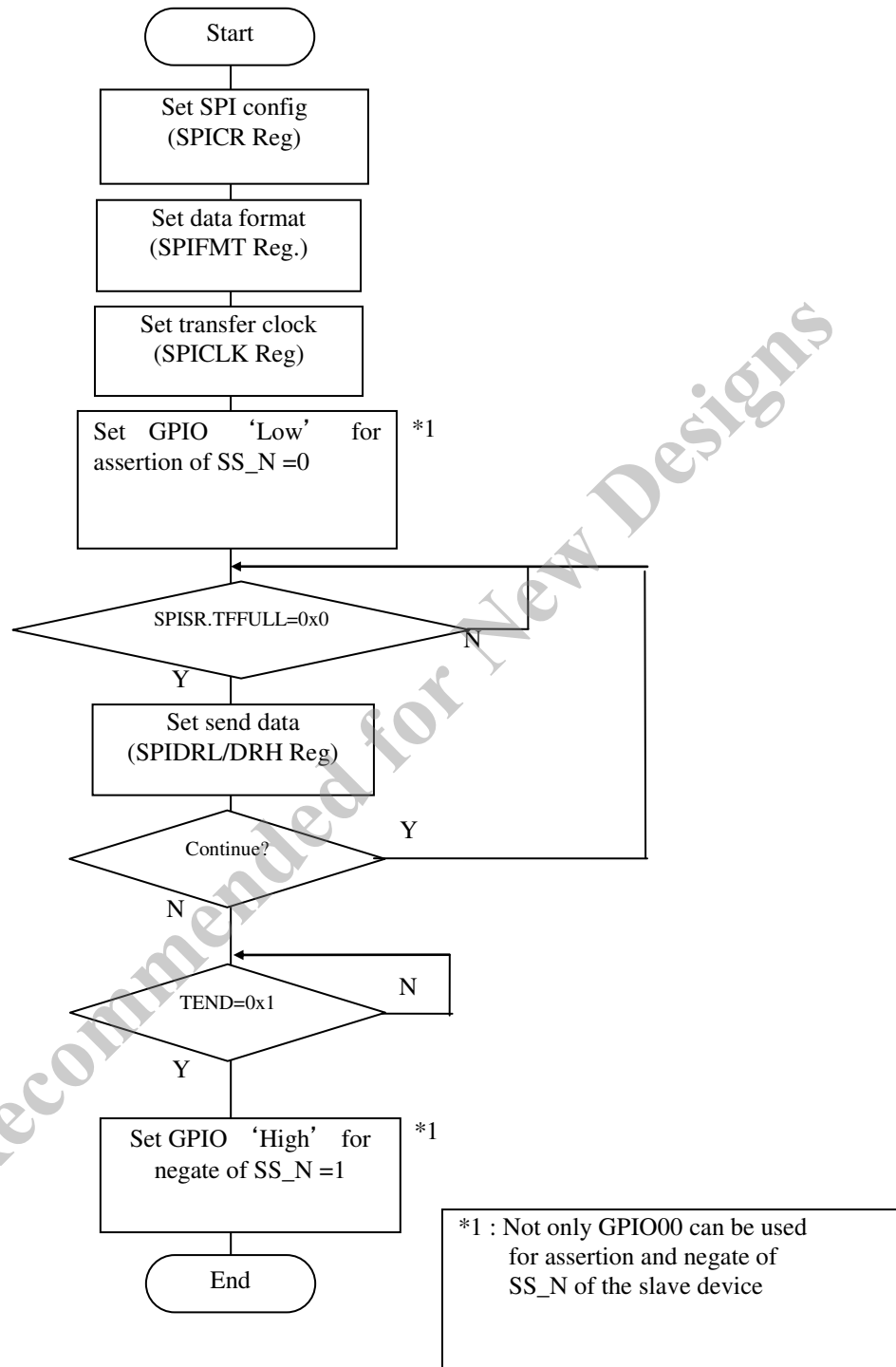


Figure 17-11 Master mode (Transmission)

Receive

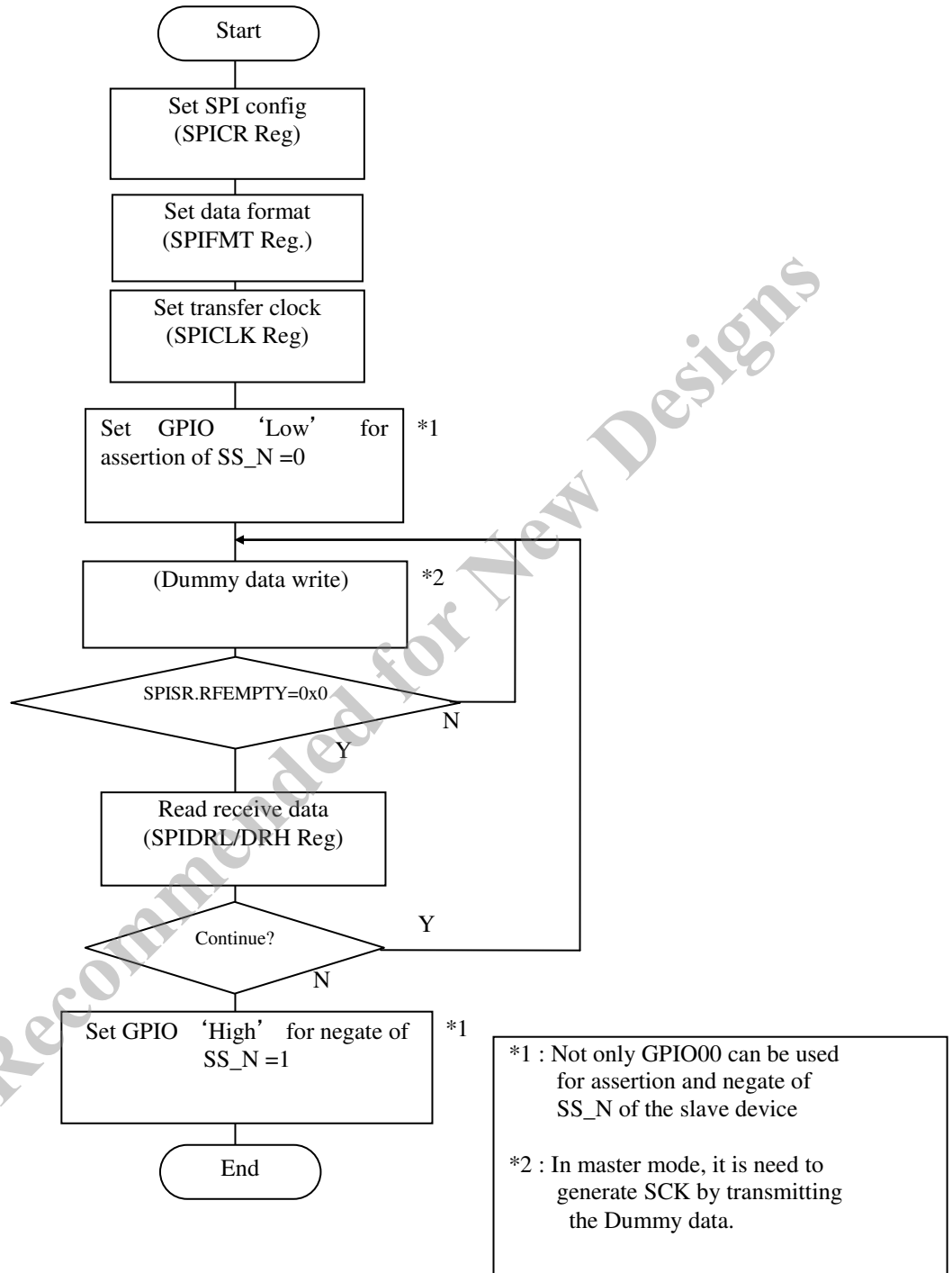


Figure 17-12 Master mode (Receive)

17.5.2 Slave Mode

Transmission start

When SS_N is Low, slave mode is enabled for operation. In slave mode, data transfer is performed in the sample timing of SCK. When TXFIFO is empty and SPIDRL/H was written data, transmitted data will be transferred to the shift register via the TXFIFO. Also, when write data to SPIDRL / H are continuously, TXFIFO status become full (SPISR.TFFULL=1).

Completion of transmission

In slave mode, SPI exits the serial transfer when receive the last SCK edge. In this case, SPIF of SPISR is changed to to1'b1.

Completion of reception

When the received data is written to RXFIFO, status of RXFIFO shows not empty (SPISR.REMPTY = 0). By reading a SPI data register (SPIDRL, SPIDRH), data can be read from RXFIFO. Depending on the number of received data RXFIFO status change.

The flow of transmit/receive operation of the slave mode is described below.

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Transmission

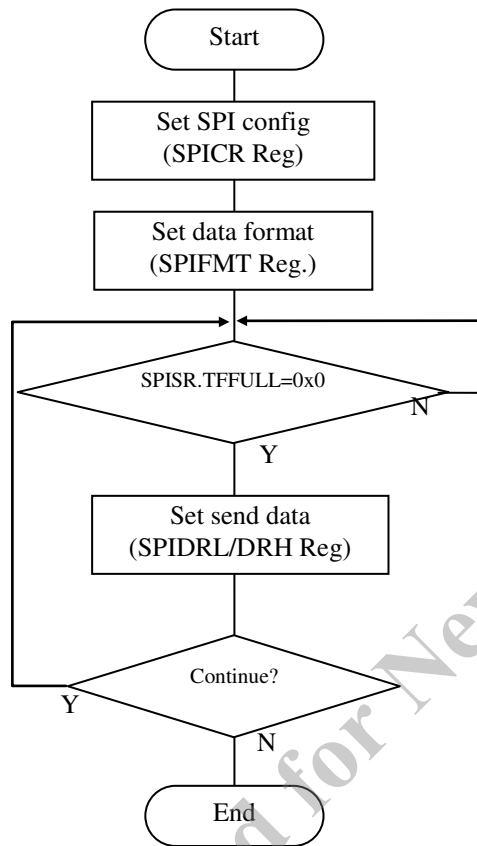


Figure 17-13 Slave mode (Transmission)

Not Recommended for New Designs

Receive

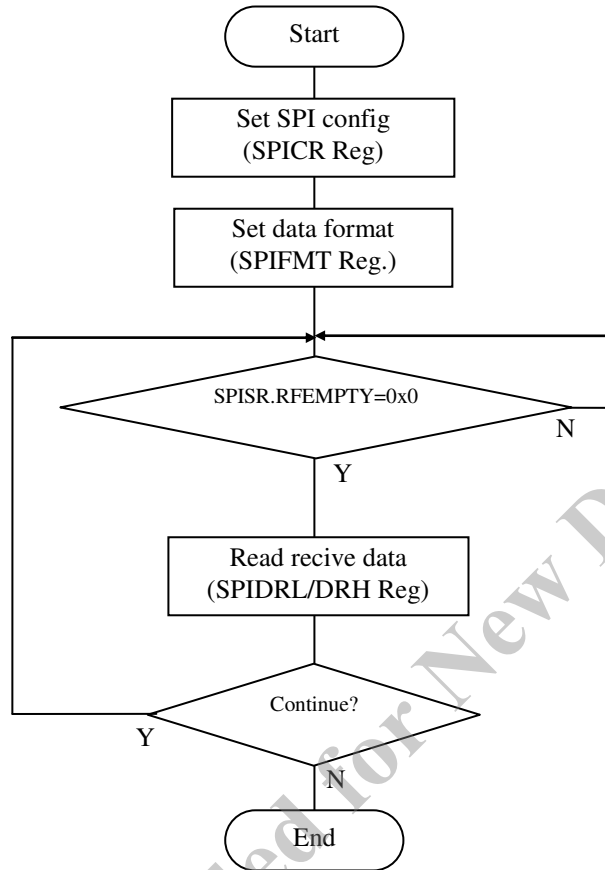


Figure 17-14 Slave mode (Receive)

18. I2C (SMBUS)

18.1 Overview

The LSI has I2C communication module which supports both master mode and slave mode.

Table 18-1 Feature of I2C

Item	Description
Communication Format	- I2C bus format or SMBUS format - Master Mode or Slave Mode selectable
Clocks	CLKSLOW/8 CLKSLOW/32 CLKSLOW/128 CLKSLOW/512
Supported Functions	General Call address
Interrupt Source	Single Sources

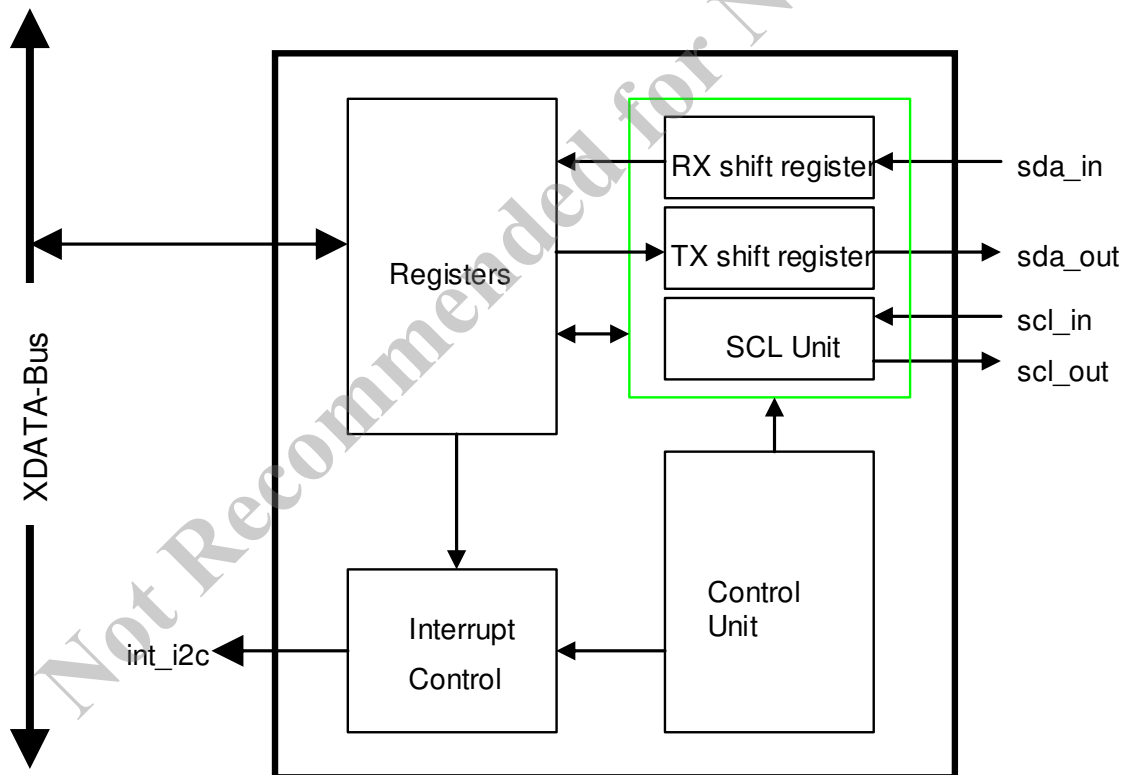


Figure 18-1 Block Diagram of I2C

18.2 Register Description

Table 18-2 List of Registers

Symbol	Name	Address	Initial value
ICCR	I2C Bus Control Register	0xFC00	0x00
ICSR	I2C Bus Status Register	0xFC01	0x00
ICRXDR	I2C Bus Receive Data Register	0xFC02	0x00
ICTXDR	I2C Bus Transmit Data Register	0xFC03	0x00
ICTSAR	I2C Transmit Address Register	0xFC04	0x00
ICSAR	I2C Slave Address Register	0xFC05	0x00
ICCLK	I2C Clock Divid Register	0xFC06	0x03
ICCMD	I2C Command Register	0xFC07	0x00
ICSSTR	I2C Bus SDA Setup Time Register	0xFC08	0x01
ICSHTR	I2C Bus SDA Hold Time Register	0xFC09	0x00
ICHDSR0	I2C Bus SDA Hardware Status Register 0	0xFC0A	0xC0
ICHDSR1	I2C Bus SDA Hardware Status Register 1	0xFC0B	0x00
ICTIMER	I2C Time Base Register	0xFC10	0xFF
SMBINT	SMBUS INT Status Register	0xFC11	0x00

18.2.1 I2C Bus Control Register (ICCR)

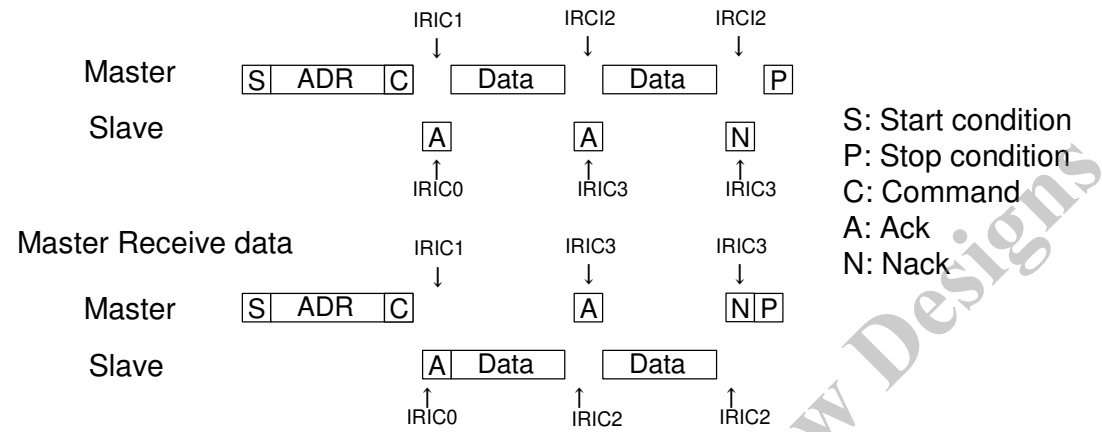
Register		ICCR		I2C Bus Control Register	Address	0xFC00
Bit	Bit Name	R/W	Initial	Description	Note	
7	ICE	R/W	0	I2C Bus I/F Enable 0 : Disable the I2C 1 : Enable the I2C		
6	IEIC0	R/W	0	IRIC0 Interrupt Enable 0 : IRIC0 interrupt disabled 1 : IRIC0 interrupt enabled		
5	IEIC1	R/W	0	IRIC1 Interrupt Enable 0 : IRIC1 interrupt disabled 1 : IRIC1 interrupt enabled		
4	IEIC2	R/W	0	IRIC2 Interrupt Enable 0 : IRIC2 interrupt disabled 1 : IRIC2 interrupt enabled		
3	IEIC3	R/W	0	IRIC3 Interrupt Enable 0 : IRIC3 interrupt disabled 1 : IRIC3 interrupt enabled		
2	IEIC4	R/W	0	IRIC4 Interrupt Enable 0 : IRIC4 interrupt disabled 1 : IRIC4 interrupt enabled		
1	IEIC5	R/W	0	IRIC5 Interrupt Enable 0 : IRIC5 interrupt disabled 1 : IRIC5 interrupt enabled		
0	GCAE	R/W	0	General Call Address Enable GCAE control the Reply to General Call Address as Slave device. 0 : GCA reply disable 1 : GCA reply enable		

18.2.2 I2C Bus Status Register (ICSR)

Register		ICSR		I2C Bus Status Register		Address	0xFC01
Bit	Bit Name	R/W	Initial	Description		Note	
7	BBSY	R	0	I2C Bus Busy Detection Flag The BBSY flag indicates whether the I2C bus is occupied (bus busy) or released (bus free). 0 : The I2C bus is released [Clear condition] When a stop condition is detected 1 : The I2C bus is occupied [Set condition] When a start condition is detected			
6	IRIC0	R/C	0	Slave Access Detection Interrupt After having detected the concordance with the slave address or GCAE=1 and General calling address at the time of slave mode, IRIC0 is set to 1 when transmit ACK. Please refer to Figure 18-8 and Figure 18-9 for the set timeliness of IRIC0. 0 : No Interrupt [Clear condition] "1" write from CPU 1 : During interrupt [Set condition] Detected the concordance with the slave address or GCAE=1 and General calling address at the time of slave mode.			
5	IRIC1	R/C	0	Received ACK/NACK Interrupt (1) (After the transmission of the address / command) When received ACK/NACK, after the transmission of the address / command, IRIC1 is set to 1. Please refer to Figure 18-10 and Figure 18-11 for the set timeliness of IRIC. 0 : No Interrupt [Clear condition] "1" write from CPU 1 : During interrupt [Set condition] When received ACK/NACK, after the transmission of the address / command.			

Register		ICSR		I2C Bus Status Register		Address	0xFC01
Bit	Bit Name	R/W	Initial	Description		Note	
4	IRIC2	R/C	0	<p>Received ACK/NACK Interrupt (2) (After the transmission of the data)</p> <p>When received ACK/NACK, after the transmission of the data, IRIC2 is set to 1.</p> <p>Please refer to Figure 18-9 and Figure 18-11 for the set timeliness of IRIC2.</p> <p>0 : No Interrupt [Clear condition] “1” write from CPU</p> <p>1 : During interrupt [Set condition] Received ACK/NACK, after the transmission of the data.</p>			
3	IRIC3	R/C	0	<p>Data Reception Complete Interrupt</p> <p>Before ACK/NACK transmission in the data reception complete, IRIC3 is set to 1.</p> <p>Please refer to Figure 18-8 and Figure 18-10 for the set timeliness of IRIC3.</p> <p>0 : No Interrupt [Clear condition] “1” write from CPU</p> <p>1 : During interrupt [Set condition] Data reception complete (before ACK/NACK transmission)</p>			
2	IRIC4	R/C	0	<p>SMBus Interrupt</p> <p>In IRIC4, the OR of the interrupt factor of the SMBINT register is displayed.</p> <p>Please clear the interrupt factor of the SMBINT register to clear it.</p> <p>0 : No Interrupt 1 : During interrupt</p>			
1	IRIC5	R/C	0	<p>Stop Condition Interrupt</p> <p>When Stop Condition is detected, IRIC5 is set to 1.</p> <p>0 : No Interrupt [Clear condition] “1” write from CPU</p> <p>1 : During interrupt [Set condition] detected Stop Condition.</p>			
0	RXACK	R	0	<p>Receive Acknowledge</p> <p>This bit is used to store the acknowledge bit information received from the slave device in Master mode.</p> <p>This bit is used to store the acknowledge bit information received from the master device in Slave mode.</p> <p>0 : Received as the acknowledge bit (ACK reception) 1 : Received as the acknowledge bit (NACK reception)</p>			

Master Send data



Master Receive data

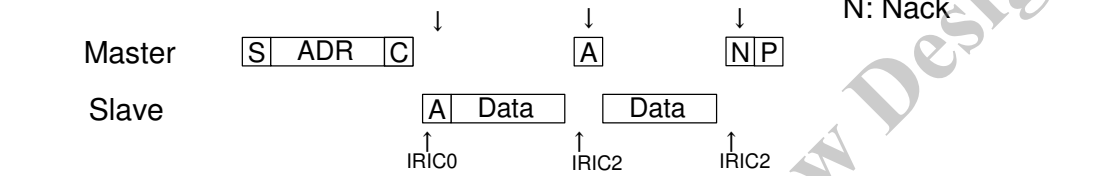


Figure 18-2 Interrupt timing schematic view

18.2.3 I2C Bus Receive Data Register (ICRXDR)

Register		ICRXDR		I2C Bus Receive Data Register		Address	0xFC02
Bit	Bit Name	R/W	Initial	Description		Note	
7	ICRXDR7	R	0	Receive Data[7]			
6	ICRXDR6	R	0	Receive Data[6]			
5	ICRXDR5	R	0	Receive Data[5]			
4	ICRXDR4	R	0	Receive Data[4]			
3	ICRXDR3	R	0	Receive Data[3]			
2	ICRXDR2	R	0	Receive Data[2]			
1	ICRXDR1	R	0	Receive Data[1]			
0	ICRXDR0	R	0	Receive Data[0]			

ICRXDR has to perform the read-out of data after the reception of data was completed.
 Can confirm the completion of the data reception by IRIC (ICSR register).

18.2.4 I2C Bus Transmit Data Register (ICTXDR)

Register		ICTXDR		I2C Bus Transmit Data Register		Address	0xFC03
Bit	Bit Name	R/W	Initial	Description		Note	
7	ICTXDR7	R/W	0	Transmit Data[7]			
6	ICTXDR6	R/W	0	Transmit Data[6]			
5	ICTXDR5	R/W	0	Transmit Data[5]			
4	ICTXDR4	R/W	0	Transmit Data[4]			
3	ICTXDR3	R/W	0	Transmit Data[3]			
2	ICTXDR2	R/W	0	Transmit Data[2]			
1	ICTXDR1	R/W	0	Transmit Data[1]			
0	ICTXDR0	R/W	0	Transmit Data[0]			

Start transmission by writing in data at ICTXDR.

Writing is prohibition until the transmission of data is completed in ICTXDR.

When write in ICTXDR during the transmission of data, the contents of data are destroyed.

18.2.5 Transmit Address Register (ICTSAR)

Register		ICTSAR		I2C Transmit Address Register		Address	0xFC04
Bit	Bit Name	R/W	Initial	Description		Note	
7	ADR6	R/W	0	Transmit Address [6]			
6	ADR5	R/W	0	Transmit Address [5]			
5	ADR4	R/W	0	Transmit Address [4]			
4	ADR3	R/W	0	Transmit Address [3]			
3	ADR2	R/W	0	Transmit Address [2]			
2	ADR1	R/W	0	Transmit Address [1]			
1	ADR0	R/W	0	Transmit Address [0]			
0	CMD	R/W	0	Transmit Command 0 : Write Command 1 : Read Command			

Please take start in ICCMD registers after setting in ICTSAR registers.

18.2.6 Slave Address Register (ICSAR)

Register		ICSAR		I2C Slave Address Register		Address	0xFC05
Bit	Bit Name	R/W	Initial	Description		Note	
7	SVA6	R/W	0	Slave Address [6]			
6	SVA5	R/W	0	Slave Address [5]			
5	SVA4	R/W	0	Slave Address [4]			
4	SVA3	R/W	0	Slave Address [3]			
3	SVA2	R/W	0	Slave Address [2]			
2	SVA1	R/W	0	Slave Address [1]			
1	SVA0	R/W	0	Slave Address [0]			
0	CMD	R	0	Receive Command 0 : Write Command 1 : Read Command			

When the receive slave address matches the SVA[5:0] value in ICSAR, work as a slave device appointed to a master device.

18.2.7 Clock Divid Register (ICCLK)

Register		ICCLK		I2C Clock Divid Register		Address	0xFC06
Bit	Bit Name	R/W	Initial	Description		Note	
7-2	Reserved	R	0	Reserved			
1	DIV[1]	R/W	1	SCL Minimum Pulse Width Setting 00: tSCLH/tSCLL= CLKSLOW 8cycle 01: tSCLH/tSCLL= CLKSLOW 32cycle 10: tSCLH/tSCLL = CLKSLOW 128cycle 11: tSCLH/tSCLL = CLKSLOW 512cycle			
0	DIV[0]	R/W	1				

Set SCL minimum pulse width with a number for a cycle of CLKSLOW.
The SCL pulse width (tHigh/tLow) on Bus spreads than this setting to need 5cycle for noise filter & synchronization.

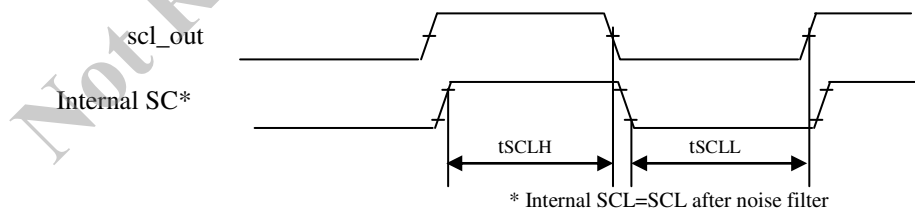


Figure 18-3 tSCLH/tSCLL Timing definition

Table 18-3 Restrictions of the minimum clock frequency

SCL frequency	0 - 100KHz(Normal mode)	0 - 400KHz(Fast mode)
CLKSLOW frequency	upper than 1.74MHz	upper than 6.67MHz

18.2.8 I2C Command Register (ICCMD)

Register		ICCMD		I2C Command Register		Address	0xFC07
Bit	Bit Name	R/W	Initial	Description		Note	
7-5	Reserved	R	0	Reserved			
4	NACK	R/W	0	NACK Answer After the data reception in the slave mode, return NACK answer. When an ACK bit is set or when be going to set it with an ACK bit, the NACK bit is not set. 0 : No action 1 : NACK answer When NACK answer complete, this bit is "0" cleared. *Be not set during master mode.			
3	ACK	R/W	0	ACK Answer After the data reception in the slave mode, return ACK answer. When an NACK bit is set , the ACK bit is not set. 0 : No action 1 : ACK answer When ACK answer complete, this bit is "0" cleared.			
2	RDCNT	R/W	0	Read Continue In a master mode, require the reading of the next data. Be not set during slave mode. 0 : No action 1 : Require the reading When Read data reception start, this bit is "0" cleared.			
1	END	R/W	0	Stop Condition generation Finish a data transfer, and require generation of the STOP condition. Change in a slave mode. Be not set during slave mode. When a GO bit is set or when be going to set it with a GO bit, the END bit is not set. 0 : No action 1 : Stop Condition generation When stop condition detected, this bit is "0" cleared.			
0	GO	R/W	0	Start Condition generation Generate START condition, and require the transmission start of the address / command. Change in a master mode. Be not set during slave mode. When an END bit is set, the GO bit is not set. 0 : No action 1 : Start Condition generation When start condition detected, this bit is "0" cleared.			

ICCMD is performed an initialization of in at the time of reset or ICCR register /ICE bit = 'zero' by 0x00.

18.2.9 I2C Bus SDA Setup Time Register (ICSSTR)

Register	ICSSTR		I2C Bus SDA Setup Time Register	Address	0xFC08	
Bit	Bit Name	R/W	Initial	Description		Note
7-6	Reserved	R	0	Reserved		
5	ICSSTR5	R/W	0	SDA Setup time setting [5]		
4	ICSSTR4	R/W	0	SDA Setup time setting [4]		
3	ICSSTR3	R/W	0	SDA Setup time setting [3]		
2	ICSSTR2	R/W	0	SDA Setup time setting [2]		
1	ICSSTR1	R/W	0	SDA Setup time setting [1]		
0	ICSSTR0	R/W	1	SDA Setup time setting [0]		

Use it for setting of the setup time of the SDA output for the SCL rising edge.
 Minimum value of ICSSTR is 0x00, and, maximum value, is 0x3F ..tSU:DAT is determined by the following expression.

$$t_{SU:DAT} = (ICSSTR + 1) \times (\text{period of CLK_SLOW [ns]})$$

When CLK_SLOW is 25MHz, becomes the set range of 40ns - 2.56μs

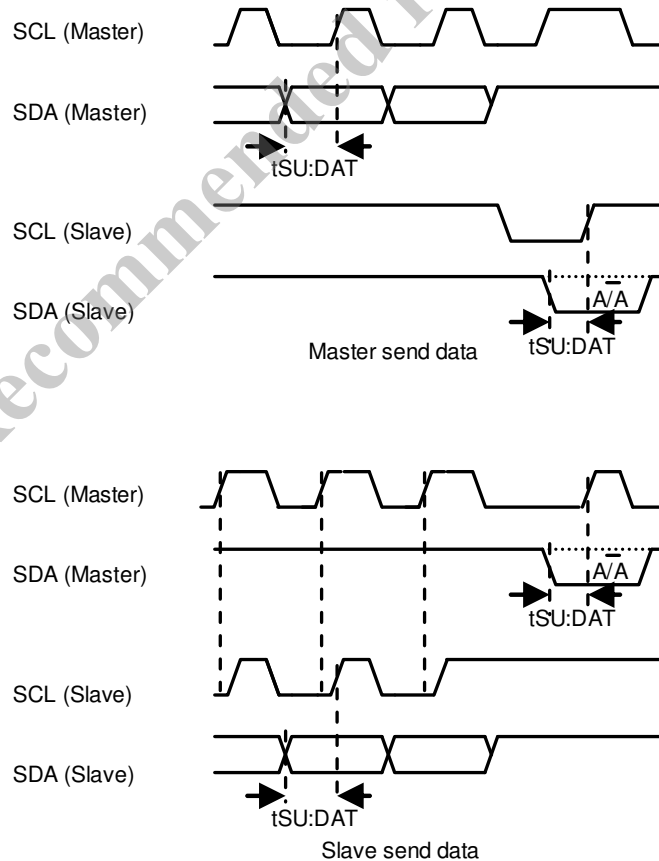


Figure 18-4 SDA Setup-time vs SCL rising

18.2.10 I2C Bus SDA Hold Time Register (ICSHTR)

Register		ICSHTR		I2C Bus SDA Hold Time Register		Address	0xFC09
Bit	Bit Name	R/W	Initial	Description		Note	
7	ICSHEXP	R/W	0	Expand SDA output Hold 0 : No expand CLKSLOW is up to 12.5MHz, or when Don't use it as SMBUS. 1 : Expand SDA output Hold CLKSLOW is more than 12.5MHz, and when use it as SMBUS. The SDA output delays 3 cycles in comparison with "zero" setting in CLKSLOW when I set it in "1".			
6-5	Reserved	R	0	Reserved			
4	ICSHTR4	R/W	0	SDA Hold time setting [4]			
3	ICSHTR3	R/W	0	SDA Hold time setting [3]			
2	ICSHTR2	R/W	0	SDA Hold time setting [2]			
1	ICSHTR1	R/W	0	SDA Hold time setting [1]			
0	ICSHTR0	R/W	0	SDA Hold time setting [0]			

In the slave address reception and a slave receive mode, use it for delay time setting to secure hold time for SCL of the SDA internally.

$$t_{HD:DAT} = (ICSHTR) \times (\text{period of CLKSLOW [ns]})$$

When CLKSLOW is 25MHz, becomes the set range of 0 ns – 1240 ns.

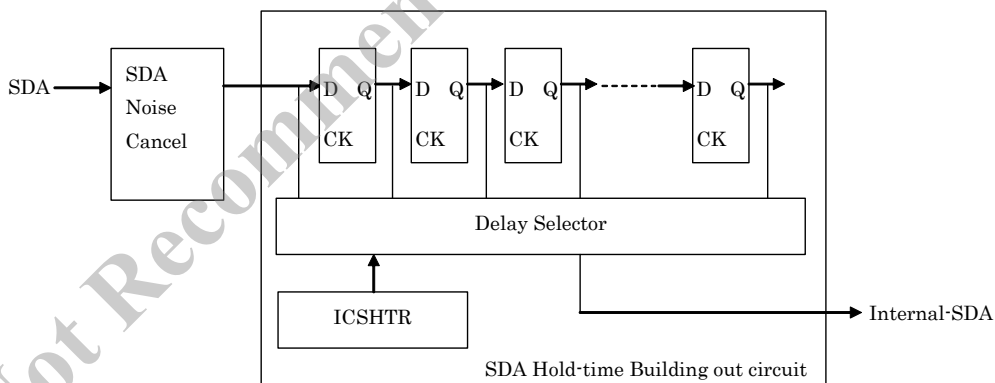


Figure 18-5 Internal-SDA generation block diagram

At the time of ICSSTR and the ICSHTR setting, please set it to satisfy the following relations.

$$(\text{Setup time by ICSSTR}) > (\text{Setup time by ICSHTR}) - (\text{Relative delay time of SDA and SCL})$$

As for the SDA and the relative delay time of SCL, it is with a difference of the delay time of SDA signal and the SCL signal on the I2C bus. In addition, this delay time lag needs consideration of the operating environment to be affected by the operating environment of the real I2C bus.

$$(\text{Relative delay time of SDA and SCL}) = (\text{SCL delay time}) - (\text{SDA delay time})$$

18.2.11 I2C Bus SDA Hardware Status Register 0(ICHDSR0)

Register		ICHDSR0		I2C Bus SDA Hardware Status Register 0		Address	0xFC0A
Bit	Bit Name	R/W	Initial	Description		Note	
7	SDAMON	R	1	Monitor of SDA signal. 0 : SDA is 'L' 1 : SDA is 'H'			
6	SCLMON	R	1	Monitor of SDA signal. 0 : SCL is 'L' 1 : SCL is 'H'			
5	SDACHG	R/C	0	SDACHG outputs having SDA signal change or not. 0 : no detect of SDA signal change [Clear condition] "1" write from CPU 1 : detect of SDA signal change [Set condition] When detect of SDA signal change			
4	SCLCHG	R/C	0	SCLCHG outputs having SCL signal change or not. 0 : no detect of SCL signal change [Clear condition] "1" write from CPU 1 : detect of SCL signal change [Set condition] When detect of SCL signal change			
3-0	Reserved	R	0	Reserved			

18.2.12 I2C Bus SDA Hardware Status Register 1(ICHDSR1)

Register		ICHDSR1		I2C Bus SDA Hardware Status Register 1		Address	0xFC0B
Bit	Bit Name	R/W	Initial	Description		Note	
7-5	Reserved	R	0	Reserved			
4	I2C_ST4	R	0	State machine status [4]			
3	I2C_ST3	R	0	State machine status [3]			
2	I2C_ST2	R	0	State machine status [2]			
1	I2C_ST1	R	0	State machine status [1]			
0	I2C_ST0	R	0	State machine status [0]			

18.2.13 I2C Time Base Register

Register		ICTIMER		I2C Time Base Register	Address	0xFC10
Bit	Bit Name	R/W	Initial	Description	Note	
7	TIME7	R/W	1	I2C Time Base To make “1ms” time tick, set value as shown below ICTIMER = ((Frequency of CLKSLOW)/10 ³ /128) -1		
6	TIME6	R/W	1			
5	TIME5	R/W	1			
4	TIME4	R/W	1			
3	TIME3	R/W	1			
2	TIME2	R/W	1			
1	TIME1	R/W	1			
0	TIME0	R/W	1			

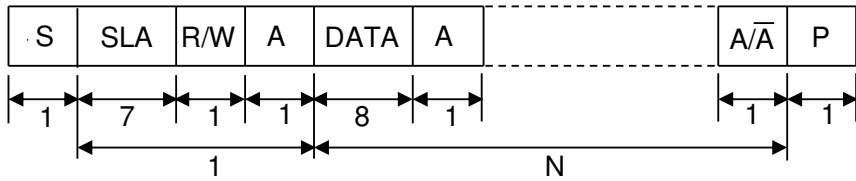
18.2.14 SMBUS INT Status Register

Register		SMBINT		SMBUS INT Status Register	Address	0xFC11
Bit	Bit Name	R/W	Initial	Description	Note	
7-3	Reserved	R	0	Reserved		
2	IRSM2	R/C	0	When IRSM2 detects violation of TTIMEOUT defined in SMBUS standard, be set to “1”. Judge the TTIMEOUT violation as ICTIMER register setting = 1ms. 0 : No Interrupt [Clear Condition] “1” write from CPU 1 : During interrupt [Set condition] Detects violation of TTIMEOUT		
1	IRSM1	R/C	0	When IRSM1 detects violation of TLOW:SEXT defined in SMBUS standard, be set to “1”. Judge the TLOW:SEXT violation as ICTIMER register setting = 1ms. 0 : No Interrupt [Clear Condition] “1” write from CPU 1 : During interrupt [Set condition] Detects violation of TLOW:SEXT		
0	IRSM0	R/C	0	When IRSM0 detects violation of TLOW:MEXT defined in SMBUS standard, be set to “1”. Judge the TLOW:MEXT violation as ICTIMER register setting = 1ms. 0 : No Interrupt [Clear Condition] “1” write from CPU 1 : During interrupt [Set condition] Detects violation of TLOW:MEXT		

18.3 I2C bus data format

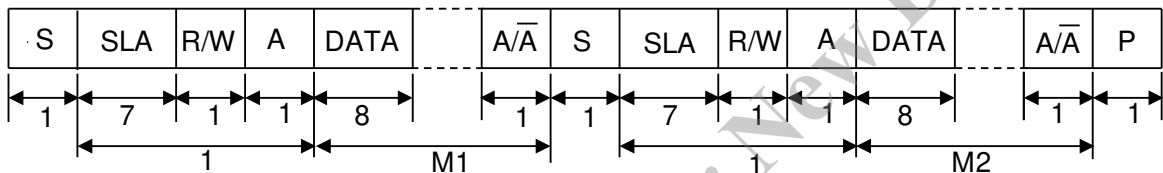
I2C bus interface are two kinds of data format (Figure 18-6). The first byte following the start condition will always be 8bit configuration. Figure 18-7 shows the timing of the I2C bus.

(a) Transfer format



N: Number of bytes transferred

(a) Transfer format (Retransmitting a start condition)



M1, M2: Number of bytes transferred

Figure 18-6 I2C bus data format

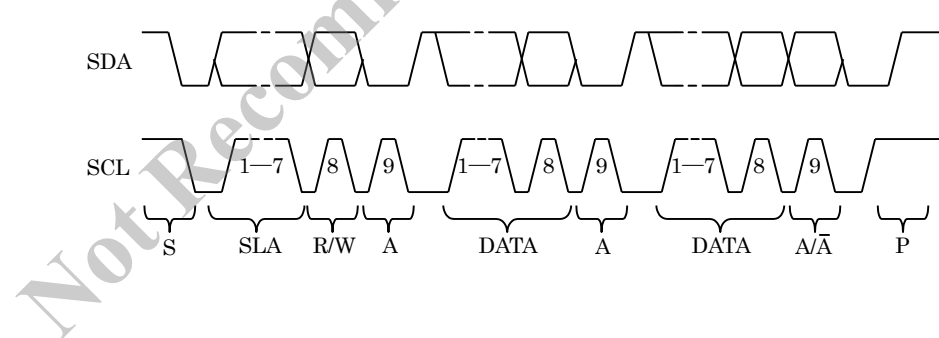


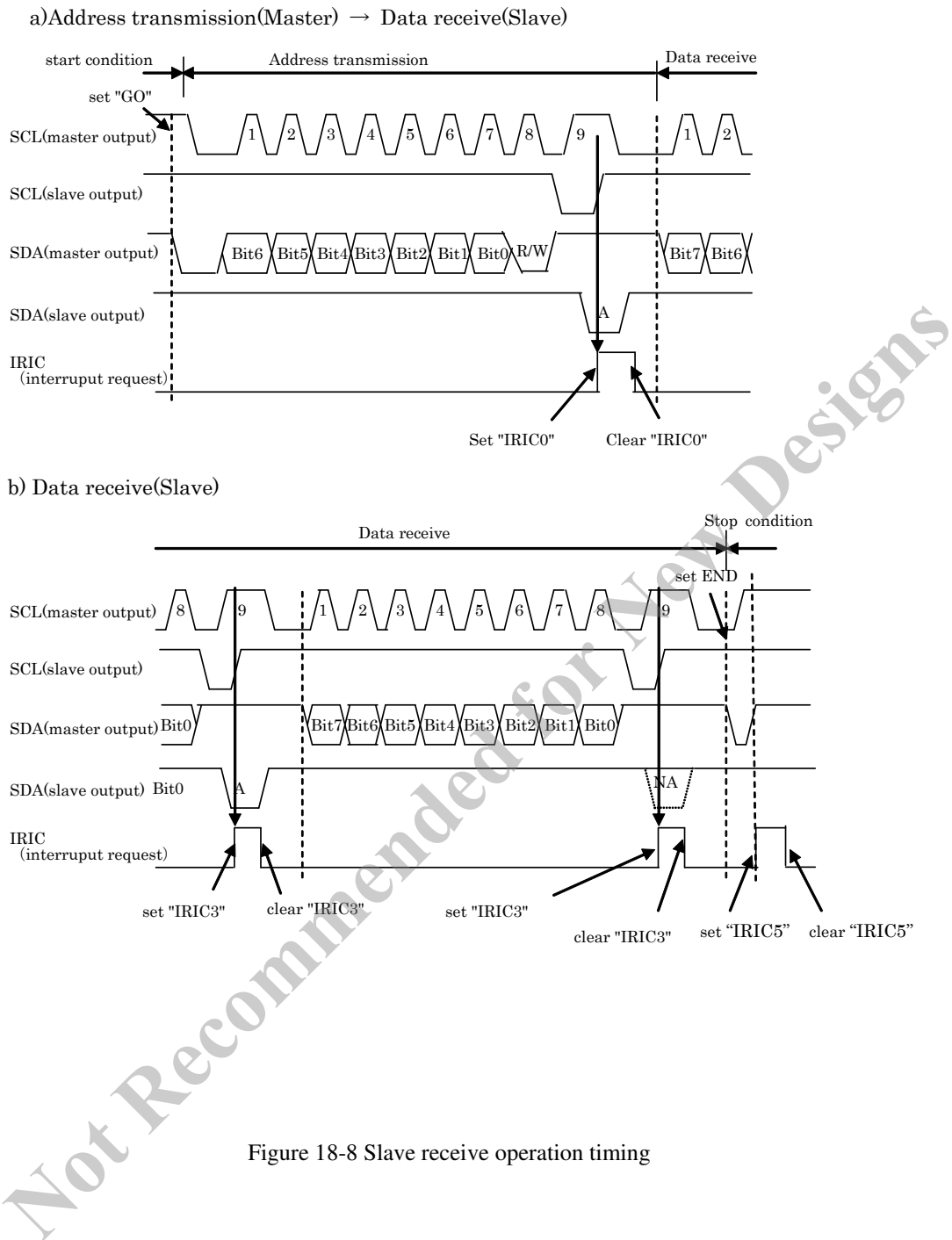
Figure 18-7 I2C bus timing

18.4 Slave receiver operation

In slave receiver operation, the master device outputs the slave address, data and clock. The slave device returns acknowledgements. The following describes the procedure and operations for slave reception.

- (1) Set the ICE bit in ICCR to "1".
- (2) Set slave address to the SVA bit in ICSAR.
- (3) The master device sends a slave address and a write command following a start condition.
- (4) To compare the SVA bit in ICSAR and received slave address.
- (5) After receiving matching slave address, stored in the CMD bit in ICSAR a write command, and returns acknowledgements to the master device.
- (6) At the same time send acknowledgements, IRIC0 bit in ICSR is set to "1" and generates an interrupt.
- (7) Clear the IRIC0 bit in ICSR to "0".
- (8) The slave receives the data from the master device.
- (9) The slave stores the received data into ICRXDR, and IRIC3 bit in ICSR set to "1".
- (10) If want to continue to receive operations, ACK bit in ICCMD set to "1". Then ACK response is output to I2C bus.
- (11) If want to continue to receive operations, return (8).
- (12) If don't want to continue to receive operations, NACK bit in ICCMD set to "1". Then NACK response is output to I2C bus.
- (13) Clear the IRIC3 bit in ICSR to "0".
- (14) If detecting the stop condition, IRIC5 bit in ICSR is set to "1" and an interrupt is generated. Clear IRIC5 in ICSR to "0".

Not Recommended for New Designs



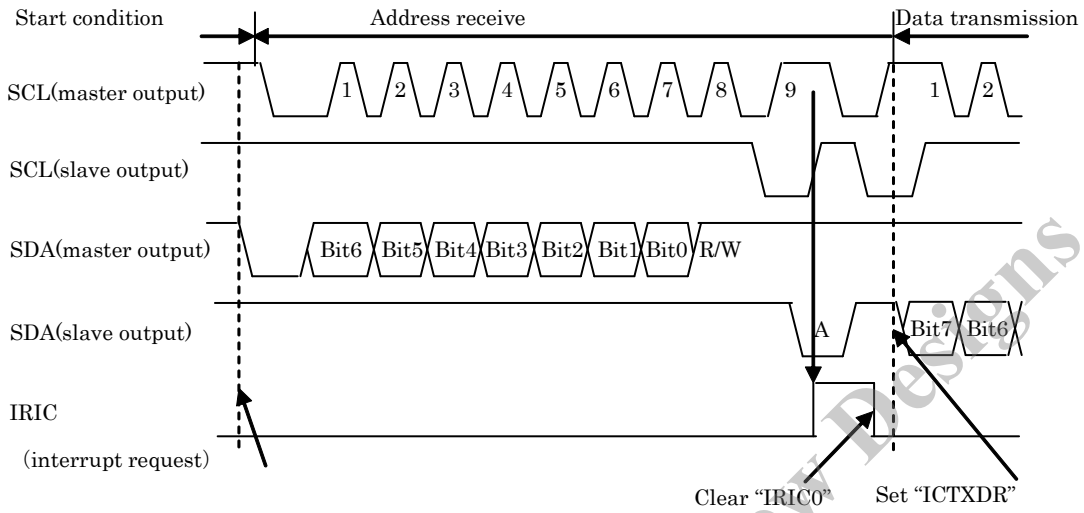
18.5 Slave transmitter operation

In slave transmitter operation, the slave device outputs transmit data, and the master device outputs the slave address, returns acknowledgements. The following describes the procedure and operations for master reception.

- (1) Set the ICE bit in ICCR to “1”.
- (2) Set slave address to the SVA bit in ICSAR.
- (3) The master device sends a slave address and a read command following a start condition.
- (4) To compare the SVA bit in ICSAR and received slave address.
- (5) After receiving matching slave address, stored in the CMD bit in ICSAR a read command, and returns acknowledgements to the master device.
- (6) At the same time send acknowledgements, IRIC0 bit in ICSR is set to “1” and generates an interrupt.
- (7) Clear the IRIC0 bit in ICSR to “0”.
- (8) When the transmit data is set in the ICTXDR, transmission is started.
- (9) When transmission is complete and receives ACK or NACK from the master device, IRIC2 bit in ICSR set to “1”.
- (10) To check the RXACK bit in ICSR for confirming which the ACK reception or NACK reception.
- (11) Clear the IRIC2 bit in ICSR to “0”.
- (12) If want to continue to transmission, return (8).
- (13) If detecting the stop condition, IRIC5 bit in ICSR is set to “1” and an interrupt is generated. Clear the IRIC5 bit in ICSR to “0”.

Not Recommended for New Designs

a) Address receive → Data transmission



b) Data transmission

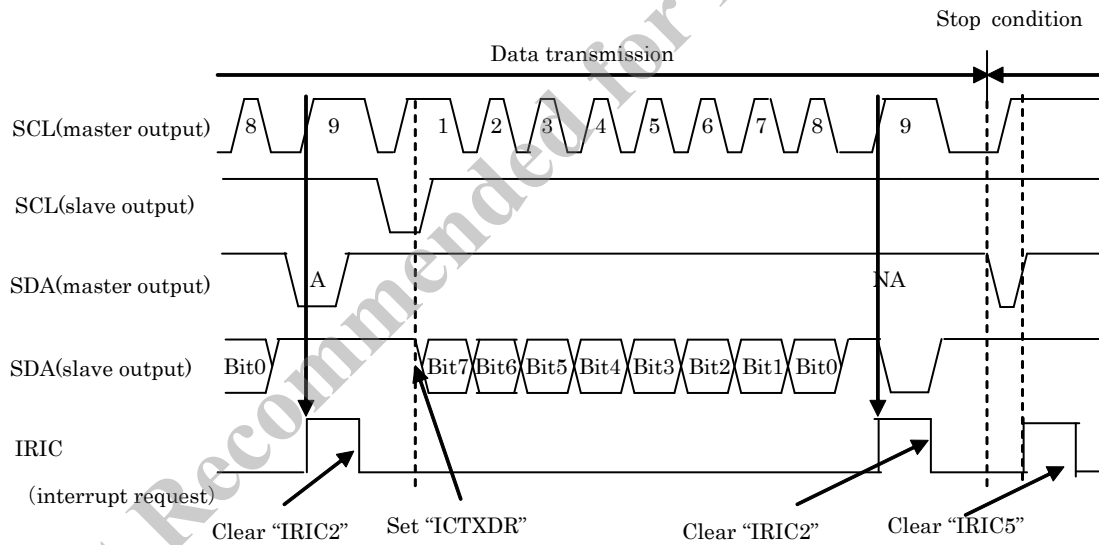


Figure 18-9 Slave transmit operation timing

18.6 Master receiver operation

In master receiver operation, the slave device outputs transmit data, and the master device outputs the slave address, returns acknowledgements. The following describes the procedure and operations for master reception.

- (1) Set the ICE bit in ICCR to "1".
- (2) Set the slave address to the ADR [6:0] in ICTSAR, and set CMD bit in ICTSAR to "1".
- (3) Set the GO bit in ICCMD to 1 in order to generate the start condition. When the start condition is detected, this GO bit is cleared automatically.
- (4) The master device sends a slave address and a read command following the start condition
- (5) At the same time receive ACK or NACK from the slave device, IRIC bit in ICSR is set to "1" and generates an interrupt..It is able to confirm which ACK reception or NACK reception by checking the RXACK bit in ICSR.. The master device will hold the SCL "Low" until write to any bit of ICCMD.
- (6) Clear the IRIC bit in ICSR to "0".
- (7) Set the RDCNT bit in ICCMD to "1" in order to release the SCL.
- (8) When receive the eight-bit data, IRIC3 bit in ICSR is set to "1" and generates interrupt. The master device will hold the SCL "Low" until write to any bit of ICCMD.
- (9) Clear the IRIC3 bit in ICSR to 0.
- (10) Read received data of ICRXDR.
- (11) If continue to receive operation :
Set the RDCNT bit in ICCMD to "1". Return the ACK to the slave device automatically, and repeat from (8) to (11).

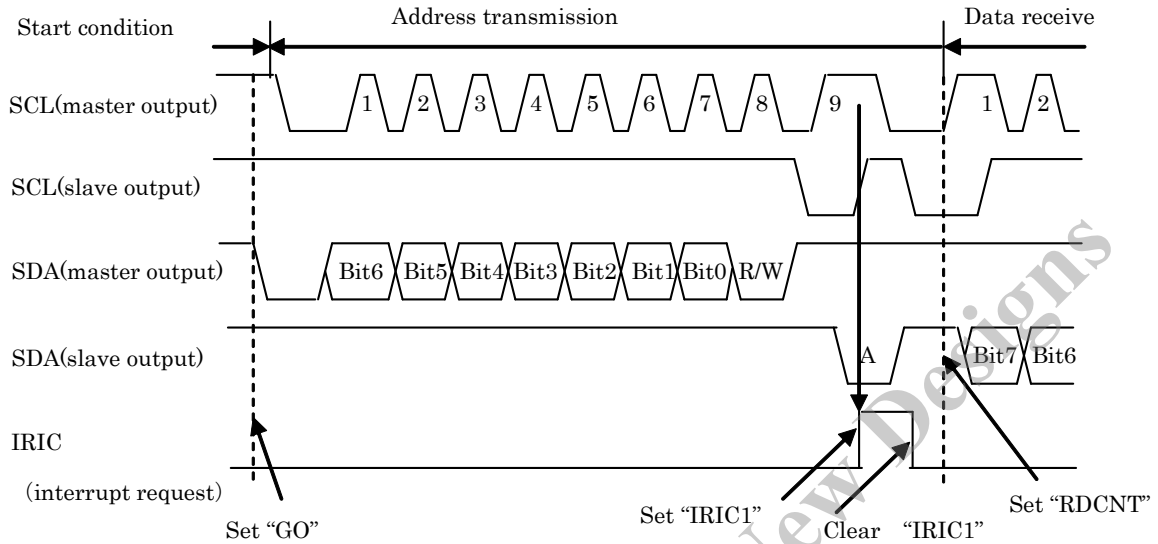
If stop the receiver operation :

Set the END bit in ICCMD to "1". Returning the NACK to the slave device automatically, the master device starts generating the stop condition. When it finishes generating the stop condition, the IRIC5 bit in ICSR is set to "1" and an interrupt is generated. Clear the IRIC5 bit in ICSR to "0".

If start the next operation

To check the BBSY bit in ICSR first for confirming the detection of the stop condition, then set the GO bit in ICCMD to "1".

a) Address transmission → data receive



b) Data receive

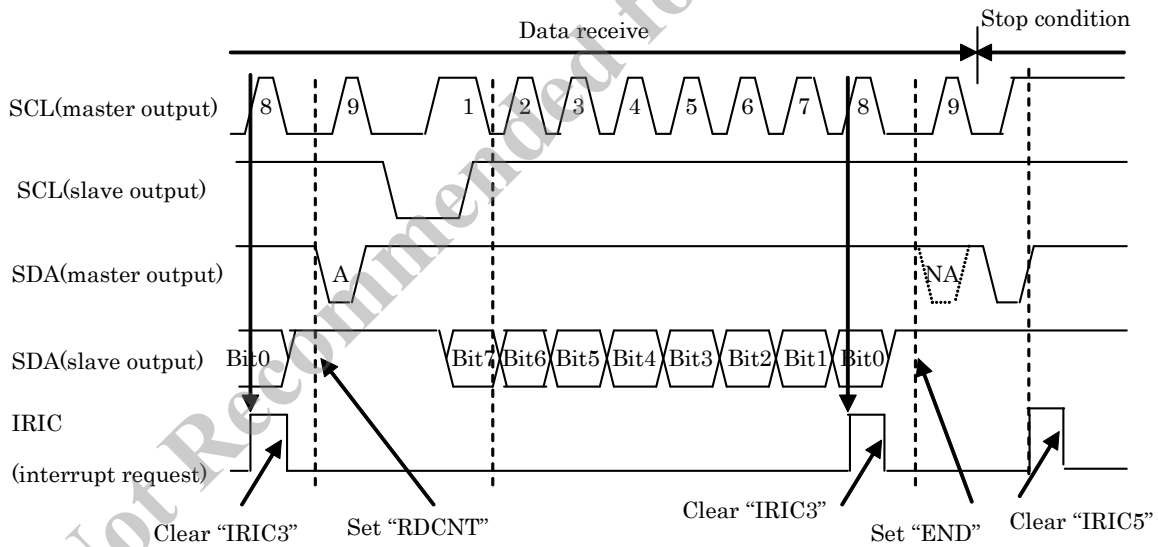


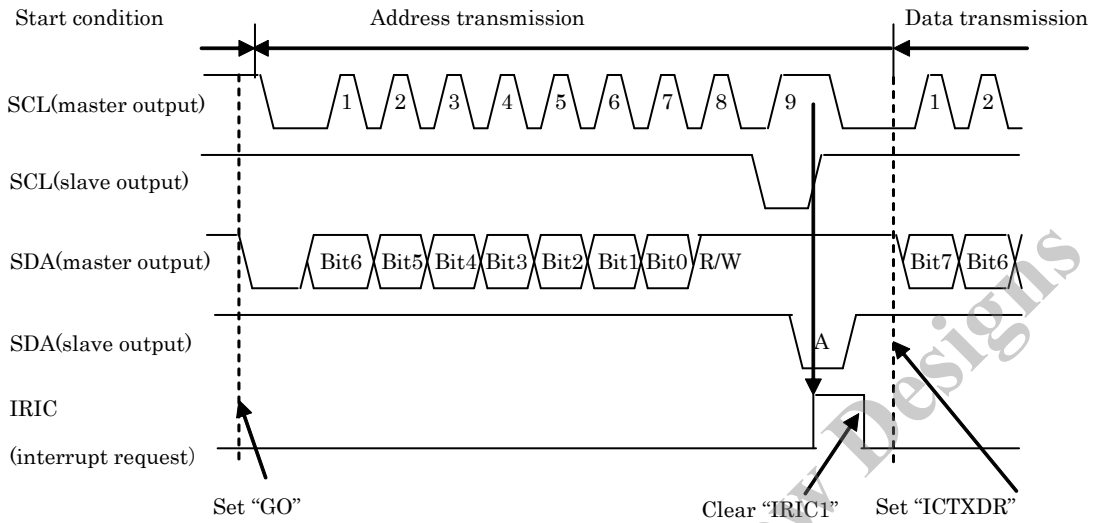
Figure 18-10 Master receive operation timing

18.7 Master transmitter operation

In master transmitter operation, master device outputs transmitted data and transmitted clock, and slave device returns acknowledgements. The following describes the procedure and operations for master transmission.

- (1) Set the ICE bit in ICCR to “1”.
 - (2) Set slave address to the ADR[6:0] in ICTSAR, and set CMD bit in ICTSAR to 0.
 - (3) Set the GObit in ICCMD to “1” in order to generate the start condition. When the start condition is detected, this GO bit is cleared automatically. .
 - (4) The master device sends a slave address and a read command following a start condition.
 - (5) At the same time receive ACK or NACK from the slave device, IRIC1 bit in ICSR is set to “1” and generates an interrupt.. ..It is able to confirm which ACK reception or NACK reception by checking the RXACK bit in ICSR.. The master device will hold the SCL “Low” until write to any bit of ICCMD or the transmit data into ICTXDR.
 - (6) Clear the IRIC1 bit in ICSR to “0”.
 - (7) Set the ICTXDR to transmit data.
 - (8) After complete transmission for the eight-bit data, The master device will wait for ACK or NACK from the slave device.
 - (9) At the same time receive ACK or NACK from the slave device, IRIC2 bit in ICSR is set to “1” and generates an interrupt. .It is able to confirm which ACK reception or NACK reception by checking the RXACK bit in ICSR.. The master device will hold the SCL “Low” until write to any bit of ICCMD or the transmit data into ICTXDR.
 - (10) Clear the IRIC2 bit in ICSR to 0.
 - (11) If continue to transmitter operation :
Set the transmit data into ICTXDR. Repeat from (8) to (11).
- If stop the transmitter operation :
Set the END bit in ICCMD to “1” and the master device starts generating the stop condition. When it finishes generating the stop condition, IRIC5 bit in ICSR is set to “1” and an interrupt is generated. Clear IRIC5 bit in ICSR to “0”.
- If start the next operation
To check the BBSY bit in ICSR first for confirming the detection of the stop condition, then set the GO bit in ICCMD to “1”.

a) Address transmission → Data transmission



b) Data transmission

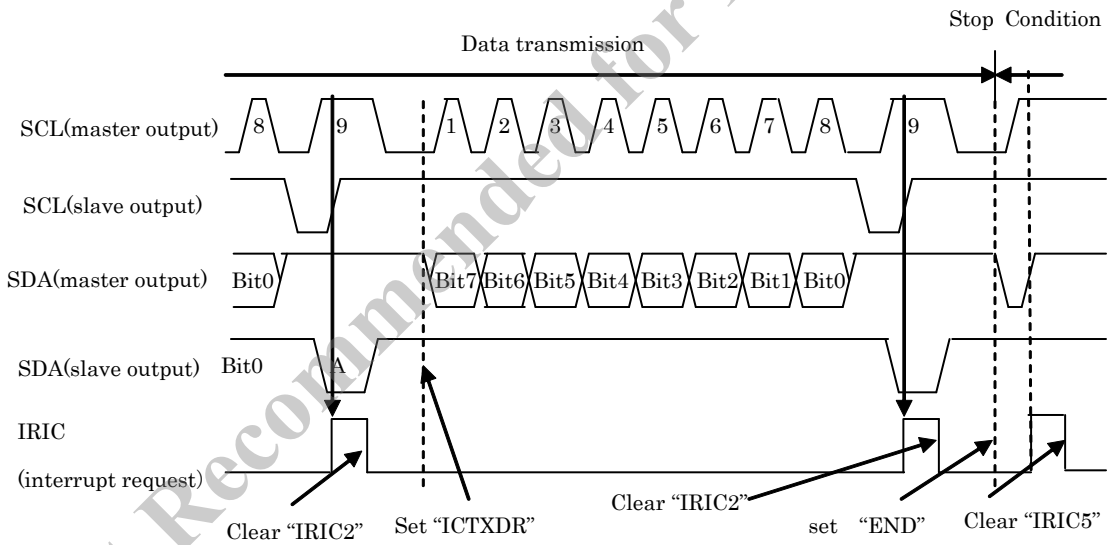


Figure 18-11 Master transmit operation timing

18.8 Noise Filter

SCL and SDA are taken into the internal circuit through the noise filter. Figure 18-12 shows the block diagram of the noise filter.

Noise filter is composed of flip-flop circuit and a match detector which are connected in series two-stage.

Noise filter is comprised of two steps of FF circuits and match detecting circuits. When SCL is sampled in CLKSLOW and two flip-flop outputs are matched, convey its level to the next stage. If outputs are unmatched, output is maintain a previous value.

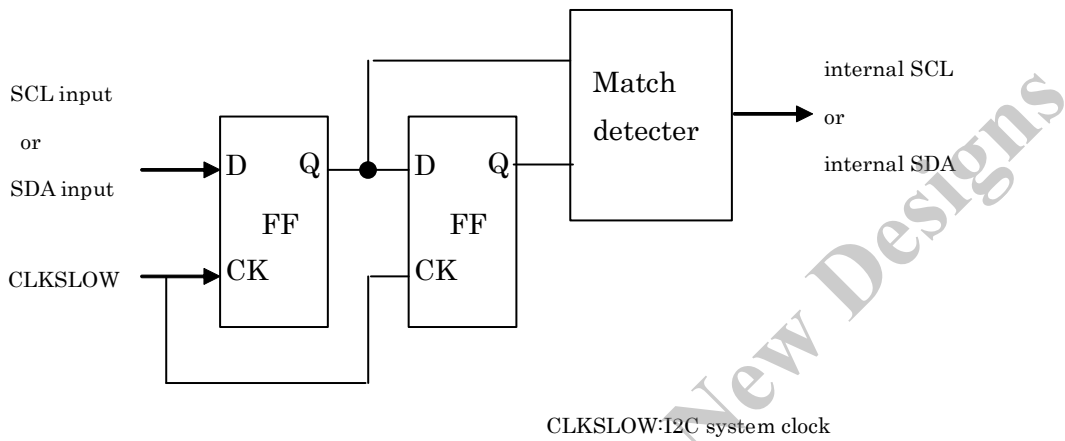


Figure 18-12 Block diagram of the noise filter

Not Recommended for New Designs

19. UART

The modem terminal control is not supported by the LSI.

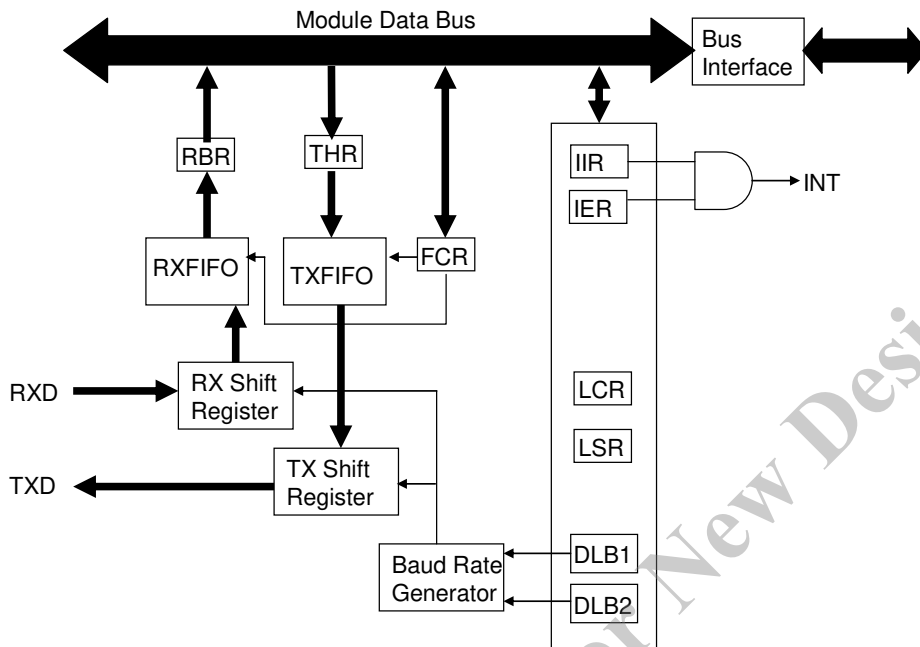
19.1 Overview

UART supports asynchronous serial I/O mode. UART has a dedicated timer to generate a transfer clock and operate independently.

Table 19-1 Feature of UART

Item	Description
Data Format	Data Length: 7, 8 or 9bits Start Bit: 1bit Parity Bit: odd, even or none Stop Bits: 1 or 2bits
Baud Rate	Based on Divisor Latch Bytes Baud Rate (bps) = CLKUART/16 x 1/ (n) CLKUART:CLKSLOW n: Setting value of Divisor Latch Bytes(DLB1 & DLB2)
FIFO	TXFIFO:16bytes RXFIFO:16bytes
Interrupt by TX	Transmit Buffer Empty Transfer Completed
Interrupt by RX	Receive Buffer Full Parity Error / Overrun Error / Framing Error

Not Recommended for New Designs



RXFIFO : Receiver FIFO
 TXFIFO : Transmitter FIFO

RX Shift Register: Receiver Shift Register
 TX Shift Register: Transmitter Shift Register

RXD: Receive Data
 TXD: Transmit Data

Figure 19-1 Block Diagram of UART

19.2 External (off-chip) connections

Port	Direction	Description
TXD	Output	Transmit Data
RXD	Input	Receive Data

19.3 Register Description

Table 19-2 List of registers

Symbol	Name	Address	Initial value
RBR	Receiver Buffer Register	0xFC80	indeterminate
THR	Transmitter Holding Register	0xFC80	indeterminate
IER	Interrupt Enable Register	0xFC81	0x00
IIR	Interrupt Identification Register	0xFC82	0xC1
FCR	FIFO Control Register	0xFC82	0xC0
LCR	Line Control Register	0xFC83	0x03
LSR	Line Status Register	0xFC85	0x60

In addition, there are 2 Clock Divisor registers that together form one 16 bit.

The registers can be accessed when LCR.DLAB is set to '1'. At this time RBR, THR and IER registers at addresses 0xFC80-0xFC81 can't be accessed.

Symbol	Name	Address	Initial value
DLB1	Divisor Latch Byte 1	0xFC80	0x00
DLB2	Divisor Latch Byte 2	0xFC81	0x00

19.3.1 Receiver Buffer Register/Transmitter Holding Register

Register	RBR	Receiver Buffer Register	Address	0xFC80	
Bit	Bit Name	R/W	Initial	Description	Note
7-0		R	indeterminate	Receiver FIFO output	

Register	THR	Transmitter Holding Register	Address	0xFC80	
Bit	Bit Name	R/W	Initial	Description	Note
7-0		W	indeterminate	Transmit FIFO input	

19.3.2 Interrupt Enable Register (IER)

This register allows enabling and disabling interrupt generation by the UART.

Register	IER	Interrupt Enable Register	Address	0xFC81	
Bit	Bit Name	R/W	Initial	Description	Note
7-3	Reserved	R/W	0	Read value '0'. Write only '0'.	
2	IER2	R/W	0	Receiver Line Status Interrupt '0' – disabled '1' – enabled	
1	IER1	R/W	0	Transmitter Holding Register empty Interrupt '0' – disabled '1' – enabled	
0	IER0	R/W	0	Received Data available Interrupt '0' – disabled '1' – enabled	

19.3.3 Interrupt Identification Register (IIR)

The IIR enables the programmer to retrieve what is the current highest priority pending interrupt.

Bit 0 indicates that an interrupt is pending when it's logic '0'. When it's '1' – no interrupt is pending.

The following table displays the list of possible interrupts along with the bits they enable, priority, and their source and reset control.

Register		IIR		Interrupt Identification Register	Address	0xFC82
Bit	Bit Name	R/W	Initial	Description	Note	
7-6	Reserved	R	1	Read value '1'. Write only '1'.		
5-4	Reserved	R	0	Read value '0'. Write only '0'.		
3	IIR3	R	0	Interrupt Type bit 3 Please refer to the following table for the type of the interrupt		
2	IIR2	R	0	Interrupt Type bit 2 Please refer to the following table for the type of the interrupt		
1	IIR1	R	0	Interrupt Type bit 1 Please refer to the following table for the type of the interrupt		
0	NOPEND	R	1	It indicates whether interrupt is pending, or no interrupt is pending '0' – indicates that an interrupt is pending '1' – no interrupt is pending		

IIR3	IIR2	IIR1	Priority	Interrupt Type	Interrupt Source	Interrupt Reset Control
0	1	1	1 st	Receiver Line Status	Parity, Overrun or Framing errors or Break Interrupt	Reading the Line Status Register
0	1	0	2 nd	Receiver Data available	FIFO trigger level reached	FIFO drops below trigger level
1	1	0	2 nd	Timeout Indication	There's at least 1 character in the FIFO but no character has been input to the FIFO or read from it for the last 4 Char times.	Reading from the FIFO (Receiver Buffer Register)
0	0	1	3 rd	Transmitter Holding Register empty	Transmitter Holding Register Empty	Writing to the Transmitter Holding Register or reading IIR.

19.3.4 FIFO Control Register (FCR)

The FCR allows selection of the FIFO trigger level (the number of bytes in FIFO required to enable the Received Data Available interrupt). In addition, the FIFOs can be cleared using this register.

Register		FCR		FIFO Control Register		Address	0xFC82
Bit	Bit Name	R/W	Initial	Description		Note	
7-6	FTL[1:0]	W	1	Define the Receiver FIFO Interrupt trigger level '00' – 1 byte '01' – 4 bytes '10' – 8 bytes '11' – 14 bytes			
5-3	Reserved	W	0	Read value '0'. Write only '0'.			
2	TFCLR	W	0	'1' – Clear TXFIFO and resets its counter logic to '0'. The TX shift register is not cleared. While '1' is written, this bit has been cleared.			
1	RFCLR	W	0	'1' – Clear RXFIFO and resets its counter logic to '0'. The RX shift register is not cleared. While '1' is written, this bit has been cleared.			
0	Reserved	W	0	Read value '0'. Write only '0'.			

Not Recommended for New Designs

19.3.5 Line Control Register (LCR)

The line control register allows the specification of the format of the asynchronous data communication used. A bit in the register also allows access to the Divisor Latches, which define the baud rate. Reading from the register is allowed to check the current settings of the communication.

Register		LCR		Line Control Register		Address	0xFC83
Bit	Bit Name	R/W	Initial	Description		Note	
7	DLAB	R/W	0	Divisor Latch Access bit. '0' – The normal registers are accessed '1' – The divisor latches can be accessed			
6	BRK	R/W	0	Break Control bit '0' – break is disabled '1' – the serial out is forced into logic '0' (break state).			
5	STICK	R/W	0	Stick Parity bit. '0' – Stick Parity disabled '1' – If PARE and EVPAR are logic '1', the parity bit is transmitted and checked as logic '0'. If PARE is '1' and EVPAR is '0' then the parity bit is transmitted and checked as '1'.			
4	EVPAR	R/W	0	Even Parity select '0' – Odd number of '1' is transmitted and checked in each word (data and parity combined). In other words, if the data has an even number of '1' in it, then the parity bit is '1'. '1' – Even number of '1' is transmitted in each word.			
3	PARE	R/W	0	Parity Enable '0' – No parity '1' – Parity bit is generated on each outgoing character and is checked on each incoming one.			
2	NSTP	R/W	0	Specify the number of generated stop bits '0' – 1 stop bit '1' – 2 stop bits, when either a 6-, 7-, or 8-bit character length is selected. 1.5 stop bits, when 5-bit character length is selected. Note that the receiver always checks the first stop bit only.			
1-0	NBCHAR	R/W	1	Select Number of bits in each character '00' – 5 bits '01' – 6 bits '10' – 7 bits '11' – 8 bits			

19.3.6 Line Status Register (LSR)

Register		LSR		Line Status Register		Address	0xFC85
Bit	Bit Name	R/W	Initial	Description		Note	
7	RXERR	R	0	'0' – No errors in RXFIFO. '1' – There is at least one parity error, framing error or break indications in the RXFIFO. The bit is cleared upon reading the LSR			
6	TXEMP	R	1	Transmitter Empty indicator. '0' – Not empty '1' – Both the TXFIFO and Tx Shift Register are empty. The bit is cleared when data is written to the TXFIFO.			
5	TFEMP	R	1	Transmit FIFO is empty. '0' – TXFIFO is not empty '1' – The TXFIFO is empty. Generates Transmitter Holding Register Empty interrupt. The bit is cleared when data is written to the TXFIFO.			
4	BRKI	R	0	Break Interrupt (BI) indicator '0' – No break condition in the current character '1' – A break condition has been reached in the current character. The break occurs when the line is held in logic 0 for a time of one character (start bit + data + parity + stop bit). In that case, one zero character enters the FIFO and the UART waits for a valid start bit to receive next character. The bit is cleared upon reading the LSR. Generates Receiver Line Status interrupt.			
3	FERI	R	0	Framing Error (FE) indicator '0' – No framing error in the current character '1' – The received character at the top of the RXFIFO did not have a valid stop bit. Of course, generally, it might be that all the following data is corrupt. The bit is cleared upon reading the LSR. Generates Receiver Line Status interrupt.			
2	PERI	R	0	Parity Error (PE) indicator '0' – No parity error in the current character '1' – The character that is currently at the top of the FIFO has been received with parity error. The bit is cleared upon reading the LSR. Generates Receiver Line Status interrupt.			
1	OERI	R	0	Overrun Error (OE) indicator '0' – No overrun state '1' – If RXD continues to fill the RXFIFO beyond the trigger level, an overrun error will occur after the RXFIFO is full and the next character has been completely received in the RX shift register. The bit is cleared upon reading the LSR. Generates Receiver Line Status interrupt.			
0	DRDYI	R	0	Data Ready (DR) indicator. '0' – No characters in the RXFIFO '1' – At least one character has been received and is in the RXFIFO. The bit is cleared upon reading all of the data in the RXFIFO			

19.3.7 Divisor Latches

Register		DLB1		Divisor Latch Byte 1(LSB)		Address		0xFC80	
Bit	Bit Name	R/W	Initial	Description				Note	
7-0		R/W	0	The LSB of the divisor latch					

Register		DLB2		Divisor Latch Byte 2(MSB)		Address		0xFC81	
Bit	Bit Name	R/W	Initial	Description				Note	
7-0		R/W	0	The MSB of the divisor latch					

The divisor latches can be accessed by setting LCR.DLAB to '1'. It needs to set '1' to LCR.DLAB before the divisor values are set into DLB1 and DLB2. The 2 bytes divisor values should be stored into DLB1 and DLB2 as a 16-bit binary code during initialization. Based on these values, the baud rate is determined by the following expression

$$\text{Baud rate} = \text{CLKUART}(\text{:CLKSLOW}) / (16 \times \text{divisor value})$$

Example of a baud rate and a divisor value are shown in Table 19-3.

The internal counter in the Baud Rate Generator starts to work when DLB1 is written, so when setting the divisor, write the MSB first and the LSB last.

The default values of DLB1 and DLB2 are '0'. After setting the divisor, LCR.DLAB should be '0' in order to access RBR and THR.

Not Recommended for New Designs

19.3.8 Baud rate

Table 19-3 Example of Baud rate, Divisor, and Crystal

Baud Rate (bps)	9.216 MHz Crystal		12.288 MHz Crystal		12.5 MHz Crystal	
	Decimal Divisor Value	Percent Error	Decimal Divisor Value	Percent Error	Decimal Divisor Value	Percent Error
2400	480	-	640	-	651	0.01
4800	240	-	320	-	326	0.15
9600	120	-	160	-	163	0.15
19200	60	-	80	-	81	0.47
38400	30	-	40	-	41	0.76
76800	15	-	20	-	28	0.35
96000	12	-	16	-	16	1.73
115200	10	-	13	2.6	14	3.11
128000	9	-	12	-	12	1.73
256000	4	12.5	6	-	6	1.73
384000	3	-	4	-	4	1.73
512000	2	12.5	3	-	3	1.73
768000	1	50	2	-	2	1.73
1152000	1	-	1	33.3	1	35.63
1536000	-	-	1	-	1	1.73

Baud Rate (bps)	12.0 MHz Crystal	
	Decimal Divisor Value	Percent Error
125K	12	-
150K	10	-
250K	6	-
300K	5	-
500K	3	-
750K	2	-
1500K	1	-

Note:
 Table 19-3 shows just the example of Baud rate and Decimal Divisor Value in case of using several Crystals.
 The Baud rate calculated it by the following Computation expression.

$$\text{Baud rate} = \text{CLKUART}(\text{CLKSLOW}) / (1 \times \text{Divisor Value})$$

$$\text{CLKUART}(\text{CLKSLOW}) = 2 \times \text{frequency of Crystal (at CLKFG0.DIV:1/1)}$$
 The accuracy of the Baud rate is depend on Crystal frequency and its characteristics.
 The errors in Table 19-3 were calculated by the computation expression as above, and are not things to guarantee.

19.4 Operation

This UART core is very similar in operation to the standard 16550 UART chip without the modem terminal control function. So only the FIFO mode is supported.

19.5 Caution of operation

19.5.1 Restriction about the UART register access

(1) Description

Expected register access can not be performed when registers of UART are contiguously accessed by MOVX instruction (read or write) without gaps.

(2) Countermeasure

When registers of UART are contiguously accessed by MOVX instruction (read or write), please insert another instructions having more than 2 bytes between each MOVX instruction.

(example 1) inserting NOP instruction.

In case of reading IER register after writing 55H to IER register

MOV A, #55H	; Set write data
MOV DPTR, #IER	; Set DPTR=IER address
MOVX @DPTR, A	; Write to IER
NOP	; 1 byte
NOP	; 1 byte
MOVX A, @DPTR	; Read from IER

(example 2) inserting instruction except NOP

In case of writing THR register consecutively

MOV A, #55H	; Set write data
MOV DPTR, #THR	; Set DPTR=THR address
MOVX @DPTR, A	; 1st Write to THR
MOV A, #AAH	; Set write data(2-byte instruction)
MOVX @DPTR, A	; 2nd Write to THR

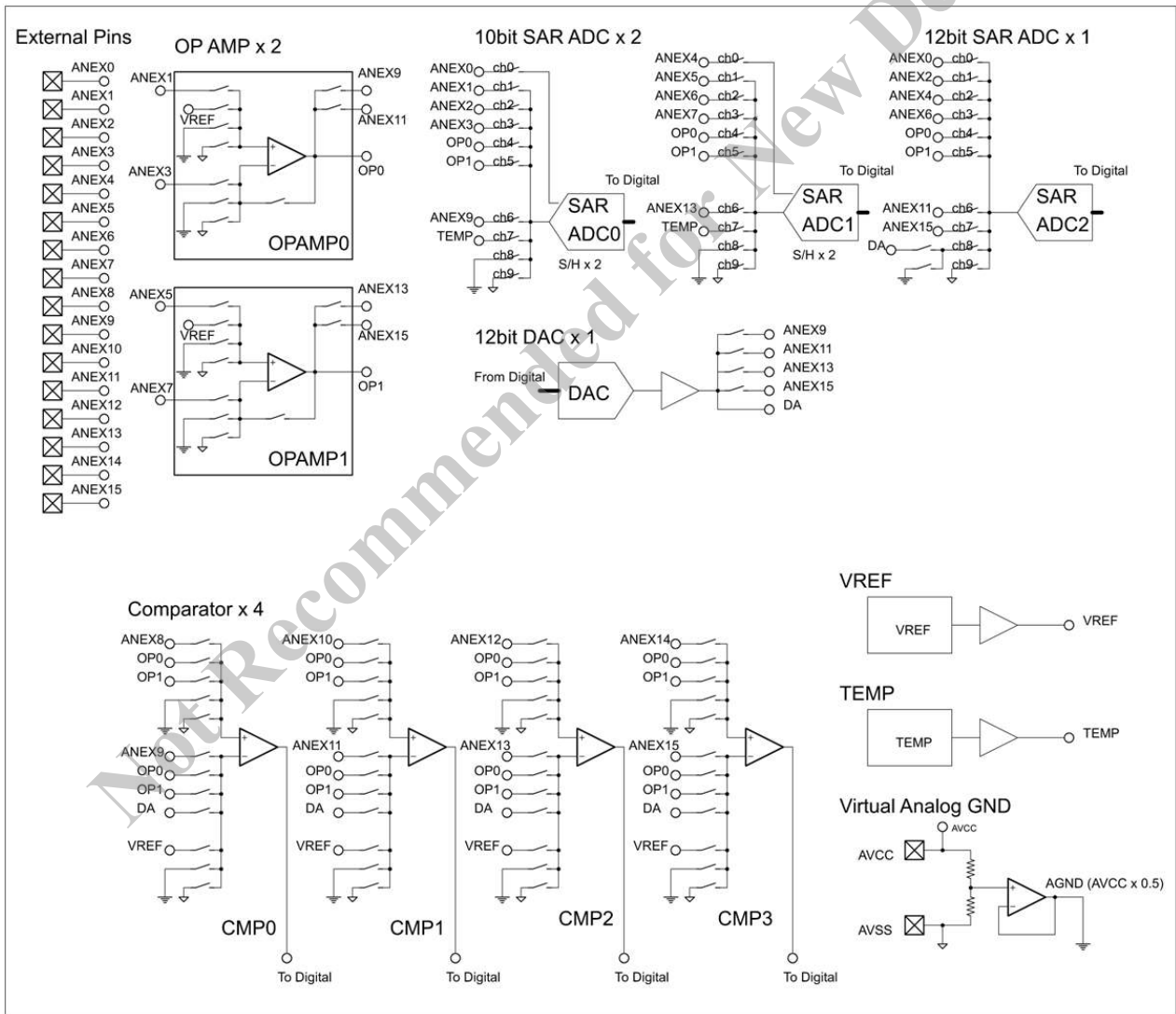
20. Analog Inter-Connection Network

20.1 Overview

The LSI has Analog Inter-Connection Network which makes connections among internal analog modules as shown in Figure 20-1. All switch states in the figure can be configured by user settings in corresponding registers.

Using this scheme, for example, user can configure as follows.

- (1) ADC Inputs can be directly connected to External Pins, or OPAMP can be inserted between External Pin and ADC Input.
 - (2) OPAMP can be used as standalone amplifier or Unity (voltage follower).
 - Comparator can be used as standalone one or OPAMP can be inserted between External Pin and Comparator Input.
 - (3) DAC Output can be connected to Comparator Inputs or External Pins.
- Voltage Reference Output and Temperature Sensor Output can be connected to Comparator or ADC Inputs.



Note: Configuration of registers refer to each chapter.

Note: Initially Comparator Inputs are connected to External Pins.

Disconnect External Pins from Comparator Inputs when Comparators are not used.

Configuration of the register refer to Page 25-3.

Figure 20-1 Analog Inter-Connection

21. High Speed 10bit SAR ADC

21.1 Overview

The LSI has Dual High Speed 10bit SAR (Successive Approximation Register) AD Converters (ADC0 and ADC1) with High Speed Conversion Rate 4MSPS. Each ADC has maximum 10 inputs and each input has corresponding result register. Each result can be applied specified Offset Value (Regarding the offset adjustment, please refer to the 21.3.5).

Each ADC-0 and ADC-1 (10bit ADC) has dual sample/hold blocks in each input block.

AD Conversion Mode is selected from “Burst until Sequence End” or “Step and Round Sequence”. The sequence means the order of input channels to be converted. In the mode “Burst until Sequence End”, one trigger can initiate contiguous burst conversions according to configured sequence. In the mode “Step and Round Sequence”, the conversion sequence follows configured one but each conversion requires something conversion trigger to start.

AD Conversion time can be selected from slow (half speed) or fast (max speed).

AD Conversion trigger can be selected from external GPIO events, analog comparator events, PWM events or Timer events. Of course, each ADC can generate interrupt when selected conversion has done. Besides interrupts, All ADC channel can be became the event source at conversion finish of specified channel (selected the channel from the ADTRGL/Hn ; multiple selection is acceptable).

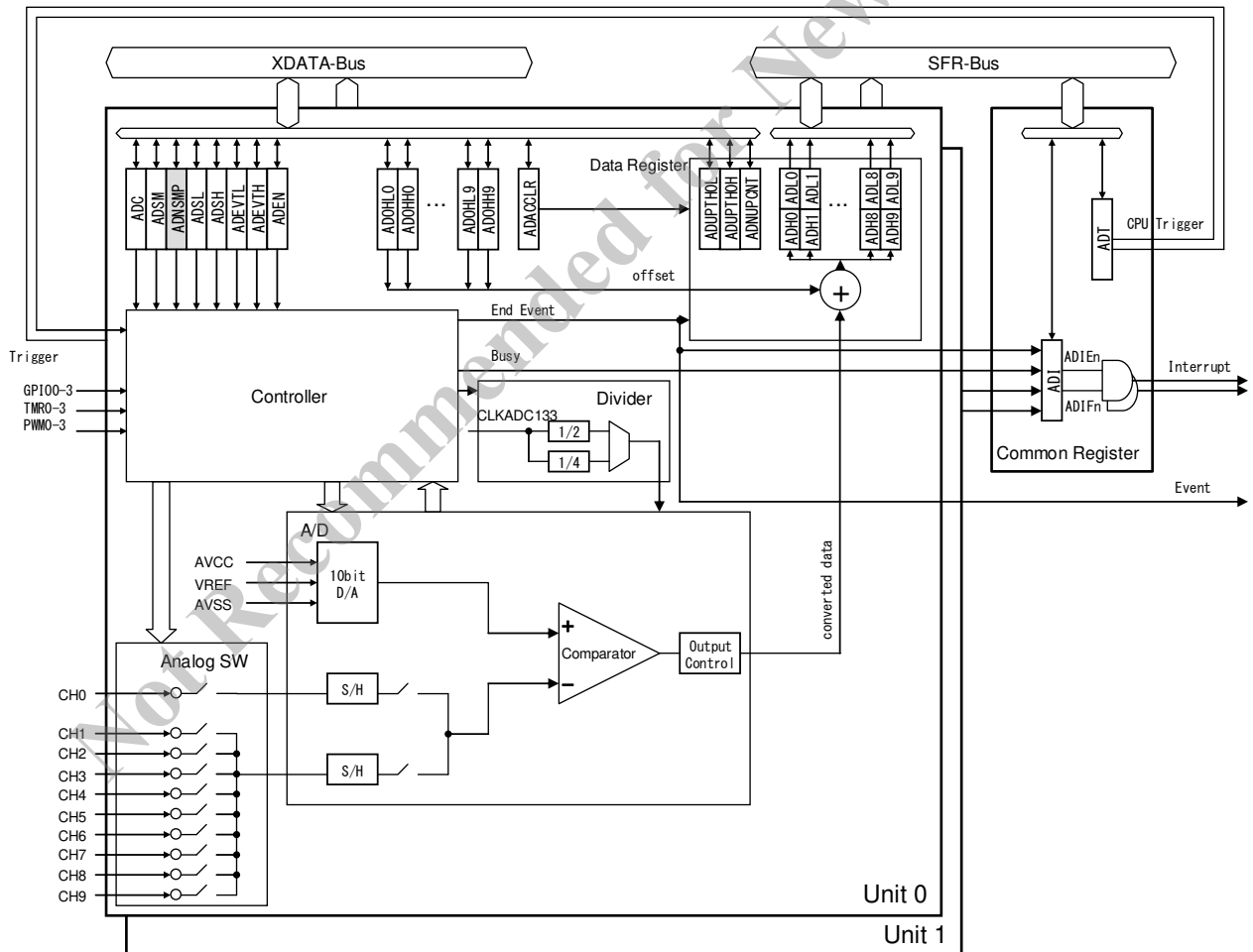


Figure 21-1 Block diagram of 10bit ADC

Table 21-1 Input/Output pins

Channel	Pin /Sig. name of Unit 0	Pin /Sig. name of Unit 1	Description
0	ANEX0	ANEX4	Analog External 0/4
1	ANEX1	ANEX5	Analog External 1/5
2	ANEX2	ANEX6	Analog External 2/6
3	ANEX3	ANEX7	Analog External 3/7
4	OP0	OP0	OPAMP0
5	OP1	OP1	OPAMP1
6	ANEX9	ANEX13	Analog External 9/13
7	TEMP	TEMP	TEMP
8	AGND	AGND	Analog GND (1/2 AVCC)
9	AVSS	AVSS	Analog VSS

Table 21-2 Feature of High Speed 10bit SAR ADC0 and ADC1

Item	Description	Note
Unit Counts	Dual Unit	Can operate independently
Input Channels	10 Inputs/unit	
Resolution	10bits	
Conversion Speed	4MSPS (million samples per second)	Sampling Time + Conversion Time = 250ns
Dual Simultaneous Sampling	Supported	
Conversion Mode	Burst Until Sequence End Step and Round Sequence	
Conversion Trigger	Selectable from internal events	
Interrupt and Event Outputs	Interrupt or Event Output can be generated when Conversion finished.	

21.2 Register Description

ADC10 has two kinds of register group: XBUS register group and SFR group. Table 21-3 shows XBUS register and Table 21-4 and Table 21-5 shows SFRs.

Table 21-3 XBUS registers

Symbol (Unit n)	Name	Address (Unit 0)	Address (Unit 1)	Initial value
ADCn	ADC Configuration Register	0xF000	0xF080	0x00
ADSMn	ADC Sample Mode Register	0xF001	0xF081	0x00
ADSLn	ADC Channel Sequence L Register	0xF002	0xF082	0x00
ADSHn	ADC Channel Sequence H Register	0xF003	0xF083	0x00
ADTRGLn	ADC Trigger Source L Register	0xF004	0xF084	0x00
ADTRGHn	ADC Trigger Source H Register	0xF005	0xF085	0x00
ADENn	ADC Enable Register	0xF007	0xF087	0x00
ADACCLRn	ADC Access counter clear Register	0xF008	0xF088	0x00
ADUPTHL0n	ADC Ch0 update threshold L Register	0xF009	0xF089	0x00
ADUPTHH0n	ADC Ch0 update threshold H Register	0xF00A	0xF08A	0x00
ADNUPCNTn	ADC Ch0 non-update counter	0xF00B	0xF08B	0x00
ADOL0n	ADC Ch0 Offset Data L Register	0xF010	0xF090	0x00
ADOH0n	ADC Ch0 Offset Data H Register	0xF011	0xF091	0x00
ADOL1n	ADC Ch1 Offset Data L Register	0xF012	0xF092	0x00
ADOH1n	ADC Ch1 Offset Data H Register	0xF013	0xF093	0x00
ADOL2n	ADC Ch2 Offset Data L Register	0xF014	0xF094	0x00
ADOH2n	ADC Ch2 Offset Data H Register	0xF015	0xF095	0x00
ADOL3n	ADC Ch3 Offset Data L Register	0xF016	0xF096	0x00
ADOH3n	ADC Ch3 Offset Data H Register	0xF017	0xF097	0x00
ADOL4n	ADC Ch4 Offset Data L Register	0xF018	0xF098	0x00
ADOH4n	ADC Ch4 Offset Data H Register	0xF019	0xF099	0x00
ADOL5n	ADC Ch5 Offset Data L Register	0xF01A	0xF09A	0x00
ADOH5n	ADC Ch5 Offset Data H Register	0xF01B	0xF09B	0x00
ADOL6n	ADC Ch6 Offset Data L Register	0xF01C	0xF09C	0x00
ADOH6n	ADC Ch6 Offset Data H Register	0xF01D	0xF09D	0x00
ADOL7n	ADC Ch7 Offset Data L Register	0xF01E	0xF09E	0x00
ADOH7n	ADC Ch7 Offset Data H Register	0xF01F	0xF09F	0x00
ADOL8n	ADC Ch8 Offset Data L Register	0xF020	0xF0A0	0x00
ADOH8n	ADC Ch8 Offset Data H Register	0xF021	0xF0A1	0x00
ADOL9n	ADC Ch9 Offset Data L Register	0xF022	0xF0A2	0x00
ADOH9n	ADC Ch9 Offset Data H Register	0xF023	0xF0A3	0x00

Table 21-4 SFR (each unit)

Symbol (Unitn)	Name	Address (Unit 0)	Address (Unit 1)	Initial value
ADL0n	ADC Ch0 Data L	0x99	0x9A	0x00
ADH0n	ADC Ch0 Data H	0x99	0x9A	0x00
ADL1n	ADC Ch1 Data L	0xA1	0xA2	0x00
ADH1n	ADC Ch1 Data H	0xA1	0xA2	0x00
ADL2n	ADC Ch2 Data L	0xA9	0xAA	0x00
ADH2n	ADC Ch2 Data H	0xA9	0xAA	0x00
ADL3n	ADC Ch3 Data L	0xB1	0xB2	0x00
ADH3n	ADC Ch3 Data H	0xB1	0xB2	0x00
ADL4n	ADC Ch4 Data L	0xB9	0xBA	0x00
ADH4n	ADC Ch4 Data H	0xB9	0xBA	0x00
ADL5n	ADC Ch5 Data L	0xC1	0xC2	0x00
ADH5n	ADC Ch5 Data H	0xC1	0xC2	0x00
ADL6n	ADC Ch6 Data L	0xC9	0xCA	0x00
ADH6n	ADC Ch6 Data H	0xC9	0xCA	0x00
ADL7n	ADC Ch7 Data L	0xD1	0xD2	0x00
ADH7n	ADC Ch7 Data H	0xD1	0xD2	0x00
ADL8n	ADC Ch8 Data L	0xD9	0xDA	0x00
ADH8n	ADC Ch8 Data H	0xD9	0xDA	0x00
ADL9n	ADC Ch9 Data L	0xE1	0xE2	0x00
ADH9n	ADC Ch9 Data H	0xE1	0xE2	0x00

Table 21-5 SFR (common)

Symbol	Name	Address	Initial value
ADT	Mix ADC CPU Trigger Register	0xF1	0x00
ADI	Mix ADC Interrupt Register	0xF2	0x00

21.2.1 ADCn (ADC Configuration Register)

Register		ADCn		ADC Configuration Register		Address(Unit 0)	0xF000		
						Address(Unit 1)	0xF080		
Bit	Bit Name	R/W	Initial	Description		Note			
7	UPTH0EN	R/W	0	CH0 update threshold enable 0: disable 1: enable					
6	ADM0DE	R/W	0	ADC Conversion Mode 0: Burst until Sequence End (Output interrupt after last sequence) 1: Step and Round Sequence (Output interrupt at each step)					
5	ADTIME	R/W	0	ADC Conversion Time 0: Slow (CLKADCn_133 / 4) 1: Fast (CLKADCn_133 / 2)					
4	ADTRG4	R/W	0	ADC Trigger Source 00000: CPU 00001: GPIO0 Event for ADC (neg edge) 00010: GPIO0 Event for ADC (pos edge) 00011: GPIO0 Event for ADC (both edge) 00100: GPIO1 Event for ADC (neg edge) 00101: GPIO1 Event for ADC (pos edge) 00110: GPIO1 Event for ADC (both edge) 00111: GPIO2 Event for ADC (neg edge) 01000: GPIO2 Event for ADC (pos edge) 01001: GPIO2 Event for ADC (both edge) 01010: GPIO3 Event for ADC (neg edge) 01011: GPIO3 Event for ADC (pos edge) 01100: GPIO3 Event for ADC (both edge) 01101: Comparator 0 (pulse) 01110: Comparator 1 (pulse) 01111: Comparator 2 (pulse) 10000: Comparator 3 (pulse) 10001: TIMER0-CM0 (pulse) 10010: TIMER0-CM1 (pulse) 10011: TIMER1-CM0 (pulse) 10100: TIMER1-CM1 (pulse) 10101: PWM0-EVENT0 (pulse) 10110: PWM0-EVENT1 (pulse) 10111: PWM1-EVENT0 (pulse) 11000: PWM1-EVENT1 (pulse) 11001: PWM2-EVENT0(pulse) 11010: PWM2-EVENT1 (pulse) 11011: PWM3-EVENT0 (pulse) 11100: PWM3-EVENT1 (pulse) Others are reserved. Do not set.					
3	ADTRG3	R/W	0						
2	ADTRG2	R/W	0						
1	ADTRG1	R/W	0						
0	ADTRG0	R/W	0						

UPTH0EN, ADM0DE and ADTIME in ADCn register should be written when ADENn.EN=0.

Setting ADENn.EN=1 and waiting 1uS, then ADC Trigger Source should be written into ADTRG[4:0].

21.2.2 ADSMn (ADC Sample Mode Register)

Register		ADSMn		ADC Sample Mode Register		Address(Unit 0)	0xF001
						Address(Unit 1)	0xF081
Bit	Bit Name	R/W	Initial	Description		Note	
7	DSHMODE	R/W	0	Dual Sample Hold mode 0: Single Sample/Hold Mode 1: Dual Sample/Hold Mode (When DSHMODE=1 and two or more than two channel are selected including ch0 by ADSL/Hn register, ch0 and the next younger channel are sampled simultaneously).			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	reserved	R	0	Read value is 0. Write only 0.			
0	reserved	R	0	Read value is 0. Write only 0.			

DSHMODE bit must be written when ADENn.EN=0.

21.2.3 ADSLn (ADC Channel Sequence L Register)

Register		ADSLn		ADC Channel Sequence L Register		Address(Unit 0)	0xF002
						Address(Unit 1)	0xF082
Bit	Bit Name	R/W	Initial	Description		Note	
7	CHSEQ7	R/W	0	Channel 7 Sequence			
6	CHSEQ6	R/W	0	Channel 6 Sequence			
5	CHSEQ5	R/W	0	Channel 5 Sequence			
4	CHSEQ4	R/W	0	Channel 4 Sequence			
3	CHSEQ3	R/W	0	Channel 3 Sequence			
2	CHSEQ2	R/W	0	Channel 2 Sequence			
1	CHSEQ1	R/W	0	Channel 1 Sequence			
0	CHSEQ0	R/W	0	Channel 0 Sequence			

ADSLn register must be written when ADENn.EN=0.

21.2.4 ADSHn (ADC Channel Sequence H Register)

Register		ADSHn		ADC Channel Sequence H Register		Address(Unit 0)	0xF003
						Address(Unit 1)	0xF083
Bit	Bit Name	R/W	Initial	Description			Note
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	CHSEQ9	R/W	0	Channel 9 Sequence			
0	CHSEQ8	R/W	0	Channel 8 Sequence			

ADSHn register must be written when ADENn.EN=0.

Note: Channel Sequence is configured as follows.

ADSHn	ADSLn	Conversion Sequence
0b00000000	0b00000001	CH0→CH0→CH0→CH0→...
0b00000000	0b00001000	CH3→CH3→CH3→CH3→...
0b00000000	0b00000011	CH0→CH1→CH0→CH1→...
0b00000000	0b00111100	CH2→CH3→CH4→CH5→CH2→CH3→CH4→CH5→...
0b00000000	0b11111111	CH0→CH1→CH2→CH3→CH4→CH5→CH6→CH7→...
0b00000010	0b10001000	CH3→CH7→CH9→CH3→CH7→CH9→...

There are 2 sample/hold circuits in each input stage. Dual input signals are sampled simultaneously according to following manner at younger channel is sampled. Each A-to-D conversion is processed after the sampling according to the previous table.

ADC0 and ADC1 (10bit ADC)					
ADSLn[ch]				Simultaneous Sampling in Dual S/Hs	Dual S/Hs stores dual signal levels when following channel is sampled.
ch=0	ch=1	ch=4	ch=5		
0	0	0	0	Not available	None
0	0	0	1	Not available	None
0	0	1	0	Not available	None
0	0	1	1	Not available	None
0	1	0	0	Not available	None
0	1	0	1	Not available	None
0	1	1	0	Not available	None
0	1	1	1	Not available	None
1	0	0	0	Not available	None
1	0	0	1	ch0 and ch5	ch0
1	0	1	0	ch0 and ch4	ch0
1	0	1	1	ch0 and ch4	ch0
1	1	0	0	ch0 and ch1	ch0
1	1	0	1	ch0 and ch1	ch0
1	1	1	0	ch0 and ch1	ch0
1	1	1	1	ch0 and ch1	ch0

21.2.5 ADTRGLn (ADC Event Source L Register)

Register		ADTRGLn		ADC Trigger Source L Register		Address(Unit 0)	0xF004
						Address(Unit 1)	0xF084
Bit	Bit Name	R/W	Initial	Description			Note
7	EVTCH7	R/W	0	Choose ADC Output Event 0: The channel finish is not included in output event. 1: The channel finish is included in output event.			
6	EVTCH6	R/W	0				
5	EVTCH5	R/W	0				
4	EVTCH4	R/W	0				
3	EVTCH3	R/W	0				
2	EVTCH2	R/W	0				
1	EVTCH1	R/W	0				
0	EVTCH0	R/W	0				

ADTRGLn register must be written when ADENn.EN=0.

21.2.6 ADTRGHn (ADC Event Source H Register)

Register		ADTRGHn		ADC Trigger Source H Register		Address(Unit 0)	0xF005
						Address(Unit 1)	0xF085
Bit	Bit Name	R/W	Initial	Description			Note
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	EVTCH9	R/W	0	Choose ADC Output Event 0: The channel finish is not included in output event. 1: The channel finish is included in output event.			
0	EVTCH8	R/W	0				

ADTRGHn register must be written when ADENn.EN=0.

21.2.7 ADENn (ADC Enable Register)

Register		ADENn		ADC Enable Register		Address(Unit 0)	0xF007
						Address(Unit 1)	0xF087
Bit	Bit Name	R/W	Initial	Description			Note
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	reserved	R	0	Read value is 0. Write only 0.			
0	EN	R/W	0	ADC Enable 0: ADC Disabled 1: ADC Enabled Activate the ADC. Do not change to 0 during A/D conversion is running.			

21.2.8 ADACCLRn (ADC Access Counter Clear Register)

Register		ADACCLRn		ADC Access Counter Clear Register		Address(Unit 0)	0xF008
						Address(Unit 1)	0xF088
Bit	Bit Name	R/W	Initial	Description			Note
7	CLRADCC DRCAC	R/W	0	Clear ADC Conversion Data Register CPU Access Counter 0: No effect 1: Register CPU Access counter clear Read : No Request Write 0: No effect Write 1: Clear Register CPU Access counter. (Clear CPU SFR access counter.)			
6	CLRADCC DRDAC	R/W	0	Clear ADC Conversion Data Register DSAC Access Counter 0: No effect 1: Register DSAC Access counter clear Read : No Request Write 0: No effect Write 1: Clear Register DSAC Access counter. (Clear DSAC SFR access counter.)			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	reserved	R	0	Read value is 0. Write only 0.			
0	reserved	R	0	Read value is 0. Write only 0.			

21.2.9 ADUPTHL0n (ADC Ch0 Update Threshold L Register)

Register		ADUPTHL0n		ADC Ch0 Update Threshold L Register		Address(Unit 0)	0xF009
						Address(Unit 1)	0xF089
Bit	Bit Name	R/W	Initial	Description			Note
7	UPTH7	R/W	0	Unsigned CH0 update threshold value			
6	UPTH6	R/W	0				
5	UPTH5	R/W	0				
4	UPTH4	R/W	0				
3	UPTH3	R/W	0				
2	UPTH2	R/W	0				
1	UPTH1	R/W	0				
0	UPTH0	R/W	0				

ADUPTHL0n register must be written when ADENn.EN=0.

21.2.10 ADUPTHH0n (ADC Ch0 Update Threshold H Register)

Register		ADUPTHH0n		ADC Ch0 Update Threshold H Register		Address(Unit 0)	0xF00A
						Address(Unit 1)	0xF08A
Bit	Bit Name	R/W	Initial	Description			Note
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	UPTH9	R/W	0	Unsigned CH0 update threshold value			
0	UPTH8	R/W	0				

ADUPTHH0n register must be written when ADENn.EN=0.

21.2.11 ADNUPCNTn (ADC Ch0 Non-update Count Register)

Register		ADNUPCNTn		ADC Ch0 Non-update Count Register	Address(Unit 0)	0xF00B
					Address(Unit 1)	0xF08B
Bit	Bit Name	R/W	Initial	Description	Note	
7	NUPCNT7	R/W	0	Ch0 Non-update counts The number of times ADLH0n register is not updated. This register can be cleared by writing 0x00.		
6	NUPCNT6	R/W	0			
5	NUPCNT5	R/W	0			
4	NUPCNT4	R/W	0			
3	NUPCNT3	R/W	0			
2	NUPCNT2	R/W	0			
1	NUPCNT1	R/W	0			
0	NUPCNT0	R/W	0			

Not Recommended for New Designs

21.2.12 ADOLXn (ADC ChX Offset Data L Register, n=0-1)

Register	ADOL0n	ADC Ch0 Offset Data L Register	Address(Unit 0)	0xF010	
			Address(Unit 1)	0xF090	
Register	ADOL1n	ADC Ch1 Offset Data L Register	Address(Unit 0)	0xF012	
			Address(Unit 1)	0xF092	
Register	ADOL2n	ADC Ch2 Offset Data L Register	Address(Unit 0)	0xF014	
			Address(Unit 1)	0xF094	
Register	ADOL3n	ADC Ch3 Offset Data L Register	Address(Unit 0)	0xF016	
			Address(Unit 1)	0xF096	
Register	ADOL4n	ADC Ch4 Offset Data L Register	Address(Unit 0)	0xF018	
			Address(Unit 1)	0xF098	
Register	ADOL5n	ADC Ch5 Offset Data L Register	Address(Unit 0)	0xF01A	
			Address(Unit 1)	0xF09A	
Register	ADOL6n	ADC Ch6 Offset Data L Register	Address(Unit 0)	0xF01C	
			Address(Unit 1)	0xF09C	
Register	ADOL7n	ADC Ch7 Offset Data L Register	Address(Unit 0)	0xF01E	
			Address(Unit 1)	0xF09E	
Register	ADOL8n	ADC Ch8 Offset Data L Register	Address(Unit 0)	0xF020	
			Address(Unit 1)	0xF0A0	
Register	ADOL9n	ADC Ch9 Offset Data L Register	Address(Unit 0)	0xF022	
			Address(Unit 1)	0xF0A2	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADOFFSET 7	R/W	0	Signed 11bit ADC Offset Data L bit 7 – bit 0 are stored.	
6	ADOFFSET 6	R/W	0		
5	ADOFFSET 5	R/W	0		
4	ADOFFSET 4	R/W	0		
3	ADOFFSET 3	R/W	0		
2	ADOFFSET 2	R/W	0	Signed 11bit ADC Offset Data L bit 7 – bit 0 are stored.	
1	ADOFFSET 1	R/W	0		
0	ADOFFSET 0	R/W	0		

21.2.13 ADOHXn (ADC ChX Offset Data H Register, n=0-1)

Register	ADOH0n	ADC Ch0 Offset Data H Register	Address(Unit 0)	0xF011	
			Address(Unit 1)	0xF091	
Register	ADOH1n	ADC Ch1 Offset Data H Register	Address(Unit 0)	0xF013	
			Address(Unit 1)	0xF093	
Register	ADOH2n	ADC Ch2 Offset Data H Register	Address(Unit 0)	0xF015	
			Address(Unit 1)	0xF095	
Register	ADOH3n	ADC Ch3 Offset Data H Register	Address(Unit 0)	0xF017	
			Address(Unit 1)	0xF097	
Register	ADOH4n	ADC Ch4 Offset Data H Register	Address(Unit 0)	0xF019	
			Address(Unit 1)	0xF099	
Register	ADOH5n	ADC Ch5 Offset Data H Register	Address(Unit 0)	0xF01B	
			Address(Unit 1)	0xF09B	
Register	ADOH6n	ADC Ch6 Offset Data H Register	Address(Unit 0)	0xF01D	
			Address(Unit 1)	0xF09D	
Register	ADOH7n	ADC Ch7 Offset Data H Register	Address(Unit 0)	0xF01F	
			Address(Unit 1)	0xF09F	
Register	ADOH8n	ADC Ch8 Offset Data H Register	Address(Unit 0)	0xF021	
			Address(Unit 1)	0xF0A1	
Register	ADOH9n	ADC Ch9 Offset Data H Register	Address(Unit 0)	0xF023	
			Address(Unit 1)	0xF0A3	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADOFFSET15	R	0	Signed enhanced bit ADOFFSET10 can be read.	
6	ADOFFSET14	R	0		
5	ADOFFSET13	R	0		
4	ADOFFSET12	R	0		
3	ADOFFSET11	R	0		
2	ADOFFSET10	R/W	0	Signed 11bit ADC Offset Data H bit 10 – bit 8 are stored.	
1	ADOFFSET9	R/W	0		
0	ADOFFSET8	R/W	0		

21.2.14 ADLXn (ADC ChX Data L Register, n=0-1)

Register	ADL0n	ADC Ch0 Data L Register	Address(Unit 0)	0x99	
			Address(Unit 1)	0x9A	
Register	ADL1n	ADC Ch1 Data L Register	Address(Unit 0)	0xA1	
			Address(Unit 1)	0xA2	
Register	ADL2n	ADC Ch2 Data L Register	Address(Unit 0)	0xA9	
			Address(Unit 1)	0xAA	
Register	ADL3n	ADC Ch3 Data L Register	Address(Unit 0)	0xB1	
			Address(Unit 1)	0xB2	
Register	ADL4n	ADC Ch4 Data L Register	Address(Unit 0)	0xB9	
			Address(Unit 1)	0xBA	
Register	ADL5n	ADC Ch5 Data L Register	Address(Unit 0)	0xC1	
			Address(Unit 1)	0xC2	
Register	ADL6n	ADC Ch6 Data L Register	Address(Unit 0)	0xC9	
			Address(Unit 1)	0xCA	
Register	ADL7n	ADC Ch7 Data L Register	Address(Unit 0)	0xD1	
			Address(Unit 1)	0xD2	
Register	ADL8n	ADC Ch8 Data L Register	Address(Unit 0)	0xD9	
			Address(Unit 1)	0xDA	
Register	ADL9n	ADC Ch9 Data L Register	Address(Unit 0)	0xE1	
			Address(Unit 1)	0xE2	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADDATA7	R	0	Signed 12bit ADC Conversion Data L bit 7 – bit 0 are stored. This value is already applied an offset specified by ADOH/Ln like as “Raw ADC Value + ADOXn” (16bit operation) Details refer to 21.3.5	
6	ADDATA6	R	0		
5	ADDATA5	R	0		
4	ADDATA4	R	0		
3	ADDATA3	R	0		
2	ADDATA2	R	0		
1	ADDATA1	R	0		
0	ADDATA0	R	0		

21.2.15 ADHXn (ADC ChX Data H Register, n=0-1)

Register	ADH0n	ADC Ch0 Data H Register	Address(Unit 0)	0x99	
			Address(Unit 1)	0x9A	
Register	ADH1n	ADC Ch1 Data H Register	Address(Unit 0)	0xA1	
			Address(Unit 1)	0xA2	
Register	ADH2n	ADC Ch2 Data H Register	Address(Unit 0)	0xA9	
			Address(Unit 1)	0xAA	
Register	ADH3n	ADC Ch3 Data H Register	Address(Unit 0)	0xB1	
			Address(Unit 1)	0xB2	
Register	ADH4n	ADC Ch4 Data H Register	Address(Unit 0)	0xB9	
			Address(Unit 1)	0xBA	
Register	ADH5n	ADC Ch5 Data H Register	Address(Unit 0)	0xC1	
			Address(Unit 1)	0xC2	
Register	ADH6n	ADC Ch6 Data H Register	Address(Unit 0)	0xC9	
			Address(Unit 1)	0xCA	
Register	ADH7n	ADC Ch7 Data H Register	Address(Unit 0)	0xD1	
			Address(Unit 1)	0xD2	
Register	ADH8n	ADC Ch8 Data H Register	Address(Unit 0)	0xD9	
			Address(Unit 1)	0xDA	
Register	ADH9n	ADC Ch9 Data H Register	Address(Unit 0)	0xE1	
			Address(Unit 1)	0xE2	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADDATA15	R	0	Signed 16bit ADC Conversion Data H bit 15 – bit 8 are stored. This value has already applied an offset specified by ADOH/Ln like as “Raw ADC Value + ADOXn” (12bit operation) Details refer to 21.3.5	
6	ADDATA14	R	0		
5	ADDATA13	R	0		
4	ADDATA12	R	0		
3	ADDATA11	R	0		
2	ADDATA10	R	0		
1	ADDATA9	R	0		
0	ADDATA8	R	0		

21.2.16 ADT (ADC Trigger Register)

Register	ADT		ADC CPU Trigger	Address	0xF1
Bit	Bit Name	R/W	Initial	Description	Note
7:3	reserved	R	0	Read value is 0. Write only 0.	
2	ADCTRG2	W	0	ADC2 Trigger / Busy Read 0: ADC2 not busy (no conversion) Read 1: ADC2 is busy (in conversion) Write 0: No effect Write 1: ADC2 Start by CPU	
1	ADCTRG1	W	0	ADC 1Trigger / Busy Read 0: ADC1 not busy (no conversion) Read 1: ADC1 is busy (in conversion) Write 0: No effect Write 1: ADC1 Start by CPU	
0	ADCTRG0	W	0	ADC0 Trigger / Busy Read 0: ADC0 not busy (no conversion) Read 1: ADC0 is busy (in conversion) Write 0: No effect Write 1: ADC0 Start by CPU	

Note: ADCTRGn are set by not only CPU but also other trigger sources.

Not Recommended for New Designs

21.2.17 ADI (ADC Interrupt Register)

Register	ADI		ADC Interrupt Register		Address	0xF2
Bit	Bit Name	R/W	Initial	Description	Note	
7	reserved	R	0	Read value is 0. Write only 0.		
6	ADIE2	R/W	0	ADC2 Interrupt Enable 0: Disable 1: Enable		
5	ADIE1	R/W	0	ADC1 Interrupt Enable 0: Disable 1: Enable		
4	ADIE0	R/W	0	ADC0 Interrupt Enable 0: Disable 1: Enable		
3	reserved	R	0	Read value is 0. Write only 0.		
2	ADIF2	R/C	0	ADC2 Interrupt Flag (before mask; independent ADIEn) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit		
1	ADIF1	R/C	0	ADC1 Interrupt Flag (before mask; independent ADIEn) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit		
0	ADIF0	R/C	0	ADC0 Interrupt Flag (before mask; independent ADIEn) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit		

Note:

If ADMODE=0, interrupt will be issued when all burst conversions are finished.

If ADMODE=1, interrupt will be issued every time when each conversion is finished.

21.3 Operation

21.3.1 Basic operation

ADC is activated by ADENn.EN bit is set to 1'b1. The AD conversion starts when ADC is active and conversion trigger from one of the peripherals is received. The AD Conversion trigger can be selected from CPU, external GPIO events, analog comparator events, PWM events or Timer events by ADCn.ADTRG[4:0] bits. The CPU trigger can be occurred by ADT.ADCTRGn bit that is mapped in SFR address space.

AD Conversion time can be selected from slow (half speed) or fast (full speed) by ADCn.ADTIME bit.

Table 21-2 shows Basic conversion sequence in the fast clock mode.

A/D conversion of a channel spends 16 cycles of ADCLK.

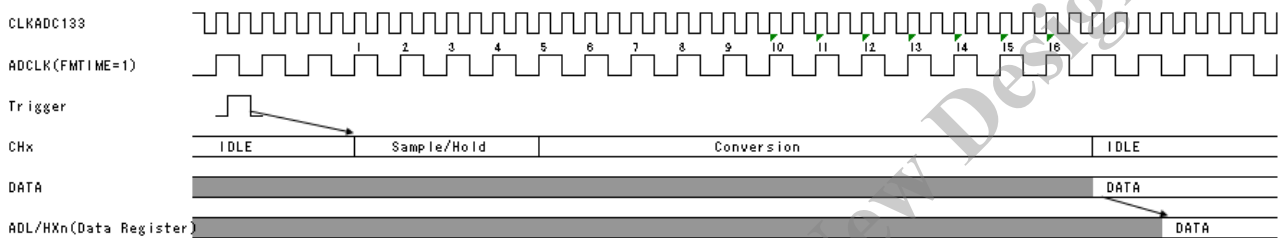


Figure 21-2 Basic conversion sequence

ADC has ten analog channels at most. The conversion of each channel can be enabled by ADSL/Hn register. The conversion starts from the youngest enabled number channel. Table 21-6 shows the correspondence between ADSL/Hn register bit and analog input.

Table 21-6 CHSEQx bit vs. analog input

Pin Name	Unit 0	Unit 1	Notes
ADSLn.CHSEQ0	ANEX0	ANEX4	
ADSLn.CHSEQ1	ANEX1	ANEX5	
ADSLn.CHSEQ2	ANEX2	ANEX6	
ADSLn.CHSEQ3	ANEX3	ANEX7	
ADSLn.CHSEQ4	AMP0	AMP0	
ADSLn.CHSEQ5	AMP1	AMP1	
ADSLn.CHSEQ6	ANEX9	ANEX13	
ADSLn.CHSEQ7	TEMP	TEMP	
ADSHn.CHSEQ8	AGND	AGND	
ADSHn.CHSEQ9	AVSS	AVSS	

21.3.2 Conversion Mode

AD Conversion Mode is selected from “Burst until Sequence End” or “Step and Round Sequence” by ADCn.ADMODE bit. The sequence means the order of input channels to be converted.

21.3.2.1. “Burst until Sequence End” mode

In the mode “Burst until Sequence End”, one trigger can initiate contiguous burst conversions according to configured sequence.

- (1) When the start trigger that is selected by ADCn.ADTRG[4:0] bit is detected, A/D conversion starts in younger channel order which is selected by ADL/H register.
- (2) When A/D conversion of a channel finished, the converted data is written to corresponding data register (ADL/HXn).
- (3) If there are un-converted channel, A/D conversion of the next younger channel starts just after finishing the previous A/D conversion. After that, go back to (2).
- (4) A/D conversion of all channels is finished, ADI.ADIF bit is set to 1'b1. If ADI.ADIE=1, ADI interrupt is issued to CPU.

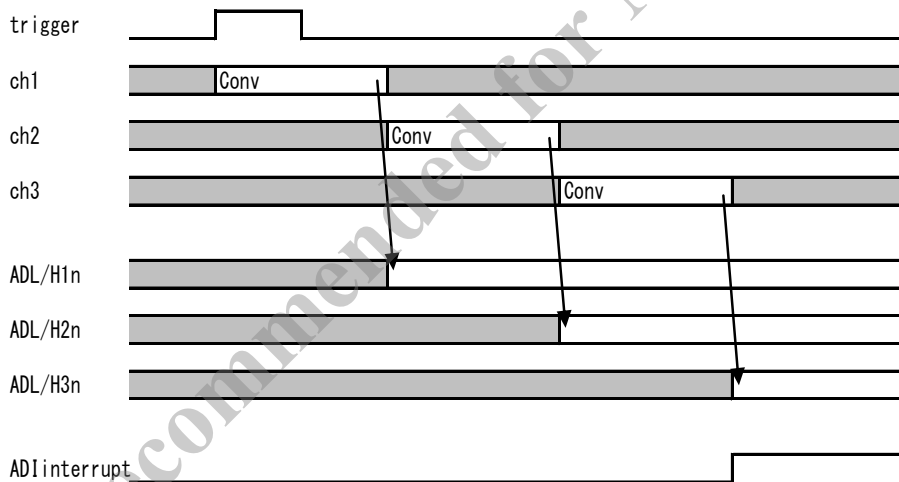


Figure 21-3 Burst until Sequence End mode.

21.3.2.2. “Step and Round Sequence” Mode

In the mode “Step and Round Sequence”, the conversion sequence follows configured one but each conversion requires something conversion trigger to start.

- (1) When the start trigger that is selected by ADCn.ADTRG[4:0] bit is detected, A/D conversion starts in younger channel order which is selected by ADSL/Hn register.
- (2) When A/D conversion of a channel finished, the converted data is written to corresponding data register (ADL/HXn).
- (3) ADCn.ADIF is set to 1'b1 if the corresponding ADTRGL/Hn register bit is set to 1'b1. If ADI.ADIE=1, ADI interrupt is issued to CPU.
- (4) The next start trigger is detected, the next younger channel of A/D conversion which is selected by ADSL/Hn register.

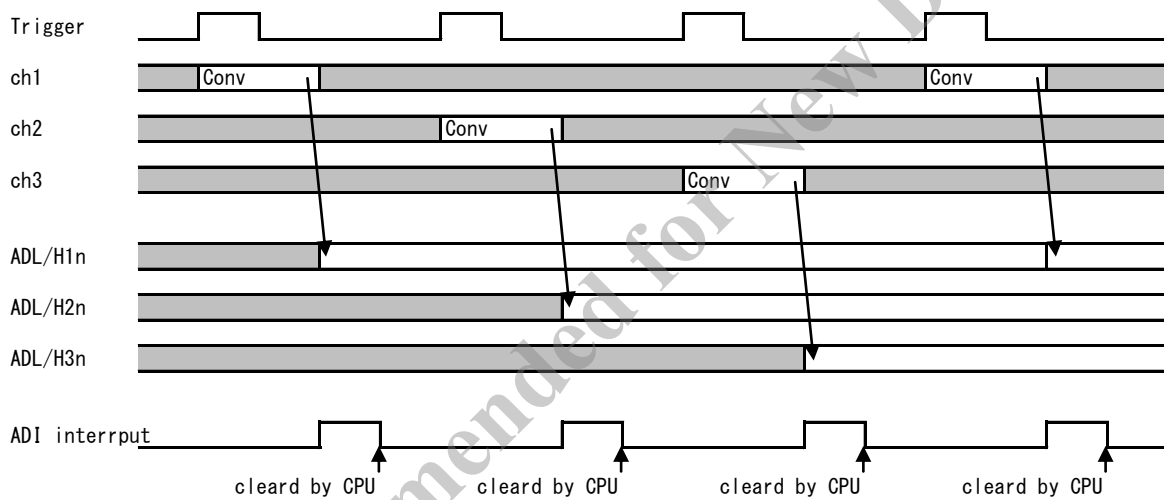


Figure 21-4 Step and Round Sequence mode

21.3.3 Dual Sample/Hold

ADC10 has two sample/hold circuits after the analog input switch. One is for only channel 0, another is for other channels. If AD_{SMn}.ADSHMODE is set to 1'b1 and two or more than two channels are enabled by AD_{SL/Hn} register, the ch0 and other younger channel of Sample/Hold is executed simultaneously. This operation can be used in both conversion modes.

In Step and Round sequence mode, the ch0 and the following dual sampled/held channel is converted sequentially only with one time trigger. ADI interrupt is asserted when the second channel conversion is finished, not asserted when the CH0 conversion is finished.

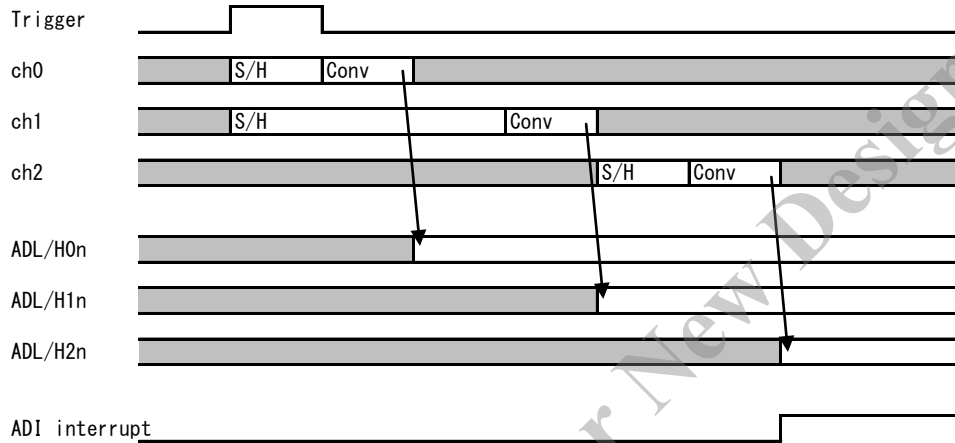


Figure 21-5 Dual Sample/Hold operation in Burst until Sequence End mode.

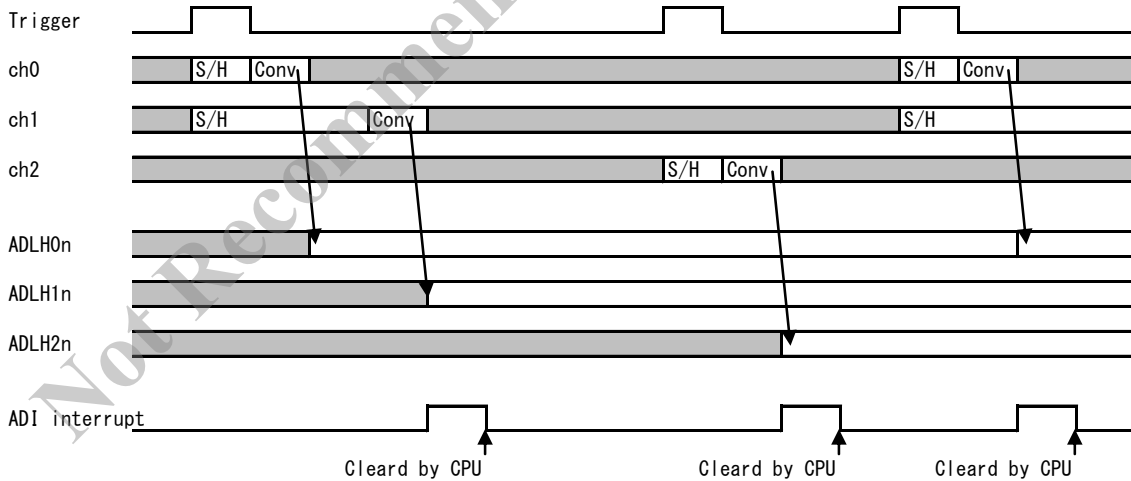


Figure 21-6 Dual Sample/Hold operation in Step and Round Sequence mode.

21.3.4 Conversion start trigger

A/D conversion starts when detecting selected A/D conversion trigger. A/D conversion start trigger can be selected by ADCn.ADTRG[4:0]. Only one conversion trigger during A/D conversion is hold, and issues after the current conversion is finished, then the next conversion will be start. The conversion trigger is not accepted when ADENn=0 or all channels are not selected (ADSL/Hn=0x00).

21.3.5 Converted data offset adjustment

The offset adjustment can be done for converted data by ADOL/HXn register. The bit length of adjusted value is enhanced from 11bit to 16bit.

$$ADOL/HXn.ADATA_tmp[11:0] = RAW_ADC_Value\{1'b0,[10:0]\} + OFFSET\{[10],[10:0]\}$$

$$ADOL/HXn.ADATA[15:0] = RAW_ADC_Value_tmp\{[11],[11],[11],[11],[11:0]\}$$

ADOL/HXn.ADATA[15:0] : ADL/HXn register bit, n is unit number, X is unit-X's channel.

RAW_ADC_Value[9:0]: Conversion result value

OFFSET[10:0] : Signed, ADOL/HXn register bit, n is unit number, X is unit-X's channel.

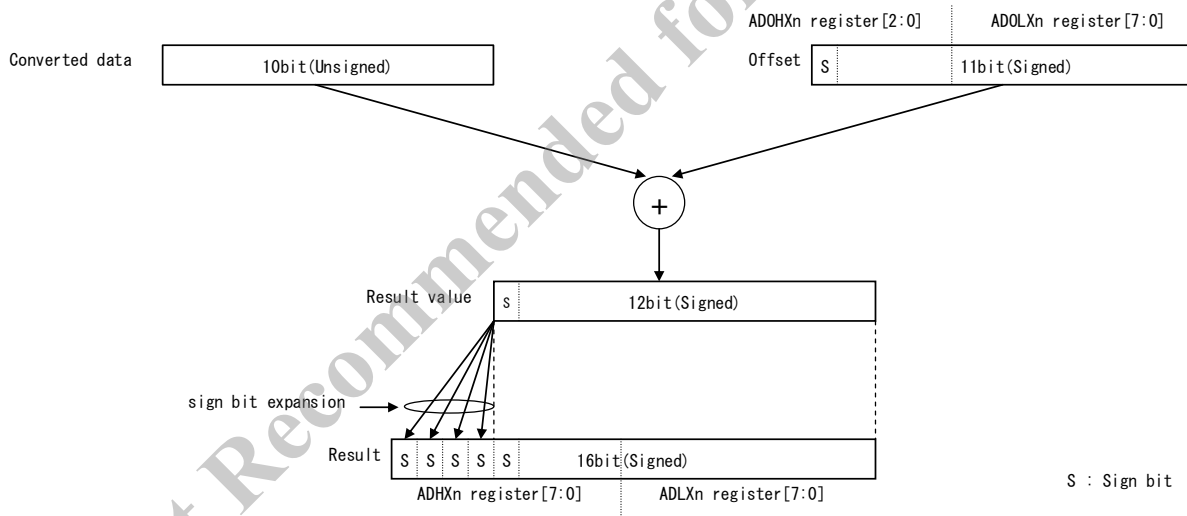


Figure 21-7 Converted data

21.3.6 Interrupts

If ADI.ADIEn=1, CPU interrupt can be occurred when ADI.ADIFn=1(n=0 or 1).

21.3.7 ADC Event

ADC event can be issued when A/D conversion will be finished. The ADC event of each channel can be selected by ADTRGL/Hn register.

Figure 21-8 shows the ADC event when ch1 and 3 are enabled and others are disabled.

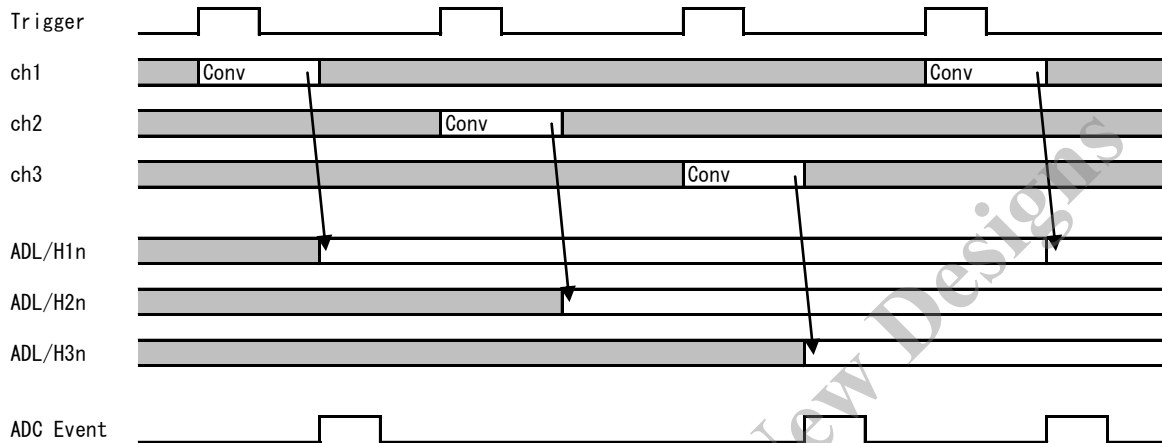


Figure 21-8 ADC event when ch1 and 3 are enabled.

21.3.8 Reading converted data

Note that the converted result data, mapped in SFR address space, pair of Low Side (LSB Side) register and High Side (MSB Side) register for 16bit value should be assigned on SAME address. In read access, 1st access gets Low Side data and 2nd access receives High Side data.

21.3.9 Threshold for conversion data update

This function controls ADL/H0n register update. ADL/H0n is updated if the difference between the current conversion result value (the offset is not included) and the previous one (the offset is not included) is equal or less than the threshold (ADUPTHH/L0n). The threshold is enabled during ADCn.UPTH0EN=1. The update condition is as follows:

$$|{(current\ conversion\ result\ value) - (previous\ conversion\ result\ value)}| \leq \{(ADUPTHH0n, ADUPTHL0n)\}.$$

The current/previous data comparison starts after ADCn.UPTH0EN=1. Therefore, the previous conversion result must be valid value for comparison. At first, the valid value should be gotten when ADCn.UPTH0EN is 0, then ADCn.UPTH0EN should be set to 1 to start the function.

ADNUPCNTn shows the number of non-update times. This register can be cleared by writing 0x00 to ADNUPCNTn register. To know ADL/H0n register is not updated, ADNUPCNTn is read when CH0 conversion ends interrupt sequence, and compares its value to the previous one. If the current value is increased from the previous value, the current conversion result is not written to ADL/H0n register.

21.3.10 Initialization sequence

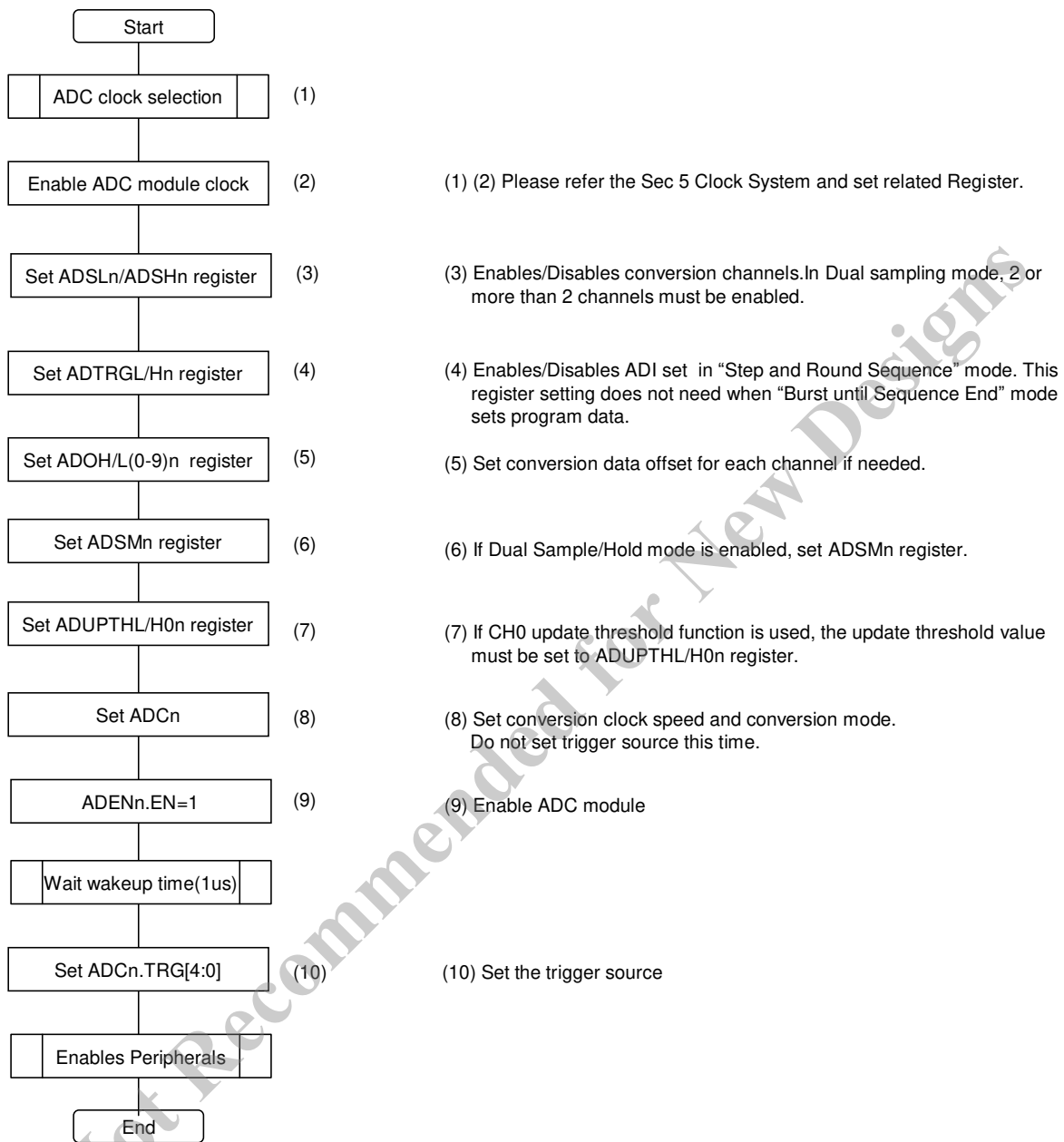


Figure 21-9 initialization sequence

21.4 Limitation of ADC10

21.4.1 Disabling ADC

When disabling ADC, please keep following sequence.

- (1) ADC Trigger Source select CPU Trigger, by setting the ADCn.ADTRG[4:0] to 5'b00000, in order to ignore other ADC trigger source. If ADTRG[4:0] is not 5'b00000, Trigger Source from peripheral must be stop by each peripheral.
- (2) Wait until ADT.ADCTRG becomes 1'b0.
- (3) Disable ADC (ADENn.EN=0).

21.4.2 Going to standby mode

Note that ADC must be disabled before going to Standby mode.

21.4.3 Clock frequency setting

Table 21-7 shows the combination of the clock frequency setting between CPUCLK and CLKADC_133. CPUCLK is divided by the Main Divider DIV1, and CLKADC_133 is divided by the DIV0. (Please refer to the related register in Sec.5 and follow the Table 21-7)

Table 21-7 Supported clock frequency setting for ADC10

	ADCn.ADTIME	1(CLKADC_133/2)				0(CLKADC_133/4)			
	CLKADC_133	1/1	1/2	1/4	1/8	1	1/2	1/4	1/8
CPUCLK	1/1	x	x	x	x	x	x	x	x
	1/2	x	x	x	x	x	x	x	x
	1/4		x	x	x	x	x	x	x
	1/8			x	x		x	x	x

x: supported

22. High Precision 12 bit SAR ADC

22.1 Overview

The LSI has Single High Precision 12 bit SAR (Successive Approximation Register) AD Converters (ADC2) with Speed Conversion Rate 1MSPS. The ADC has maximum 10 inputs and each input has corresponding result register. Each result can be applied specified Offset Value (Regarding the offset adjustment, please refer to the 22.3.4).

AD Conversion Mode is selected from “Burst until Sequence End” or “Step and Round Sequence”. The sequence means the order of input channels to be converted. In the mode “Burst until Sequence End”, one trigger can initiate contiguous burst conversions according to configured sequence. In the mode “Step and Round Sequence”, the conversion sequence follows configured one but each conversion requires some conversion trigger to start.

AD Conversion time can be selected from slow (half speed) or fast (max speed).

AD Conversion trigger can be selected from external GPIO events, analog comparator events, PWM events or Timer events. Of course, each ADC can generate interrupt when selected conversion has done. Besides interrupts, All ADC channel can be became the event source at conversion finish of specified channel (selected the channel from the ADTRGL/H2 ; multiple selection is acceptable).

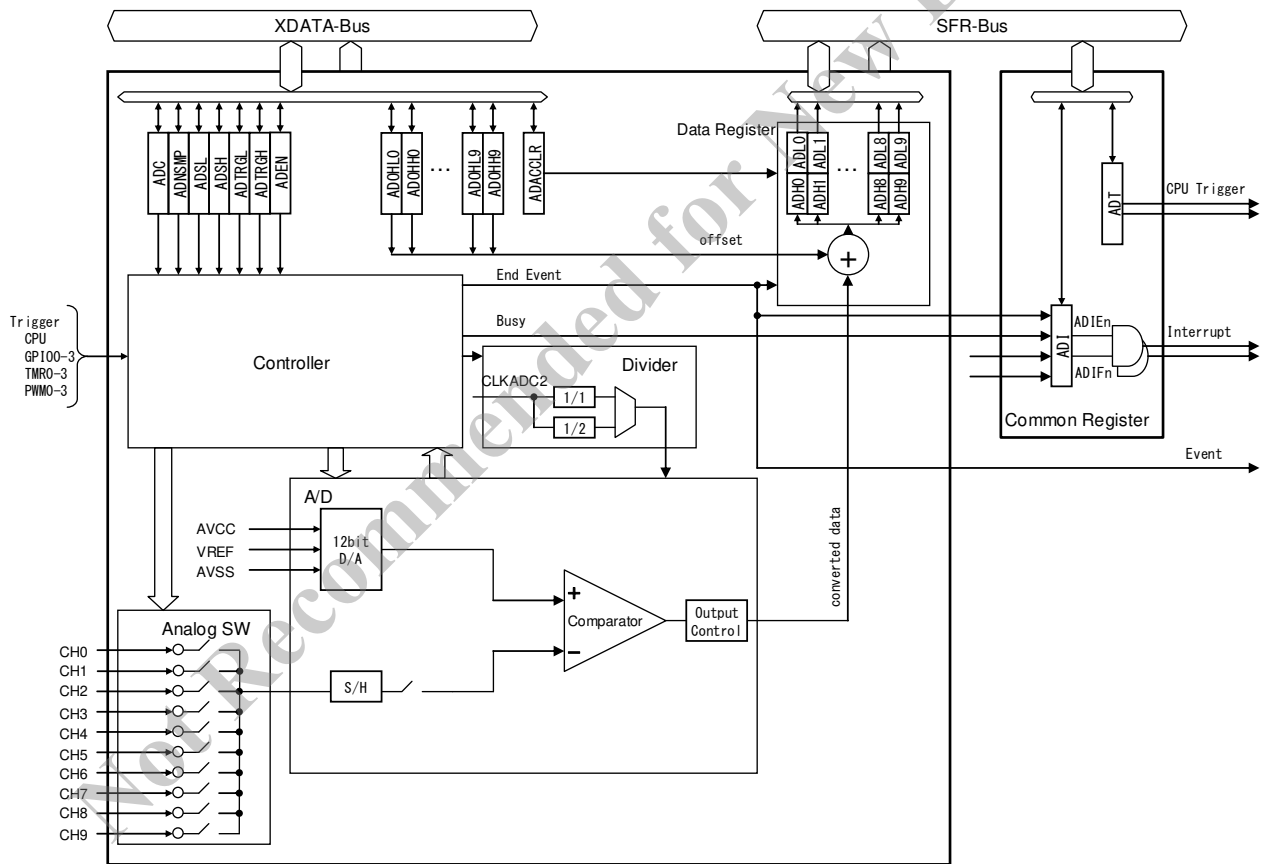


Figure 22-1 Block Diagram of High Precision 12 bit SAR ADC

Table 22-1 Input/Output Pins

Channel	Pin /Sig. Name	Description
0	ANEX0	Analog External 0
1	ANEX2	Analog External 2
2	ANEX4	Analog External 4
3	ANEX6	Analog External 6
4	OP0	OPAMP 0
5	OP1	OPAMP 1
6	ANEX11	Analog External 11
7	ANEX15	Analog External 15
8	DAC /AGND	DAC /Analog GND(1/2 AVCC)
9	AVSS	Analog VSS

DAC /AGND selection is determined by DACOUT.CALIB bit, please refer the 23.3.

Table 22-2 Feature of High Precision 12 bit SAR ADC

Item	Description	Note
Unit Counts	Single Unit	
Input Channels	10 Inputs/unit	
Resolution	12 bit	
Conversion Speed	1MSPS (M samples per second)	Sampling Time + Conversion Time = 1000ns
Conversion Mode	Burst Until Sequence End Step and Round Sequence	
Conversion Trigger	Selectable from internal events	
Interrupt and Event Outputs	Interrupt or Event Output can be generated when Conversion finished.	

22.2 Register Description

ADC12 has two kind of register group: XBUS register group and SFR group. Table 22-3 shows XDATA-Bus registers. Table 22-4 and Table 22-5 show SFRs.

Table 22-3 XDATA-Bus registers

Symbol	Name	Address	Initial value
ADC2	ADC Configuration Register	0xF100	0x00
ADSL2	ADC Channel Sequence L Register	0xF102	0x00
ADSH2	ADC Channel Sequence H Register	0xF103	0x00
ADTRGL2	ADC Trigger Source L Register	0xF104	0x00
ADTRGH2	ADC Trigger Source H Register	0xF105	0x00
ADEN2	ADC Enable Register	0xF107	0x00
ADACCLR2	ADC Access counter clear Register	0xF108	0x00
ADUPTHL02	ADC Ch0 Update Threshold L Register	0xF109	0x00
ADUPTHH02	ADC Ch0 Update Threshold H Register	0xF10A	0x00
ADNUPCNT2	ADC Ch0 Non-update Count Register	0xF10B	0x00
ADOL02	ADC Ch0 Offset Data L Register	0xF110	0x00
ADOH02	ADC Ch0 Offset Data H Register	0xF111	0x00
ADOL12	ADC Ch1 Offset Data L Register	0xF112	0x00
ADOH12	ADC Ch1 Offset Data H Register	0xF113	0x00
ADOL22	ADC Ch2 Offset Data L Register	0xF114	0x00
ADOH22	ADC Ch2 Offset Data H Register	0xF115	0x00
ADOL32	ADC Ch3 Offset Data L Register	0xF116	0x00
ADOH32	ADC Ch3 Offset Data H Register	0xF117	0x00
ADOL42	ADC Ch4 Offset Data L Register	0xF118	0x00
ADOH42	ADC Ch4 Offset Data H Register	0xF119	0x00
ADOL52	ADC Ch5 Offset Data L Register	0xF11A	0x00
ADOH52	ADC Ch5 Offset Data H Register	0xF11B	0x00
ADOL62	ADC Ch6 Offset Data L Register	0xF11C	0x00
ADOH62	ADC Ch6 Offset Data H Register	0xF11D	0x00
ADOL72	ADC Ch7 Offset Data L Register	0xF11E	0x00
ADOH72	ADC Ch7 Offset Data H Register	0xF11F	0x00
ADOL82	ADC Ch8 Offset Data L Register	0xF120	0x00
ADOH82	ADC Ch8 Offset Data H Register	0xF121	0x00
ADOL92	ADC Ch9 Offset Data L Register	0xF122	0x00
ADOH92	ADC Ch9 Offset Data H Register	0xF123	0x00

Table 22-4 SFR (each unit)

Symbol	Name	Address	Initial value
ADL02	ADC Ch0 Data L	0x9B	0x00
ADH02	ADC Ch0 Data H	0x9B	0x00
ADL12	ADC Ch1 Data L	0xA3	0x00
ADH12	ADC Ch1 Data H	0xA3	0x00
ADL22	ADC Ch2 Data L	0xAB	0x00
ADH22	ADC Ch2 Data H	0xAB	0x00
ADL32	ADC Ch3 Data L	0xB3	0x00
ADH32	ADC Ch3 Data H	0xB3	0x00
ADL42	ADC Ch4 Data L	0xBB	0x00
ADH42	ADC Ch4 Data H	0xBB	0x00
ADL52	ADC Ch5 Data L	0xC3	0x00
ADH52	ADC Ch5 Data H	0xC3	0x00
ADL62	ADC Ch6 Data L	0xCB	0x00
ADH62	ADC Ch6 Data H	0xCB	0x00
ADL72	ADC Ch7 Data L	0xD3	0x00
ADH72	ADC Ch7 Data H	0xD3	0x00
ADL82	ADC Ch8 Data L	0xDB	0x00
ADH82	ADC Ch8 Data H	0xDB	0x00
ADL92	ADC Ch9 Data L	0xE3	0x00
ADH92	ADC Ch9 Data H	0xE3	0x00

Table 22-5 SFR (common)

Symbol	Name	Address	Initial value
ADT	Mix ADC CPU Trigger Register	0xF1	0x00
ADI	Mix ADC Interrupt Register	0xF2	0x00

22.2.1 ADC2 (ADC Configuration Register)

Register		ADC2		ADC Configuration Register		Address	0xF100
Bit	Bit Name	R/W	Initial	Description		Note	
7	UPTH0EN	R/W	0	CH0 update threshold enable 0: disable 1: enable			
6	ADMODE	R/W	0	ADC Conversion Mode 0: Burst until Sequence End (Output interrupt after last sequence) 1: Step and Round Sequence (Output interrupt at each step)			
5	ADTIME	R/W	0	ADC Conversion Time 0: Slow (CLKADC2 / 2) 1: Fast (CLKADC2)			
4	ADTRG4	R/W	0	ADC Trigger Source			
3	ADTRG3	R/W	0	00000: CPU			
2	ADTRG2	R/W	0	00001: GPIO0 Event for ADC (neg edge)			
1	ADTRG1	R/W	0	00010: GPIO0 Event for ADC (pos edge)			
0	ADTRG0	R/W	0	00011: GPIO0 Event for ADC (both edge)			
				00100: GPIO1 Event for ADC (neg edge)			
				00101: GPIO1 Event for ADC (pos edge)			
				00110: GPIO1 Event for ADC (both edge)			
				00111: GPIO2 Event for ADC (neg edge)			
				01000: GPIO2 Event for ADC (pos edge)			
				01001: GPIO2 Event for ADC (both edge)			
				01010: GPIO3 Event for ADC (neg edge)			
				01011: GPIO3 Event for ADC (pos edge)			
				01100: GPIO3 Event for ADC (both edge)			
				01101: Comparator 0 (pulse)			
				01110: Comparator 1 (pulse)			
				01111: Comparator 2 (pulse)			
				10000: Comparator 3 (pulse)			
				10001: TIMER0-CM0 (pulse)			
				10010: TIMER0-CM1 (pulse)			
				10011: TIMER1-CM0 (pulse)			
				10100: TIMER1-CM1 (pulse)			
				10101: PWM0-EVENT0 (pulse)			
				10110: PWM0-EVENT1 (pulse)			
				10111: PWM1-EVENT0 (pulse)			
				11000: PWM1-EVENT1 (pulse)			
				11001: PWM2-EVENT0(pulse)			
				11010: PWM2-EVENT1 (pulse)			
				11011: PWM3-EVENT0 (pulse)			
				11100: PWM3-EVENT1 (pulse)			
				Others are reserved. Do not set.			

UPTH0EN, ADMODE and ADTIME in ADC2 register should be written when ADEN2.EN=0.
Setting ADEN2.EN=1 and waiting 1 μ s, then ADC Trigger Source should be written into ADTRG[4:0].

22.2.2 ADSL2 (ADC Channel Sequence L Register)

Register		ADSL2		ADC Channel Sequence L Register	Address	0xF102
Bit	Bit Name	R/W	Initial	Description	Note	
7	CHSEQ7	R/W	0	Channel 7 Sequence		
6	CHSEQ6	R/W	0	Channel 6 Sequence		
5	CHSEQ5	R/W	0	Channel 5 Sequence		
4	CHSEQ4	R/W	0	Channel 4 Sequence		
3	CHSEQ3	R/W	0	Channel 3 Sequence		
2	CHSEQ2	R/W	0	Channel 2 Sequence		
1	CHSEQ1	R/W	0	Channel 1 Sequence		
0	CHSEQ0	R/W	0	Channel 0 Sequence		

ADSL2 register must be written when ADEN2.EN=0.

22.2.3 ADSH2 (ADC Channel Sequence H Register)

Register		ADSH2		ADC Channel Sequence H Register	Address	0xF103
Bit	Bit Name	R/W	Initial	Description	Note	
7	reserved	R	0	Read value is 0. Write only 0.		
6	reserved	R	0	Read value is 0. Write only 0.		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	reserved	R	0	Read value is 0. Write only 0.		
2	reserved	R	0	Read value is 0. Write only 0.		
1	CHSEQ9	R/W	0	Channel 9 Sequence		
0	CHSEQ8	R/W	0	Channel 8 Sequence		

ADSH2 register must be written when ADEN2.EN=0.

Note: Channel Sequence is configured as follows.

ADSHn	ADSLn	Conversion Sequence
0b00000000	0b00000001	CH0→CH0→CH0→CH0→...
0b00000000	0b00001000	CH3→CH3→CH3→CH3→...
0b00000000	0b00000011	CH0→CH1→CH0→CH1→...
0b00000000	0b00111100	CH2→CH3→CH4→CH5→CH2→CH3→CH4→CH5→...
0b00000000	0b11111111	CH0→CH1→CH2→CH3→CH4→CH5→CH6→CH7→...
0b00000010	0b10001000	CH3→CH7→CH9→CH3→CH7→CH9→...

22.2.4 ADTRGL2 (ADC Event Source L Register)

Register		ADTRGL2		ADC Event Source L Register		Address	0xF104
Bit	Bit Name	R/W	Initial	Description		Note	
7	EVTCH7	R/W	0	Choose ADC Output Trigger 0: The channel finish is not included in output trigger. 1: The channel finish is included in output trigger.			
6	EVTCH6	R/W	0				
5	EVTCH5	R/W	0				
4	EVTCH4	R/W	0				
3	EVTCH3	R/W	0				
2	EVTCH2	R/W	0				
1	EVTCH1	R/W	0				
0	EVTCH0	R/W	0				

ADTRGL2 register must be written when ADEN2.EN=0.

22.2.5 ADTRGH2 (ADC Event Source H Register)

Register		ADTRGH2		ADC Event Source H Register		Address	0xF105
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	EVTCH9	R/W	0	Choose ADC Output Trigger 0: The channel finish is not included in output trigger. 1: The channel finish is included in output trigger.			
0	EVTCH8	R/W	0				

ADTRGH2 register must be written when ADEN2.EN=0.

22.2.6 ADEN2 (ADC Enable Register)

Register		ADEN2		ADC Enable Register		Address	0xF107
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	reserved	R	0	Read value is 0. Write only 0.			
0	EN	R/W	0	ADC Enable 0: ADC Disabled 1: ADC Enabled Activate the ADC.			

22.2.7 ADACCLR2 (ADC Access Counter Clear Register)

Register		ADACCLR2		ADC Access Counter Clear Register		Address	0xF108
Bit	Bit Name	R/W	Initial	Description		Note	
7	CLRADCCDR CAC	R/W	0	Clear ADC Conversion Data Register CPU Access Counter 0: No effect 1: Register CPU Access counter clear Read : No Request Write 0: No effect Write 1: Clear Register CPU Access counter. (Clear CPU SFR access counter.)			
6	CLRADCCDR DAC	R/W	0	Clear ADC Conversion Data Register DSAC Access Counter 0: No effect 1: Register DSAC Access counter clear Read : No Request Write 0: No effect Write 1: Clear Register DSAC Access counter. (Clear DSAC SFR access counter.)			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	reserved	R	0	Read value is 0. Write only 0.			
2	reserved	R	0	Read value is 0. Write only 0.			
1	reserved	R	0	Read value is 0. Write only 0.			
0	reserved	R	0	Read value is 0. Write only 0.			

22.2.8 ADUPTHL02 (ADC Ch0 Update Threshold L Register)

Register		ADUPTHL02		ADC Ch0 Update Threshold L Register		Address	0xF109
Bit	Bit Name	R/W	Initial	Description		Note	
7	UPTH7	R/W	0	Unsigned CH0 update threshold value			
6	UPTH6	R/W	0				
5	UPTH5	R/W	0				
4	UPTH4	R/W	0				
3	UPTH3	R/W	0				
2	UPTH2	R/W	0				
1	UPTH1	R/W	0				
0	UPTH0	R/W	0				

ADUPTHL02 register must be written when ADEN2.EN=0.

22.2.9 ADUPTHH02 (ADC Ch0 Update Threshold H Register)

Register		ADUPTHH02		ADC Ch0 Update Threshold H Register		Address	0xF10A
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0.			
6	reserved	R	0	Read value is 0. Write only 0.			
5	reserved	R	0	Read value is 0. Write only 0.			
4	reserved	R	0	Read value is 0. Write only 0.			
3	UPTH11	R/W	0	Unsigned CH0 update threshold value			
2	UPTH10	R/W	0				
1	UPTH9	R/W	0				
0	UPTH8	R/W	0				

ADUPTHH02 register must be written when ADEN2.EN=0.

22.2.10 ADNUPCNT2 (ADC Ch0 Non-update Count Register)

Register		ADNUPCNT2		ADC Ch0 Non-update Count Register		Address	0xF10B
Bit	Bit Name	R/W	Initial	Description		Note	
7	NUPCNT7	R/W	0	Ch0 Non-update counts The number of the times of ADL/H02 register being not updated. This register can be cleared by writing 0x00.			
6	NUPCNT6	R/W	0				
5	NUPCNT5	R/W	0				
4	NUPCNT4	R/W	0				
3	NUPCNT3	R/W	0				
2	NUPCNT2	R/W	0				
1	NUPCNT1	R/W	0				
0	NUPCNT0	R/W	0				

22.2.11 ADOLX2 (ADC ChX Offset Data L Register)

Register	ADOL02	ADC Ch0 Offset Data L Register	Address	0xF110	
Register	ADOL12	ADC Ch1 Offset Data L Register	Address	0xF112	
Register	ADOL22	ADC Ch2 Offset Data L Register	Address	0xF114	
Register	ADOL32	ADC Ch3 Offset Data L Register	Address	0xF116	
Register	ADOL42	ADC Ch4 Offset Data L Register	Address	0xF118	
Register	ADOL52	ADC Ch5 Offset Data L Register	Address	0xF11A	
Register	ADOL62	ADC Ch6 Offset Data L Register	Address	0xF11C	
Register	ADOL72	ADC Ch7 Offset Data L Register	Address	0xF11E	
Register	ADOL82	ADC Ch8 Offset Data L Register	Address	0xF120	
Register	ADOL92	ADC Ch9 Offset Data L Register	Address	0xF122	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADOFFSET 7	R/W	0	Signed 13 bit ADC Offset Data L bit 7 – bit 0 are stored.	
6	ADOFFSET 6	R/W	0		
5	ADOFFSET 5	R/W	0		
4	ADOFFSET 4	R/W	0		
3	ADOFFSET 3	R/W	0		
2	ADOFFSET 2	R/W	0		
1	ADOFFSET 1	R/W	0		
0	ADOFFSET 0	R/W	0		

Not Recommended for New Designs

22.2.12 ADOHX2 (ADC ChX Offset Data H Register, X=0-9)

Register	ADOH02	ADC Ch0 Offset Data H Register	Address	0xF111	
Register	ADOH12	ADC Ch1 Offset Data H Register	Address	0xF113	
Register	ADOH22	ADC Ch2 Offset Data H Register	Address	0xF115	
Register	ADOH32	ADC Ch3 Offset Data H Register	Address	0xF117	
Register	ADOH42	ADC Ch4 Offset Data H Register	Address	0xF119	
Register	ADOH52	ADC Ch5 Offset Data H Register	Address	0xF11B	
Register	ADOH62	ADC Ch6 Offset Data H Register	Address	0xF11D	
Register	ADOH72	ADC Ch7 Offset Data H Register	Address	0xF11F	
Register	ADOH82	ADC Ch8 Offset Data H Register	Address	0xF121	
Register	ADOH92	ADC Ch9 Offset Data H Register	Address	0xF123	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	ADOFFSET12	R/W	0	Signed 13 bit ADC Offset Data H bit 12 – bit 8 are stored.	
3	ADOFFSET11	R/W	0		
2	ADOFFSET10	R/W	0		
1	ADOFFSET9	R/W	0		
0	ADOFFSET8	R/W	0		

22.2.13 ADLX2 (ADC ChX Data L Register)

Register	ADL02	ADC Ch0 Data L Register	Address	0x9B	
Register	ADL12	ADC Ch1 Data L Register	Address	0xA3	
Register	ADL22	ADC Ch2 Data L Register	Address	0xAB	
Register	ADL32	ADC Ch3 Data L Register	Address	0xB3	
Register	ADL42	ADC Ch4 Data L Register	Address	0xBB	
Register	ADL52	ADC Ch5 Data L Register	Address	0xC3	
Register	ADL62	ADC Ch6 Data L Register	Address	0xCB	
Register	ADL72	ADC Ch7 Data L Register	Address	0xD3	
Register	ADL82	ADC Ch8 Data L Register	Address	0xDB	
Register	ADL92	ADC Ch9 Data L Register	Address	0xE3	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADDATA 7	R	0	Signed 16 bit ADC Conversion Data L bit 7 – bit 0 are stored. This value is already applied an offset specified by ADOL/HX2 like as “Raw ADC Value + ADOL/HX2” (14 bit operation) Details refer to 22.3.4	
6	ADDATA 6	R	0		
5	ADDATA 5	R	0		
4	ADDATA 4	R	0		
3	ADDATA 3	R	0		
2	ADDATA 2	R	0		
1	ADDATA 1	R	0		
0	ADDATA 0	R	0		

22.2.14 ADHX2 (ADC ChX Data H Register)

Register	ADH02	ADC Ch0 Data H Register	Address	0x9B	
Register	ADH12	ADC Ch1 Data H Register	Address	0xA3	
Register	ADH22	ADC Ch2 Data H Register	Address	0xAB	
Register	ADH32	ADC Ch3 Data H Register	Address	0xB3	
Register	ADH42	ADC Ch4 Data H Register	Address	0xBB	
Register	ADH52	ADC Ch5 Data H Register	Address	0xC3	
Register	ADH62	ADC Ch6 Data H Register	Address	0xCB	
Register	ADH72	ADC Ch7 Data H Register	Address	0xD3	
Register	ADH82	ADC Ch8 Data H Register	Address	0xDB	
Register	ADH92	ADC Ch9 Data H Register	Address	0xE3	
Bit	Bit Name	R/W	Initial	Description	Note
7	ADDATA 15	R	0	Signed 16 bit ADC Conversion Data H bit 15 – bit 8 are stored. This value is already applied an offset specified by ADOH/LX2 like as “Raw ADC Value + ADOX2” (14 bit operation) Details refer to 22.3.4	
6	ADDATA 14	R	0		
5	ADDATA 13	R	0		
4	ADDATA 12	R	0		
3	ADDATA 11	R	0		
2	ADDATA 10	R	0		
1	ADDATA 9	R	0		
0	ADDATA 8	R	0		

22.2.15 ADT (ADC Trigger Register)

Please refer to the 21.2.16 ADT(ADC Trigger Register) in Sec 21 High Speed 10 bit SAR ADC.

22.2.16 ADI (ADC Interrupt Register)

Please refer to the 21.2.17 ADI(ADC Interrupt Register) in Sec 21 High Speed 10 bit SAR ADC

22.3 Operation

22.3.1 Basic operation

ADC is activated when ADEN2.EN bit is set to 1'b1. The AD conversion starts when ADC is active and a conversion trigger from one of the peripherals is received. The AD Conversion trigger can be selected from CPU, external GPIO events, analog comparator events, PWM events or Timer events by ADC2.ADTRG[4:0] bits. The CPU trigger can be generated by ADT.ADCTRGN bit that is mapped in SFR address space.

AD Conversion time can be selected from slow (half speed) or fast (full speed) by ADC2.ADTIME bit.

Figure 22-2 Basic conversion sequence.

A/D conversion of a channel spends 50 cycles of ADCLK.

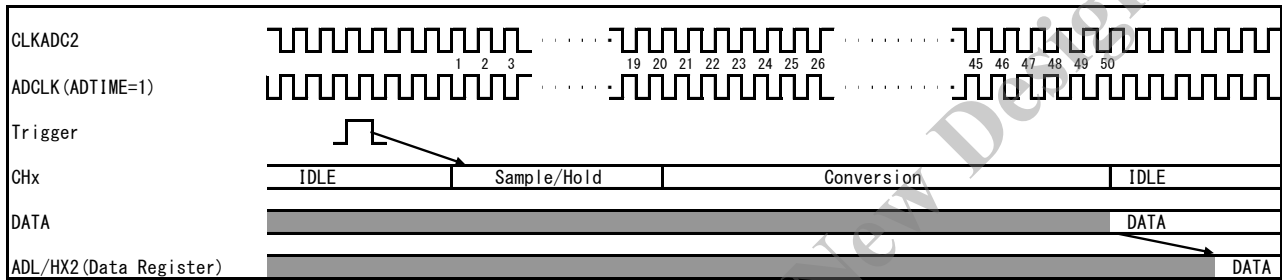


Figure 22-2 Basic conversion sequence

ADC has ten analog channels at most. The conversion of each channel can be enabled by ADSL/H2 register. The conversion starts from the youngest enabled number channel. Table 22-6 shows the correspondence between ADSL/H2 register bit and analog input.

Table 22-6 CHSEQx bit vs. analog input

Pin Name	ADC12	Notes
ADSL2.CHSEQ0	ANEX0	
ADSL2.CHSEQ1	ANEX2	
ADSL2.CHSEQ2	ANEX4	
ADSL2.CHSEQ3	ANEX6	
ADSL2.CHSEQ4	AMP0	
ADSL2.CHSEQ5	AMP1	
ADSL2.CHSEQ6	ANEX11	
ADSL2.CHSEQ7	ANEX15	
ADSH2.CHSEQ8	AGND	
ADSH2.CHSEQ9	AVSS	

22.3.2 Conversion Mode

AD Conversion Mode is selected from “Burst until Sequence End” or “Step and Round Sequence” by ADC2.ADMODE bit. The sequence means the order of input channels to be converted.

22.3.2.1. Burst until Sequence End mode

In the mode “Burst until Sequence End”, one trigger can initiate contiguous burst conversions according to configured sequence.

- (1) When the start trigger that is selected by ADC2.ADTRG[4:0] bit is detected, A/D conversion starts in younger channel order which is selected by ADSL/H2 register.
- (2) When A/D conversion of a channel finished, the converted data is written to corresponding data register (ADLHX2).
- (3) If there are un-converted channel, A/D conversion of the next younger channel starts just after finishing the previous A/D conversion. After that, go back to (2).
- (4) A/D conversions of all channels are finished, ADI.ADIF bit is set to 1'b1. If ADI.ADIE=1, ADI interrupt is issued to CPU.

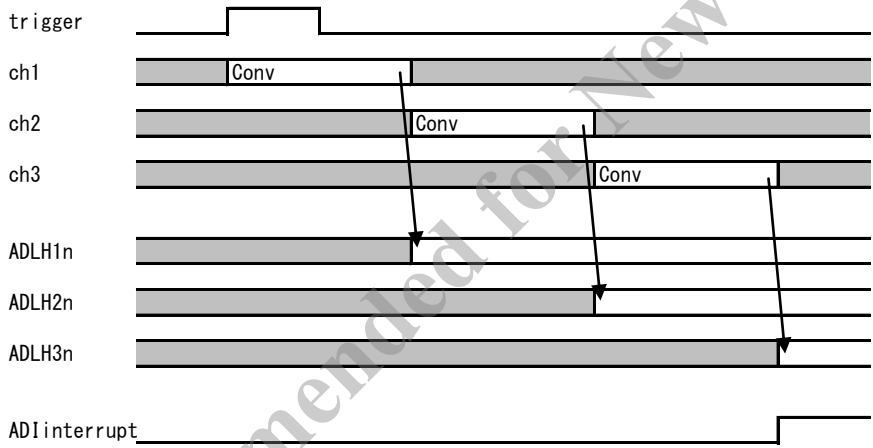


Figure 22-3 Burst until Sequence End mode.

22.3.2.2. Step and Round Sequence Mode

In the mode “Step and Round Sequence”, the conversion sequence follows configured one but each conversion requires some conversion trigger to start.

- (1) When the start trigger that is selected by ADC2.ADTRG[4:0] bit is detected, A/D conversion starts in younger channel order which is selected by ADSL/H2 register.
- (2) When A/D conversion of a channel finished, the converted data is written to corresponding data register (ADLHX2).
- (3) ADC.ADIF is set to 1'b1 if the corresponding ADTRGL/H2 register bit is set to 1'b1. If ADI.ADIE=1, ADI interrupt is issued to CPU.
- (4) The next start trigger is detected, the next younger channel of A/D conversion which is selected by ADSL/H2 register.

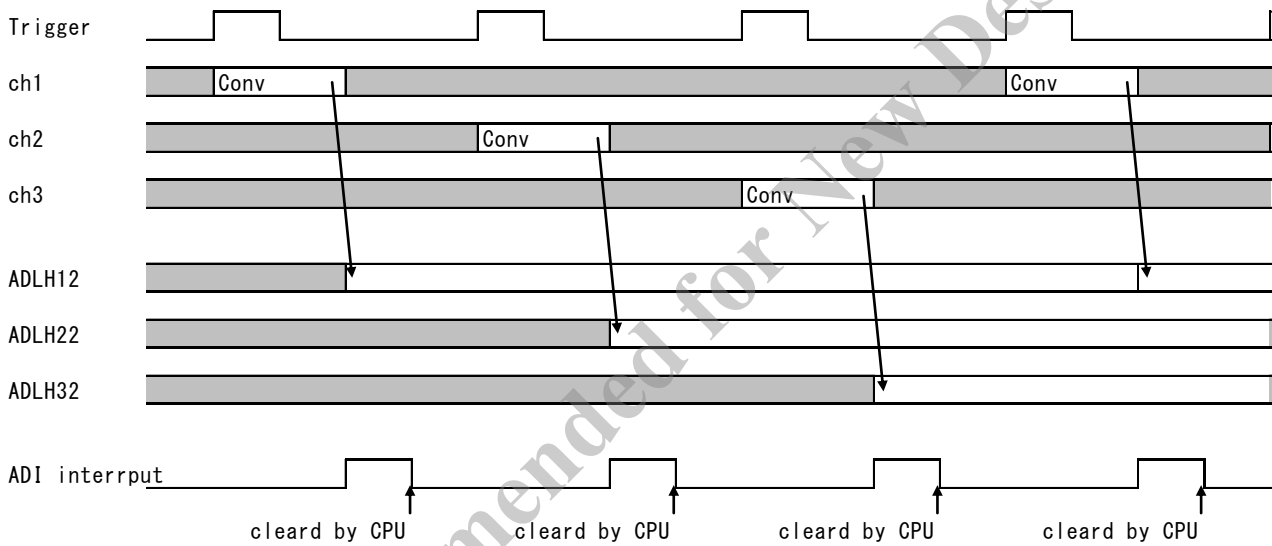


Figure 22-4 Step and Round Sequence mode.

22.3.3 Conversion start trigger

A/D conversion starts when detecting selected A/D conversion trigger. A/D conversion start trigger can be selected by ADC2.ADTRG[4:0]. Only one conversion trigger during A/D conversion is hold, and issues after the current conversion is finished, then the next conversion will start. The conversion trigger is not accepted when ADEN2=0 or all channels are not selected (ADSL/H2=0x00).

22.3.4 Converted data offset adjustment

The offset adjustment can be done for converted data by ADOL/HX2 register. The bit length of adjusted value is enhanced from 12 bit to 16 bit.

$$\text{ADOH/LX2.ADATA_tmp}[13:0] = \text{RAW_ADC_Value}\{2'b00,[11:0]\} + \text{OFFSET}\{[12],[12:0]\}$$

$$\text{ADOH/LX2.ADATA}[15:0] = \text{RAW_ADC_Value_tmp}\{[13],[13],[13:0]\}$$

ADOH/LX2.ADATA[15:0] : ADLHX2 register bit, X is unit-X's channel.

RAW_ADC_Value[11:0]: Conversion result value

OFFSET[12:0] : Signed, ADOH/LX2 register bit, X is unit-X's channel.

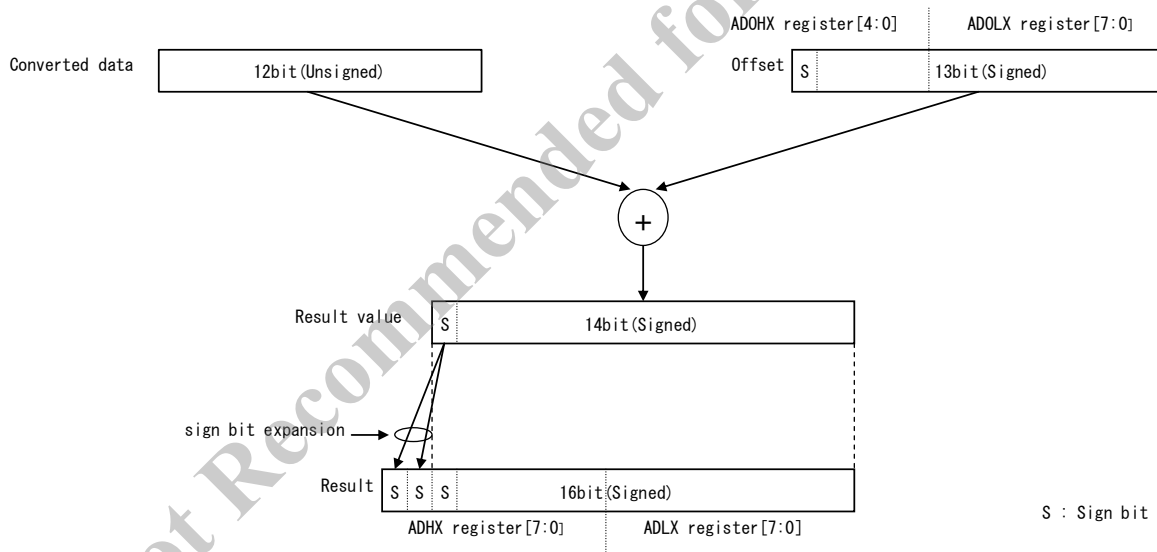


Figure 22-5 Converted data

22.3.5 Interrupts

If ADI.ADIEn=1, CPU interrupt can be occurred when ADI.ADIFn=1(n=0 or 1).

22.3.6 ADC Event

ADC event can be issued when A/D conversion is finished. The ADC event of each channel can be selected by ADTRGL/H2 register. Table 22-6 shows the ADC event when ch0 and 3 are enabled, others are disabled.

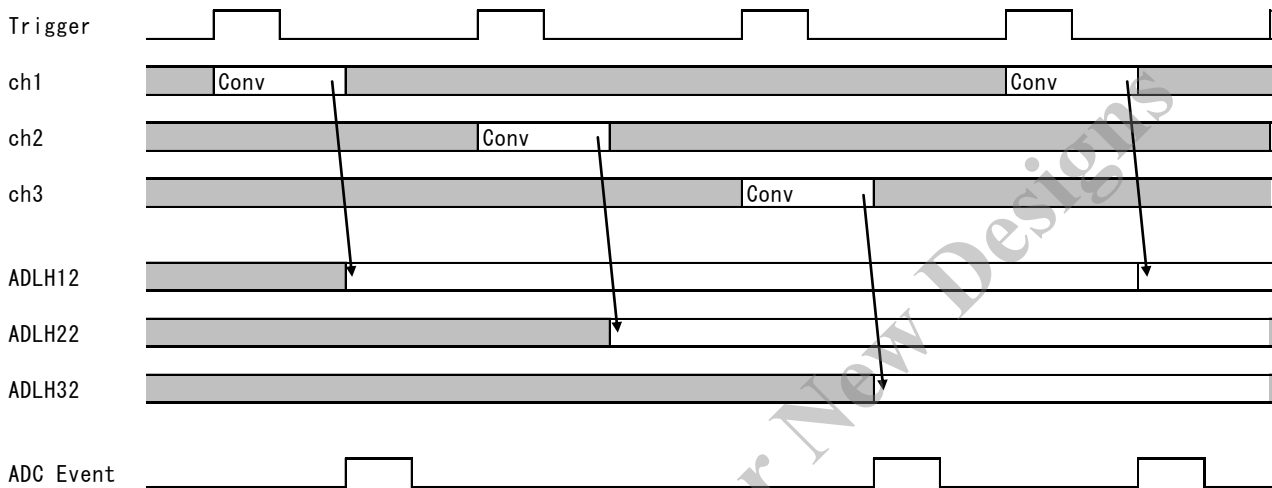


Figure 22-6 ADC event when ch1 and 3 are enabled.

22.3.7 Reading converted data

Note that the converted result data, mapped in SFR address space, pair of Low Side (LSB Side) register and High Side (MSB Side) register for 16 bit value should be assigned on SAME address. In read access, 1st access gets Low Side data and 2nd access receives High Side data.

The LSB/MSB Side is selected by CPU/DSAC access counter. When CPU reads from ADLHX2 register, CPU counter is incremented. If ADACCLR2.CLRADCCDRCAC bit is set to 1'b1, the CPU access counter is cleared. After that, the LSB Side can be read by CPU. When DSAC reads from ADLHX2 register, DSAC counter is incremented. If ADACCLR2.CLRADCCDRDAC bit is set to 1'b1, the DSAC access counter is cleared. After that, the LSB Side can be read by DSAC.

22.3.8 Threshold for conversion data update

This function controls ADLH02 register update. ADLH02 is updated if the difference between the current conversion result value (the offset is not included) and previous one (the offset is not included) are equal or less than the threshold(ADUPTHH/L02). The threshold is enabled during ADC2.UPTH0EN=1. The update condition is as follows:

$$|{(current\ conversion\ result\ value) - (previous\ conversion\ result\ value)}| \leq \{(ADUPTHH02, ADUPTHL02)\}.$$

The current/previous data comparison starts after ADC2.UPTH0EN=1. Therefore, the previous conversion result must be valid value for comparison. At first, the valid value should be gotten when ADC2.UPTH0EN, then ADC2.UPTH0EN should be set to 1 to start the function.

ADNUPCNT2 shows the number of non-update times. This register can be cleared by writing 0x00 to ADNUPCNT2 register. To know ADLH02 register is not updated, ADNUPCNT2 is read when CH0 conversion end interrupt sequence, and compare its value to previous one. If the current value is increased from previous value, the current conversion result is not written to ADLH02 register.

22.3.9 Initialization sequence

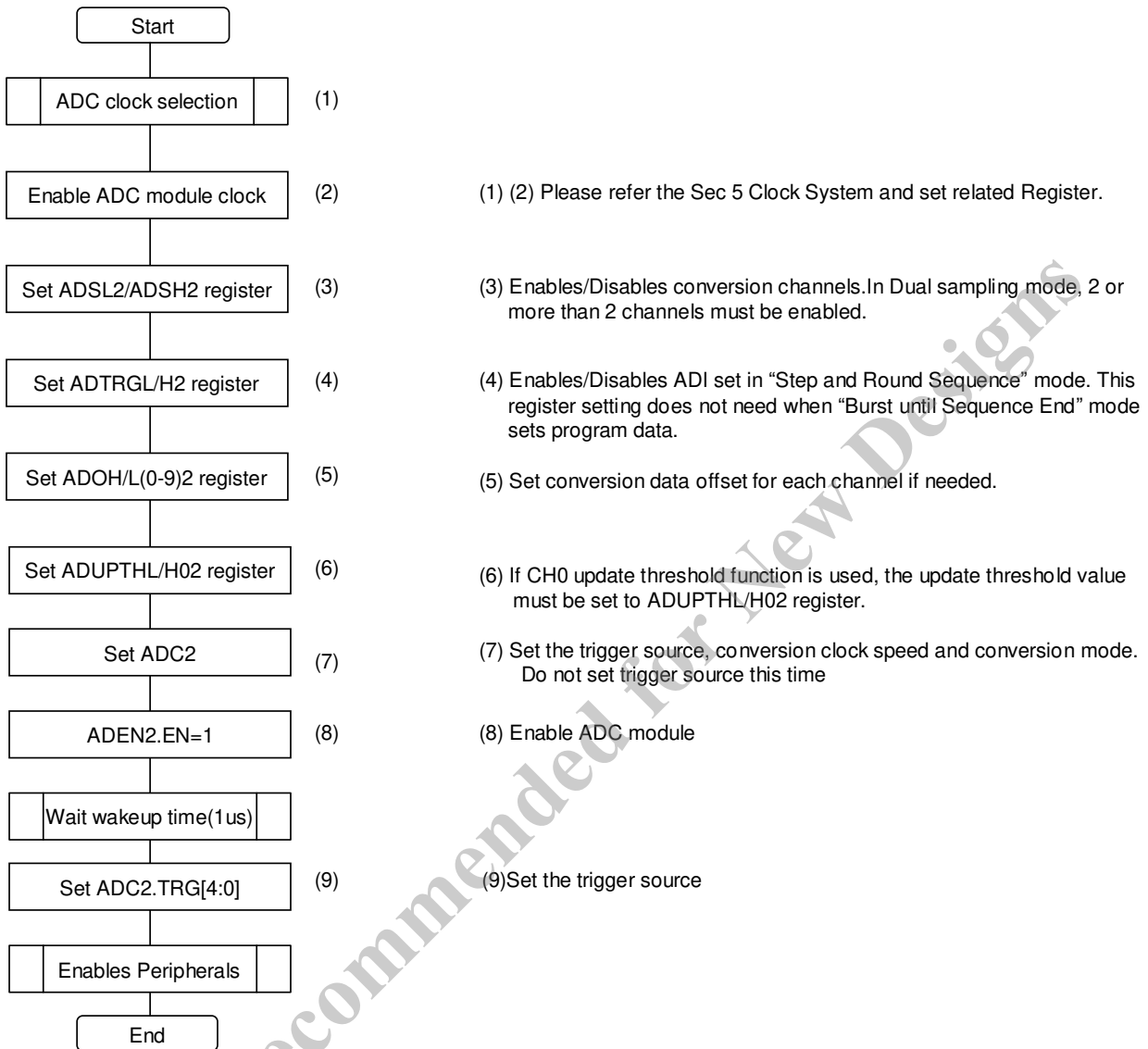


Figure 22-7 Initialization sequence

22.4 Limitation of ADC12

22.4.1 Disabling ADC

When disabling ADC, please keep following sequence.

- (1) ADC Trigger Source select CPU Trigger by setting the ADC2.ADTRG[4:0] to 5'b00000, then other ADC trigger source can be ignored. If ADTRG[4:0] is not 5'b00000, Trigger Source from peripheral must be stop by each peripheral.
- (2) Wait until ADT.ADCTR2G becomes 1'b0. Please refer to 21.2.16.
- (3) Disable ADC(ADEN2.EN=0).

22.4.2 Going to standby mode

Note that ADC must be disabled before going to Standby mode.

22.5 Caution of operation

22.5.1 Restriction about the conversion time of the 12 bits ADC

- (1) Description
When conversion time of the 12 bits ADC is set to slow mode, conversion results are corrupted.
- (2) Condition
If ADTIME bit of ADC2(ADC Configuration Register) is set to 0 (slow mode), conversion results are corrupted.
- (3) Countermeasure
ADTIME bit of ADC2(ADC Configuration Register) should be set to 1 (fast mode).

Not Recommended for New Designs

23. High Precision 12 bit DAC

23.1 Overview

The LSI has one 12 bit DA Converter. DA output levels are updated by CPU, DSAC, Comparator Events, Timer Events or PWM Events.

Table 23-1 Feature of High Precision 12bit DAC

Item	Description	Note
Unit Counts	Single Unit	
Resolution	12bit	
Conversion Speed	1MSPS (Mega samples per second)	Settling Time = 1000ns
Output Update Event	CPU Writing DSAC Writing Comparator Events Timer Events PWM Events	

23.2 Block Diagram

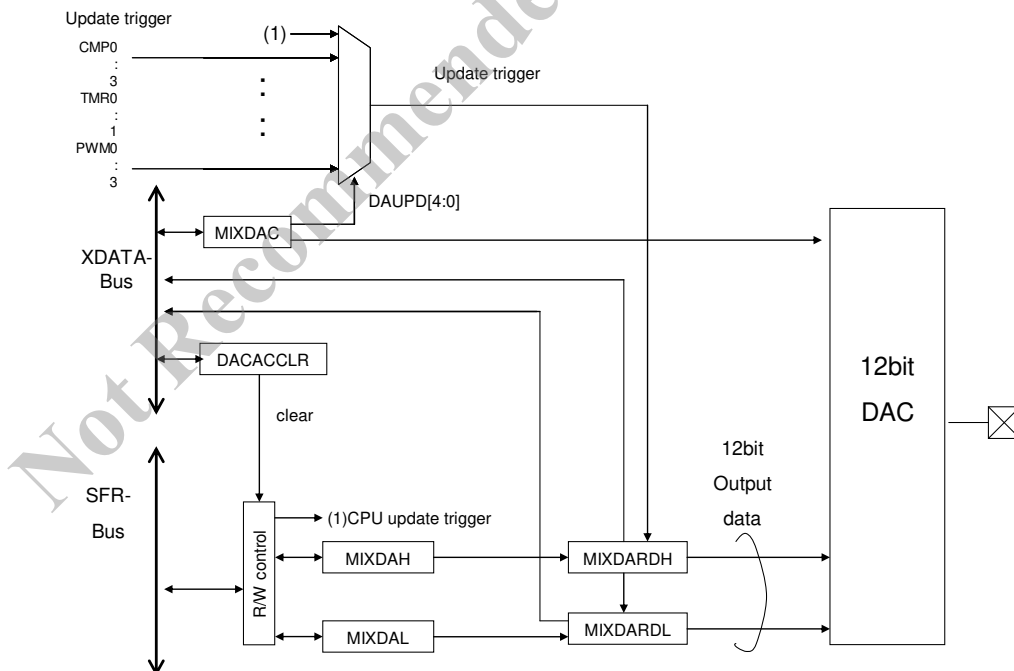


Figure 23-1 Block diagram of 12bit DAC

23.3 Register Description

Table 23-2 List of Registers

Symbol	Name	Address	Initial value
MIXDAC	Mix DAC Configuration	0xF200	0x00
DACOUT	Mix DAC Output select Register	0xF201	0x00
MIXDAL	Mix DAC Data L	0x96	0x00
MIXDAH	Mix DAC Data H	0x96	0x00
MIXDARDL	Mix DAC Read Data L	0xF202	0x00
MIXDARDH	Mix DAC Read Data H	0xF203	0x00
DACACCLR	Mix DAC Access Counter Clear Register	0xF204	0x00

23.3.1 Mix DAC Configuration (MIXDAC)

Register		MIXDAC	Mix DAC Configuration		Address	0xF200
Bit	Bit Name	R/W	Initial	Description		Note
7	DAEN	R/W	0	DAC Enable 0: Disabled 1: Enabled		
6	reserved	R	0	Read value is 0. Write only 0.		
5	reserved	R	0	Read value is 0. Write only 0.		
4	DAUPD4	R/W	0	DAC Update Timing 0000: Immediate Update by CPU 01000: Comparator 0 (pulse) 01001: Comparator 1 (pulse) 01010: Comparator 2 (pulse) 01011: Comparator 3 (pulse) 01100: TIMER0-CM0 (pulse) 01101: TIMER0-CM1 (pulse) 01110: TIMER1-CM0 (pulse) 01111: TIMER1-CM1 (pulse) 10000: PWM0-EVENT0 (pulse) 10001: PWM0-EVENT1 (pulse) 10010: PWM1-EVENT0 (pulse) 10011: PWM1-EVENT1 (pulse) 10100: PWM2-EVENT0 (pulse) 10101: PWM2-EVENT1 (pulse) 10110: PWM3-EVENT0 (pulse) 10111: PWM3-EVENT1 (pulse) Others are reserved. Do not set.		
3	DAUPD3	R/W	0			
2	DAUPD2	R/W	0			
1	DAUPD1	R/W	0			
0	DAUPD0	R/W	0			

23.3.2 Mix DAC Data L (MIXDAL)

Register		MIXDAL		Mix DAC Data L	Address	0x96
Bit	Bit Name	R/W	Initial	Description	Note	
7	DADATA3	R/W	0	DAC Conversion Data L bit 3-bit 0 are stored.		
6	DADATA2	R/W	0			
5	DADATA1	R/W	0			
4	DADATA0	R/W	0			
3	reserved	R	0	Read value is 0. Write only 0.		
2	reserved	R	0	Read value is 0. Write only 0.		
1	reserved	R	0	Read value is 0. Write only 0.		
0	reserved	R	0	Read value is 0. Write only 0.		

23.3.3 Mix DAC Data H (MIXDAH)

Register		MIXDAH		Mix DAC Data H	Address	0x96
Bit	Bit Name	R/W	Initial	Description	Note	
7	DADATA11	R/W	0	DAC Conversion Data H bit 11-bit 4 are stored. If DAUPDn=5'b00000, the DA output will be updated when CPU sets MIXDAHx (2nd access). If DAUPDn != 5'b00000, the DA output will be updated when specified update trigger is issued. Thus, MIXDALx and MIXDAHx should be valid prior to update trigger.		
6	DADATA10	R/W	0			
5	DADATA9	R/W	0			
4	DADATA8	R/W	0			
3	DADATA7	R/W	0			
2	DADATA6	R/W	0			
1	DADATA5	R/W	0			
0	DADATA4	R/W	0			

23.3.4 Mix DAC Read Data L (MIXDARDL)

Register		MIXDARDL		Mix DAC Read Data L	Address	0xF202
Bit	Bit Name	R/W	Initial	Description	Note	
7	DARD3	R	0	DAC Conversion Read Data L bit 3-bit 0 are stored.		
6	DARD2	R	0			
5	DARD1	R	0			
4	DARD0	R	0			
3	reserved	R	0	Read value is 0. Write only 0.		
2	reserved	R	0	Read value is 0. Write only 0.		
1	reserved	R	0	Read value is 0. Write only 0.		
0	reserved	R	0	Read value is 0. Write only 0.		

23.3.5 Mix DAC Read Data H (MIXDARDH)

Register		MIXDARDH		Mix DAC Read Data H	Address	0xF203
Bit	Bit Name	R/W	Initial	Description	Note	
7	DARD11	R	0	DAC Conversion Read Data H bit 11-bit 4 are stored.		
6	DARD10	R	0			
5	DARD9	R	0			
4	DARD8	R	0			
3	DARD7	R	0			
2	DARD6	R	0			
1	DARD5	R	0			
0	DARD4	R	0			

*If MIXDAC[4:0] trigger is detected after both MIXDAH and MIXDAL are written, MIXDARDL and MIXDARDH will be updated.

23.3.6 Mix DAC Access Counter Clear Register (DACACCLR)

Register		DACACCLR		Mix DAC Access Counter Clear Register	Address	0xF204
Bit	Bit Name	R/W	Initial	Description	Note	
7	CPUCLR	R/W	0	Clear DAC Conversion Data Register CPU Access Counter Read : Read value is 0. Write 0: No effect Write 1: Clear Register CPU Access counter. (Clear CPU SFR access counter.)		
6	DSACCLR	R/W	0	Clear DAC Conversion Data Register DSAC Access Counter Read : Read value is 0. Write 0: No effect Write 1: Clear Register DSAC Access counter. (Clear DSAC SFR access counter.)		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	reserved	R	0	Read value is 0. Write only 0.		
2	reserved	R	0	Read value is 0. Write only 0.		
1	reserved	R	0	Read value is 0. Write only 0.		
0	reserved	R	0	Read value is 0. Write only 0.		

23.3.7 Mix DAC Output select Register (DACOUT)

Register		DACOUT		Mix DAC Output select Register	Address	0xF201
Bit	Bit Name	R/W	Initial	Description	Note	
7	CALIB	R/W	0	DAC calibration mode. Output to the CH8 of ADC12. 0: Normal mode 1: Calibration mode Usually set to 0.		
6	reserved	R	0	Read value is 0. Write only 0.		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	SEL3	R/W	0	OPA Output Enable(ANEX15) 0:Not connected to External Pin ANEX15 1:Connected to External Pin ANEX15		
2	SEL2	R/W	0	OPA Output Enable(ANEX13) 0:Not connected to External Pin ANEX13 1:Connected to External Pin ANEX13		
1	SEL1	R/W	0	OPA Output Enable(ANEX11) 0:Not connected to External Pin ANEX11 1:Connected to External Pin ANEX11		
0	SEL0	R/W	0	OPA Output Enable(ANEX09) 0:Not connected to External Pin ANEX09 1:Connected to External Pin ANEX09		

Not Recommended for New Designs

23.4 Operation

12 bit DAC outputs analog data converting 12 bit data to the terminal of MD6601. MIXDAC.DAEN bit sets DAC active or inactive. When it is set "1", the output is active. DACOUT.SELx (x=0-3) bit can select the output terminal for DAC. When DACCOUNT.SELx bit is set to "1", DAC output signal is outputted from the designated terminal. Multi output terminals are selectable. 12 bit data is set to MIXDAL/H register. Access sequence should be from MIXDAL to MIXDAH. When MIXDAH is accessed, the value of MIXDAL/H registers are revised. After this, detecting the revise trigger which is set by MIXDAC.DAUPD[4:0] bit, the value of MIXDAL/H register transfers to MIXDARDL/H register. After passing over setting time, the analog signal equivalent to 12 bit data outputs from the terminal (Refer to Table 23-2). Setting MIXDAC.DAUPD[4:0]=5'b00000, revise trigger occurs when writing MIXDAH register. When DACACCLR.CPUCLR bit is written "1", MIXDAL/H register access counter from CPU is cleared. After clear, MIXDAL can be accessed. When DACACCLR.DSACCLR bit is written "1", MIXDAL/H register access counter from DSAC is cleared. After clear, MIXDAL can be accessed.

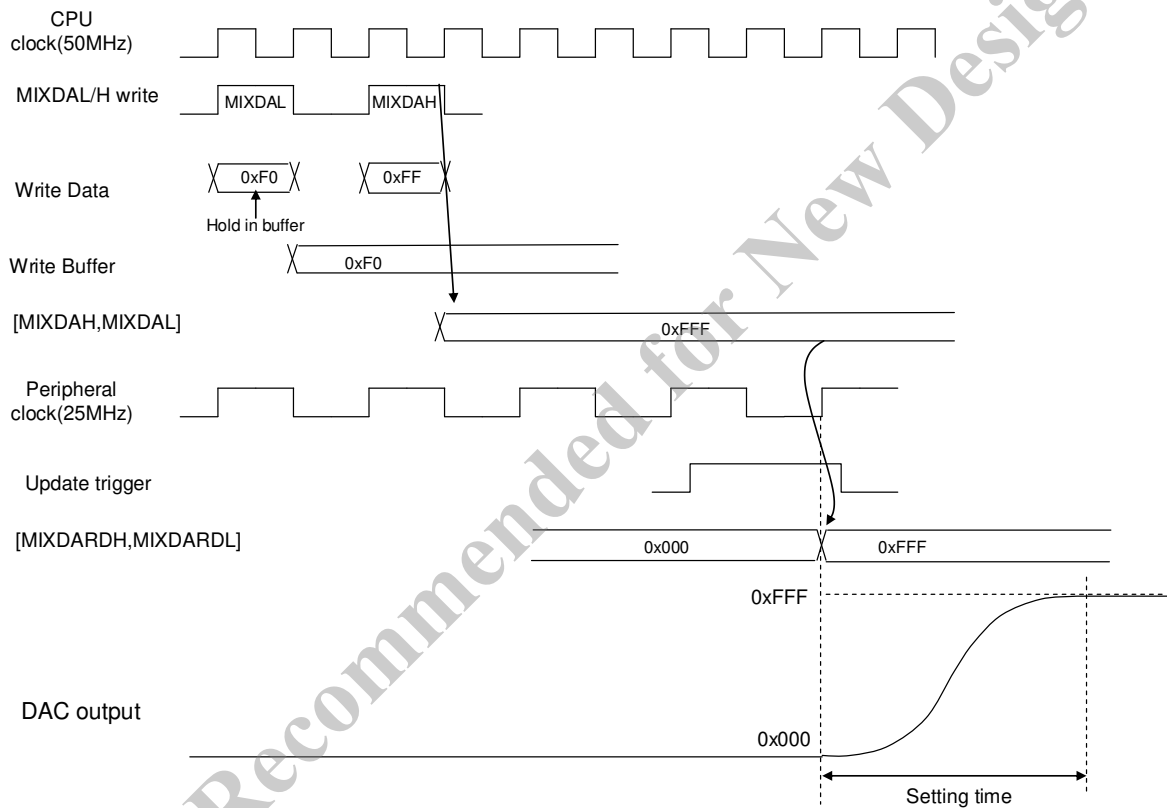


Figure 23-2 Timing diagram of 12bit DAC

23.5 Limitation of DAC

23.5.1 MIXDAL/H register access

When CPU is writing to MIXDAL/H register, DSAC should not read MIXDAL/H register. In addition, When DSAC is writing to MIXDAL/H register, CPU should not read MIXDAL/H register.

24. OPAMP

24.1 Overview

The LSI has general purpose OP Amps which can be configured as stand-alone type or unity (voltage follower) type. Also its inputs and output can be connected to not only external pins but also internal resources. These configurations can be set by register settings.

Table 24-1 Feature of OPAMP

Item	Description	Note
Unit Counts	2 Units	
Input	Rail-to-Rail	
Output	Rail-to-Rail	
Selectable Topology	- Standalone - Unity Amp	

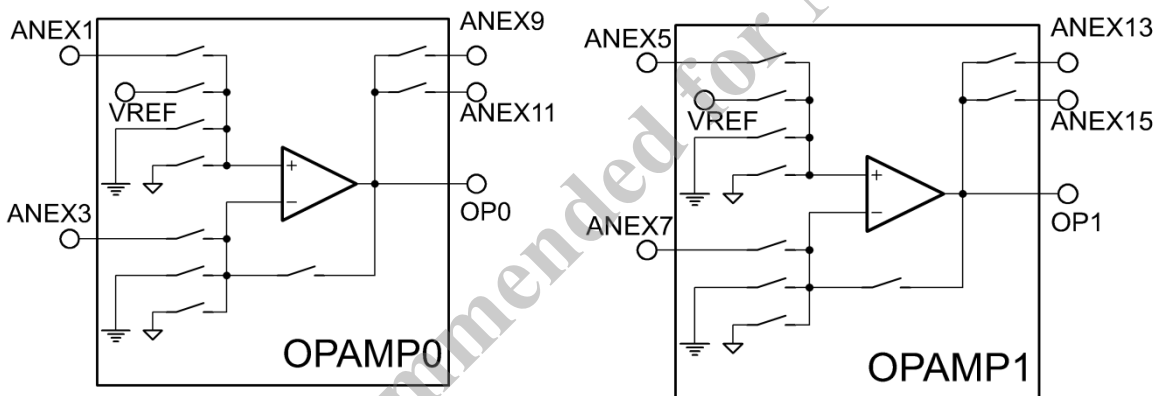


Figure 24-1 Block Diagram of OPAMP

24.2 Register Description

Table 24-2 List of Registers

Symbol	Name	Address	Initial value
MIXOPA0	Mix OPAMP0 Configuration	0xF600	0x00
MIXPGA0	Mix OPAMP0 PGA Configuration	0xF601	0x00
MIXOPA1	Mix OPAMP1 Configuration	0xF680	0x00
MIXPGA1	Mix OPAMP1 PGA Configuration	0xF681	0x00

24.2.1 Mix OPAMPn Configuration (MIXOPAn) (n=0-1)

Register	MIXOPA0	Mix OPAMP0 Configuration			Address	0xF600
Register	MIXOPA1	Mix OPAMP1 Configuration			Address	0xF680
Bit	Bit Name	R/W	Initial	Description	Note	
7	OPAENB	R/W	0	OPAMP Enable 0: Disabled 1: Enabled		
6	reserved	R	0	Read value is 0. Write only 0.		
5	OPAOUT1	R/W	0	OPA Output Enable 0:Not connected to External Pin M 1:Connected to External Pin M	Pin M: ANEX11(OPAMP0) ANEX15(OPAMP1)	
4	OPAOUT0	R/W	0	OPA Output Enable 0:Not connected to External Pin N 1:Connected to External Pin N	Pin N: ANEX9(OPAMP0) ANEX13(OPAMP1)	
3	OPAIM1	R/W	0	Select Input(-) 00:External Pin		
2	OPAIM0	R/W	0	01:reserved 10:AGND= 0.5 x AVcc 11:AVSS		
1	OPAIP1	R/W	0	Select Input(+) 00:External Pin		
0	OPAIP0	R/W	0	01:VREF 10:AGND= 0.5 x AVcc 11:AVSS		

24.2.2 Mix OPAMPn PGA Configuration (MIXPGAn)(n=0-1)

Register	MIXPGA0	Mix OPAMP0 PGA Configuration			Address	0xF601
Register	MIXPGA1	Mix OPAMP1 PGA Configuration			Address	0xF681
Bit	Bit Name	R/W	Initial	Description	Note	
7	reserved	R	0	Read value is 0. Write only 0.		
6	reserved	R	0	Read value is 0. Write only 0.		
5	reserved	R	0	Read value is 0. Write only 0.		
4	reserved	R	0	Read value is 0. Write only 0.		
3	reserved	R/W	0	Read value is 0. Write only 0.		
2	reserved	R/W	0	Read value is 0. Write only 0.		
1	reserved	R/W	0	Read value is 0. Write only 0.		
0	OPAFOLL	R/W	0	Change to OPAMP and voltage follower. 0:OPAMP 1:Voltage follower		

24.2.3 Notice of OPAMP

24.2.3.1. Resistance of analog switch that exists between OPAMP output and PIN

OPAMP is connected to the PIN via the analog switch. Resistor value of the analog switch is 300Ω(typ). This resistor will affect when you make a Gain-Amp with an external resistor. Feedback resistor of the Gain-Amp is the value obtained by adding the resistance of the analog switch to the external resistor value. If the exact gain is required, Please perform the correction by using the built-in ADC.

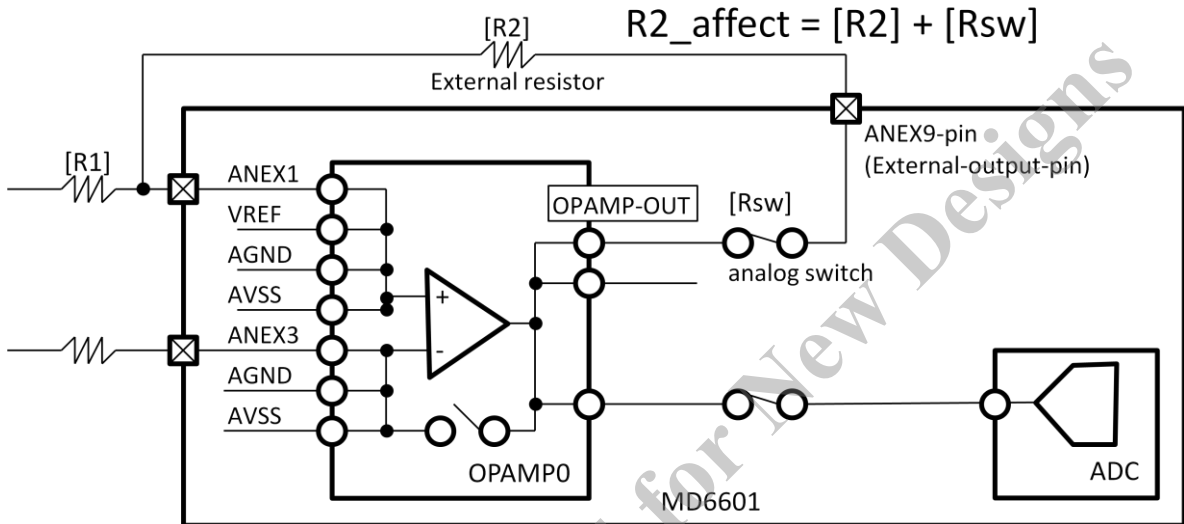


Figure 24-2 Example of the Gain_AMP

If OPAMP-OUT is used only ADC-input or comparator-input, the [Rsw] can be ignored by the connection shown in Figure 24.3. In order to make this configuration, the ADC-input(or comparator-input) and OPAMP-OUT should be assign to the same external output pin.

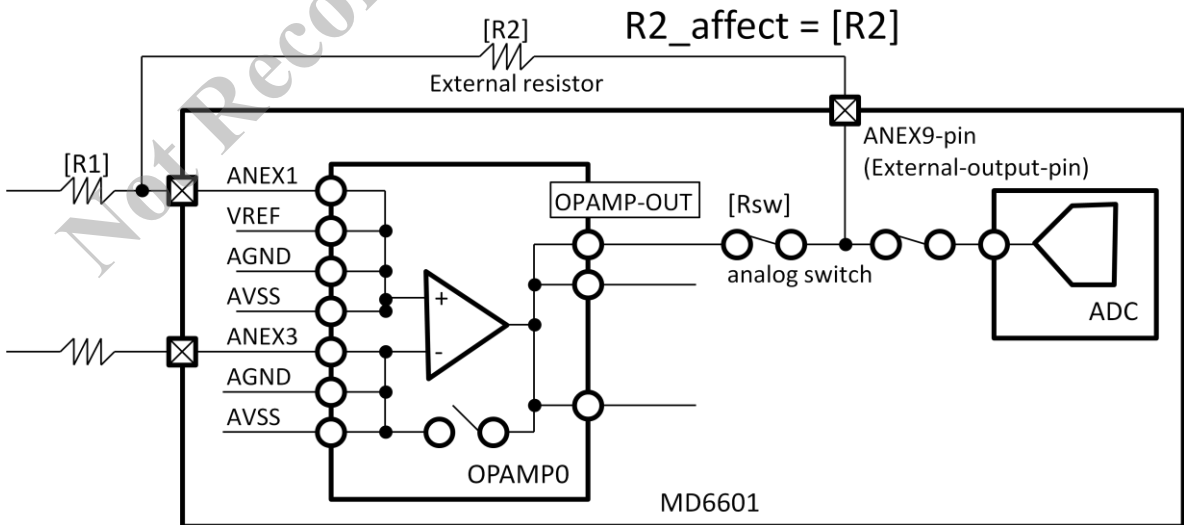


Figure 24-3 Example of the Gain_AMP (no influence of [Rsw])

25. Comparator

25.1 Overview

The LSI has four-high speed analog comparators. Input signals can be configured. Besides, outputs can be used as not only interrupt requests but also trigger events for other modules.

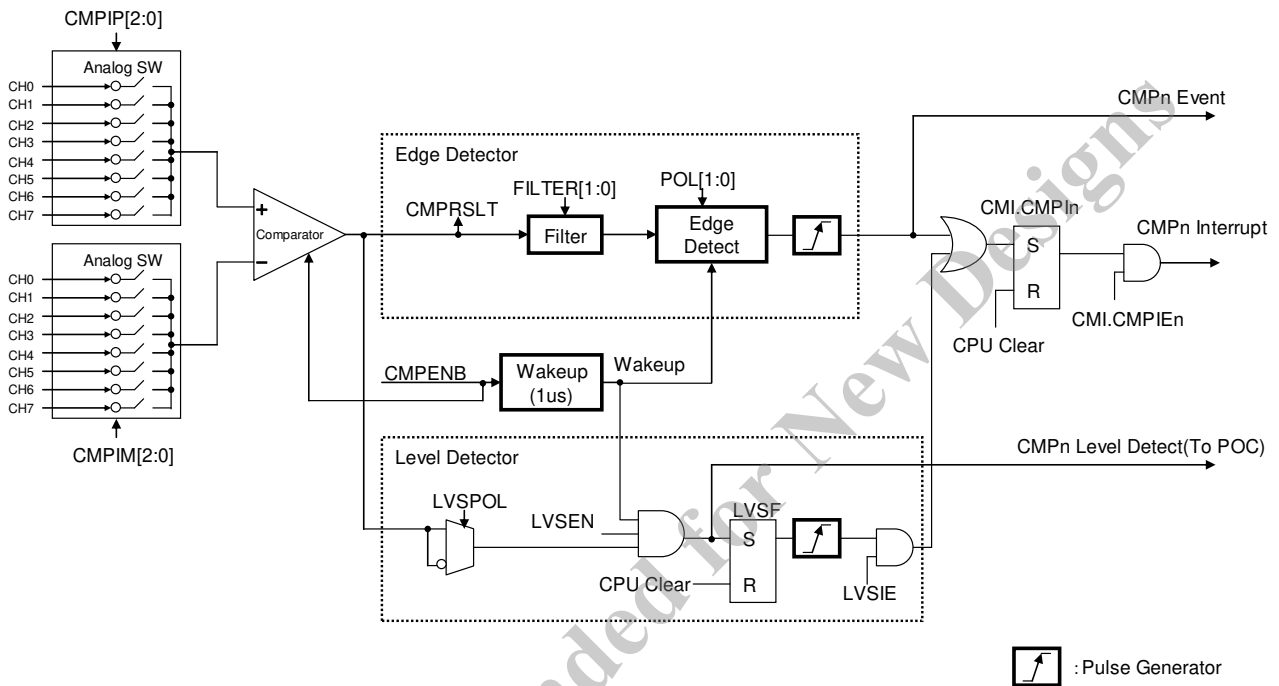


Figure 25-1 Block diagram of Comparator

25.2 Register Description

Table 25-1 List of Registers

Symbol	Name	Address	Initial value
MIXCMP0	Mix Comparator 0 Configuration	0xF380	0x00
MIXCMS0	Mix Comparator 0 Functional Select	0xF381	0x00
MIXCMR0	Mix Comparator 0 Result	0xF382	0x00
MIXCMP1	Mix Comparator 1 Configuration	0xF400	0x00
MIXCMS1	Mix Comparator 1 Functional Select	0xF401	0x00
MIXCMR1	Mix Comparator 1 Result	0xF402	0x0X
MIXCMP2	Mix Comparator 2 Configuration	0xF480	0x00
MIXCMS2	Mix Comparator 2 Functional Select	0xF481	0x00
MIXCMR2	Mix Comparator 2 Result	0xF482	0x0X
MIXCMP3	Mix Comparator 3 Configuration	0xF500	0x00
MIXCMS3	Mix Comparator 3 Functional Select	0xF501	0x00
MIXCMR3	Mix Comparator 3 Result	0xF502	0x0X
CMI	Mix Comparator Interrupt	0xF3	0x00

Not Recommended for New Designs

25.2.1 Mix Comparator n Configuration (MIXCMPn) (n=0-3)

Register	MIXCMP0	Mix Comparator 0 Configuration	Address	0xF380	
Register	MIXCMP1	Mix Comparator 1 Configuration	Address	0xF400	
Register	MIXCMP2	Mix Comparator 2 Configuration	Address	0xF480	
Register	MIXCMP3	Mix Comparator 3 Configuration	Address	0xF500	
Bit	Bit Name	R/W	Initial	Description	Note
7	CMPENB	R/W	0	Comparator Enable 0: Disabled 1: Enabled	
6	CMPIM2	R/W	0	Select Input (-) 000: External Pin 001: OPAMP0 Output 010: OPAMP1 Output 011: DAC Output 100: reserved 101: VREF 110: AGND= 0.5 x AVCC 111: AVSS	n=0: External Pin=ANEX9 n=1: External Pin=ANEX11 n=2: External Pin=ANEX13 n=3: External Pin=ANEX15
5	CMPIM1	R/W	0		
4	CMPIM0	R/W	0		
3	reserved	R	0	Read value is 0. Write only 0.	
2	CMPIP2	R/W	0	Select Input (+) 000: External Pin 001: OPAMP0 Output 010: OPAMP1 Output 011: reserved 100: reserved 101: reserved 110:AGND= 0.5 x AVCC 111: AVSS	n=0: External Pin=ANEX8 n=1: External Pin=ANEX10 n=2: External Pin=ANEX12 n=3: External Pin=ANEX14
1	CMPIP1	R/W	0		
0	CMPIP0	R/W	0		

Note: The initial value of MIXCMPn(n=0~3) is set to b'00000000. So, Comparator Inputs are connected to External Pins. Set MIXCMPn(n=0~3) to b'01000100 to disconnect External Pins from Comparator Inputs when Comparators are not used.

25.2.2 Mix Comparator n Functional Select (MIXCMSn) (n=0-3)

Register	MIXCMS0	Mix Comparator 0 Functional Select	Address	0xF381	
Register	MIXCMS1	Mix Comparator 1 Functional Select	Address	0xF401	
Register	MIXCMS2	Mix Comparator 2 Functional Select	Address	0xF481	
Register	MIXCMS3	Mix Comparator 3 Functional Select	Address	0xF501	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	LVSEN	R/W	0	Level sense enable 1: Level sense enable 0: disable	
5	LVSIE	R/W	0	Level sense interrupt enable 1: Level sense interrupt enable 0: disable	
4	LVSPOL	R/W	0	Level sense polarity 1: High level 0: Low level	
3	POL1	R/W	0	Edge Sense Polarity 00: None (as well as CMPENB=0) 01: Negative Edge 10: Positive Edge 11: Both Edge	
2	POLO	R/W	0		
1	FILTER1	R/W	0	Glitch Filter Select 00: No Glitch Filter 01: 1cyc 10: 2cyc 11: 4cyc	
0	FILTER0	R/W	0		

Note that MIXCMSx register must be written when CMPENB = 0.

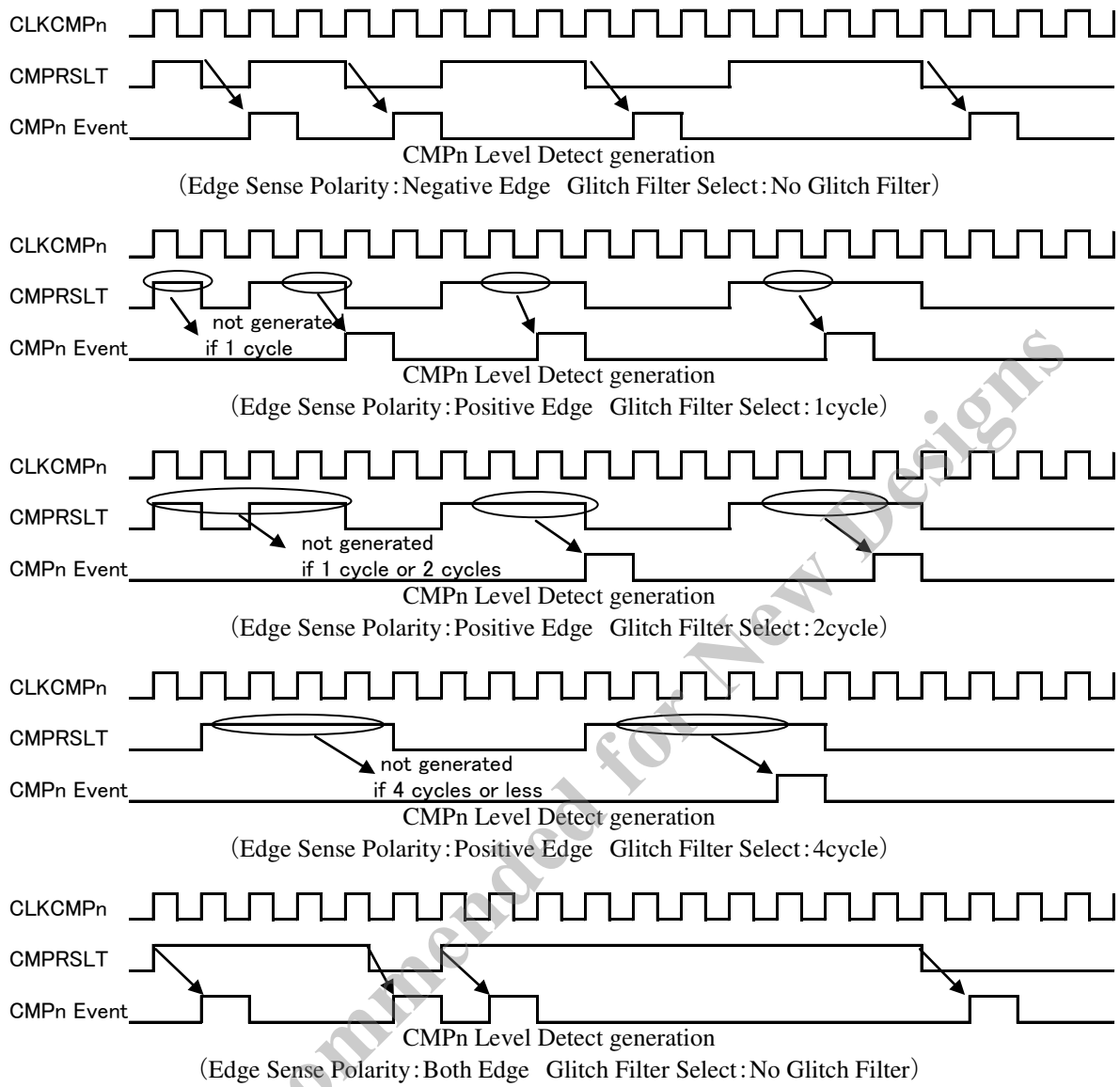


Figure 25-2 Examples of CMPn Level Detect generation

25.2.3 Comparator n Result (MIXCMRn) (n=0-3)

Register	MIXCMR0	Mix Comparator 0 Result	Address	0xF382	
Register	MIXCMR1	Mix Comparator 1 Result	Address	0xF402	
Register	MIXCMR2	Mix Comparator 2 Result	Address	0xF482	
Register	MIXCMR3	Mix Comparator 3 Result	Address	0xF502	
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	LVSF	R/C	0	Level sense detect flag Read: 1: Detected 0: not detected Write: 1: Clear 0: not effect This bit can be cleared by writing 1 when level detection is not detected.	
0	CMPSLT	R	x	Monitor CMP_OUT	

25.2.4 Mix Comparator Interrupt(CMI)

Register		CMI		Mix Comparator Interrupt	Address	0xF3
Bit	Bit Name	R/W	Initial	Description	Note	
7	CMPIE3	R/W	0	Comparator3 Interrupt Enable 0: Disable 1: Enable		
6	CMPIE2	R/W	0	Comparator2 Interrupt Enable 0: Disable 1: Enable		
5	CMPIE1	R/W	0	Comparator1 Interrupt Enable 0: Disable 1: Enable		
4	CMPIE0	R/W	0	Comparator0 Interrupt Enable 0: Disable 1: Enable		
3	CMPI3	R/C	0	Comparator3 Interrupt Flag (before mask; independent CMPIEn) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit		
2	CMPI2	R/C	0	Comparator2 Interrupt Flag (before mask; independent CMPIEn) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit		
1	CMPI1	R/C	0	Comparator1 Interrupt Flag (before mask; independent CMPIEn) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit		
0	CMPI0	R/C	0	Comparator0 Interrupt Flag (before mask; independent CMPIEn) Read 0: No Request Read 1: Interrupt Event Occurred Write 0: No effect Write 1: To clear corresponding bit		

25.3 Operation

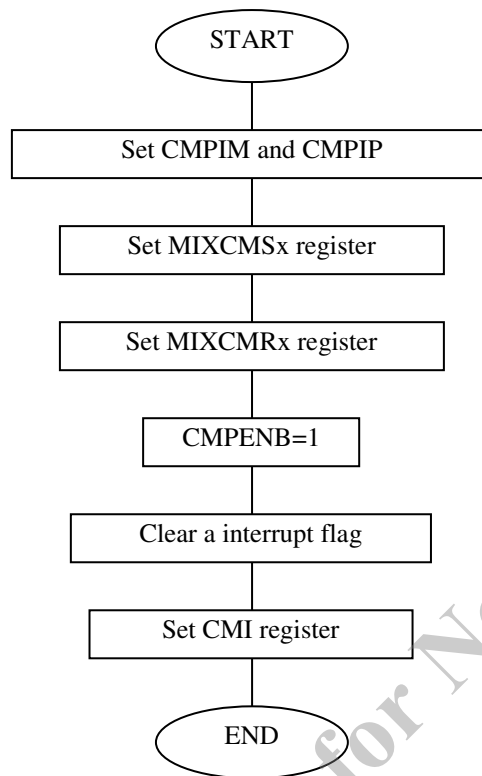


Figure 25-3 Operation flowchart

An interrupt might be misdirected when CMPENB is set to 1 at first. Please clear the interrupt flag.

The comparator has a wakeup counter which prevents the unexpected interrupts and events in un-stable state when startup. The wakeup counter counts 25 clocks ($1\mu\text{s}@CLKCMPx=25\text{MHz}$) from CMPENB changes 0 to 1. The interrupts and events are not detected during wakeup counter is counting.

26. Voltage Reference (VREF)

26.1 Overview

The LSI has Voltage Reference (VREF) which generates constant voltage to be used in Analog Inter-Connection Network. The voltage can be connected to ADCs or Comparators.

Table 26-1 Feature of VREF

Item	Description	Note
Unit Counts	Single Unit	
Output Voltage	1.2V (typ)	

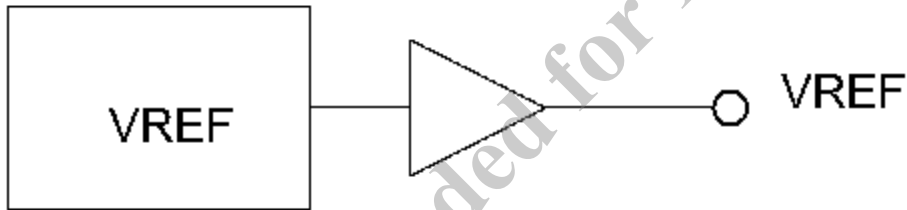


Figure 26-1 Block Diagram of VREF

27. Temperature Sensor (TEMP)

27.1 Overview

The LSI has Temperature Sensor (TEMP) which generates a voltage related to Junction Temperature to be used in Analog Inter-Connection Network. The voltage can be connected to ADCs.

Table 27-1 Feature of TEMP

Item	Description	Note
Unit Counts	Single Unit	
Output Voltage		Refer to Characteristic

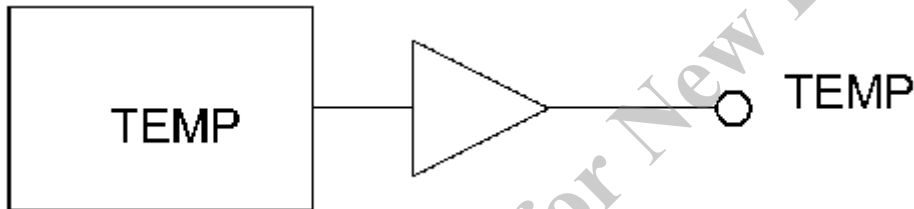


Figure 27-1 Block diagram of TEMP

27.2 Register Description

27.2.1 Temperature sensor Control (TEMP)

Register	TEMP	Temperature sensor Control		Address	0xFFC1
Bit	Bit Name	R/W	Initial	Description	Note
7	reserved	R	0	Read value is 0. Write only 0.	
6	reserved	R	0	Read value is 0. Write only 0.	
5	reserved	R	0	Read value is 0. Write only 0.	
4	reserved	R	0	Read value is 0. Write only 0.	
3	reserved	R	0	Read value is 0. Write only 0.	
2	reserved	R	0	Read value is 0. Write only 0.	
1	reserved	R	0	Read value is 0. Write only 0.	
0	TEMPE	R/W	0	TEMP Enable 0: Disable 1: Enable	

28. POC (PWM Output Controller)

28.1 Overview

POC can place PWM output pins in the high-impedance state when the comparator detects the selected event. Figure 28-1 shows the block diagram of POC.

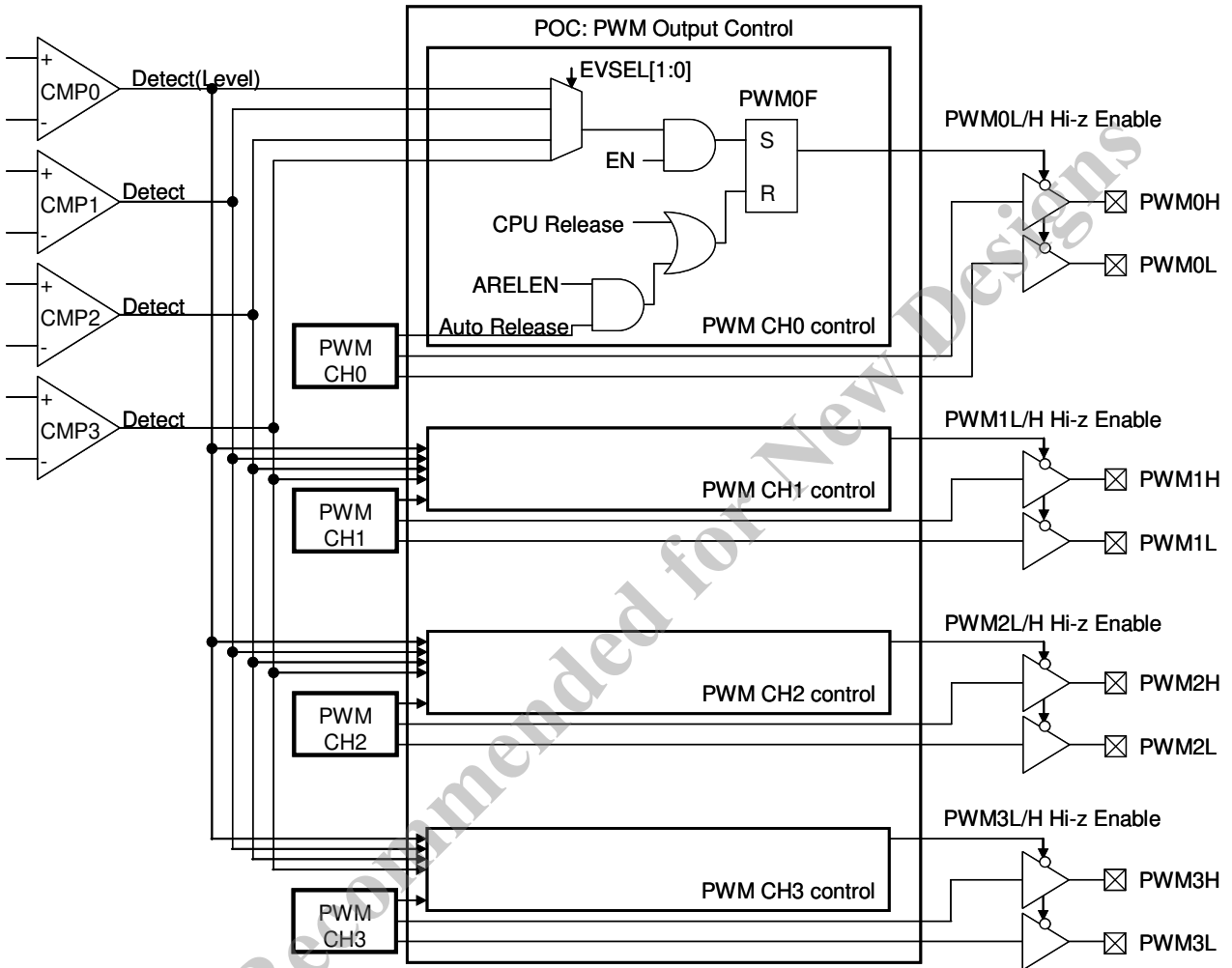


Figure 28-1 Block diagram of POC

28.2 Register Description

Table 28-1 XBUS registers

Symbol	Name	Address	Initial value
POCCR0	POC Control Register 0	0xFD80	0x00
POCCR1	POC Control Register 1	0xFD81	0x00
POCCR2	POC Control Register 2	0xFD82	0x00
POCCR3	POC Control Register 3	0xFD83	0x00
POCSTS	POC Status Resister	0xFD88	0x00

28.2.1 POCCRn (POC Control Register)

Register	POCCR0	POC Control Resister 0	Address	0xFD80	
Register	POCCR1	POC Control Resister 1	Address	0xFD81	
Register	POCCR2	POC Control Resister 2	Address	0xFD82	
Register	POCCR3	POC Control Resister 3	Address	0xFD83	
Bit	Bit Name	R/W	Initial	Description	Note
7	EN	R/W	0	PWMn output pins Hi-Z enable 0: Disable 1: Enable When PWMnF bit is set, the output pins are placed in Hi-Z state.	
6	ARELEN	R/W	0	PWMn output pins Hi-Z auto release enable 0: Disable Only CPU can release 1: Enable Release when PWMn detects CMP_MIN /CMP_MAX match	
5	reserved	R/W	0	Write only 0. Don't write 1.	
4	reserved	R/W	0	Write only 0. Don't write 1.	
3	reserved	R	0	Read value is 0. Write only 0	
2	reserved	R	0	Read value is 0. Write only 0	
1	EVSEL1	R/W	0	Event selection for PWMn output pins Hi-Z 00: Comparator CH0 01: Comparator CH1 10: Comparator CH2 11: Comparator CH3	
0	EVSEL0	R/W	0		

28.2.2 POCSTS (POC Status Register)

Register		POCSTS		POC Status Resister		Address	0xFD88
Bit	Bit Name	R/W	Initial	Description		Note	
7	reserved	R	0	Read value is 0. Write only 0			
6	reserved	R	0	Read value is 0. Write only 0			
5	reserved	R	0	Read value is 0. Write only 0			
4	reserved	R	0	Read value is 0. Write only 0			
3	PWM3F	R/C	0	PWM3 output pins control status Read: 1: Fixed PWM3H & 3L are controlled by POC 0: Released PWM3H & 3L are controlled by PWM3 Write: 1: Clear 0: not effect			
2	PWM2F	R/C	0	PWM2 output pins control status Read: 1: Fixed PWM2H & 2L are controlled by POC 0: Released PWM2H & 2L are controlled by PWM2 Write: 1: Clear 0: not effect			
1	PWM1F	R/C	0	PWM1 output pins control status Read: 1: Fixed PWM1H & 1L are controlled by POC 0: Released PWM1H & 1L are controlled by PWM1 Write: 1: Clear 0: not effect			
0	PWM0F	R/C	0	PWM0 output pins control status Read: 1: Fixed PWM0H & L are controlled by POC 0: Released PWM0H & L are controlled by PWM0 Write: 1: Clear 0: not effect			

28.3 Operation

POC can PWMnH/L(n=0,1,2,3) output pins in high-impedance state when the selected event occurs.

POCCRn.EVSEL[1:0] bit selects the trigger event from CMP 0,1,2 and 3 Level detect events.

POCSTS.PWMnF bit indicates output pins of PWMn High-Impedance status.

When POCSTS.PWMnF=1, PWMnH&L are placed in the high-impedance state. There are two ways to release high-impedance state: CPU release and auto release. The CPU release can be issued by writing 1 to POCSTS.PWMnF bit. The auto release can be issued by PWM CHn when POC n.ARELEN=1. PWM CHn issues an auto release trigger when PWMn CMP_MIN event occurs in Up-Down mode or CMP_MAX event occurs in Up mode, (PWMnCNT changes CMP_MAX to CMP_MIN). POCSTS.PWMnF bit can be cleared when the CPU/auto release is issued and the selected event is not detected.

Figure 28-2 shows PWML/H output control timing.

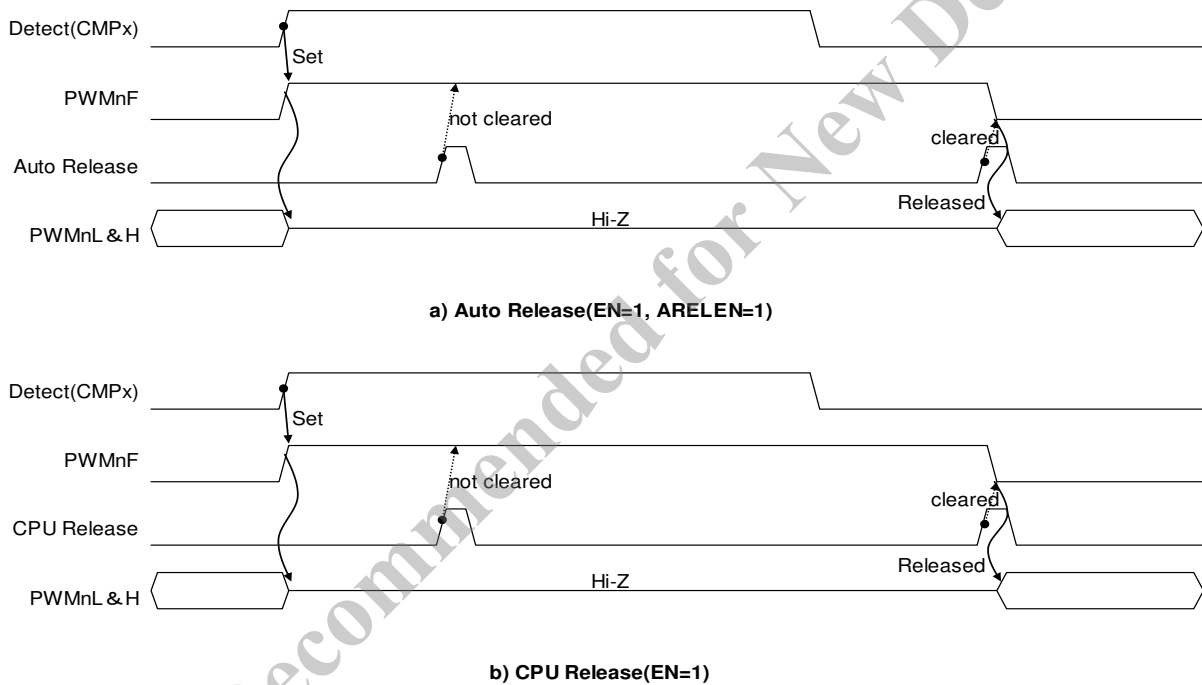


Figure 28-2 Operation timing

POCCRn.EN bit enables POC function for PWM CHn. When POC n.EN=1, POCSTS.PWMnF bit can be set by selected control event. When POC n.EN=0, POCSTS.PWMnF bit cannot be set. POC n.EVSEL[1:0] and POC n.ARELEN bit must be changed when POC n.EN=0.

29. Electrical Characteristics

29.1 Absolute Maximum Ratings

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Storage Temperature	T _{storage}	-40		+125	degC	
Digital Power Supply	DVCC _{amr}	-0.3		+4.0	V	
Analog Power Supply	AVCC _{amr}	-0.3		+4.0	V	
Digital Input Voltage on 5V Tolerant Pin	DVIN5 _{amr}	-0.3		+5.5	V	
Digital Input Voltage on Non 5V Tolerant Pin	DVIN3 _{amr}	-0.3		DVCC+0.3 and < 4.0	V	
Analog Input Voltage	AVIN3 _{amr}	-0.3		AVCC+0.3	V	
Output Current from Digital Pin(total)	ΣDOU _{amr}			58	mA	
Output Current from Analog Pin(total)	ΣIAOU _{amr}			32	mA	

29.2 Recommended Operating Conditions

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Ambient Temperature	T _a	-40		85	degC	
Ambient Temperature for FLASH Programming/Erasing Operation	T _{a_FLASH}	0		55	degC	
Digital Power Supply	DVCC	3.0	3.3	3.6	V	
Analog Power Supply	AVCC	3.0	3.3	3.6	V	

AVCC = DVCC ± 0.3 V

29.3 Package Information

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Thermal Resistance of QFN-40	Theta J-A (QFN-40)		40		deg/W	Wind 0m/s
	Theta J-C (QFN-40)		20		deg/W	Wind 0m/s
Thermal Resistance of QFP-44	Theta J-A (QFP-44)		68		deg/W	Wind 0m/s
	Theta J-C (QFP-44)		22		deg/W	Wind 0m/s

29.4 Current Consumption

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
DVCC Current (Active)	DICC_Active		45	80	mA	CPU 50MHz
DVCC Current (Sleep)	DICC_Sleep		40	70	mA	CPU Stops
DVCC Current (Stby)	DICC_Stby		2	5	mA	*1
DVCC Current under FLASH Programming or Erasing	DICC_FLASH		55		mA	*4
AVCC Current (ADC10)	AICC_ADC10		1	5	mA	*2
AVCC Current (ADC12)	AICC_ADC12		2	7	mA	*2
AVCC Current (DAC12)	AICC_DAC12		2	5	mA	*2
AVCC Current (COMP)	AICC_COMP		0.3	1	mA	*2
AVCC Current (OPAMP)	AICC_OPAMP		1	4	mA	*2
AVCC Current (TEMP)	AICC_TEMP		0.3	1	mA	*2
AVCC Current (Stby)	AICC_Stby		0.3	1	mA	*3

*1: Even in STBY state, internal voltage regulator ,VREF,POR and consumes power.

*2: AVCC current consumption for each module unit which is enabled.

*3: AVCC current consumption when all analog modules are disabled.

*4: Not including external load.

29.5 Low Voltage Detector

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Voltage detection level	Vdet		2.4		V	

29.6 Reset Operation

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
External /RES Width	tRES	10			ms	Cold Start
		1			μs	Hot Start
Internal POR Detect Voltage (VCORE)	VPOR			1.5	V	
Internal POR Detect Hysteresis Voltage	VPOR_hys		100		mV	

29.7 Clock Operation

Item	Symbol	min	typ	max	Unit	Note
External XTAL Oscillation Stabling Time	tXTAL	10			ms	XTAL =12.5MHz
Internal IRC Oscillation Stabling Time	tIRC	100			μs	
Internal IRC Oscillation Frequency	fIRC		10		MHz	
PLL1/2 Oscillation Stabling Time	tPLL_OSC		100		μs	
Input Clock(XTALIN) Frequency	fCLK_IN	8		12.5	MHz	

29.8 10 bit ADC

Item	Symbol	Typ.	Unit	Notes
Resolution	BIT_ADC10	10	bit	
Input Voltage Range	VIN_ADC10	AVSS — AVCC	V	
Conversion Speed (Sampling Time + Conversion Time)	fCONV_ADC10	4	MSPS	
Integral Non Linearity Error	INL_ADC10	±3.5	LSB	
Differential Non Linearity Error	DNL_ADC10	±3.5	LSB	
Zero Scale Error	ZS_ADC10	±4	LSB	
Full Scale Error	FS_ADC10	±4	LSB	
Absolute Error	ABS_ADC10	±4	LSB	

*Measured by Impedance of Source($R_{out_ADC10} \leq 200 \text{ Ohm}$)

29.9 12 bit ADC

Item	Symbol	Typ.	Unit	Notes
Resolution	BIT_ADC12	12	bit	
Input Voltage Range	VIN_ADC12	AVSS — AVCC	V	
Conversion Speed (Sampling Time + Conversion Time)	fCONV_ADC12	1	MSPS	
Integral Non Linearity Error	INL_ADC12	±5	LSB	
Differential Non Linearity Error	DNL_ADC12	±5	LSB	
Zero Scale Error	ZS_ADC12	±12	LSB	
Full Scale Error	FS_ADC12	±12	LSB	
Absolute Error	ABS_ADC12	±16	LSB	

*Measured by Impedance of Source($R_{out_ADC12} \leq 3000 \text{ Ohm}$)

29.10 12 bit DAC

Item	Symbol	Typ.	Unit	Notes
Resolution	BIT_DAC12	12	bit	
Output Voltage Range	VOUT_DAC12	(AVSS+0.2) — (AVCC-0.3)	V	
Output Settling Time	tCONV_DAC12	1	μs	
Output Current	Iout_DAC12	1	mA	
Output Load	Cout_DAC12	50	pF	
Integral Non Linearity Error	INL_DAC12	±20	LSB	
Differential Non Linearity Error	DNL_DAC12	±2.5	LSB	
Zero Scale Error	ZS_DAC12	±20	LSB	
Full Scale Error	FS_DAC12	±40	LSB	
Absolute Error	ABS_DAC12	±40	LSB	

29.11 OPAMP

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Input Voltage Range	VIN_OPAMP	AVSS+0.4		AVCC-0.5	V	
Output Voltage Range	VOUT_OPAMP	AVSS		AVCC	V	
Vin Offset	Voffset_OPAMP		±3		mV	
Output Current	IOUT_OPAMP		±1		mA	
CMRR	CMRR_OPAMP		70		dB	
PMRR	PMRR_OPAMP		50		dB	
Output Noise	ON_OPAMP		45		μVrms	1k~1GHz
Open Gain	GAIN_OPAMP		80		dB	
Gain Band Width	GBW_OPAMP		20		MHz	
Slew Rate	SR_OPAMP		15		V/μs	

29.12 Comparator

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Input Voltage Range	VIN_COMP	AVSS		AVCC	V	
Comparison Voltage Range	VIN_REF	AVSS+1.0		AVCC-1.0	V	
Hysteresis	VIN_hys	10		50	mV	*1
Response Time	tRESP_COMP			20	ns	*2

*1:condition of VIN_COMP=AVCCx0.5

*2:Measurement condition is as follows.

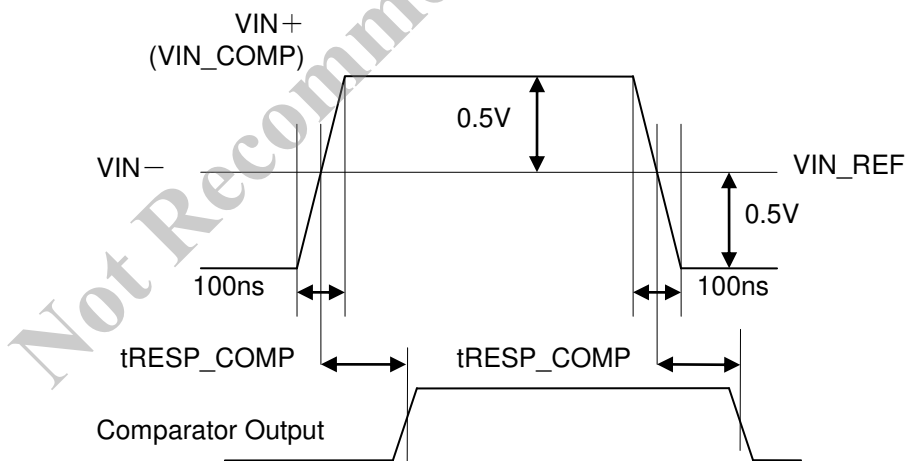


Figure 29-1 Comparator Timing Chart

29.13 Voltage Reference

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Output Voltage	VREF		1.20		V	

29.14 Temperature Sensor

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Output Voltage (T _j =25degC)	VTEMP		1.52		V	
Temperature slope	dTEMP		4.8		mV/degC	
Settling Time	tTEMP			2	ms	from Enabling

29.15 Analog GND

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Output Voltage	VAGND	typ-0.03	AVCCx0.5	Typ+0.03	V	

29.16 Digital I/O DC Spec

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Input Voltage High Level	VIH	2.0			V	
Input Voltage Low Level	VIL			0.8	V	
Input Voltage High Level (Schmitt)	VIH_S	2.0			V	
Input Voltage Low Level (Schmitt)	VIL_S			0.8	V	
Hysteresis for Schmitt	Vhys_S		0.05		V	
Pull Up Register	Rpup	20	60	100	kohm	
Input Leak Current	IL	-2	±1	+2	μA	
Input Capacitance (except ANEX0-15)	CIN			20	pF	
Input Capacitance(ANEX0-15)	CIN			30	pF	
Output Voltage High Level (4mA)	VOH4	2.4			V	I _{oh} = 4 mA
Output Voltage Low Level (4mA)	VOL4			0.4	V	I _{ol} = 4 mA
Output Voltage High Level (16mA)	VOH16	VCC-0.7			V	I _{oh} = 16 mA
Output Voltage Low Level (16mA)	VOL16			0.4	V	I _{ol} = 16 mA

29.17 Digital I/O AC Spec

29.17.1 Timing of PWM

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
Rise Time of PWM terminal (GPIO10-17)	tr		2.0		ns	C=30pF VOH=DVCC×0.7 VOL=DVCC×0.3
Fall Time of PWM terminal (GPIO10-17)	tf		2.0		ns	C=30pF VOH=DVCC×0.7 VOL=DVCC×0.3

29.17.2 Timing of SPI

(1) Master Mode

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
SCK Period	tSCK	80			ns	
SO Output Delay	tdSPI	0		10	ns	
SI Hold	tHLSPI	-3			ns	
SI Setup	tSUSPI	13			ns	

(2) Slave Mode

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
SCK Period	tSCK	80			ns	
SO Output Delay	tdSPI	5		15	ns	
SI Hold	tHLSPI	5			ns	
SI Setup	tSUSPI	5			ns	

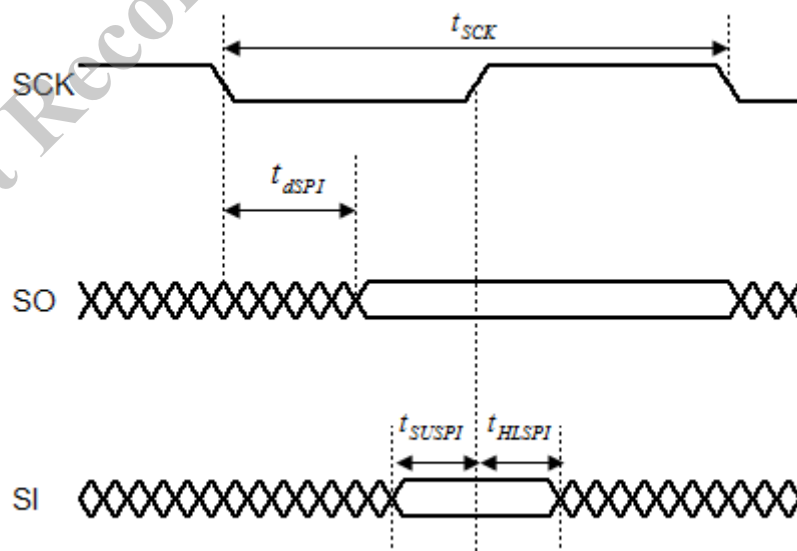


Figure 29-2 SPI Timing (MODE0,3)

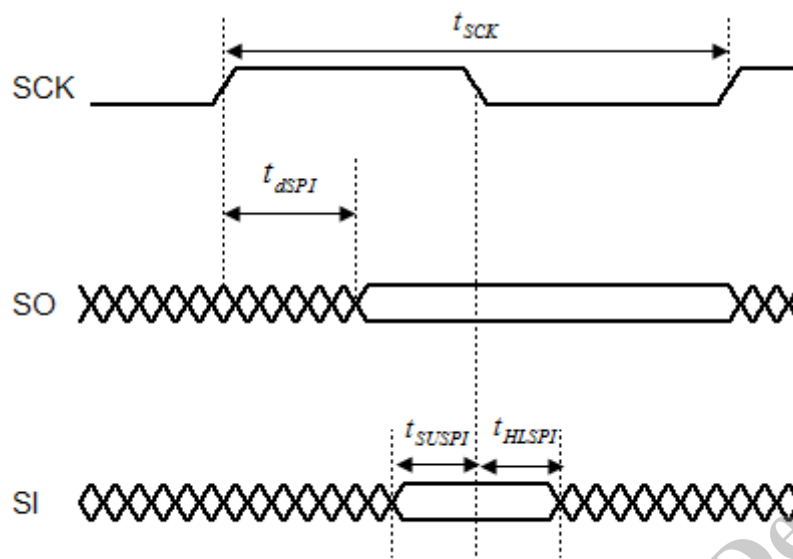


Figure 29-3 SPI Timing (MODE 1,2)

29.17.3 Timing of I2C

(1) Normal Mode

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
SCL clock frequency	fSCL	0		100	kHz	
hold time (repeated) START condition	tHD:STA	4.0			μs	
LOW period of the SCL clock	tLOWI2C	4.7			μs	
HIGH period of the SCL clock	tHIGHI2C	4.0			μs	
set-up time for a repeated START condition	tSU:STA	4.7			μs	
data hold Time	CBUS compatible masters	5.0			μs	
	I2C-bus devices	0				
data set-up time	tSU:DAT	250			ns	
rise time of both SDA and SCL signals	tRI2C			1000	ns	
fall time of both SDA and SCL signals	tFI2C			300	ns	
set-up time for STOP condition	tSU:STO	4.0			μs	
bus free time between a STOP and START condition	tBUFI2C	4.7			μs	
capacitive load for each bus line	Cb			400	pF	
noise margin at the LOW level	VnL	0.1× DVCC			V	
noise margin at the HIGH level	VnH	0.2× DVCC			V	
pulse width of spikes that must be suppressed by the input filter	tSPI2C	-		-	ns	

(2) Fast Mode

Item	Symbol	Min.	Typ.	Max.	Unit	Notes
SCL clock frequency	fSCL	0		400	kHz	
hold time (repeated) START condition	tHD:STA	0.6			μs	
LOW period of the SCL clock	tLOWI2C	1.3			μs	
HIGH period of the SCL clock	tHIGHI2C	0.6			μs	
set-up time for a repeated START condition	tSU:STA	0.6			μs	
data hold time	CBUS compatible masters	0		3.45	μs	
	I2C-bus devices	0		0.9		
data set-up time	tSU:DAT	100			ns	
rise time of both SDA and SCL signals	tRI2C	20+ 0.1Cb		300	ns	
fall time of both SDA and SCL signals	tFI2C	20+ 0.1Cb		300	ns	
set-up time for STOP condition	tSU:STO	0.6			μs	
bus free time between a STOP and START condition	tBUFI2C	1.3			μs	
capacitive load for each bus line	Cb			400	pF	
noise margin at the LOW level	VnL	0.1× DVCC			V	
noise margin at the HIGH level	VnH	0.2× DVCC			V	
pulse width of spikes that must be suppressed by the input filter	tSPI2C	0		50	ns	

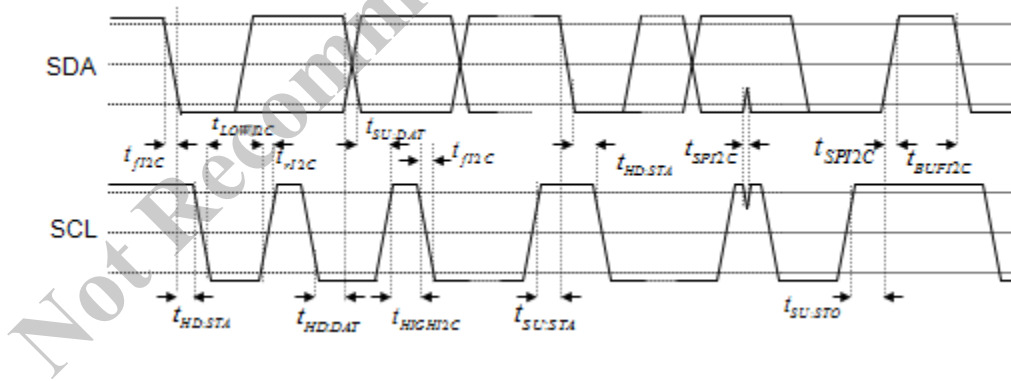


Figure 29-4 I2C timing

30. Packaging information

30.1 QFN40_PKG_dimensional outline drawing

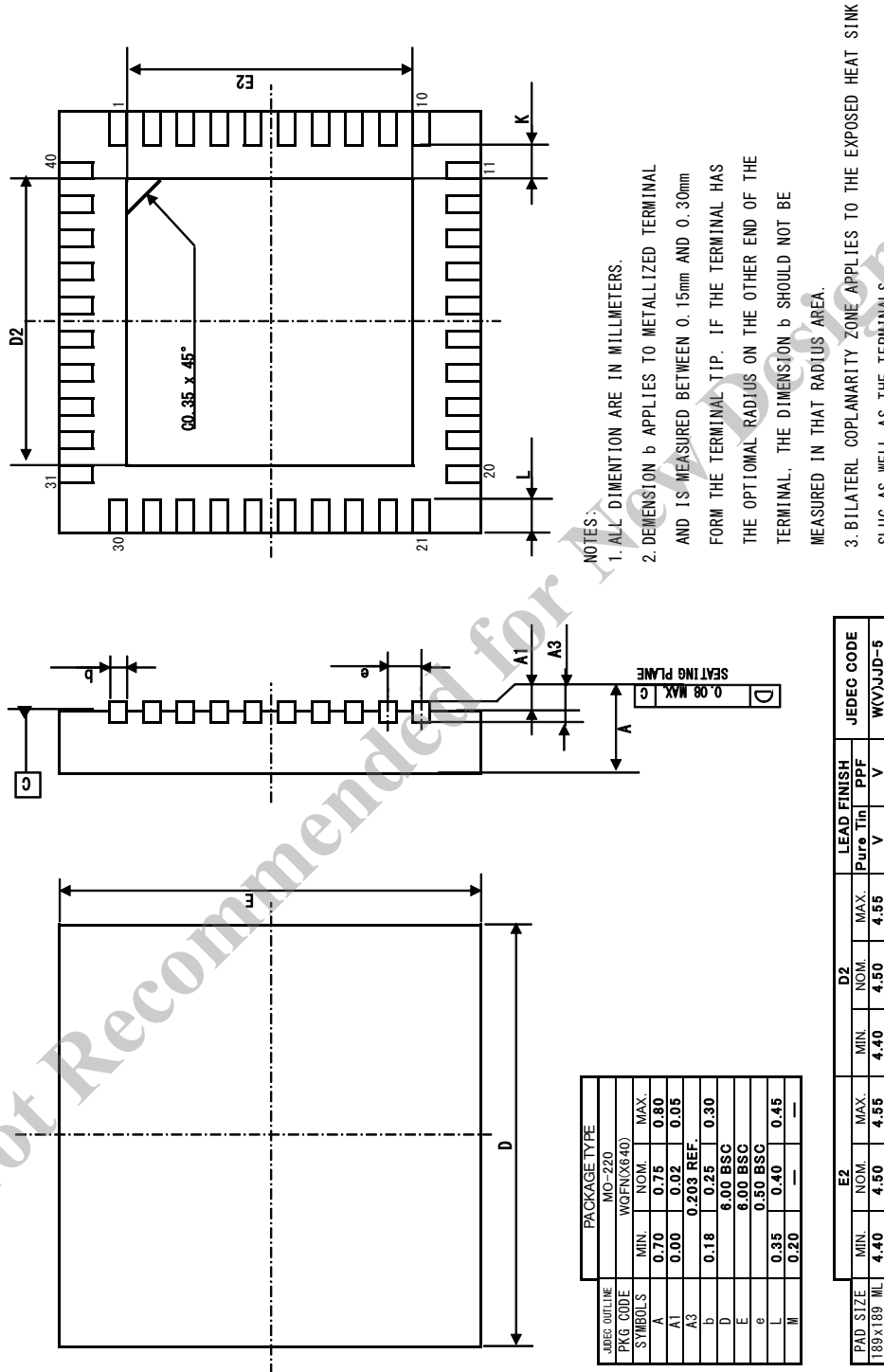


Figure 30-1 QFN40_PKG_dimensional outline drawing.

Note: After mounting, Excessive Stress on the device should not be added to prevent Characteristic Change.

30.2 LQFP44_PKG_dimensional outline drawing

VARATIONS (ALL DIMENSIONS SHOWN IN MM)

SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.60
A1	0.05	—	0.15
A2	1.35	1.40	1.45
c1	0.09	—	0.16
D	12.00 BSC		
D1	10.00 BSC		
E	12.00 BSC		
E1	10.00 BSC		
e	0.80 BSC		
b (w/o plating)	0.25	0.30	0.35
L	0.45	0.60	0.75
L1	1.00 REF		
θ°	0°	3.5°	7°

- NOTES:
1. JEDEC OUTLINE: MS-026 BCB
 2. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PER SIDE. D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.
 3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION BY MORE THAN 0.08mm.

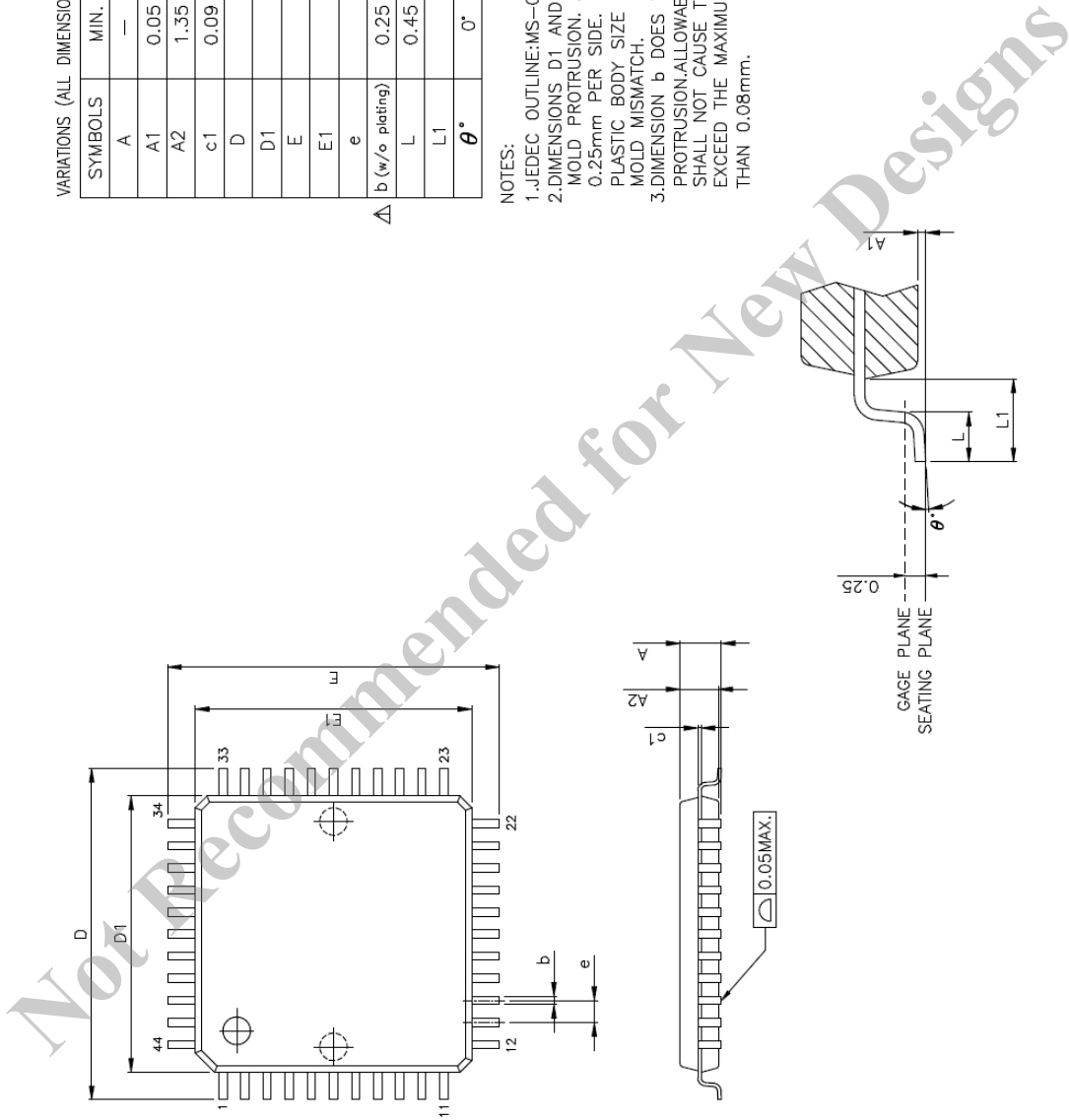


Figure 30-2 LQFP44_PKG_dimensional outline drawing

Note: After mounting, Excessive Stress on the device should not be added to prevent Characteristic Change.

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Revision History

Note: Page numbers for previous revisions may differ from page numbers in current version.

MD6601 Revisions

No.	Rev.	Page	Chapter	Revision details
1	01-05	-	-	Not listed contents because of non-publication
2	06	-	-	First publication
3	07	5-11	Clock System	Added Section 5.5, An example way to configure Clock Settings after Power On.
4	07	10-2	Interrupt Controller	Modified Table 10-2, Vector No.3 "GPIO3"
5	07	10-10	Interrupt Controller	Added Section 10.4.4, Interrupt external pins
6	07	11-9	DSAC	Added Figure 11-2, Multi bytes transfer
7	07	12-3	FLASH Memory Control	Added Section 12.2, Flash memory map structure
8	07	12-15	FLASH Memory Control	Added Section 12.6.4, Protect function
9	07	13-12 to 23	Tiny DSP	Described DSP0 and DSP1 registers separately
10	07	14-2 to 3	PWM	Modified Section 14.3 Resources, The operation of CH2 and CH3 is different from that of CH0 and CH1.
11	07	14-13 to 15	PWM	Modified Section 14.5.2 PWM Mode 0.
12	07	14-16 to 21	PWM	Modified Section 14.5.3 PWM Mode 1 (Auto Dead Time)
13	07	14-22 to 23	PWM	Modified Section 14.5.4 PWM Mode 2 (Phase Shift)
14	07	14-24 to 27	PWM	Modified Section 14.5.5 PWM Mode 3 (Phase Shift + Auto Dead Time)
15	07	14-34 to 39	PWM	Modified Section 14.8 Re-Trigger Operation, There are five Re-trigger operations Mode A/B/C/D and MASK operation which can control output levels of both PWMxH and PWMxL.
16	07	16-3 to 4	TMR	Named bit 2,1,0 of Register TMOD0/TMOD1 as PRSCL
17	07	17-3	SPI	Modified register addresses of Table 17-2 List of Registers
18	07	18-19 to 20	I2C	Modified Section 18.5 Slave receiver operation
19	07	18-21	I2C	Modified Section 18.6 Slave transmitter operation
20	07	18-22 to 23	I2C	Modified Section 18.7 Master receiver operation
21	07	18-24 to 25	I2C	Modified Section 18.8 Master transmitter operation
22	07	19-9	UART	Modified Section 19.4 Operation
23	07	21-2	10bit SAR ADC	Added Figure 21-1 Block diagram of 10bit ADC
24	07	21-4 to 6	10bit SAR ADC	Modified Symbols of Table 21-3 XBUS registers
25	07	21-25	10bit SAR ADC	Added ADL/HXn on Figure 21-2 Basic conversion sequence

No.	Rev.	Page	Chapter	Revision details
26	07	22-2	12bit SAR ADC	Added Figure 22-1 Block diagram of High Precision 12bit ADC
27	07	22-4 to 6	12bit SAR ADC	Modified Symbols of Table 22-3 XBUS registers
28	07	22-21	12bit SAR ADC	Added ADL/HX2 on Figure 22-2 Basic conversion sequence
29	07	5-2,3,4,5,6,7 6-5 27-1	Clock System, 8051 CPU, TEMP	Deleted Chapter 28 System Controller(SYSC) , The registers of Chapter 28 were moved to each chapters. REMAP to chapter6 (8051 CPU Subsystem). TEMP to chapter27 (Temperature/Sensor). CLKCFG0/G1,MCLKE0/E1/E2/E3,LPCTRL and LVDCTRL to chapter5 (Clock System).
30	07	28-1 to 6	POC	Changed Chapter No.29 of POC to No.28.
31	08	29-1	Packaging Information	Added Chapter 29 Packging information.
32	08	4-2 to 3	Reset System and LVD	Register"LVDCTRL" is shifted from chapter5 to chapter4.
33	08	5-10	Clock System	Modified section 5.4.2 STBY Mode
34	08	6-2	8051 CPU	The description of Figure6-1 is modified.
35	08	7-1	Register Mapping	The description of Table7-1 is modified.
36	08	7-2	Register Mapping	Register name of"DPL0" is changed to DPL.
37	08	7-2	Register Mapping	Register name of"DPH0" is changed to DPH.
38	08	13-2	Tiny DSP	The description of Figure13-1 is modified.
39	08	14-4	PWM	The description of Figure14-2 is modified.
40	08	14-16 to 17	PWM	Modified section 14.5.3 PWM Mode 1(Auto Dead Time)
41	08	14-69 to 70	PWM	Modified register addresses of section 14.12.26 BUF_A/B/C/Dn(n=0-3).
42	08	16-1	TMR	The description of Figure16-1 is modified.
43	08	17-3 to 9	SPI	The Addresses are modified as follows. 0xFB00 -> 0xFB80 0xFB01 -> 0xFB81 0xFB02 -> 0xFB82 0xFB04 -> 0xFB84 0xFB05 -> 0xFB85 0xFB06 -> 0xFB86 0xFB08 -> 0xFB88 0xFB09 -> 0xFB89
44	08	17-12 to 13	SPI	Modified section 17.4.1 Master mode
45	08	17-17 to 18	SPI	Modified section 17.4.2 Slave mode

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No.	Rev.	Page	Chapter	Revision details
46	08	27-1	TEMP	The description of table27-1 is modified.
47	08	29	Electric Characteristics	Added Chapter No. 29 Electric Characteristics
48	08	30	Packaging Information	Changed Chapter NO. from 29 to 30
49	09	1-3	Product Overview	Correcting typo of Figure1-1
50	09	21-30	10bit SAR ADC	Correcting typo of section 21.3.7 ADC Event
51	09	29-11	Electrical Characteristics	Correcting typo of section 29.17.3 Timing of I2C
52	1.0	1-3	Product Overview	Modified Part#(LQFP-44) of Table 1.4 Ordering Information. Added Part#(MD6601FNVL) of Table 1.4 Ordering Information.
53	1.0	5-1	Clock System	Modified Figure 5-1 Clock System.
54	1.0	5-4	Clock System	Added the Table 5-2 clock's enabler condition and disabler condition.
55	1.0	5-9	Clock System	Added Section 5-6 Limitation of clock system.
56	1.0	8-1 to 2	GPIO	Remove Section 8.1, move to Section 8.2
57	1.0	8-1	GPIO	Modified GPIO0x and 1x structure in Figure.8-1
58	1.0	11-8	DSAC	Modified 11.6 Limitation of DSAC.
59	1.0	12-1	FLASH Memory Control	Remove T.B.D. description in Table 12-1.
60	1.0	13-7	TinyDSP	Added the description for SFR access counter.
61	1.0	13-10	TinyDSP	Modified the Table13-4 for DSPn Access Counter Clear Register.
62	1.0	13-20	TinyDSP	Added the Table for DSPn Access Counter Clear Register.
63	1.0	13-21	TinyDSP	Added the description about DSP_SS and the DIV instruction.
64	1.0	14-3	PWM	Added the note for changing clock source.
65	1.0	14-9, 12	PWM	Added explanation for Up-Down Mode.
66	1.0	14-37 to 55	PWM	Modified the description and note for PWMnACSTS.
67	1.0	17-1	SPI	Modified Table 17-1. Added the number of FIFO stage.
68	1.0	18-3	I2C	Modified description for ICCR register.
69	1.0	18-5	I2C	Modified description for ICSR register.
70	1.0	18-15 to 22	I2C	Modified Section 18.4-7. Added description for stop condition interrupt.
71	1.0	23-6	12bit DAC	Added Section 23.5 Limitation of DAC - 23.5.1 MIXDAL/H register access.

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No.	Rev.	Page	Chapter	Revision details
72	1.0	24-3	OPAMP	Added Section 24.2.3 Notice of OPAMP – 24.2.3.1 Resistance of analog switch that exists between OPAMP output and PIN.
73	1.0	25-8	Comparator	Added wakeup counter description.
74	1.0	29-1	Electrical Characteristics	Modified typical value(LQFP-44) of Table 29.3 Package Information.
75	1.0	29-6	Electrical Characteristics	Modified SO Output Delay in slave mode.
76	1.0	30-2	Packging information	Added Figure No. 30-2 LQFP44_PKG_dimensional outline drawing

Not Recommended for New Designs